

# TMS570LC4357-SEP 采用增强型航天塑料封装、基于 Arm® Cortex®-R 内核的 Hercules™ 微控制器

## 1 特性

- **VID - V62/18621**
- **耐辐射**
  - 单粒子闩锁 (SEL) 在 125°C 下的抗扰度可达 43MeV-cm<sup>2</sup>/mg
  - 每个晶圆批次的 RLAT 总电离剂量 (TID) 高达 30krad (Si)
- **增强型航天塑料**
  - 受控基线
  - 金 Au 导线
  - 一个封测厂
  - 一个制造厂
  - 具有更宽的温度范围 ( -55°C 至 125°C )
  - 延长的产品生命周期
  - 延长的产品变更通知
  - 产品可追溯性
  - 采用增强型模具化合物实现低释气
- **针对安全关键应用的高性能汽车级微控制器**
  - 双核锁步 CPU，具有 ECC 保护高速缓存
  - 闪存和 RAM 接口上具有 ECC
  - 针对 CPU、高端计时器和片上 RAM 的内置自检 (BIST)
  - 带有错误引脚的错误信令模块 (ESM)
  - 电压和时钟监视
- **Arm® Cortex®-R5F 32 位 RISC CPU**
  - 1.66DMIPS/MHz，具有 8 级流水线
  - 支持单精度和双精度的 FPU
  - 16 区域存储器保护单元 (MPU)
  - 配有 32KB 的指令和 32KB 的数据高速缓存 (支持 ECC)
  - 带有第三方支持的开放式架构
- **运行条件**
  - 频率高达 300MHz 的 CPU 时钟
  - 内核电源电压 (VCC) : 1.14V 至 1.32V
  - I/O 电源电压 (VCCIO) : 3.0V 至 3.6V
- **集成存储器**
  - 支持 ECC 的 4MB 程序闪存
  - 支持 ECC 的 512KB RAM
  - 用于仿真的 EEPROM 的 128KB 数据闪存 (支持 ECC)
- **16 位外部存储器接口 (EMIF)**
- **Hercules™ 通用平台架构**
  - 系列间一致的存储器映射
  - 实时中断 (RTI) 计时器 ( OS 计时器 )
  - 2 个具有向量表 ECC 保护的 128 通道向量中断模块 (VIM)
    - VIM1 和 VIM2 在安全锁步模式下运行
    - 2 个双通道循环冗余校验器 (CRC) 模块
- **直接存储器存取 (DMA) 控制器**
  - 32 个通道和 48 个外设请求
  - 针对控制包 RAM 的 ECC 保护
  - 由专用 MPU 保护的 DMA 访问
- **内置滑动检测器的调频锁相环 (FMPLL)**
- **独立的非调制 PLL**
- **IEEE 1149.1 JTAG，边界扫描和 Arm CoreSight™ 组件**
- **高级 JTAG 安全模块 (AJSM)**
- **跟踪和校准功能**
  - ETM™、RTP、DMM、POM
- **多个通信接口**
  - 10/100Mbps 以太网 MAC (EMAC)
    - 符合 IEEE 802.3 标准 ( 仅限 3.3V I/O )
    - 支持 MII、RMII 和 MDIO
  - 双通道 FlexRay 控制器
    - 支持 ECC 保护的 8KB 消息 RAM
    - 专用 FlexRay 传输单元 (FTU)
  - 四个 CAN 控制器 (DCAN) 模块
    - 64 个支持 ECC 保护的邮箱
    - 与 CAN 协议 2.0B 版兼容
  - 两个内部集成电路 (I<sup>2</sup>C) 模块
  - 五个多缓冲串行外设接口 (MibSPI) 模块
    - MibSPI1 : 256 字，带有 ECC 保护
    - 其他 MibSPI : 128 字，带有 ECC 保护
  - 4 个 UART (SCI) 接口，其中 2 个支持本地互连网络 (LIN 2.1) 接口
- **两个下一代高端计时器 (N2HET) 模块**
  - 每个模块拥有 32 个可编程通道
  - 带有奇偶校验的 256 字指令 RAM
  - 每个 N2HET 都带有硬件角度生成器
  - 每个 N2HET 都带有专用高端计时器传输单元 (HTU)



- **2 个 12 位多通道缓冲模数转换器 (MibADC) 模块**
  - MibADC1 : 32 通道 + 针对高达 1024 个片外通道的控制
  - MibADC2 : 25 通道
  - 16 个共享通道
  - 64 个具有奇偶校验保护的结果缓冲器
- **增强型计时外设**
  - 7 个增强型脉宽调制器 (ePWM) 模块
  - 6 个增强型捕捉 (eCAP) 模块
  - 2 个增强型正交编码器脉冲 (eQEP) 模块
- **3 个片上温度传感器**
- **多达 145 个通用 I/O (GPIO) 引脚**
- **16 个具有外部中断功能的专用 GPIO 引脚**
- **封装**
  - 337 Ball Grid Array (GWT) 封装 [绿色环保]

## 2 应用

- 支持近地轨道航天应用
- 航天制动系统 ( 防抱死制动系统和电子稳定性控制 )
- 电动助力转向 (EPS)
- HEV 和 EV 逆变器系统
- 电池管理系统
- 主动驾驶员辅助系统
- 航天和航空电子设备
- 铁路通信
- 越野车

### 3 说明

TMS570LC4357-SEP 器件属于基于 ARM® Cortex®-R 的 **Hercules TMS570** 系列高性能汽车级 MCU。该器件配有完备的文档、工具和软件，可协助开发 ISO 26262 和 IEC 61508 功能安全应用。使用 **Hercules TMS570LC43x LaunchPad 开发套件** 可立即开始评估。TMS570LC4357-SEP 器件具有片上诊断特性，具体包括：两个 CPU 采用锁步运行；针对 CPU、N2HET 协处理器以及片上 SRAM 的内置自检 (BIST) 逻辑；L1 高速缓存、L2 闪存和 SRAM 存储器具有 ECC 保护。该器件还为外设存储器提供了 ECC 或奇偶校验保护，外设 I/O 上具有环回功能。

TMS570LC4357-SEP 器件集成了两个 ARM Cortex-R5F 浮点 CPU，该 CPU 采用锁步运行，并提供了高效的 1.66DMIPS/MHz 速率，运行频率高达 300MHz，从而提供高达 498DMIPS 的指令执行速度。此器件支持大端字节序 [BE32] 格式。

TMS570LC4357-SEP 器件具有 4MB 的集成闪存和 512KB 的数据 RAM，并带有一位错误纠正和双位错误检测功能。该器件上的闪存存储器是实现了 64 位宽数据总线接口的可电擦除且可编程的非易失性存储器。对于所有读取、编程和擦除操作，该闪存都在 3.3V 电源输入（与 I/O 电源电平相同）下运行。SRAM 支持字节、半字和字模式的读取和写入访问。

TMS570LC4357-SEP 器件具有适用于实时控制应用的外设，包括两个下一代高端计时器 (N2HET) 时序协处理器（总 I/O 端子多达 64 个）。

N2HET 是一款高级智能计时器，此计时器能够为实时应用提供精密的计时功能。该计时器由软件控制，具有专用的计时器微机和随附 I/O 端口。N2HET 可用于脉宽调制输出、捕捉或比较输入，或 GPIO。N2HET 旨在用于要求多个传感器信息或用复杂、准确的时间脉冲来驱动执行器的应用。高端计时器传输单元 (HTU) 能够执行 DMA 类型事务来与主存储器之间传输 N2HET 数据。HTU 中内置有存储器保护单元 (MPU)。

增强型脉宽调制器 (ePWM) 模块能够用超少的 CPU 开销或干预来生成复杂脉宽波形。ePWM 易于使用，并且支持高侧和低侧 PWM 以及死区生成。借助于集成的触发区保护以及与片上 MibADC 同步，ePWM 模块非常适用于数字电机控制应用。

如果系统注重外部事件的准时捕捉，那么增强型捕捉 (eCAP) 模块将是必不可少的。在不被用于捕捉应用时，eCAP 还可被用于监视 ePWM 输出或用于简单的 PWM 生成。

增强型正交编码器脉冲 (eQEP) 模块直接连接一个线性或旋转递增编码器，进而从一个高性能运动和位置控制系统中正在旋转的机械中获得位置、方向、和速度信息。

该器件具有两个 12 位分辨率 MibADC，两者均有总共 41 个通道以及带奇偶校验保护的 64 字缓冲 RAM。MibADC 通道可被独立转换或者可针对特殊转换序列由软件分组转换。16 个通道可在两个 MibADC 间共用。每个 MibADC 均支持三个独立的分组。每个序列可在被触发时转换一次，或者通过配置以执行连续转换模式。MibADC 具有一个 10 位模式，可在需要兼容早期器件或需要提高转换速率时使用。MibADC1 中的一个通道和 MibADC2 中的两个通道可搭配用于转换来自 3 个片上温度传感器的温度测量值。

该器件有多个通信接口：5 个 MibSPI；4 个 UART (SCI) 接口，其中 2 个支持 LIN；4 个 CAN；2 个 I2C 模块；1 个以太网控制器；和 1 个 FlexRay 控制器。SPI 为相似的移位寄存器类型器件之间的高速通信提供了一种便捷的串行交互方法。LIN 支持本地互联标准 (LIN 2.1) 并可被用作一个使用标准不归零码 (NRZ) 格式的全双工模式 UART。DCAN 支持 CAN 2.0B 协议标准并使用串行多主机通信协议，此协议有效支持对最高速率为 1Mbps 的稳健通信实现分布式实时控制。DCAN 非常适合嘈杂和恶劣环境中的应用（例如：汽车和工业领域），此类应用需要可靠的串行通信或多路复用布线。FlexRay 控制器使用一个双通道串行、基于固定时间的多主通信协议，每个通道支持 10Mbps 的通信速率。FlexRay 传输单元 (FTU) 可实现与主 CPU 存储器之间的 FlexRay 数据匿名传输。HTU 传输受一个专用的内置 MPU 保护。以太网模块支持 MII、RMII 和管理数据 I/O (MDIO) 接口。I2C 模块是一个多主通信模块，可为微控制器和与 I2C 兼容的器件之间提供接口（通过 I2C 串行总线）。I2C 模块支持 100kbps 和 400kbps 的速率。

调频锁相环 (FMPPLL) 时钟模块会将外部频率基准与一个内部使用的更高频率相乘。全局时钟模块 (GCM) 管理可用时钟源与内部器件时钟域间的映射。

该器件还具有 2 个外部时钟预分频器 (ECP) 模块。ECP 启用后，会在 ECLK1 和 ECLK2 焊球上输出一个连续的外部时钟。ECLK 频率与外设接口时钟 (VCLK) 频率的比例是用户可编程的。这个可被外部监视的低频输出作为此器件运行频率的指示器。

直接存储器存取 (DMA) 控制器有 32 个通道、48 个外设请求和针对其存储器的 ECC 保护。DMA 内置有 MPU，用于保护存储器免遭错误传输。

错误信令模块 (ESM) 监控片上器件错误并在检测到故障时确定是触发一个中断还是触发一个外部错误引脚/焊球 (nERROR)。可从外部监视 nERROR 信号，作为微控制器内故障条件的指示器。

外部存储器接口 (EMIF) 提供对异步和同步存储器或者其他从器件的存储器扩展。

该器件包含参数覆盖模块，可增强应用代码的调试功能。POM 能够将闪存访问重新路由至内部 RAM 或 EMIF，从而避免了闪存内参数更新所需的重编程步骤。该功能在实时系统校准过程中特别有用。

该器件实现了若干个接口，可增强应用代码的调试功能。除了内置的 Arm® Cortex®-R5F CoreSight 调试特性外，嵌入式交叉触发器 (ECT) 支持 SoC 内多触发事件的交互和同步。外部跟踪宏单元 (ETM) 提供程序执行的指令和数据跟踪。为了实现仪器测量的目的，执行了一个 RAM 跟踪端口模块 (RTP) 来支持由 CPU 或者任何其它主控所访问的 RAM 和外设的高速跟踪。一个数据修改模块 (DMM) 提供向器件内存写入外部数据的功能。RTP 和 DMM 对应用代码的程序执行时间影响非常小。

借助集成的安全特性和各种通信和控制外设，TMS570LC4357-SEP 器件旨在用于具有安全关键要求的高性能实时控制应用。

#### 器件信息

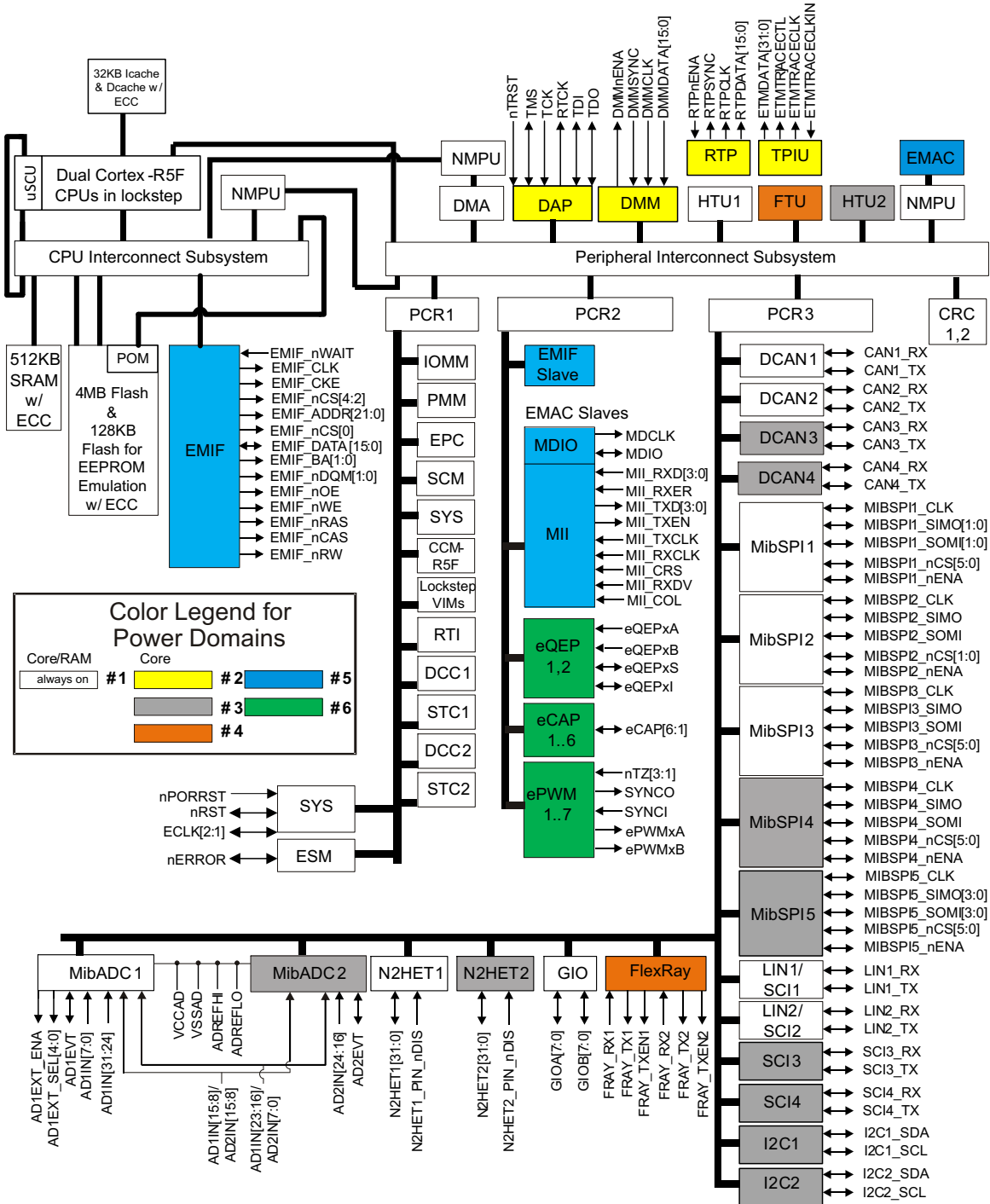
| 器件型号 <sup>(1) (2)</sup> | 等级              | 封装                     | 封装尺寸              |
|-------------------------|-----------------|------------------------|-------------------|
| TMS570LC4357GWT-SEP     | 30krad(Si) RLAT | GWT ( NFBGA ,<br>337 ) | 16.00mm × 16.00mm |

(1) 有关这些器件的更多信息，请参阅 [机械、封装和可订购信息](#)。

(2) 器件采用卷带包装。

### 3.1 功能方框图

图 3-1 展示了器件的功能方框图。



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图 3-1. 功能方框图

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## 4 Device Comparison

表 4-1 shows a comparison between devices, highlighting the differences (for example, the TMS570LC4357GWT-SEP device).

**表 4-1. TMS570LC4357-SEP Device Comparison**

| FEATURES <sup>(1)</sup>               | DEVICES                         |
|---------------------------------------|---------------------------------|
| Generic Part Number                   | <b>TMS570LC4357GWT-SEP</b>      |
| Package                               | 337 BGA                         |
| CPU                                   | ARM® Cortex®-R5F                |
| Frequency (MHz)                       | 300                             |
| Cache (KB)                            | 32 I<br>32 D                    |
| Flash (KB)                            | 4096                            |
| RAM (KB)                              | 512                             |
| Data Flash [EEPROM] (KB)              | 128                             |
| EMAC                                  | 10/100                          |
| FlexRay                               | 2-ch                            |
| CAN                                   | 4                               |
| MibADC<br>12-bit (Ch)                 | 2 (41ch)                        |
| N2HET (Ch)                            | 2 (64)                          |
| ePWM Channels                         | 14                              |
| eCAP Channels                         | 6                               |
| eQEP Channels                         | 2                               |
| MibSPI (CS)                           | 5 (4 × 6 + 2)                   |
| SPI (CS)                              | –                               |
| SCI (LIN)                             | 4 (2 with LIN)                  |
| I <sup>2</sup> C                      | 2                               |
| GPIO (INT) <sup>(2)</sup>             | 168 (with 16 interrupt capable) |
| EMIF                                  | 16-bit data                     |
| ETM (Trace)                           | 32-bit                          |
| RTP/DMM                               | 16/16                           |
| Operating Temperature, T <sub>A</sub> | – 55°C to 125°C                 |
| Core Supply (V)                       | 1.14 V – 1.32 V                 |
| I/O Supply (V)                        | 3.0 V – 3.6 V                   |

- (1) This table reflects the maximum configuration for each peripheral. Some functions are multiplexed and not all pins are available at the same time.
- (2) Total number of pins that can be used as general-purpose input or output when not used as part of a peripheral.

## 5 Terminal Configuration and Functions

### 5.1 GWT BGA Package Ball-Map (337 Terminal Grid Array)

|    | A           | B              | C              | D             | E                           | F                           | G                           | H               | J               | K                           | L                           | M                           | N                            | P                            | R                            | T                     | U                     | V                    | W                     |    |
|----|-------------|----------------|----------------|---------------|-----------------------------|-----------------------------|-----------------------------|-----------------|-----------------|-----------------------------|-----------------------------|-----------------------------|------------------------------|------------------------------|------------------------------|-----------------------|-----------------------|----------------------|-----------------------|----|
| 19 | VSS         | VSS            | TMS            | N2HET1 [10]   | MIBSPI5 NCS[0]              | MIBSPI1 SIMO[0]             | MIBSPI1 NENA                | MIBSPI5 CLK     | MIBSPI5 SIMO[0] | N2HET1 [28]                 | DMM DATA[0]                 | DCAN3RX                     | AD1EVT                       | AD1IN[15] / AD2IN[15]        | AD1IN[22] / AD2IN[06]        | AD1IN [06]            | AD1IN[11] / AD2IN[11] | AD2IN[24]            | VSSAD                 | 19 |
| 18 | VSS         | TCK            | TDO            | nTRST         | N2HET1 [08]                 | MIBSPI1 CLK                 | MIBSPI1 SOMI[0]             | MIBSPI5 NENA    | MIBSPI5 SOMI[0] | N2HET1 [0]                  | DMM DATA[1]                 | DCAN3TX                     | AD1IN[24]                    | AD1IN[08] / AD2IN[08]        | AD1IN[14] / AD2IN[14]        | AD1IN[13] / AD2IN[13] | AD1IN [04]            | AD1IN [02]           | AD2IN[24]             | 18 |
| 17 | TDI         | nRST           | EMIF ADDR[21]  | EMIF nWE      | MIBSPI5 SOMI[1]             | DMM CLK                     | MIBSPI5 SIMO[3]             | MIBSPI5 SOMI[2] | N2HET1 [31]     | EMIF nCS[3]                 | EMIF nCS[2]                 | EMIF nCS[4]                 | EMIF nCS[0]                  | AD1IN[25]                    | AD1IN [05]                   | AD1IN [03]            | AD1IN[10] / AD2IN[10] | AD1IN [01]           | AD1IN[09] / AD2IN[09] | 17 |
| 16 | RTCK        | FRAY TXEN1     | EMIF ADDR[20]  | EMIF BA[1]    | MIBSPI5 SIMO[1]             | DMM nENA                    | MIBSPI5 SOMI[3]             | MIBSPI5 SOMI[2] | DMM SYNC        | N2HET2 [08]                 | N2HET2 [09]                 | N2HET2 [10]                 | N2HET2 [11]                  | AD1IN[26]                    | AD1IN[23] / AD2IN[07]        | AD1IN[12] / AD2IN[12] | AD1IN[19] / AD2IN[03] | ADREFLO              | VSSAD                 | 16 |
| 15 | FRAYRX1     | FRAYTX1        | EMIF ADDR[19]  | EMIF ADDR[18] | ETM DATA[06]                | ETM DATA[05]                | ETM DATA[04]                | ETM DATA[03]    | ETM DATA[02]    | ETM DATA[16] / EMIF DATA[0] | ETM DATA[17] / EMIF DATA[1] | ETM DATA[18] / EMIF DATA[2] | ETM DATA[19] / EMIF DATA[3]  | AD1IN[27]                    | AD1IN[28]                    | AD1IN[21] / AD2IN[05] | AD1IN[20] / AD2IN[04] | ADREFHI              | VCCAD                 | 15 |
| 14 | N2HET1 [26] | nERROR         | EMIF ADDR[17]  | EMIF ADDR[16] | ETM DATA[07]                | VCCIO                       | VCCIO                       | VCCIO           | VCC             | VCC                         | VCCIO                       | VCCIO                       | VCCIO                        | VCCIO                        | AD1IN[29]                    | AD1IN[30]             | AD1IN[18] / AD2IN[02] | AD1IN [07]           | AD1IN [0]             | 14 |
| 13 | N2HET1 [17] | N2HET1 [19]    | EMIF ADDR[15]  | N2HET2 [04]   | ETM DATA[12] / EMIF_BA[0]   | VCCIO                       | <div></div>                 |                 |                 |                             |                             | <div></div>                 |                              | VCCIO                        | ETM DATA[01]                 | AD1IN[31]             | AD1IN[17] / AD2IN[01] | AD1IN[16] / AD2IN[0] | AD2IN[16]             | 13 |
| 12 | ECLK        | N2HET1 [04]    | EMIF ADDR[14]  | N2HET2 [05]   | ETM DATA[13] / EMIF_nOE     | VCCIO                       |                             |                 |                 |                             |                             |                             |                              | VCCIO                        | ETM DATA[0]                  | MIBSPI5 NCS[3]        | AD2IN[19]             | AD2IN[18]            | AD2IN[17]             | 12 |
| 11 | N2HET1 [14] | N2HET1 [30]    | EMIF ADDR[13]  | N2HET2 [06]   | ETM DATA[14] / EMIF_nDQM[1] | VCCIO                       |                             |                 |                 |                             |                             |                             |                              | VCCPLL                       | ETM TRACE CTL                | AD2IN[20]             | AD2IN[21]             | AD2IN[22]            | AD2IN[23]             | 11 |
| 10 | DCAN1TX     | DCAN1RX        | EMIF ADDR[12]  | ePWM1B        | ETM DATA[15] / EMIF_nDQM[0] | VCC                         |                             |                 |                 |                             |                             |                             |                              | VCC                          | ETM TRACE CLKOUT             | AD2EVT                | MIBSPI1 NCS[4]        | MIBSPI3 NCS[0]       | GIOB[3]               | 10 |
| 9  | N2HET1 [27] | FRAY TXEN2     | EMIF ADDR[11]  | ePWM1A        | ETM DATA[08] / EMIF ADDR[5] | VCC                         |                             |                 |                 |                             |                             |                             |                              | VCCIO                        | ETM TRACE CLKIN              | MDCLK                 | MIBSPI1 NCS[5]        | MIBSPI3 CLK          | MIBSPI3 NENA          | 9  |
| 8  | FRAYRX2     | FRAYTX2        | EMIF ADDR[10]  | N2HET2[11]    | ETM DATA[09] / EMIF ADDR[4] | VCCP                        | <div></div>                 |                 |                 |                             |                             | <div></div>                 |                              | VCCIO                        | ETM DATA[31] / EMIF DATA[15] | N2HET2 [23]           | MII_TXD [0]           | MIBSPI3 SOMI         | MIBSPI3 SIMO          | 8  |
| 7  | LIN1RX      | LIN1TX         | EMIF ADDR[9]   | N2HET2 [2]    | ETM DATA[10] / EMIF ADDR[3] | VCCIO                       |                             |                 |                 |                             |                             |                             |                              | VCCIO                        | ETM DATA[30] / EMIF DATA[14] | N2HET2 [22]           | MII_TX_CLK            | N2HET1 [09]          | nPORRST               | 7  |
| 6  | GIOA[4]     | MIBSPI5 NCS[1] | EMIF ADDR[8]   | N2HET2 [0]    | ETM DATA[11] / EMIF ADDR[2] | VCCIO                       | VCCIO                       | VCCIO           | VCCIO           | VCC                         | VCC                         | VCCIO                       | VCCIO                        | VCCIO                        | ETM DATA[29] / EMIF DATA[13] | N2HET2 [21]           | MII_RX_DV             | N2HET1 [05]          | MIBSPI5 NCS[2]        | 6  |
| 5  | GIOA[0]     | GIOA[5]        | EMIF ADDR[7]   | EMIF ADDR[1]  | ETM DATA[20] / EMIF DATA[4] | ETM DATA[21] / EMIF DATA[5] | ETM DATA[22] / EMIF DATA[6] | FLTP2           | FLTP1           | ETM DATA[23] / EMIF DATA[7] | ETM DATA[24] / EMIF DATA[8] | ETM DATA[25] / EMIF DATA[9] | ETM DATA[26] / EMIF DATA[10] | ETM DATA[27] / EMIF DATA[11] | ETM DATA[28] / EMIF DATA[12] | N2HET2 [20]           | MII_RX_ER             | MIBSPI3 NCS[1]       | N2HET1 [02]           | 5  |
| 4  | N2HET1 [16] | N2HET1 [12]    | EMIF ADDR[6]   | EMIF ADDR[0]  | MII_TXEN                    | MDIO                        | MII_TXD [3]                 | N2HET1 [21]     | N2HET1 [23]     | N2HET2 [15]                 | N2HET2 [16]                 | N2HET2 [17]                 | N2HET2 [18]                  | N2HET2 [19]                  | EMIF nCAS                    | MII_RXCLK             | MII_RXD [0]           | MII_CRS              | MII_COL               | 4  |
| 3  | N2HET1 [29] | N2HET1 [22]    | MIBSPI3 NCS[3] | N2HET2 [12]   | N2HET1 [11]                 | MIBSPI1 NCS[1]              | MIBSPI1 NCS[2]              | GIOA[6]         | MIBSPI1 NCS[3]  | EMIF CLK                    | EMIF_CKE                    | N2HET1 [25]                 | N2HET2 [7]                   | EMIF nWAIT                   | EMIF nRAS                    | MII_RXD [1]           | MII_RXD [2]           | MII_RXD [3]          | N2HET1 [06]           | 3  |
| 2  | VSS         | MIBSPI3 NCS[2] | GIOA[1]        | N2HET2 [13]   | N2HET2 [3]                  | GIOB[2]                     | GIOB[5]                     | DCAN2TX         | GIOB[6]         | GIOB[1]                     | KELVIN_GND                  | GIOB[0]                     | N2HET1 [13]                  | N2HET1 [20]                  | MIBSPI1 NCS[0]               | MII_TXD [2]           | TEST                  | N2HET1 [1]           | VSS                   | 2  |
| 1  | VSS         | VSS            | GIOA[2]        | N2HET2 [14]   | GIOA[3]                     | GIOB[7]                     | GIOB[4]                     | DCAN2RX         | N2HET1 [16]     | OSCIN                       | OSCAUT                      | GIOA[7]                     | N2HET1 [15]                  | N2HET1 [24]                  | MII_TXD [1]                  | N2HET1 [7]            | NHET1 [03]            | VSS                  | VSS                   | 1  |
|    | A           | B              | C              | D             | E                           | F                           | G                           | H               | J               | K                           | L                           | M                           | N                            | P                            | R                            | T                     | U                     | V                    | W                     |    |

图 5-1. GWT Package Pinout - Top View

Note: Balls can have multiplexed functions. See 节 5.2.2 for detailed information.

## 5.2 Terminal Functions

表 5-1 through 表 5-27 identify the external signal names, the associated terminal numbers along with the mechanical package designator, the terminal type (Input, Output, I/O, Power, or Ground), whether the terminal has any internal pullup/pulldown, whether the terminal can be configured as a GIO, and a functional terminal description. The first signal name listed is the primary function for that terminal. The signal name in **Bold** is the function being described. For information on how to select between different multiplexed functions, see the 节 5.2.2, *Multiplexing* of this data manual along with the I/O Multiplexing Module (IOMM) chapter in the Technical Reference Manual (TRM) (SPNU563).

### 备注

In the Terminal Functions tables below, the "Default Pull State" is the state of the pull applied to the terminal while nPORRST is low and immediately after nPORRST goes High. The default pull direction may change when software configures the pin for an alternate function. The "Pull Type" is the type of pull asserted when the signal name in bold is enabled for the given terminal by the IOMM control registers.

All I/O signals except nRST are configured as inputs while nPORRST is low and immediately after nPORRST goes High. While nPORRST is low, the input buffers are disabled, and the output buffers are disabled with the default pulls enabled.

All output-only signals have the output buffer disabled and the default pull enabled while nPORRST is low, and are configured as outputs with the pulls disabled immediately after nPORRST goes High.

### 5.2.1 GWT Package

#### 5.2.1.1 Multibuffered Analog-to-Digital Converters (MibADC)

表 5-1. GWT Multibuffered Analog-to-Digital Converters (MibADC1, MibADC2)

| TERMINAL                           |            | SIGNAL<br>TYPE | DEFAULT<br>PULL<br>STATE | PULL TYPE                   | OUTPUT<br>BUFFER<br>DRIVE<br>STRENGTH | DESCRIPTION                         |
|------------------------------------|------------|----------------|--------------------------|-----------------------------|---------------------------------------|-------------------------------------|
| SIGNAL NAME                        | 337<br>GWT |                |                          |                             |                                       |                                     |
| AD1EVT/MII_RX_ER/RMII_RX_ER/nTZ1_1 | N19        | I/O            | Pulldown                 | Programmable,<br>20 $\mu$ A | 2-mA ZD                               | ADC1 event trigger input, or<br>GIO |
| AD1IN[0]                           | W14        | Input          | -                        | -                           | -                                     | ADC1 Input                          |
| AD1IN[1]                           | V17        | Input          | -                        | -                           | -                                     | ADC1 Input                          |
| AD1IN[2]                           | V18        | Input          | -                        | -                           | -                                     | ADC1 Input                          |
| AD1IN[3]                           | T17        | Input          | -                        | -                           | -                                     | ADC1 Input                          |
| AD1IN[4]                           | U18        | Input          | -                        | -                           | -                                     | ADC1 Input                          |
| AD1IN[5]                           | R17        | Input          | -                        | -                           | -                                     | ADC1 Input                          |
| AD1IN[6]                           | T19        | Input          | -                        | -                           | -                                     | ADC1 Input                          |
| AD1IN[7]                           | V14        | Input          | -                        | -                           | -                                     | ADC1 Input                          |
| AD1IN[8]/AD2IN[8]                  | P18        | Input          | -                        | -                           | -                                     | ADC1/ADC2 shared Input              |
| AD1IN[9]/AD2IN[9]                  | W17        | Input          | -                        | -                           | -                                     | ADC1/ADC2 shared Input              |
| AD1IN[10]/AD2IN[10]                | U17        | Input          | -                        | -                           | -                                     | ADC1/ADC2 shared Input              |
| AD1IN[11]/AD2IN[11]                | U19        | Input          | -                        | -                           | -                                     | ADC1/ADC2 shared Input              |
| AD1IN[12]/AD2IN[12]                | T16        | Input          | -                        | -                           | -                                     | ADC1/ADC2 shared Input              |
| AD1IN[13]/AD2IN[13]                | T18        | Input          | -                        | -                           | -                                     | ADC1/ADC2 shared Input              |
| AD1IN[14]/AD2IN[14]                | R18        | Input          | -                        | -                           | -                                     | ADC1/ADC2 shared Input              |
| AD1IN[15]/AD2IN[15]                | P19        | Input          | -                        | -                           | -                                     | ADC1/ADC2 shared Input              |
| AD1IN[16]/AD2IN[0]                 | V13        | Input          | -                        | -                           | -                                     | ADC1/ADC2 shared Input              |
| AD1IN[17]/AD2IN[1]                 | U13        | Input          | -                        | -                           | -                                     | ADC1/ADC2 shared Input              |
| AD1IN[18]/AD2IN[2]                 | U14        | Input          | -                        | -                           | -                                     | ADC1/ADC2 shared Input              |

表 5-1. GWT Multibuffered Analog-to-Digital Converters (MibADC1, MibADC2) (续)

| TERMINAL                                           |                    | SIGNAL<br>TYPE | DEFAULT<br>PULL<br>STATE | PULL TYPE                   | OUTPUT<br>BUFFER<br>DRIVE<br>STRENGTH | DESCRIPTION                         |
|----------------------------------------------------|--------------------|----------------|--------------------------|-----------------------------|---------------------------------------|-------------------------------------|
| SIGNAL NAME                                        | 337<br>GWT         |                |                          |                             |                                       |                                     |
| AD1IN[19]/AD2IN[3]                                 | U16                | Input          | -                        | -                           | -                                     | ADC1/ADC2 shared Input              |
| AD1IN[20]/AD2IN[4]                                 | U15                | Input          | -                        | -                           | -                                     | ADC1/ADC2 shared Input              |
| AD1IN[21]/AD2IN[5]                                 | T15                | Input          | -                        | -                           | -                                     | ADC1/ADC2 shared Input              |
| AD1IN[22]/AD2IN[6]                                 | R19                | Input          | -                        | -                           | -                                     | ADC1/ADC2 shared Input              |
| AD1IN[23]/AD2IN[7]                                 | R16                | Input          | -                        | -                           | -                                     | ADC1/ADC2 shared Input              |
| AD1IN[24]                                          | N18                | Input          | -                        | -                           | -                                     | ADC1 Input                          |
| AD1IN[25]                                          | P17                | Input          | -                        | -                           | -                                     | ADC1 Input                          |
| AD1IN[26]                                          | P16                | Input          | -                        | -                           | -                                     | ADC1 Input                          |
| AD1IN[27]                                          | P15                | Input          | -                        | -                           | -                                     | ADC1 Input                          |
| AD1IN[28]                                          | R15                | Input          | -                        | -                           | -                                     | ADC1 Input                          |
| AD1IN[29]                                          | R14                | Input          | -                        | -                           | -                                     | ADC1 Input                          |
| AD1IN[30]                                          | T14                | Input          | -                        | -                           | -                                     | ADC1 Input                          |
| AD1IN[31]                                          | T13                | Input          | -                        | -                           | -                                     | ADC1 Input <sup>(1)</sup>           |
| AD2EVT                                             | T10                | I/O            | Pulldown                 | Programmable,<br>20 $\mu$ A | 2-mA ZD                               | ADC2 event trigger input, or<br>GIO |
| MIBSPI3NCS[0]/AD2EVT/eQEP1I                        | V10 <sup>(2)</sup> |                |                          |                             |                                       |                                     |
| AD2IN[16]                                          | W13                | Input          | -                        | -                           | -                                     | ADC2 Input                          |
| AD2IN[17]                                          | W12                | Input          | -                        | -                           | -                                     | ADC2 Input                          |
| AD2IN[18]                                          | V12                | Input          | -                        | -                           | -                                     | ADC2 Input                          |
| AD2IN[19]                                          | U12                | Input          | -                        | -                           | -                                     | ADC2 Input                          |
| AD2IN[20]                                          | T11                | Input          | -                        | -                           | -                                     | ADC2 Input                          |
| AD2IN[21]                                          | U11                | Input          | -                        | -                           | -                                     | ADC2 Input                          |
| AD2IN[22]                                          | V11                | Input          | -                        | -                           | -                                     | ADC2 Input                          |
| AD2IN[23]                                          | W11                | Input          | -                        | -                           | -                                     | ADC2 Input                          |
| AD2IN[24]                                          | V19                | Input          | -                        | -                           | -                                     | ADC2 Input                          |
| AD2IN[24]                                          | W18                |                |                          |                             |                                       |                                     |
| ADREFHI                                            | V15 <sup>(3)</sup> | Input          | -                        | -                           | -                                     | ADC high reference supply           |
| ADREFLO                                            | V16 <sup>(3)</sup> | Input          | -                        | -                           | -                                     | ADC low reference supply            |
| MIBSPI3SOMI/AD1EXT_ENA/ECAP2                       | V8                 | Output         | Pullup                   | 20 $\mu$ A                  | 2-mA ZD                               | External Mux ENA                    |
| MIBSPI5SOMI[3]/DMM_DATA[15]/I2C2_SCL/AD1EXT_ENA    | G16                |                |                          |                             |                                       |                                     |
| MIBSPI3SIMO/AD1EXT_SEL[0]/ECAP3                    | W8                 | Output         | Pullup                   | 20 $\mu$ A                  | 2-mA ZD                               | External Mux Select 0               |
| MIBSPI5SIMO[1]/DMM_DATA[9]/AD1EXT_SEL[0]           | E16                |                |                          |                             |                                       |                                     |
| MIBSPI3CLK/AD1EXT_SEL[1]/eQEP1A                    | V9                 | Output         | Pullup                   | 20 $\mu$ A                  | 2-mA ZD                               | External Mux Select 1               |
| MIBSPI5SIMO[2]/DMM_DATA[10]/AD1EXT_SEL[1]          | H17                |                |                          |                             |                                       |                                     |
| MIBSPI5SIMO[3]/DMM_DATA[11]/I2C2_SDA/AD1EXT_SEL[2] | G17                | Output         | Pullup                   | 20 $\mu$ A                  | 2-mA ZD                               | External Mux Select 2               |
| MIBSPI5SOMI[1]/DMM_DATA[13]/AD1EXT_SEL[3]          | E17                | Output         | Pullup                   | 20 $\mu$ A                  | 2-mA ZD                               | External Mux Select 3               |
| MIBSPI5SOMI[2]/DMM_DATA[14]/AD1EXT_SEL[4]          | H16                | Output         | Pullup                   | 20 $\mu$ A                  | 2-mA ZD                               | External Mux Select 4               |
| VCCAD                                              | W15 <sup>(3)</sup> | Input          | -                        | -                           | -                                     | Operating supply for ADC            |
| VSSAD                                              | W16 <sup>(3)</sup> | Input          | -                        | -                           | -                                     | ADC supply ground                   |
| VSSAD                                              | W19 <sup>(3)</sup> | Input          | -                        | -                           | -                                     | ADC supply ground                   |

(1) This ADC channel is also multiplexed with an internal temperature sensor.

(2) This is the secondary terminal at which the signal is also available. See 节 5.2.2.2 for more detail on how to select between the available terminals for input functionality.

(3) The ADREFHI, ADREFLO, VCCAD, and VSSAD connections are common for both ADC cores.

### 5.2.1.2 Enhanced High-End Timer Modules (N2HET)

表 5-2. GWT Enhanced High-End Timer Modules (N2HET)

| Terminal                                       |         | Signal Type | Default Pull State | Pull Type                | Output Buffer Drive Strength | Description                                         |
|------------------------------------------------|---------|-------------|--------------------|--------------------------|------------------------------|-----------------------------------------------------|
| Signal Name                                    | 337 GWT |             |                    |                          |                              |                                                     |
| N2HET1[0]/MIBSPI4CLK/ePWM2B                    | K18     | I/O         | Pulldown           | Programmable, 20 $\mu$ A | 2-mA ZD                      | N2HET1 time input capture or output compare, or GIO |
| N2HET1[1]/MIBSPI4NENA/N2HET2[8]/eQEP2A         | V2      | I/O         | Pulldown           | Programmable, 20 $\mu$ A | 2-mA ZD                      | N2HET1 time input capture or output compare, or GIO |
| N2HET1[2]/MIBSPI4SIMO/ePWM3A                   | W5      | I/O         | Pulldown           | Programmable, 20 $\mu$ A | 2-mA ZD                      | N2HET1 time input capture or output compare, or GIO |
| N2HET1[3]/MIBSPI4NCS[0]/N2HET2[10]/eQEP2B      | U1      | I/O         | Pulldown           | Programmable, 20 $\mu$ A | 2-mA ZD                      | N2HET1 time input capture or output compare, or GIO |
| N2HET1[4]/MIBSPI4NCS[1]/ePWM4B                 | B12     | I/O         | Pulldown           | Programmable, 20 $\mu$ A | 2-mA ZD                      | N2HET1 time input capture or output compare, or GIO |
| N2HET1[5]/MIBSPI4SOMI/N2HET2[12]/ePWM3B        | V6      | I/O         | Pulldown           | Programmable, 20 $\mu$ A | 2-mA ZD                      | N2HET1 time input capture or output compare, or GIO |
| N2HET1[6]/SCI3RX/ePWM5A                        | W3      | I/O         | Pulldown           | Programmable, 20 $\mu$ A | 2-mA ZD                      | N2HET1 time input capture or output compare, or GIO |
| N2HET1[7]/MIBSPI4NCS[2]/N2HET2[14]/ePWM7B      | T1      | I/O         | Pulldown           | Programmable, 20 $\mu$ A | 2-mA ZD                      | N2HET1 time input capture or output compare, or GIO |
| N2HET1[8]/MIBSPI1SIMO[1]/MII_TXD[3]            | E18     | I/O         | Pulldown           | Programmable, 20 $\mu$ A | 2-mA ZD                      | N2HET1 time input capture or output compare, or GIO |
| N2HET1[9]/MIBSPI4NCS[3]/N2HET2[16]/ePWM7A      | V7      | I/O         | Pulldown           | Programmable, 20 $\mu$ A | 2-mA ZD                      | N2HET1 time input capture or output compare, or GIO |
| N2HET1[10]/MIBSPI4NCS[4]/MII_TX_CLK/nTZ1_3     | D19     | I/O         | Pulldown           | Programmable, 20 $\mu$ A | 2-mA ZD                      | N2HET1 time input capture or output compare, or GIO |
| N2HET1[11]/MIBSPI3NCS[4]/N2HET2[18]/ePWM1SYNCO | E3      | I/O         | Pulldown           | Programmable, 20 $\mu$ A | 2-mA ZD                      | N2HET1 time input capture or output compare, or GIO |
| N2HET1[12]/MIBSPI4NCS[5]/MII_CRS/RMII_CRS_DV   | B4      | I/O         | Pulldown           | Programmable, 20 $\mu$ A | 2-mA ZD                      | N2HET1 time input capture or output compare, or GIO |
| N2HET1[13]/SCI3TX/N2HET2[20]/ePWM5B            | N2      | I/O         | Pulldown           | Programmable, 20 $\mu$ A | 2-mA ZD                      | N2HET1 time input capture or output compare, or GIO |
| N2HET1[14]                                     | A11     | I/O         | Pulldown           | Programmable, 20 $\mu$ A | 2-mA ZD                      | N2HET1 time input capture or output compare, or GIO |
| N2HET1[15]/MIBSPI1NCS[4]/N2HET2[22]/ECAP1      | N1      | I/O         | Pulldown           | Programmable, 20 $\mu$ A | 2-mA ZD                      | N2HET1 time input capture or output compare, or GIO |
| N2HET1[16]/ePWM1SYNCL/ePWM1SYNCO               | A4      | I/O         | Pulldown           | Programmable, 20 $\mu$ A | 2-mA ZD                      | N2HET1 time input capture or output compare, or GIO |

表 5-2. GWT Enhanced High-End Timer Modules (N2HET) (续)

| Terminal                                        |                    | Signal Type | Default Pull State | Pull Type                | Output Buffer Drive Strength | Description                                         |
|-------------------------------------------------|--------------------|-------------|--------------------|--------------------------|------------------------------|-----------------------------------------------------|
| Signal Name                                     | 337 GWT            |             |                    |                          |                              |                                                     |
| N2HET1[17]/EMIF_nOE/SCI4RX                      | A13                | I/O         | Pulldown           | Programmable, 20 $\mu$ A | 2-mA ZD                      | N2HET1 time input capture or output compare, or GIO |
| MIBSPI1NCS[1]/MII_COL/N2HET1[17]/eQEP1S         | F3 <sup>(1)</sup>  |             |                    |                          |                              |                                                     |
| N2HET1[18]/EMIF_RNW/ePWM6A                      | J1                 | I/O         | Pulldown           | Programmable, 20 $\mu$ A | 2-mA ZD                      | N2HET1 time input capture or output compare, or GIO |
| N2HET1[19]/EMIF_nDQM[0]/SCI4TX                  | B13                | I/O         | Pulldown           | Programmable, 20 $\mu$ A | 2m A ZD                      | N2HET1 time input capture or output compare, or GIO |
| MIBSPI1NCS[2]/MDIO/N2HET1[19]                   | G3 <sup>(1)</sup>  |             |                    |                          |                              |                                                     |
| N2HET1[20]/EMIF_nDQM[1]/ePWM6B                  | P2                 | I/O         | Pulldown           | Programmable, 20 $\mu$ A | 2-mA ZD                      | N2HET1 time input capture or output compare, or GIO |
| N2HET1[21]/EMIF_nDQM[2]                         | H4                 | I/O         | Pulldown           | Programmable, 20 $\mu$ A | 2-mA ZD                      | N2HET1 time input capture or output compare, or GIO |
| MIBSPI1NCS[3]/N2HET1[21]/nTZ1_3                 | J3 <sup>(1)</sup>  |             |                    |                          |                              |                                                     |
| N2HET1[22]/EMIF_nDQM[3]                         | B3                 | I/O         | Pulldown           | Programmable, 20 $\mu$ A | 2-mA ZD                      | N2HET1 time input capture or output compare, or GIO |
| N2HET1[23]/EMIF_BA[0]                           | J4                 | I/O         | Pulldown           | Programmable, 20 $\mu$ A | 2-mA ZD                      | N2HET1 time input capture or output compare, or GIO |
| MIBSPI1NENA/MII_RXD[2]/N2HET1[23]/ECAP4         | G19 <sup>(1)</sup> |             |                    |                          |                              |                                                     |
| N2HET1[24]/MIBSPI1NCS[5]/MII_RXD[0]/RMII_RXD[0] | P1                 | I/O         | Pulldown           | Programmable, 20 $\mu$ A | 2-mA ZD                      | N2HET1 time input capture or output compare, or GIO |
| N2HET1[25]                                      | M3                 | I/O         | Pulldown           | Programmable, 20 $\mu$ A | 2-mA ZD                      | N2HET1 time input capture or output compare, or GIO |
| MIBSPI3NCS[1]/MDCLK/N2HET1[25]                  | V5 <sup>(1)</sup>  |             |                    |                          |                              |                                                     |
| N2HET1[26]/MII_RXD[1]/RMII_RXD[1]               | A14                | I/O         | Pulldown           | Programmable, 20 $\mu$ A | 2-mA ZD                      | N2HET1 time input capture or output compare, or GIO |
| N2HET1[27]                                      | A9                 | I/O         | Pulldown           | Programmable, 20 $\mu$ A | 2-mA ZD                      | N2HET1 time input capture or output compare, or GIO |
| MIBSPI3NCS[2]/I2C1_SDA/N2HET1[27]/nTZ1_2        | B2 <sup>(1)</sup>  |             |                    |                          |                              |                                                     |
| N2HET1[28]/MII_RXCLK/RMII_REFCLK                | K19                | I/O         | Pulldown           | Programmable, 20 $\mu$ A | 2-mA ZD                      | N2HET1 time input capture or output compare, or GIO |
| N2HET1[29]                                      | A3                 | I/O         | Pulldown           | Programmable, 20 $\mu$ A | 2-mA ZD                      | N2HET1 time input capture or output compare, or GIO |
| MIBSPI3NCS[3]/I2C1_SCL/N2HET1[29]/nTZ1_1        | C3 <sup>(1)</sup>  |             |                    |                          |                              |                                                     |
| N2HET1[30]/MII_RX_DV/eQEP2S                     | B11                | I/O         | Pulldown           | Programmable, 20 $\mu$ A | 2-mA ZD                      | N2HET1 time input capture or output compare, or GIO |
| N2HET1[31]                                      | J17                | I/O         | Pulldown           | Programmable, 20 $\mu$ A | 2-mA ZD                      | N2HET1 time input capture or output compare, or GIO |
| MIBSPI3NENA/MIBSPI3NCS[5]/N2HET1[31]/eQEP1B     | W9 <sup>(1)</sup>  |             |                    |                          |                              |                                                     |
| N2HET2[0]                                       | D6                 | I/O         | Pulldown           | Programmable, 20 $\mu$ A | 2-mA ZD                      | N2HET2 time input capture or output compare, or GIO |
| GIOA[2]/N2HET2[0]/eQEP2I                        | C1 <sup>(1)</sup>  |             |                    |                          |                              |                                                     |
| N2HET2[1]/N2HET1_NDIS                           | D8                 | I/O         | Pulldown           | Programmable, 20 $\mu$ A | 2-mA ZD                      | N2HET2 time input capture or output compare, or GIO |
| EMIF_ADDR[0]/N2HET2[1]                          | D4 <sup>(1)</sup>  |             |                    |                          |                              |                                                     |
| N2HET2[2]/N2HET2_NDIS                           | D7                 | I/O         | Pulldown           | Programmable, 20 $\mu$ A | 2-mA ZD                      | N2HET2 time input capture or output compare, or GIO |
| GIOA[3]/N2HET2[2]                               | E1 <sup>(1)</sup>  |             |                    |                          |                              |                                                     |

**表 5-2. GWT Enhanced High-End Timer Modules (N2HET) (续)**

| Terminal                                       |                    | Signal Type | Default Pull State | Pull Type           | Output Buffer Drive Strength | Description                                         |
|------------------------------------------------|--------------------|-------------|--------------------|---------------------|------------------------------|-----------------------------------------------------|
| Signal Name                                    | 337 GWT            |             |                    |                     |                              |                                                     |
| N2HET2[3]/MIBSPI2CLK                           | E2                 | I/O         | Pulldown           | Programmable, 20 µA | 2-mA ZD                      | N2HET2 time input capture or output compare, or GIO |
| EMIF_ADDR[1]/N2HET2[3]                         | D5 <sup>(1)</sup>  |             |                    |                     |                              |                                                     |
| N2HET2[4]                                      | D13                | I/O         | Pulldown           | Programmable, 20 µA | 2-mA ZD                      | N2HET2 time input capture or output compare, or GIO |
| GIOA[6]/N2HET2[4]/ePWM1B                       | H3 <sup>(1)</sup>  |             |                    |                     |                              |                                                     |
| N2HET2[5]                                      | D12                | I/O         | Pulldown           | Programmable, 20 µA | 2-mA ZD                      | N2HET2 time input capture or output compare, or GIO |
| EMIF_BA[1]/N2HET2[5]                           | D16 <sup>(1)</sup> |             |                    |                     |                              |                                                     |
| N2HET2[6]                                      | D11                | I/O         | Pulldown           | Programmable, 20 µA | 2-mA ZD                      | N2HET2 time input capture or output compare, or GIO |
| GIOA[7]/N2HET2[6]/ePWM2A                       | M1 <sup>(1)</sup>  |             |                    |                     |                              |                                                     |
| N2HET2[7]/MIBSPI2NCS[0]                        | N3                 | I/O         | Pulldown           | Programmable, 20 µA | 2-mA ZD                      | N2HET2 time input capture or output compare, or GIO |
| EMIF_nCS[0]/RTP_DATA[15]/N2HET2[7]             | N17 <sup>(1)</sup> |             |                    |                     |                              |                                                     |
| N2HET2[8]                                      | K16                | I/O         | Pulldown           | Programmable, 20 µA | 2-mA ZD                      | N2HET2 time input capture or output compare, or GIO |
| N2HET1[1]/MIBSPI4NENA/N2HET2[8]/eQEP2A         | V2 <sup>(1)</sup>  |             |                    |                     |                              |                                                     |
| N2HET2[9]                                      | L16                | I/O         | Pulldown           | Programmable, 20 µA | 2-mA ZD                      | N2HET2 time input capture or output compare, or GIO |
| EMIF_nCS[3]/RTP_DATA[14]/N2HET2[9]             | K17 <sup>(1)</sup> |             |                    |                     |                              |                                                     |
| N2HET2[10]                                     | M16                | I/O         | Pulldown           | Programmable, 20 µA | 2-mA ZD                      | N2HET2 time input capture or output compare, or GIO |
| N2HET1[3]/MIBSPI4NCS[0]/N2HET2[10]/eQEP2B      | U1 <sup>(1)</sup>  |             |                    |                     |                              |                                                     |
| N2HET2[11]                                     | N16                | I/O         | Pulldown           | Programmable, 20 µA | 2-mA ZD                      | N2HET2 time input capture or output compare, or GIO |
| EMIF_ADDR[6]/RTP_DATA[13]/N2HET2[11]           | C4 <sup>(1)</sup>  |             |                    |                     |                              |                                                     |
| N2HET2[12]/MIBSPI2NENA/MIBSPI2NCS[1]           | D3                 | I/O         | Pulldown           | Programmable, 20 µA | 2-mA ZD                      | N2HET2 time input capture or output compare, or GIO |
| N2HET1[5]/MIBSPI4SOMI/N2HET2[12]/ePWM3B        | V6 <sup>(1)</sup>  |             |                    |                     |                              |                                                     |
| N2HET2[13]/MIBSPI2SOMI                         | D2                 | I/O         | Pulldown           | Programmable, 20 µA | 2-mA ZD                      | N2HET2 time input capture or output compare, or GIO |
| EMIF_ADDR[7]/RTP_DATA[12]/N2HET2[13]           | C5 <sup>(1)</sup>  |             |                    |                     |                              |                                                     |
| N2HET2[14]/MIBSPI2SIMO                         | D1                 | I/O         | Pulldown           | Programmable, 20 µA | 2-mA ZD                      | N2HET2 time input capture or output compare, or GIO |
| N2HET1[7]/MIBSPI4NCS[2]/N2HET2[14]/ePWM7B      | T1 <sup>(1)</sup>  |             |                    |                     |                              |                                                     |
| N2HET2[15]                                     | K4                 | I/O         | Pulldown           | Programmable, 20 µA | 2-mA ZD                      | N2HET2 time input capture or output compare, or GIO |
| EMIF_ADDR[8]/RTP_DATA[11]/N2HET2[15]           | C6 <sup>(1)</sup>  |             |                    |                     |                              |                                                     |
| N2HET2[16]                                     | L4                 | I/O         | Pulldown           | Programmable, 20 µA | 2-mA ZD                      | N2HET2 time input capture or output compare, or GIO |
| N2HET1[9]/MIBSPI4NCS[3]/N2HET2[16]/ePWM7A      | V7 <sup>(1)</sup>  |             |                    |                     |                              |                                                     |
| N2HET2[17]                                     | M4                 | I/O         | Pulldown           | Programmable, 20 µA | 2-mA ZD                      | N2HET2 time input capture or output compare, or GIO |
| N2HET2[18]                                     | N4                 | I/O         | Pulldown           | Programmable, 20 µA | 2-mA ZD                      | N2HET2 time input capture or output compare, or GIO |
| N2HET1[11]/MIBSPI3NCS[4]/N2HET2[18]/ePWM1SYNCO | E3 <sup>(1)</sup>  |             |                    |                     |                              |                                                     |
| N2HET2[19]/LIN2RX                              | P4                 | I/O         | Pulldown           | Programmable, 20 µA | 2-mA ZD                      | N2HET2 time input capture or output compare, or GIO |

表 5-2. GWT Enhanced High-End Timer Modules (N2HET) (续)

| Terminal                                          |                   | Signal Type | Default Pull State | Pull Type                | Output Buffer Drive Strength | Description                                         |
|---------------------------------------------------|-------------------|-------------|--------------------|--------------------------|------------------------------|-----------------------------------------------------|
| Signal Name                                       | 337 GWT           |             |                    |                          |                              |                                                     |
| N2HET2[20]/LIN2TX                                 | T5                | I/O         | Pulldown           | Programmable, 20 $\mu$ A | 2-mA ZD                      | N2HET2 time input capture or output compare, or GIO |
| N2HET1[13]/SCI3TX/N2HET2[20]/ePWM5B               | N2 <sup>(1)</sup> |             |                    |                          |                              |                                                     |
| N2HET2[21]                                        | T6                | I/O         | Pulldown           | Programmable, 20 $\mu$ A | 2-mA ZD                      | N2HET2 time input capture or output compare, or GIO |
| N2HET2[22]                                        | T7                | I/O         | Pulldown           | Programmable, 20 $\mu$ A | 2-mA ZD                      | N2HET2 time input capture or output compare, or GIO |
| N2HET1[15]/MIBSPI1NCS[4]/N2HET2[22]/ECAP1         | N1 <sup>(1)</sup> |             |                    |                          |                              |                                                     |
| N2HET2[23]                                        | T8                | I/O         | Pulldown           | Programmable, 20 $\mu$ A | 2-mA ZD                      | N2HET2 time input capture or output compare, or GIO |
| ETMDATA[24]/EMIF_DATA[8]/N2HET2[24]/MIBSPI5NCS[4] | L5                | I/O         | Pulldown           | Programmable, 20 $\mu$ A | 2-mA ZD                      | N2HET2 time input capture or output compare, or GIO |
| ETMDATA[25]/EMIF_DATA[9]/N2HET2[25]/MIBSPI5NCS[5] | M5                | I/O         | Pulldown           | Programmable, 20 $\mu$ A | 2-mA ZD                      | N2HET2 time input capture or output compare, or GIO |
| ETMDATA[26]/EMIF_DATA[10]/N2HET2[26]              | N5                | I/O         | Pulldown           | Programmable, 20 $\mu$ A | 2-mA ZD                      | N2HET2 time input capture or output compare, or GIO |
| ETMDATA[27]/EMIF_DATA[11]/N2HET2[27]              | P5                | I/O         | Pulldown           | Programmable, 20 $\mu$ A | 2-mA ZD                      | N2HET2 time input capture or output compare, or GIO |
| ETMDATA[28]/EMIF_DATA[12]/N2HET2[28]/GIOA[0]      | R5                | I/O         | Pulldown           | Programmable, 20 $\mu$ A | 2-mA ZD                      | N2HET2 time input capture or output compare, or GIO |
| ETMDATA[29]/EMIF_DATA[13]/N2HET2[29]/GIOA[1]      | R6                | I/O         | Pulldown           | Programmable, 20 $\mu$ A | 2-mA ZD                      | N2HET2 time input capture or output compare, or GIO |
| ETMDATA[30]/EMIF_DATA[14]/N2HET2[30]/GIOA[3]      | R7                | I/O         | Pulldown           | Programmable, 20 $\mu$ A | 2-mA ZD                      | N2HET2 time input capture or output compare, or GIO |
| ETMDATA[31]/EMIF_DATA[15]/N2HET2[31]/GIOA[4]      | R8                | I/O         | Pulldown           | Programmable, 20 $\mu$ A | 2-mA ZD                      | N2HET2 time input capture or output compare, or GIO |
| N2HET2[1]/N2HET1_NDIS                             | D8                | Input       | Pulldown           | Fixed, 20 $\mu$ A        | 2-mA ZD                      | N2HET1 Disable                                      |
| N2HET2[2]/N2HET2_NDIS                             | D7                | Input       | Pulldown           | Fixed, 20 $\mu$ A        | 2-mA ZD                      | N2HET2 Disable                                      |

(1) This is the secondary terminal at which the signal is also available. See 节 5.2.2.2 for more detail on how to select between the available terminals for input functionality.

### 5.2.1.3 RAM Trace Port (RTP)

表 5-3. GWT RAM Trace Port (RTP)

| Terminal                             |         | Signal Type | Default Pull State | Pull Type                | Output Buffer Drive Strength | Description                  |
|--------------------------------------|---------|-------------|--------------------|--------------------------|------------------------------|------------------------------|
| Signal Name                          | 337 GWT |             |                    |                          |                              |                              |
| EMIF_ADDR[21]/RTP_CLK                | C17     | I/O         | Pulldown           | Programmable, 20 $\mu$ A | 8 mA                         | RTP packet clock, or GIO     |
| EMIF_ADDR[18]/RTP_DATA[0]            | D15     | I/O         | Pulldown           | Programmable, 20 $\mu$ A | 8 mA                         | RTP packet data, or GIO      |
| EMIF_ADDR[17]/RTP_DATA[1]            | C14     | I/O         | Pulldown           | Programmable, 20 $\mu$ A | 8 mA                         | RTP packet data, or GIO      |
| EMIF_ADDR[16]/RTP_DATA[2]            | D14     | I/O         | Pulldown           | Programmable, 20 $\mu$ A | 8 mA                         | RTP packet data, or GIO      |
| EMIF_ADDR[15]/RTP_DATA[3]            | C13     | I/O         | Pulldown           | Programmable, 20 $\mu$ A | 8 mA                         | RTP packet data, or GIO      |
| EMIF_ADDR[14]/RTP_DATA[4]            | C12     | I/O         | Pulldown           | Programmable, 20 $\mu$ A | 8 mA                         | RTP packet data, or GIO      |
| EMIF_ADDR[13]/RTP_DATA[5]            | C11     | I/O         | Pulldown           | Programmable, 20 $\mu$ A | 8 mA                         | RTP packet data, or GIO      |
| EMIF_ADDR[12]/RTP_DATA[6]            | C10     | I/O         | Pulldown           | Programmable, 20 $\mu$ A | 8 mA                         | RTP packet data, or GIO      |
| EMIF_nCS[4]/RTP_DATA[7]/GIOB[5]      | M17     | I/O         | Pulldown           | Programmable, 20 $\mu$ A | 8 mA                         | RTP packet data, or GIO      |
| EMIF_ADDR[11]/RTP_DATA[8]            | C9      | I/O         | Pulldown           | Programmable, 20 $\mu$ A | 8 mA                         | RTP packet data, or GIO      |
| EMIF_ADDR[10]/RTP_DATA[9]            | C8      | I/O         | Pulldown           | Programmable, 20 $\mu$ A | 8 mA                         | RTP packet data, or GIO      |
| EMIF_ADDR[9]/RTP_DATA[10]            | C7      | I/O         | Pulldown           | Programmable, 20 $\mu$ A | 8 mA                         | RTP packet data, or GIO      |
| EMIF_ADDR[8]/RTP_DATA[11]/N2HET2[15] | C6      | I/O         | Pulldown           | Programmable, 20 $\mu$ A | 8 mA                         | RTP packet data, or GIO      |
| EMIF_ADDR[7]/RTP_DATA[12]/N2HET2[13] | C5      | I/O         | Pulldown           | Programmable, 20 $\mu$ A | 8 mA                         | RTP packet data, or GIO      |
| EMIF_ADDR[6]/RTP_DATA[13]/N2HET2[11] | C4      | I/O         | Pulldown           | Programmable, 20 $\mu$ A | 8 mA                         | RTP packet data, or GIO      |
| EMIF_nCS[3]/RTP_DATA[14]/N2HET2[9]   | K17     | I/O         | Pulldown           | Programmable, 20 $\mu$ A | 8 mA                         | RTP packet data, or GIO      |
| EMIF_nCS[0]/RTP_DATA[15]/N2HET2[7]   | N17     | I/O         | Pulldown           | Programmable, 20 $\mu$ A | 8 mA                         | RTP packet data, or GIO      |
| EMIF_ADDR[19]/RTP_nENA               | C15     | I/O         | Pullup             | Programmable, 20 $\mu$ A | 8 mA                         | RTP packet handshake, or GIO |
| EMIF_ADDR[20]/RTP_nSYNC              | C16     | I/O         | Pullup             | Programmable, 20 $\mu$ A | 8 mA                         | RTP synchronization, or GIO  |

### 5.2.1.4 Enhanced Capture Modules (eCAP)

表 5-4. GWT Enhanced Capture Modules (eCAP)

| Terminal                                              |         | Signal Type | Default Pull State | Pull Type         | Output Buffer Drive Strength | Description                   |
|-------------------------------------------------------|---------|-------------|--------------------|-------------------|------------------------------|-------------------------------|
| Signal Name                                           | 337 GWT |             |                    |                   |                              |                               |
| N2HET1[15]/MIBSPI1NCS[4]/N2HET2[22]/ <b>ECAP1</b>     | N1      | I/O         | Pullup             | Fixed, 20 $\mu$ A | 8 mA                         | Enhanced Capture Module 1 I/O |
| MIBSPI3SOMI/AD1EXT_ENA/ <b>ECAP2</b>                  | V8      | I/O         | Pullup             | Fixed, 20 $\mu$ A | 8 mA                         | Enhanced Capture Module 2 I/O |
| MIBSPI3SIMO/AD1EXT_SEL[0]/ <b>ECAP3</b>               | W8      | I/O         | Pullup             | Fixed, 20 $\mu$ A | 8 mA                         | Enhanced Capture Module 3 I/O |
| MIBSPI1NENA/MII_RXD[2]/N2HET1[23]/ <b>ECAP4</b>       | G19     | I/O         | Pullup             | Fixed, 20 $\mu$ A | 8 mA                         | Enhanced Capture Module 4 I/O |
| MIBSPI5NENA/DMM_DATA[7]/MII_RXD[3]/ <b>ECAP5</b>      | H18     | I/O         | Pullup             | Fixed, 20 $\mu$ A | 8 mA                         | Enhanced Capture Module 5 I/O |
| MIBSPI1NCS[0]/MIBSPI1SOMI[1]/MII_TXD[2]/ <b>ECAP6</b> | R2      | I/O         | Pullup             | Fixed, 20 $\mu$ A | 8 mA                         | Enhanced Capture Module 6 I/O |

### 5.2.1.5 Enhanced Quadrature Encoder Pulse Modules (eQEP)

表 5-5. GWT Enhanced Quadrature Encoder Pulse Modules (eQEP)

| Terminal <sup>(1)</sup>                             |         | Signal Type | Default Pull State | Pull Type         | Output Buffer Drive Strength | Description           |
|-----------------------------------------------------|---------|-------------|--------------------|-------------------|------------------------------|-----------------------|
| Signal Name                                         | 337 GWT |             |                    |                   |                              |                       |
| MIBSPI3CLK/AD1EXT_SEL[1]/ <b>eQEP1A</b>             | V9      | Input       | Pullup             | Fixed, 20 $\mu$ A | -                            | Enhanced QEP1 Input A |
| MIBSPI3NENA/MIBSPI3NCS[5]/N2HET1[31]/ <b>eQEP1B</b> | W9      | Input       | Pullup             | Fixed, 20 $\mu$ A | -                            | Enhanced QEP1 Input B |
| MIBSPI3NCS[0]/AD2EVT/ <b>eQEP1I</b>                 | V10     | I/O         | Pullup             | Fixed, 20 $\mu$ A | 8 mA                         | Enhanced QEP1 Index   |
| MIBSPI1NCS[1]/MII_COL/N2HET1[17]/ <b>eQEP1S</b>     | F3      | I/O         | Pullup             | Fixed, 20 $\mu$ A | 8 mA                         | Enhanced QEP1 Strobe  |
| N2HET1[1]/MIBSPI4NENA/N2HET2[8]/ <b>eQEP2A</b>      | V2      | Input       | Pullup             | Fixed, 20 $\mu$ A | -                            | Enhanced QEP2 Input A |
| N2HET1[3]/MIBSPI4NCS[0]/N2HET2[10]/ <b>eQEP2B</b>   | U1      | Input       | Pullup             | Fixed, 20 $\mu$ A | -                            | Enhanced QEP2 Input B |
| GIOA[2]/N2HET2[0]/ <b>eQEP2I</b>                    | C1      | I/O         | Pullup             | Fixed, 20 $\mu$ A | 8 mA                         | Enhanced QEP2 Index   |
| N2HET1[30]/MII_RX_DV/ <b>eQEP2S</b>                 | B11     | I/O         | Pullup             | Fixed, 20 $\mu$ A | 8 mA                         | Enhanced QEP2 Strobe  |

(1) These signals are double-synchronized and then optionally filtered with a 6-cycle VCLK4-based counter.

### 5.2.1.6 Enhanced Pulse-Width Modulator Modules (ePWM)

表 5-6. GWT Enhanced Pulse-Width Modulator Modules (ePWM)

| TERMINAL                                                  |                    | SIGNAL<br>TYPE | DEFAULT<br>PULL<br>STATE | PULL<br>TYPE    | OUTPUT<br>BUFFER<br>DRIVE<br>STRENGTH | DESCRIPTION                        |
|-----------------------------------------------------------|--------------------|----------------|--------------------------|-----------------|---------------------------------------|------------------------------------|
| SIGNAL NAME                                               | 337<br>GWT         |                |                          |                 |                                       |                                    |
| <b>ePWM1A</b>                                             | D9                 | Output         | –                        | –               | 8 mA                                  | Enhanced PWM1 Output A             |
| GIOA[5]/EXTCLKIN1/ <b>ePWM1A</b>                          | B5 <sup>(1)</sup>  |                |                          |                 |                                       |                                    |
| <b>ePWM1B</b>                                             | D10                | Output         | –                        | –               | 8 mA                                  | Enhanced PWM1 Output B             |
| GIOA[6]/N2HET2[4]/ <b>ePWM1B</b>                          | H3 <sup>(1)</sup>  |                |                          |                 |                                       |                                    |
| N2HET1[16]/ <b>ePWM1SYNCl</b> / <b>ePWM1SYNCO</b>         | A4                 | Input          | Pulldown                 | Fixed,<br>20 µA | –                                     | External ePWM Sync Pulse<br>Input  |
| N2HET1[11]/MIBSPI3NCS[4]/N2HET2[18]/<br><b>ePWM1SYNCO</b> | E3                 | Output         | Pulldown                 | 20 µA           | 2-mA ZD                               | External ePWM Sync Pulse<br>Output |
| N2HET1[16]/ <b>ePWM1SYNCl</b> / <b>ePWM1SYNCO</b>         | A4 <sup>(1)</sup>  |                |                          |                 |                                       |                                    |
| GIOA[7]/N2HET2[6]/ <b>ePWM2A</b>                          | M1                 | Output         | Pulldown                 | 20 µA           | 8 mA                                  | Enhanced PWM2 Output A             |
| N2HET1[0]/MIBSPI4CLK/ <b>ePWM2B</b>                       | K18                | Output         | Pulldown                 | 20 µA           | 8 mA                                  | Enhanced PWM2 Output B             |
| N2HET1[2]/MIBSPI4SIMO/ <b>ePWM3A</b>                      | W5                 | Output         | Pulldown                 | 20 µA           | 8 mA                                  | Enhanced PWM3 Output A             |
| N2HET1[5]/MIBSPI4SOMI/N2HET2[12]/ <b>ePWM3B</b>           | V6                 | Output         | Pulldown                 | 20 µA           | 8 mA                                  | Enhanced PWM3 Output B             |
| MIBSPI5NCS[0]/DMM_DATA[5]/ <b>ePWM4A</b>                  | E19                | Output         | Pulldown                 | 20 µA           | 8 mA                                  | Enhanced PWM4 Output A             |
| N2HET1[4]/MIBSPI4NCS[1]/ <b>ePWM4B</b>                    | B12                | Output         | Pulldown                 | 20 µA           | 8 mA                                  | Enhanced PWM4 Output B             |
| N2HET1[6]/SCI3RX/ <b>ePWM5A</b>                           | W3                 | Output         | Pulldown                 | 20 µA           | 8 mA                                  | Enhanced PWM5 Output A             |
| N2HET1[13]/SCI3TX/N2HET2[20]/ <b>ePWM5B</b>               | N2                 | Output         | Pulldown                 | 20 µA           | 8 mA                                  | Enhanced PWM5 Output B             |
| N2HET1[18]/EMIF_RNW/ <b>ePWM6A</b>                        | J1                 | Output         | –                        | –               | 8 mA                                  | Enhanced PWM6 Output A             |
| N2HET1[20]/EMIF_nDQM[1]/ <b>ePWM6B</b>                    | P2                 | Output         | –                        | –               | 8 mA                                  | Enhanced PWM6 Output B             |
| N2HET1[9]/MIBSPI4NCS[3]/N2HET2[16]/ <b>ePWM7A</b>         | V7                 | Output         | –                        | –               | 8 mA                                  | Enhanced PWM7 Output A             |
| N2HET1[7]/MIBSPI4NCS[2]/N2HET2[14]/ <b>ePWM7B</b>         | T1                 | Output         | –                        | –               | 8 mA                                  | Enhanced PWM7 Output B             |
| AD1EVT/MII_RX_ER/RMII_RX_ER/ <b>nTZ1_1</b>                | N19                | Input          | Pulldown                 | Fixed,<br>20 µA | –                                     | Trip Zone 1 Input 1                |
| MIBSPI3NCS[3]/I2C1_SCL/N2HET1[29]/ <b>nTZ1_1</b>          | C3 <sup>(1)</sup>  |                |                          |                 |                                       |                                    |
| GIOB[7]/ <b>nTZ1_2</b>                                    | F1                 | Input          | Pulldown                 | Fixed,<br>20 µA | –                                     | Trip Zone 1 Input 2                |
| MIBSPI3NCS[2]/I2C1_SDA/N2HET1[27]/ <b>nTZ1_2</b>          | B2 <sup>(1)</sup>  |                |                          |                 |                                       |                                    |
| MIBSPI1NCS[3]/N2HET1[21]/ <b>nTZ1_3</b>                   | J3                 | Input          | Pullup                   | Fixed,<br>20 µA | –                                     | Trip Zone 1 Input 3                |
| N2HET1[10]/MIBSPI4NCS[4]/MII_TX_CLK/ <b>nTZ1_3</b>        | D19 <sup>(1)</sup> |                |                          |                 |                                       |                                    |

- (1) This is the secondary terminal at which the signal is also available. See [节 5.2.2.2](#) for more detail on how to select between the available terminals for input functionality.

### 5.2.1.7 Data Modification Module (DMM)

表 5-7. GWT Data Modification Module (DMM)

| Terminal                                           |         | Signal Type | Default Pull State | Pull Type                | Output Buffer Drive Strength | Description                 |
|----------------------------------------------------|---------|-------------|--------------------|--------------------------|------------------------------|-----------------------------|
| Signal Name                                        | 337 GWT |             |                    |                          |                              |                             |
| DMM_CLK                                            | F17     | I/O         | Pullup             | Programmable, 20 $\mu$ A | 2-mA ZD                      | DMM clock, or GIO           |
| DMM_DATA[0]                                        | L19     | I/O         | Pullup             | Programmable, 20 $\mu$ A | 2-mA ZD                      | DMM data, or GIO            |
| DMM_DATA[1]                                        | L18     | I/O         | Pullup             | Programmable, 20 $\mu$ A | 2-mA ZD                      | DMM data, or GIO            |
| MIBSPI5NCS[2]/DMM_DATA[2]                          | W6      | I/O         | Pullup             | Programmable, 20 $\mu$ A | 2-mA ZD                      | DMM data, or GIO            |
| MIBSPI5NCS[3]/DMM_DATA[3]                          | T12     | I/O         | Pullup             | Programmable, 20 $\mu$ A | 2-mA ZD                      | DMM data, or GIO            |
| MIBSPI5CLK/DMM_DATA[4]/MII_TXEN/RMII_TXEN          | H19     | I/O         | Pullup             | Programmable, 20 $\mu$ A | 2-mA ZD                      | DMM data, or GIO            |
| MIBSPI5NCS[0]/DMM_DATA[5]/ePWM4A                   | E19     | I/O         | Pullup             | Programmable, 20 $\mu$ A | 2-mA ZD                      | DMM data, or GIO            |
| MIBSPI5NCS[1]/DMM_DATA[6]                          | B6      | I/O         | Pullup             | Programmable, 20 $\mu$ A | 2-mA ZD                      | DMM data, or GIO            |
| MIBSPI5NENA/DMM_DATA[7]/MII_RXD[3]/ECAP5           | H18     | I/O         | Pullup             | Programmable, 20 $\mu$ A | 2-mA ZD                      | DMM data, or GIO            |
| MIBSPI5SIMO[0]/DMM_DATA[8]/MII_TXD[1]/RMII_TXD[1]  | J19     | I/O         | Pullup             | Programmable, 20 $\mu$ A | 2-mA ZD                      | DMM data, or GIO            |
| MIBSPI5SIMO[1]/DMM_DATA[9]/AD1EXT_SEL[0]           | E16     | I/O         | Pullup             | Programmable, 20 $\mu$ A | 2-mA ZD                      | DMM data, or GIO            |
| MIBSPI5SIMO[2]/DMM_DATA[10]/AD1EXT_SEL[1]          | H17     | I/O         | Pullup             | Programmable, 20 $\mu$ A | 2-mA ZD                      | DMM data, or GIO            |
| MIBSPI5SIMO[3]/DMM_DATA[11]/I2C2_SDA/AD1EXT_SEL[2] | G17     | I/O         | Pullup             | Programmable, 20 $\mu$ A | 2-mA ZD                      | DMM data, or GIO            |
| MIBSPI5SOMI[0]/DMM_DATA[12]/MII_TXD[0]/RMII_TXD[0] | J18     | I/O         | Pullup             | Programmable, 20 $\mu$ A | 2-mA ZD                      | DMM data, or GIO            |
| MIBSPI5SOMI[1]/DMM_DATA[13]/AD1EXT_SEL[3]          | E17     | I/O         | Pullup             | Programmable, 20 $\mu$ A | 2-mA ZD                      | DMM data, or GIO            |
| MIBSPI5SOMI[2]/DMM_DATA[14]/AD1EXT_SEL[4]          | H16     | I/O         | Pullup             | Programmable, 20 $\mu$ A | 2-mA ZD                      | DMM data, or GIO            |
| MIBSPI5SOMI[3]/DMM_DATA[15]/I2C2_SCL/AD1EXT_ENA    | G16     | I/O         | Pullup             | Programmable, 20 $\mu$ A | 2-mA ZD                      | DMM data, or GIO            |
| DMM_nENA                                           | F16     | I/O         | Pullup             | Programmable, 20 $\mu$ A | 2-mA ZD                      | DMM handshake, or GIO       |
| DMM_SYNC                                           | J16     | I/O         | Pullup             | Programmable, 20 $\mu$ A | 2-mA ZD                      | DMM synchronization, or GIO |

## 5.2.1.8 General-Purpose Input / Output (GPIO)

表 5-8. GWT General-Purpose Input / Output (GPIO)

| Terminal                                             |                    | Signal Type | Default Pull State | Pull Type                | Output Buffer Drive Strength | Description                                     |
|------------------------------------------------------|--------------------|-------------|--------------------|--------------------------|------------------------------|-------------------------------------------------|
| Signal Name                                          | 337 GWT            |             |                    |                          |                              |                                                 |
| <b>GPIO[0]</b>                                       | A5                 | I/O         | Pulldown           | Programmable, 20 $\mu$ A | 2-mA ZD                      | General-purpose I/O, external interrupt capable |
| ETMDATA[28]/EMIF_DATA[12]/N2HET2[28]/ <b>GPIO[0]</b> | R5 <sup>(1)</sup>  |             |                    |                          |                              |                                                 |
| <b>GPIO[1]</b>                                       | C2                 | I/O         | Pulldown           | Programmable, 20 $\mu$ A | 2-mA ZD                      | General-purpose I/O, external interrupt capable |
| ETMDATA[29]/EMIF_DATA[13]/N2HET2[29]/ <b>GPIO[1]</b> | R6 <sup>(1)</sup>  |             |                    |                          |                              |                                                 |
| <b>GPIO[2]</b> /N2HET2[0] /eQEP2I                    | C1                 | I/O         | Pulldown           | Programmable, 20 $\mu$ A | 2-mA ZD                      | General-purpose I/O, external interrupt capable |
| FRAYTX1/ <b>GPIO[2]</b>                              | B15 <sup>(1)</sup> |             |                    |                          |                              |                                                 |
| <b>GPIO[3]</b> /N2HET2[2]                            | E1                 | I/O         | Pulldown           | Programmable, 20 $\mu$ A | 2-mA ZD                      | General-purpose I/O, external interrupt capable |
| ETMDATA[30]/EMIF_DATA[14]/N2HET2[30]/ <b>GPIO[3]</b> | R7 <sup>(1)</sup>  |             |                    |                          |                              |                                                 |
| <b>GPIO[4]</b>                                       | A6                 | I/O         | Pulldown           | Programmable, 20 $\mu$ A | 2-mA ZD                      | General-purpose I/O, external interrupt capable |
| ETMDATA[31]/EMIF_DATA[15]/N2HET2[31]/ <b>GPIO[4]</b> | R8 <sup>(1)</sup>  |             |                    |                          |                              |                                                 |
| <b>GPIO[5]</b> /EXTCLKIN1 /ePWM1A                    | B5                 | I/O         | Pulldown           | Programmable, 20 $\mu$ A | 2-mA ZD                      | General-purpose I/O, external interrupt capable |
| ETMTRACECLKIN/EXTCLKIN2/ <b>GPIO[5]</b>              | R9 <sup>(1)</sup>  |             |                    |                          |                              |                                                 |
| <b>GPIO[6]</b> /N2HET2[4]/ePWM1B                     | H3                 | I/O         | Pulldown           | Programmable, 20 $\mu$ A | 2-mA ZD                      | General-purpose I/O, external interrupt capable |
| ETMTRACECLKOUT/ <b>GPIO[6]</b>                       | R10 <sup>(1)</sup> |             |                    |                          |                              |                                                 |
| <b>GPIO[7]</b> /N2HET2[6] /ePWM2A                    | M1                 | I/O         | Pulldown           | Programmable, 20 $\mu$ A | 2-mA ZD                      | General-purpose I/O, external interrupt capable |
| ETMTRACECTL/ <b>GPIO[7]</b>                          | R11 <sup>(1)</sup> |             |                    |                          |                              |                                                 |
| <b>IOB[0]</b>                                        | M2                 | I/O         | Pulldown           | Programmable, 20 $\mu$ A | 2-mA ZD                      | General-purpose I/O, external interrupt capable |
| FRAYTX2/ <b>IOB[0]</b>                               | B8 <sup>(1)</sup>  |             |                    |                          |                              |                                                 |
| <b>IOB[1]</b>                                        | K2                 | I/O         | Pulldown           | Programmable, 20 $\mu$ A | 2-mA ZD                      | General-purpose I/O, external interrupt capable |
| FRAYTXEN1/ <b>IOB[1]</b>                             | B16 <sup>(1)</sup> |             |                    |                          |                              |                                                 |
| <b>IOB[2]</b> /DCAN4TX                               | F2                 | I/O         | Pulldown           | Programmable, 20 $\mu$ A | 2-mA ZD                      | General-purpose I/O, external interrupt capable |
| FRAYTXEN2/ <b>IOB[2]</b>                             | B9 <sup>(1)</sup>  |             |                    |                          |                              |                                                 |
| <b>IOB[3]</b> /DCAN4RX                               | W10                | I/O         | Pulldown           | Programmable, 20 $\mu$ A | 2-mA ZD                      | General-purpose I/O, external interrupt capable |
| EMIF_nCAS/ <b>IOB[3]</b>                             | R4 <sup>(1)</sup>  |             |                    |                          |                              |                                                 |
| <b>IOB[4]</b>                                        | G1                 | I/O         | Pulldown           | Programmable, 20 $\mu$ A | 2-mA ZD                      | General-purpose I/O, external interrupt capable |
| EMIF_nCS[2]/ <b>IOB[4]</b>                           | L17 <sup>(1)</sup> |             |                    |                          |                              |                                                 |
| <b>IOB[5]</b>                                        | G2                 | I/O         | Pulldown           | Programmable, 20 $\mu$ A | 2-mA ZD                      | General-purpose I/O, external interrupt capable |
| EMIF_nCS[4]/RTP_DATA[7]/ <b>IOB[5]</b>               | M17 <sup>(1)</sup> |             |                    |                          |                              |                                                 |

**表 5-8. GWT General-Purpose Input / Output (GIO) ( 续 )**

| Terminal                   |                   | Signal Type | Default Pull State | Pull Type                | Output Buffer Drive Strength | Description                                     |
|----------------------------|-------------------|-------------|--------------------|--------------------------|------------------------------|-------------------------------------------------|
| Signal Name                | 337 GWT           |             |                    |                          |                              |                                                 |
| <b>GIOB[6]</b> /nERROR     | J2                | I/O         | Pulldown           | Programmable, 20 $\mu$ A | 2-mA ZD                      | General-purpose I/O, external interrupt capable |
| EMIF_nRAS/ <b>GIOB[6]</b>  | R3 <sup>(1)</sup> |             |                    |                          |                              |                                                 |
| <b>GIOB[7]</b> /nTZ1_2     | F1                | I/O         | Pulldown           | Programmable, 20 $\mu$ A | 2-mA ZD                      | General-purpose I/O, external interrupt capable |
| EMIF_nWAIT/ <b>GIOB[7]</b> | P3 <sup>(1)</sup> |             |                    |                          |                              |                                                 |

- (1) This is the secondary terminal at which the signal is also available. See [节 5.2.2.2](#) for more detail on how to select between the available terminals for input functionality.

### 5.2.1.9 FlexRay Interface Controller (FlexRay)

表 5-9. FlexRay Interface Controller (FlexRay)

| Terminal                  |         | Signal Type | Default Pull State | Pull Type          | Output Buffer Drive Strength | Description                         |
|---------------------------|---------|-------------|--------------------|--------------------|------------------------------|-------------------------------------|
| Signal Name               | 337 GWT |             |                    |                    |                              |                                     |
| <b>FRAYRX1</b>            | A15     | Input       | Pullup             | Fixed, 100 $\mu$ A | –                            | FlexRay data receive (channel 1)    |
| <b>FRAYRX2</b>            | A8      | Input       | Pullup             | Fixed, 100 $\mu$ A | –                            | FlexRay data receive (channel 2)    |
| <b>FRAYTX1</b> /GIOA[2]   | B15     | Output      | Pulldown           | 20 $\mu$ A         | 8 mA                         | FlexRay data transmit (channel 1)   |
| <b>FRAYTX2</b> /GIOB[0]   | B8      | Output      | Pulldown           | 20 $\mu$ A         | 8 mA                         | FlexRay data transmit (channel 2)   |
| <b>FRAYTXEN1</b> /GIOB[1] | B16     | Output      | Pulldown           | 20 $\mu$ A         | 8 mA                         | FlexRay transmit enable (channel 1) |
| <b>FRAYTXEN2</b> /GIOB[2] | B9      | Output      | Pulldown           | 20 $\mu$ A         | 8 mA                         | FlexRay transmit enable (channel 2) |

### 5.2.1.10 Controller Area Network Controllers (DCAN)

**表 5-10. GWT Controller Area Network Controllers (DCAN)**

| Terminal        |         | Signal Type | Default Pull State | Pull Type                | Output Buffer Drive Strength | Description           |
|-----------------|---------|-------------|--------------------|--------------------------|------------------------------|-----------------------|
| Signal Name     | 337 GWT |             |                    |                          |                              |                       |
| DCAN1RX         | B10     | I/O         | Pullup             | Programmable, 20 $\mu$ A | 2-mA ZD                      | CAN1 receive, or GIO  |
| DCAN1TX         | A10     | I/O         | Pullup             | Programmable, 20 $\mu$ A | 2-mA ZD                      | CAN1 transmit, or GIO |
| DCAN2RX         | H1      | I/O         | Pullup             | Programmable, 20 $\mu$ A | 2-mA ZD                      | CAN2 receive, or GIO  |
| DCAN2TX         | H2      | I/O         | Pullup             | Programmable, 20 $\mu$ A | 2-mA ZD                      | CAN2 transmit, or GIO |
| DCAN3RX         | M19     | I/O         | Pullup             | Programmable, 20 $\mu$ A | 2-mA ZD                      | CAN3 receive, or GIO  |
| DCAN3TX         | M18     | I/O         | Pullup             | Programmable, 20 $\mu$ A | 2-mA ZD                      | CAN3 transmit, or GIO |
| GLOB[3]/DCAN4RX | W10     | I/O         | Pulldown           | Programmable, 20 $\mu$ A | 2-mA ZD                      | CAN4 receive, or GIO  |
| GLOB[2]/DCAN4TX | F2      | I/O         | Pulldown           | Programmable, 20 $\mu$ A | 2-mA ZD                      | CAN4 transmit, or GIO |

### 5.2.1.11 Local Interconnect Network Interface Module (LIN)

表 5-11. GWT Local Interconnect Network Interface Module (LIN)

| Terminal          |         | Signal Type | Default Pull State | Pull Type                | Output Buffer Drive Strength | Description          |
|-------------------|---------|-------------|--------------------|--------------------------|------------------------------|----------------------|
| Signal Name       | 337 GWT |             |                    |                          |                              |                      |
| LIN1RX            | A7      | I/O         | Pullup             | Programmable, 20 $\mu$ A | 2-mA ZD                      | LIN receive, or GIO  |
| LIN1TX            | B7      | I/O         | Pullup             | Programmable, 20 $\mu$ A | 2-mA ZD                      | LIN transmit, or GIO |
| N2HET2[19]/LIN2RX | P4      | I/O         | Pulldown           | Programmable, 20 $\mu$ A | 2-mA ZD                      | LIN receive, or GIO  |
| N2HET2[20]/LIN2TX | T5      | I/O         | Pulldown           | Programmable, 20 $\mu$ A | 2-mA ZD                      | LIN transmit, or GIO |

### 5.2.1.12 Standard Serial Communication Interface (SCI)

表 5-12. GWT Standard Serial Communication Interface (SCI)

| Terminal                                     |         | Signal Type | Default Pull State | Pull Type                | Output Buffer Drive Strength | Description          |
|----------------------------------------------|---------|-------------|--------------------|--------------------------|------------------------------|----------------------|
| Signal Name                                  | 337 GWT |             |                    |                          |                              |                      |
| N2HET1[6]/ <b>SCI3RX</b> /ePWM5A             | W3      | I/O         | Pulldown           | Programmable, 20 $\mu$ A | 2-mA ZD                      | SCI receive, or GIO  |
| N2HET1[13]/ <b>SCI3TX</b> /N2HET2[20]/ePWM5B | N2      | I/O         | Pulldown           | Programmable, 20 $\mu$ A | 2-mA ZD                      | SCI transmit, or GIO |
| N2HET1[17]/EMIF_nOE/ <b>SCI4RX</b>           | A13     | I/O         | Pulldown           | Programmable, 20 $\mu$ A | 2-mA ZD                      | SCI receive, or GIO  |
| N2HET1[19]/EMIF_nDQM[0]/ <b>SCI4TX</b>       | B13     | I/O         | Pulldown           | Programmable, 20 $\mu$ A | 2-mA ZD                      | SCI transmit, or GIO |

### 5.2.1.13 Inter-Integrated Circuit Interface Module (I2C)

表 5-13. GWT Inter-Integrated Circuit Interface Module (I2C)

| Terminal                                           |         | Signal Type | Default Pull State | Pull Type                | Output Buffer Drive Strength | Description              |
|----------------------------------------------------|---------|-------------|--------------------|--------------------------|------------------------------|--------------------------|
| Signal Name                                        | 337 GWT |             |                    |                          |                              |                          |
| MIBSPI3NCS[3]/I2C1_SCL/N2HET1[29]/nTZ1_1           | C3      | I/O         | Pullup             | Programmable, 20 $\mu$ A | 2-mA ZD                      | I2C serial clock, or GIO |
| MIBSPI3NCS[2]/I2C1_SDA/N2HET1[27]/nTZ1_2           | B2      | I/O         | Pullup             | Programmable, 20uA       | 2-mA ZD                      | I2C serial data, or GIO  |
| MIBSPI5SOMI[3]/DMM_DATA[15]/I2C2_SCL/AD1EXT_ENA    | G16     | I/O         | Pullup             | Programmable, 20uA       | 2-mA ZD                      | I2C serial clock, or GIO |
| MIBSPI5SIMO[3]/DMM_DATA[11]/I2C2_SDA/AD1EXT_SEL[2] | G17     | I/O         | Pullup             | Programmable, 20uA       | 2-mA ZD                      | I2C serial data, or GIO  |

### 5.2.1.14 Multibuffered Serial Peripheral Interface Modules (MibSPI)

**表 5-14. GWT Multibuffered Serial Peripheral Interface Modules (MibSPI)**

| Terminal                                                 |                   | Signal Type | Default Pull State | Pull Type                | Output Buffer Drive Strength | Description                         |
|----------------------------------------------------------|-------------------|-------------|--------------------|--------------------------|------------------------------|-------------------------------------|
| Signal Name                                              | 337 GWT           |             |                    |                          |                              |                                     |
| <b>MIBSPI1CLK</b>                                        | F18               | I/O         | Pullup             | Programmable, 20 $\mu$ A | 8 mA                         | MibSPI1 clock, or GIO               |
| <b>MIBSPI1NCS[0]</b> /MIBSPI1SOMI[1] /MII_TXD[2]/ECAP6   | R2                | I/O         | Pullup             | Programmable, 20 $\mu$ A | 8 mA                         | MibSPI1 chip select, or GIO         |
| <b>MIBSPI1NCS[1]</b> /MII_COL /N2HET1[17] /eQEP1S        | F3                | I/O         | Pullup             | Programmable, 20 $\mu$ A | 2-mA ZD                      | MibSPI1 chip select, or GIO         |
| <b>MIBSPI1NCS[2]</b> /MDIO /N2HET1[19]                   | G3                | I/O         | Pullup             | Programmable, 20 $\mu$ A | 2-mA ZD                      | MibSPI1 chip select, or GIO         |
| <b>MIBSPI1NCS[3]</b> /N2HET1[21] /nTZ1_3                 | J3                | I/O         | Pullup             | Programmable, 20 $\mu$ A | 2-mA ZD                      | MibSPI1 chip select, or GIO         |
| <b>MIBSPI1NCS[4]</b>                                     | U10               | I/O         | Pullup             | Programmable, 20 $\mu$ A | 2-mA ZD                      | MibSPI1 chip select, or GIO         |
| N2HET1[15]/ <b>MIBSPI1NCS[4]</b> /N2HET2[22]/ECAP1       | N1 <sup>(1)</sup> |             |                    |                          |                              |                                     |
| <b>MIBSPI1NCS[5]</b>                                     | U9                |             |                    |                          |                              |                                     |
| N2HET1[24]/ <b>MIBSPI1NCS[5]</b> /MII_RXD[0]/RMII_RXD[0] | P1 <sup>(1)</sup> | I/O         | Pullup             | Programmable, 20 $\mu$ A | 2-mA ZD                      | MibSPI1 chip select, or GIO         |
| <b>MIBSPI1NENA</b> /MII_RXD[2] /N2HET1[23] /ECAP4        | G19               | I/O         | Pullup             | Programmable, 20 $\mu$ A | 2-mA ZD                      | MibSPI1 enable, or GIO              |
| <b>MIBSPI1SIMO[0]</b>                                    | F19               | I/O         | Pullup             | Programmable, 20 $\mu$ A | 8 mA                         | MibSPI1 slave-in master-out, or GIO |
| N2HET1[8]/ <b>MIBSPI1SIMO[1]</b> /MII_TXD[3]             | E18               | I/O         | Pulldown           | Programmable, 20 $\mu$ A | 8 mA                         | MibSPI1 slave-in master-out, or GIO |
| <b>MIBSPI1SOMI[0]</b>                                    | G18               | I/O         | Pullup             | Programmable, 20 $\mu$ A | 8 mA                         | MibSPI1 slave-out master-in, or GIO |
| MIBSPI1NCS[0]/ <b>MIBSPI1SOMI[1]</b> /MII_TXD[2]/ECAP6   | R2                | I/O         | Pullup             | Programmable, 20 $\mu$ A | 8 mA                         | MibSPI1 slave-out master-in, or GIO |
| N2HET2[3]/ <b>MIBSPI2CLK</b>                             | E2                | I/O         | Pulldown           | Programmable, 20 $\mu$ A | 8 mA                         | MibSPI2 clock, or GIO               |
| N2HET2[7]/ <b>MIBSPI2NCS[0]</b>                          | N3                | I/O         | Pulldown           | Programmable, 20 $\mu$ A | 2-mA ZD                      | MibSPI2 chip select, or GIO         |
| N2HET2[12]/MIBSPI2NENA/ <b>MIBSPI2NCS[1]</b>             | D3                | I/O         | Pulldown           | Programmable, 20 $\mu$ A | 2-mA ZD                      | MibSPI2 chip select, or GIO         |
| N2HET2[12]/ <b>MIBSPI2NENA</b> /MIBSPI2NCS[1]            | D3                | I/O         | Pulldown           | Programmable, 20 $\mu$ A | 2-mA ZD                      | MibSPI2 enable, or GIO              |
| N2HET2[14]/ <b>MIBSPI2SIMO</b>                           | D1                | I/O         | Pulldown           | Programmable, 20 $\mu$ A | 8 mA                         | MibSPI2 slave-in master-out, or GIO |
| N2HET2[13]/ <b>MIBSPI2SOMI</b>                           | D2                | I/O         | Pulldown           | Programmable, 20 $\mu$ A | 8 mA                         | MibSPI2 slave-out master-in, or GIO |
| <b>MIBSPI3CLK</b> /AD1EXT_SEL[1] /eQEP1A                 | V9                | I/O         | Pullup             | Programmable, 20 $\mu$ A | 8 mA                         | MibSPI3 clock, or GIO               |
| <b>MIBSPI3NCS[0]</b> /AD2EVT /eQEP1I                     | V10               | I/O         | Pullup             | Programmable, 20 $\mu$ A | 2-mA ZD                      | MibSPI3 chip select, or GIO         |
| <b>MIBSPI3NCS[1]</b> /MDCLK /N2HET1[25]                  | V5                | I/O         | Pullup             | Programmable, 20 $\mu$ A | 2-mA ZD                      | MibSPI3 chip select, or GIO         |
| <b>MIBSPI3NCS[2]</b> /I2C1_SDA/N2HET1[27] /nTZ1_2        | B2                | I/O         | Pullup             | Programmable, 20 $\mu$ A | 2-mA ZD                      | MibSPI3 chip select, or GIO         |
| <b>MIBSPI3NCS[3]</b> /I2C1_SCL/N2HET1[29] /nTZ1_1        | C3                | I/O         | Pullup             | Programmable, 20 $\mu$ A | 2-mA ZD                      | MibSPI3 chip select, or GIO         |
| N2HET1[11]/ <b>MIBSPI3NCS[4]</b> /N2HET2[18]/ePWM1SYNCO  | E3                | I/O         | Pulldown           | Programmable, 20 $\mu$ A | 2-mA ZD                      | MibSPI3 chip select, or GIO         |
| MIBSPI3NENA/ <b>MIBSPI3NCS[5]</b> /N2HET1[31]/eQEP1B     | W9                | I/O         | Pullup             | Programmable, 20 $\mu$ A | 2-mA ZD                      | MibSPI3 chip select, or GIO         |
| <b>MIBSPI3NENA</b> /MIBSPI3NCS[5]/N2HET1[31] /eQEP1B     | W9                | I/O         | Pullup             | Programmable, 20 $\mu$ A | 2-mA ZD                      | MibSPI3 enable, or GIO              |
| <b>MIBSPI3SIMO</b> /AD1EXT_SEL[0] /ECAP3                 | W8                | I/O         | Pullup             | Programmable, 20 $\mu$ A | 8 mA                         | MibSPI3 slave-in master-out, or GIO |

表 5-14. GWT Multibuffered Serial Peripheral Interface Modules (MibSPI) (续)

| Terminal                                             |         | Signal Type | Default Pull State | Pull Type                | Output Buffer Drive Strength | Description                         |
|------------------------------------------------------|---------|-------------|--------------------|--------------------------|------------------------------|-------------------------------------|
| Signal Name                                          | 337 GWT |             |                    |                          |                              |                                     |
| MIBSPI3SOMI /AD1EXT_ENA /ECAP2                       | V8      | I/O         | Pullup             | Programmable, 20 $\mu$ A | 8 mA                         | MibSPI3 slave-out master-in, or GIO |
| N2HET1[0]/MIBSPI4CLK /ePWM2B                         | K18     | I/O         | Pulldown           | Programmable, 20 $\mu$ A | 8 mA                         | MibSPI4 clock, or GIO               |
| N2HET1[3]/MIBSPI4NCS[0]/N2HET2[10]/eQEP2B            | U1      | I/O         | Pulldown           | Programmable, 20 $\mu$ A | 2-mA ZD                      | MibSPI4 chip select, or GIO         |
| N2HET1[4]/MIBSPI4NCS[1] /ePWM4B                      | B12     | I/O         | Pulldown           | Programmable, 20 $\mu$ A | 2-mA ZD                      | MibSPI4 chip select, or GIO         |
| N2HET1[7]/MIBSPI4NCS[2]/N2HET2[14]/ePWM7B            | T1      | I/O         | Pulldown           | Programmable, 20 $\mu$ A | 2-mA ZD                      | MibSPI4 chip select, or GIO         |
| N2HET1[9]/MIBSPI4NCS[3]/N2HET2[16]/ePWM7A            | V7      | I/O         | Pulldown           | Programmable, 20 $\mu$ A | 2-mA ZD                      | MibSPI4 chip select, or GIO         |
| N2HET1[10]/MIBSPI4NCS[4] /MII_TX_CLK/nTZ1_3          | D19     | I/O         | Pulldown           | Programmable, 20 $\mu$ A | 2-mA ZD                      | MibSPI4 chip select, or GIO         |
| N2HET1[12]/MIBSPI4NCS[5] /MII_CRS/RMII_CRS_DV        | B4      | I/O         | Pulldown           | Programmable, 20 $\mu$ A | 4 mA                         | MibSPI4 chip select, or GIO         |
| N2HET1[1]/MIBSPI4NENA/N2HET2[8]/eQEP2A               | V2      | I/O         | Pulldown           | Programmable, 20 $\mu$ A | 8 mA                         | MibSPI4 enable, or GIO              |
| N2HET1[2]/MIBSPI4SIMO /ePWM3A                        | W5      | I/O         | Pulldown           | Programmable, 20 $\mu$ A | 8 mA                         | MibSPI4 slave-in master-out, or GIO |
| N2HET1[5]/MIBSPI4SOMI/N2HET2[12]/ePWM3B              | V6      | I/O         | Pulldown           | Programmable, 20 $\mu$ A | 8 mA                         | MibSPI4 slave-out master-in, or GIO |
| MIBSPI5CLK /DMM_DATA[4] /MII_TXEN/RMII_TXEN          | H19     | I/O         | Pullup             | Programmable, 20 $\mu$ A | 8 mA                         | MibSPI5 clock, or GIO               |
| MIBSPI5NCS[0] /DMM_DATA[5] /ePWM4A                   | E19     | I/O         | Pullup             | Programmable, 20 $\mu$ A | 2-mA ZD                      | MibSPI5 chip select, or GIO         |
| MIBSPI5NCS[1] /DMM_DATA[6]                           | B6      | I/O         | Pullup             | Programmable, 20 $\mu$ A | 2-mA ZD                      | MibSPI5 chip select, or GIO         |
| MIBSPI5NCS[2] /DMM_DATA[2]                           | W6      | I/O         | Pullup             | Programmable, 20 $\mu$ A | 2-mA ZD                      | MibSPI5 chip select, or GIO         |
| MIBSPI5NCS[3] /DMM_DATA[3]                           | T12     | I/O         | Pullup             | Programmable, 20 $\mu$ A | 2-mA ZD                      | MibSPI5 chip select, or GIO         |
| ETMDATA[24]/EMIF_DATA[8]/N2HET2[24]/MIBSPI5NCS[4]    | L5      | I/O         | Pullup             | Programmable, 20 $\mu$ A | 2-mA ZD                      | MibSPI5 chip select, or GIO         |
| ETMDATA[25]/EMIF_DATA[9]/N2HET2[25]/MIBSPI5NCS[5]    | M5      | I/O         | Pullup             | Programmable, 20 $\mu$ A | 2-mA ZD                      | MibSPI5 chip select, or GIO         |
| MIBSPI5NENA /DMM_DATA[7] /MII_RXD[3]/ECAP5           | H18     | I/O         | Pullup             | Programmable, 20 $\mu$ A | 2-mA ZD                      | MibSPI5 enable, or GIO              |
| MIBSPI5SIMO[0] /DMM_DATA[8] /MII_TXD[1]/RMII_TXD[1]  | J19     | I/O         | Pullup             | Programmable, 20 $\mu$ A | 8 mA                         | MibSPI5 slave-in master-out, or GIO |
| MIBSPI5SIMO[1] /DMM_DATA[9]/AD1EXT_SEL[0]            | E16     | I/O         | Pullup             | Programmable, 20 $\mu$ A | 8 mA                         | MibSPI5 slave-in master-out, or GIO |
| MIBSPI5SIMO[2] /DMM_DATA[10]/AD1EXT_SEL[1]           | H17     | I/O         | Pullup             | Programmable, 20 $\mu$ A | 8 mA                         | MibSPI5 slave-in master-out, or GIO |
| MIBSPI5SIMO[3] /DMM_DATA[11]/I2C2_SDA/AD1EXT_SEL[2]  | G17     | I/O         | Pullup             | Programmable, 20 $\mu$ A | 8 mA                         | MibSPI5 slave-in master-out, or GIO |
| MIBSPI5SOMI[0] /DMM_DATA[12] /MII_TXD[0]/RMII_TXD[0] | J18     | I/O         | Pullup             | Programmable, 20 $\mu$ A | 8 mA                         | MibSPI5 slave-out master-in, or GIO |
| MIBSPI5SOMI[1] /DMM_DATA[13]/AD1EXT_SEL[3]           | E17     | I/O         | Pullup             | Programmable, 20 $\mu$ A | 8 mA                         | MibSPI5 slave-out master-in, or GIO |
| MIBSPI5SOMI[2] /DMM_DATA[14]/AD1EXT_SEL[4]           | H16     | I/O         | Pullup             | Programmable, 20 $\mu$ A | 8 mA                         | MibSPI5 slave-out master-in, or GIO |
| MIBSPI5SOMI[3] /DMM_DATA[15]/I2C2_SCL/AD1EXT_ENA     | G16     | I/O         | Pullup             | Programmable, 20 $\mu$ A | 8 mA                         | MibSPI5 slave-out master-in, or GIO |

- (1) This is the secondary terminal at which the signal is also available. See 节 5.2.2.2 for more detail on how to select between the available terminals for input functionality.

### 5.2.1.15 Ethernet Controller

表 5-15. GWT Ethernet Controller: MDIO Interface

| Terminal                                |                   | Signal Type | Default Pull State | Pull Type    | Output Buffer Drive Strength | Description              |
|-----------------------------------------|-------------------|-------------|--------------------|--------------|------------------------------|--------------------------|
| Signal Name                             | 337 GWT           |             |                    |              |                              |                          |
| <b>MDCLK</b>                            | T9                | Output      | -                  | -            | 8 mA                         | Serial clock output      |
| MIBSPI3NCS[1]/ <b>MDCLK</b> /N2HET1[25] | V5 <sup>(1)</sup> |             |                    |              |                              |                          |
| <b>MDIO</b>                             | F4                | I/O         | Pulldown           | Fixed, 20 µA | 8 mA                         | Serial data input/output |
| MIBSPI1NCS[2]/ <b>MDIO</b> /N2HET1[19]  | G3 <sup>(1)</sup> |             |                    |              |                              |                          |

(1) This is the secondary terminal at which the signal is also available. See 节 5.2.2.2 for more detail on how to select between the available terminals for input functionality.

表 5-16. GWT Ethernet Controller: Reduced Media Independent Interface (RMII)

| Terminal                                                   |         | Signal Type | Default Pull State | Pull Type    | Output Buffer Drive Strength | Description                                                                  |
|------------------------------------------------------------|---------|-------------|--------------------|--------------|------------------------------|------------------------------------------------------------------------------|
| Signal Name                                                | 337 GWT |             |                    |              |                              |                                                                              |
| N2HET1[12]/MIBSPI4NCS[5]/MII_CRS/ <b>RMII_CRS_DV</b>       | B4      | Input       | Pulldown           | Fixed, 20 µA | -                            | RMII carrier sense and data valid                                            |
| N2HET1[28]/MII_RXCLK/ <b>RMII_REFCLK</b>                   | K19     | Input       | Pulldown           | Fixed, 20 µA | 8 mA                         | EMII synchronous reference clock for receive, transmit and control interface |
| AD1EVT/MII_RX_ER/ <b>RMII_RX_ER</b> /nTZ1_1                | N19     | Input       | Pulldown           | Fixed, 20 µA | -                            | RMII receive error                                                           |
| N2HET1[24]/MIBSPI1NCS[5]/MII_RXD[0]/ <b>RMII_RXD[0]</b>    | P1      | Input       | Pulldown           | Fixed, 20 µA | -                            | RMII receive data                                                            |
| N2HET1[26]/MII_RXD[1]/ <b>RMII_RXD[1]</b>                  | A14     | Input       | Pulldown           | Fixed, 20 µA | -                            | RMII receive data                                                            |
| MIBSPI5SOMI[0]/DMM_DATA[12]/MII_TXD[0]/ <b>RMII_TXD[0]</b> | J18     | Output      | Pullup             | 20 µA        | 8 mA                         | RMII transmit data                                                           |
| MIBSPI5SIMO[0]/DMM_DATA[8]/MII_TXD[1]/ <b>RMII_TXD[1]</b>  | J19     | Output      | Pullup             | 20 µA        | 8 mA                         | RMII transmit data                                                           |
| MIBSPI5CLK/DMM_DATA[4]/MII_TXEN/ <b>RMII_TXEN</b>          | H19     | Output      | Pullup             | 20 µA        | 8 mA                         | RMII transmit enable                                                         |

表 5-17. GWT Ethernet Controller: Media Independent Interface (MII)

| Terminal                                                 |                    | Signal Type | Default Pull State | Pull Type    | Output Buffer Drive Strength | Description                     |
|----------------------------------------------------------|--------------------|-------------|--------------------|--------------|------------------------------|---------------------------------|
| Signal Name                                              | 337 GWT            |             |                    |              |                              |                                 |
| <b>MII_COL</b>                                           | W4                 | Input       | Pullup             | Fixed, 20 µA | -                            | Collision detect                |
| MIBSPI1NCS[1]/ <b>MII_COL</b> /N2HET1[17]/eQEP1S         | F3 <sup>(1)</sup>  |             |                    |              |                              |                                 |
| <b>MII_CRS</b>                                           | V4                 | Input       | Pulldown           | Fixed, 20 µA | -                            | Carrier sense and receive valid |
| N2HET1[12]/MIBSPI4NCS[5]/ <b>MII_CRS</b> /RMII_CRS_DV    | B4 <sup>(1)</sup>  |             |                    |              |                              |                                 |
| <b>MII_RX_DV</b>                                         | U6                 | Input       | Pulldown           | Fixed, 20 µA | -                            | Received data valid             |
| N2HET1[30]/ <b>MII_RX_DV</b> /eQEP2S                     | B11 <sup>(1)</sup> |             |                    |              |                              |                                 |
| <b>MII_RX_ER</b>                                         | U5                 | Input       | Pulldown           | Fixed, 20 µA | -                            | Receive error                   |
| AD1EVT/ <b>MII_RX_ER</b> /RMII_RX_ER/nTZ1_1              | N19 <sup>(1)</sup> |             |                    |              |                              |                                 |
| <b>MII_RXCLK</b>                                         | T4                 | Input       | Pulldown           | Fixed, 20 µA | -                            | Receive clock                   |
| N2HET1[28]/ <b>MII_RXCLK</b> /RMII_REFCLK                | K19 <sup>(1)</sup> |             |                    |              |                              |                                 |
| <b>MII_RXD[0]</b>                                        | U4                 | Input       | Pulldown           | Fixed, 20 µA | -                            | Receive data                    |
| N2HET1[24]/MIBSPI1NCS[5]/ <b>MII_RXD[0]</b> /RMII_RXD[0] | P1 <sup>(1)</sup>  |             |                    |              |                              |                                 |

表 5-17. GWT Ethernet Controller: Media Independent Interface (MII) (续)

| Terminal                                           |                    | Signal Type | Default Pull State | Pull Type         | Output Buffer Drive Strength | Description    |
|----------------------------------------------------|--------------------|-------------|--------------------|-------------------|------------------------------|----------------|
| Signal Name                                        | 337 GWT            |             |                    |                   |                              |                |
| MII_RXD[1]                                         | T3                 | Input       | Pulldown           | Fixed, 20 $\mu$ A | -                            | Receive data   |
| N2HET1[26]/MII_RXD[1]/RMII_RXD[1]                  | A14 <sup>(1)</sup> |             |                    |                   |                              |                |
| MII_RXD[2]                                         | U3                 | Input       | Pulldown           | Fixed, 20 $\mu$ A | -                            | Receive data   |
| MIBSPI1NENA/MII_RXD[2]/N2HET1[23]/ECAP4            | G19 <sup>(1)</sup> |             |                    |                   |                              |                |
| MII_RXD[3]                                         | V3                 | Input       | Pulldown           | Fixed, 20 $\mu$ A | -                            | Receive data   |
| MIBSPI5NENA/DMM_DATA[7]/MII_RXD[3]/ECAP5           | H18 <sup>(1)</sup> |             |                    |                   |                              |                |
| MII_TX_CLK                                         | U7                 | Input       | Pulldown           | Fixed, 20 $\mu$ A | -                            | Transmit clock |
| N2HET1[10]/MIBSPI4NCS[4]/MII_TX_CLK/nTZ1_3         | D19 <sup>(1)</sup> |             |                    |                   |                              |                |
| MII_TXD[0]                                         | U8                 | Output      | -                  | -                 | 8 mA                         | Transmit data  |
| MIBSPI5SOMI[0]/DMM_DATA[12]/MII_TXD[0]/RMII_TXD[0] | J18 <sup>(1)</sup> |             |                    |                   |                              |                |
| MII_TXD[1]                                         | R1                 | Output      | -                  | -                 | 8 mA                         | Transmit data  |
| MIBSPI5SIMO[0]/DMM_DATA[8]/MII_TXD[1]/RMII_TXD[1]  | J19 <sup>(1)</sup> |             |                    |                   |                              |                |
| MII_TXD[2]                                         | T2                 | Output      | -                  | -                 | 8 mA                         | Transmit data  |
| MIBSPI1NCS[0]/MIBSPI1SOMI[1]/MII_TXD[2]/ECAP6      | R2 <sup>(1)</sup>  |             |                    |                   |                              |                |
| MII_TXD[3]                                         | G4                 | Output      | -                  | -                 | 8 mA                         | Transmit data  |
| N2HET1[8]/MIBSPI1SIMO[1]/MII_TXD[3]                | E18 <sup>(1)</sup> |             |                    |                   |                              |                |

表 5-17. GWT Ethernet Controller: Media Independent Interface (MII) (续)

| Terminal                                  |            | Signal Type | Default Pull State | Pull Type | Output Buffer Drive Strength | Description     |
|-------------------------------------------|------------|-------------|--------------------|-----------|------------------------------|-----------------|
| Signal Name                               | 337 GWT    |             |                    |           |                              |                 |
| MII_TXEN                                  | E4         | Output      | -                  | -         | 8 mA                         | Transmit enable |
| MIBSPI5CLK/DMM_DATA[4]/MII_TXEN/RMII_TXEN | H19<br>(1) |             |                    |           |                              |                 |

- (1) This is the secondary terminal at which the signal is also available. See [节 5.2.2.2](#) for more detail on how to select between the available terminals for input functionality.

## 5.2.1.16 External Memory Interface (EMIF)

表 5-18. External Memory Interface (EMIF)

| Terminal <sup>(2)</sup>              |                   | Signal Type | Default Pull State | Pull Type  | Output Buffer Drive Strength | Description                       |
|--------------------------------------|-------------------|-------------|--------------------|------------|------------------------------|-----------------------------------|
| Signal Name                          | 337 GWT           |             |                    |            |                              |                                   |
| EMIF_ADDR[0]/N2HET2[1]               | D4                | Output      | Pulldown           | 20 $\mu$ A | 8 mA                         | EMIF address                      |
| EMIF_ADDR[1]/N2HET2[3]               | D5                | Output      | Pulldown           | 20 $\mu$ A | 8 mA                         | EMIF address                      |
| ETMDATA[11]/EMIF_ADDR[2]             | E6                | Output      | -                  | -          | 8 mA                         | EMIF address                      |
| ETMDATA[10]/EMIF_ADDR[3]             | E7                | Output      | -                  | -          | 8 mA                         | EMIF address                      |
| ETMDATA[9]/EMIF_ADDR[4]              | E8                | Output      | -                  | -          | 8 mA                         | EMIF address                      |
| ETMDATA[8]/EMIF_ADDR[5]              | E9                | Output      | -                  | -          | 8 mA                         | EMIF address                      |
| EMIF_ADDR[6]/RTP_DATA[13]/N2HET2[11] | C4                | Output      | Pulldown           | 20 $\mu$ A | 8 mA                         | EMIF address                      |
| EMIF_ADDR[7]/RTP_DATA[12]/N2HET2[13] | C5                | Output      | Pulldown           | 20 $\mu$ A | 8 mA                         | EMIF address                      |
| EMIF_ADDR[8]/RTP_DATA[11]/N2HET2[15] | C6                | Output      | Pulldown           | 20 $\mu$ A | 8 mA                         | EMIF address                      |
| EMIF_ADDR[9]/RTP_DATA[10]            | C7                | Output      | Pulldown           | 20 $\mu$ A | 8 mA                         | EMIF address                      |
| EMIF_ADDR[10]/RTP_DATA[9]            | C8                | Output      | Pulldown           | 20 $\mu$ A | 8 mA                         | EMIF address                      |
| EMIF_ADDR[11]/RTP_DATA[8]            | C9                | Output      | Pulldown           | 20 $\mu$ A | 8 mA                         | EMIF address                      |
| EMIF_ADDR[12]/RTP_DATA[6]            | C10               | Output      | Pulldown           | 20 $\mu$ A | 8 mA                         | EMIF address                      |
| EMIF_ADDR[13]/RTP_DATA[5]            | C11               | Output      | Pulldown           | 20 $\mu$ A | 8 mA                         | EMIF address                      |
| EMIF_ADDR[14]/RTP_DATA[4]            | C12               | Output      | Pulldown           | 20 $\mu$ A | 8 mA                         | EMIF address                      |
| EMIF_ADDR[15]/RTP_DATA[3]            | C13               | Output      | Pulldown           | 20 $\mu$ A | 8 mA                         | EMIF address                      |
| EMIF_ADDR[16]/RTP_DATA[2]            | D14               | Output      | Pulldown           | 20 $\mu$ A | 8 mA                         | EMIF address                      |
| EMIF_ADDR[17]/RTP_DATA[1]            | C14               | Output      | Pulldown           | 20 $\mu$ A | 8 mA                         | EMIF address                      |
| EMIF_ADDR[18]/RTP_DATA[0]            | D15               | Output      | Pulldown           | 20 $\mu$ A | 8 mA                         | EMIF address                      |
| EMIF_ADDR[19]/RTP_nENA               | C15               | Output      | Pullup             | 20 $\mu$ A | 8 mA                         | EMIF address                      |
| EMIF_ADDR[20]/RTP_nSYNC              | C16               | Output      | Pullup             | 20 $\mu$ A | 8 mA                         | EMIF address                      |
| EMIF_ADDR[21]/RTP_CLK                | C17               | Output      | Pulldown           | 20 $\mu$ A | 8 mA                         | EMIF address                      |
| ETMDATA[12]/EMIF_BA[0]               | E13               | Output      | Pulldown           | 20 $\mu$ A | 8 mA                         | EMIF bank address or address line |
| N2HET1[23]/EMIF_BA[0]                | J4 <sup>(1)</sup> |             |                    |            |                              |                                   |
| EMIF_BA[1]/N2HET2[5]                 | D16               | Output      | Pulldown           | 20 $\mu$ A | 8 mA                         | EMIF bank address or address line |

表 5-18. External Memory Interface (EMIF) (续)

| Terminal <sup>(2)</sup>                           |                    | Signal Type | Default Pull State | Pull Type         | Output Buffer Drive Strength | Description                    |
|---------------------------------------------------|--------------------|-------------|--------------------|-------------------|------------------------------|--------------------------------|
| Signal Name                                       | 337 GWT            |             |                    |                   |                              |                                |
| EMIF_CKE                                          | L3                 | Output      | -                  | -                 | 8 mA                         | EMIF clock enable              |
| EMIF_CLK/ECLK2                                    | K3                 | Output      | Pulldown           | 20 $\mu$ A        | 8 mA                         | EMIF clock                     |
| ETMDATA[16]/EMIF_DATA[0]                          | K15                | I/O         | Pulldown           | Fixed, 20 $\mu$ A | 8 mA                         | EMIF data                      |
| ETMDATA[17]/EMIF_DATA[1]                          | L15                | I/O         | Pulldown           | Fixed, 20 $\mu$ A | 8 mA                         | EMIF data                      |
| ETMDATA[18]/EMIF_DATA[2]                          | M15                | I/O         | Pulldown           | Fixed, 20 $\mu$ A | 8 mA                         | EMIF data                      |
| ETMDATA[19]/EMIF_DATA[3]                          | N15                | I/O         | Pulldown           | Fixed, 20 $\mu$ A | 8 mA                         | EMIF data                      |
| ETMDATA[20]/EMIF_DATA[4]                          | E5                 | I/O         | Pulldown           | Fixed, 20 $\mu$ A | 8 mA                         | EMIF data                      |
| ETMDATA[21]/EMIF_DATA[5]                          | F5                 | I/O         | Pulldown           | Fixed, 20 $\mu$ A | 8 mA                         | EMIF data                      |
| ETMDATA[22]/EMIF_DATA[6]                          | G5                 | I/O         | Pulldown           | Fixed, 20 $\mu$ A | 8 mA                         | EMIF data                      |
| ETMDATA[23]/EMIF_DATA[7]                          | K5                 | I/O         | Pulldown           | Fixed, 20 $\mu$ A | 8 mA                         | EMIF data                      |
| ETMDATA[24]/EMIF_DATA[8]/N2HET2[24]/MIBSPI5NCS[4] | L5                 | I/O         | Pulldown           | Fixed, 20 $\mu$ A | 8 mA                         | EMIF data                      |
| ETMDATA[25]/EMIF_DATA[9]/N2HET2[25]/MIBSPI5NCS[5] | M5                 | I/O         | Pulldown           | Fixed, 20 $\mu$ A | 8 mA                         | EMIF data                      |
| ETMDATA[26]/EMIF_DATA[10]/N2HET2[26]              | N5                 | I/O         | Pulldown           | Fixed, 20 $\mu$ A | 8 mA                         | EMIF data                      |
| ETMDATA[27]/EMIF_DATA[11]/N2HET2[27]              | P5                 | I/O         | Pulldown           | Fixed, 20 $\mu$ A | 8 mA                         | EMIF data                      |
| ETMDATA[28]/EMIF_DATA[12]/N2HET2[28]/GIOA[0]      | R5                 | I/O         | Pulldown           | Fixed, 20 $\mu$ A | 8 mA                         | EMIF data                      |
| ETMDATA[29]/EMIF_DATA[13]/N2HET2[29]/GIOA[1]      | R6                 | I/O         | Pulldown           | Fixed, 20 $\mu$ A | 8 mA                         | EMIF data                      |
| ETMDATA[30]/EMIF_DATA[14]/N2HET2[30]/GIOA[3]      | R7                 | I/O         | Pulldown           | Fixed, 20 $\mu$ A | 8 mA                         | EMIF data                      |
| ETMDATA[31]/EMIF_DATA[15]/N2HET2[31]/GIOA[4]      | R8                 | I/O         | Pulldown           | Fixed, 20 $\mu$ A | 8 mA                         | EMIF data                      |
| EMIF_nCAS/GIOB[3]                                 | R4                 | Output      | Pulldown           | 20 $\mu$ A        | 8 mA                         | EMIF column address strobe     |
| EMIF_nCS[0]/RTP_DATA[15]/N2HET2[7]                | N17                | Output      | Pulldown           | 20 $\mu$ A        | 8 mA                         | EMIF chip select, synchronous  |
| EMIF_nCS[2]/GIOB[4]                               | L17                | Output      | Pulldown           | 20 $\mu$ A        | 8 mA                         | EMIF chip select, asynchronous |
| EMIF_nCS[3]/RTP_DATA[14]/N2HET2[9]                | K17                | Output      | Pulldown           | 20 $\mu$ A        | 8 mA                         | EMIF chip select, asynchronous |
| EMIF_nCS[4]/RTP_DATA[7]/GIOB[5]                   | M17                | Output      | Pulldown           | 20 $\mu$ A        | 8 mA                         | EMIF chip select, asynchronous |
| ETMDATA[15]/EMIF_nDQM[0]                          | E10                | Output      | Pulldown           | 20 $\mu$ A        | 8 mA                         | EMIF byte enable               |
| N2HET1[19]/EMIF_nDQM[0]/SCI4TX                    | B13 <sup>(1)</sup> |             |                    |                   |                              |                                |
| ETMDATA[14]/EMIF_nDQM[1]                          | E11                | Output      | Pulldown           | 20 $\mu$ A        | 8 mA                         | EMIF byte enable               |
| N2HET1[20]/EMIF_nDQM[1]/ePWM6B                    | P2 <sup>(1)</sup>  |             |                    |                   |                              |                                |
| N2HET1[21]/EMIF_nDQM[2]                           | H4                 | Output      | Pulldown           | 20 $\mu$ A        | 8 mA                         | EMIF byte enable               |
| N2HET1[22]/EMIF_nDQM[3]                           | B3                 | Output      | Pulldown           | 20 $\mu$ A        | 8 mA                         | EMIF byte enable               |

表 5-18. External Memory Interface (EMIF) (续)

| Terminal <sup>(2)</sup>     |                    | Signal Type | Default Pull State | Pull Type         | Output Buffer Drive Strength | Description             |
|-----------------------------|--------------------|-------------|--------------------|-------------------|------------------------------|-------------------------|
| Signal Name                 | 337 GWT            |             |                    |                   |                              |                         |
| ETMDATA[13]/EMIF_nOE        | E12                | Output      | Pulldown           | 20 $\mu$ A        | 8 mA                         | EMIF output enable      |
| N2HET1[17]/EMIF_nOE /SCI4RX | A13 <sup>(1)</sup> |             |                    |                   |                              |                         |
| EMIF_nRAS/GIOB[6]           | R3                 | Output      | Pulldown           | 20 $\mu$ A        | 8 mA                         | EMIF row address strobe |
| EMIF_nWAIT/GIOB[7]          | P3                 | Input       | Pullup             | Fixed, 20 $\mu$ A | -                            | EMIF wait               |
| EMIF_nWE/EMIF_RNW           | D17                | Output      | -                  | -                 | 8 mA                         | EMIF write enable       |
| EMIF_nWE/EMIF_RNW           | D17                | Output      | -                  | -                 | 8 mA                         | EMIF read-not-write     |
| N2HET1[18]/EMIF_RNW /ePWM6A | J1 <sup>(1)</sup>  |             |                    |                   |                              |                         |

- (1) This is the secondary terminal at which the signal is also available. See 节 5.2.2.2 for more detail on how to select between the available terminals for input functionality.
- (2) By default, the EMIF interface pins are the primary pins before configuring the IOMM (IO Muxing Module). The output buffers of these pins are forced to tri-state until enabled by setting PINMMR174[8] = 0 and PINMMR174[9] = 1.”

### 5.2.1.17 Embedded Trace Macrocell Interface for Cortex-R5F (ETM-R5)

表 5-19. GWT Embedded Trace Macrocell Interface for Cortex-R5F (ETM-R5)

| Terminal                                             |         | Signal Type | Default Pull State | Pull Type         | Output Buffer Drive Strength | Description            |
|------------------------------------------------------|---------|-------------|--------------------|-------------------|------------------------------|------------------------|
| Signal Name                                          | 337 GWT |             |                    |                   |                              |                        |
| ETMDATA[0]                                           | R12     | Output      | Pulldown           | 20 $\mu$ A        | 8 mA                         | ETM data               |
| ETMDATA[1]                                           | R13     | Output      | Pulldown           | 20 $\mu$ A        | 8 mA                         | ETM data               |
| ETMDATA[2]                                           | J15     | Output      | Pulldown           | 20 $\mu$ A        | 8 mA                         | ETM data               |
| ETMDATA[3]                                           | H15     | Output      | Pulldown           | 20 $\mu$ A        | 8 mA                         | ETM data               |
| ETMDATA[4]                                           | G15     | Output      | Pulldown           | 20 $\mu$ A        | 8 mA                         | ETM data               |
| ETMDATA[5]                                           | F15     | Output      | Pulldown           | 20 $\mu$ A        | 8 mA                         | ETM data               |
| ETMDATA[6]                                           | E15     | Output      | Pulldown           | 20 $\mu$ A        | 8 mA                         | ETM data               |
| ETMDATA[7]                                           | E14     | Output      | Pulldown           | 20 $\mu$ A        | 8 mA                         | ETM data               |
| ETMDATA[8] /EMIF_ADDR[5]                             | E9      | Output      | Pulldown           | 20 $\mu$ A        | 8 mA                         | ETM data               |
| ETMDATA[9] /EMIF_ADDR[4]                             | E8      | Output      | Pulldown           | 20 $\mu$ A        | 8 mA                         | ETM data               |
| ETMDATA[10] /EMIF_ADDR[3]                            | E7      | Output      | Pulldown           | 20 $\mu$ A        | 8 mA                         | ETM data               |
| ETMDATA[11] /EMIF_ADDR[2]                            | E6      | Output      | Pulldown           | 20 $\mu$ A        | 8 mA                         | ETM data               |
| ETMDATA[12] /EMIF_BA[0]                              | E13     | Output      | Pulldown           | 20 $\mu$ A        | 8 mA                         | ETM data               |
| ETMDATA[13] /EMIF_nOE                                | E12     | Output      | Pulldown           | 20 $\mu$ A        | 8 mA                         | ETM data               |
| ETMDATA[14] /EMIF_nDQM[1]                            | E11     | Output      | Pulldown           | 20 $\mu$ A        | 8 mA                         | ETM data               |
| ETMDATA[15] /EMIF_nDQM[0]                            | E10     | Output      | Pulldown           | 20 $\mu$ A        | 8 mA                         | ETM data               |
| ETMDATA[16] /EMIF_DATA[0]                            | K15     | Output      | Pulldown           | 20 $\mu$ A        | 8 mA                         | ETM data               |
| ETMDATA[17] /EMIF_DATA[1]                            | L15     | Output      | Pulldown           | 20 $\mu$ A        | 8 mA                         | ETM data               |
| ETMDATA[18] /EMIF_DATA[2]                            | M15     | Output      | Pulldown           | 20 $\mu$ A        | 8 mA                         | ETM data               |
| ETMDATA[19] /EMIF_DATA[3]                            | N15     | Output      | Pulldown           | 20 $\mu$ A        | 8 mA                         | ETM data               |
| ETMDATA[20] /EMIF_DATA[4]                            | E5      | Output      | Pulldown           | 20 $\mu$ A        | 8 mA                         | ETM data               |
| ETMDATA[21] /EMIF_DATA[5]                            | F5      | Output      | Pulldown           | 20 $\mu$ A        | 8 mA                         | ETM data               |
| ETMDATA[22] /EMIF_DATA[6]                            | G5      | Output      | Pulldown           | 20 $\mu$ A        | 8 mA                         | ETM data               |
| ETMDATA[23] /EMIF_DATA[7]                            | K5      | Output      | Pulldown           | 20 $\mu$ A        | 8 mA                         | ETM data               |
| ETMDATA[24] /EMIF_DATA[8] /N2HET2[24]/ MIBSPI5NCS[4] | L5      | Output      | Pulldown           | 20 $\mu$ A        | 8 mA                         | ETM data               |
| ETMDATA[25] /EMIF_DATA[9] /N2HET2[25]/ MIBSPI5NCS[5] | M5      | Output      | Pulldown           | 20 $\mu$ A        | 8 mA                         | ETM data               |
| ETMDATA[26] /EMIF_DATA[10] /N2HET2[26]               | N5      | Output      | Pulldown           | 20 $\mu$ A        | 8 mA                         | ETM data               |
| ETMDATA[27] /EMIF_DATA[11] /N2HET2[27]               | P5      | Output      | Pulldown           | 20 $\mu$ A        | 8 mA                         | ETM data               |
| ETMDATA[28] /EMIF_DATA[12] /N2HET2[28]/GIOA[0]       | R5      | Output      | Pulldown           | 20 $\mu$ A        | 8 mA                         | ETM data               |
| ETMDATA[29] /EMIF_DATA[13] /N2HET2[29]/GIOA[1]       | R6      | Output      | Pulldown           | 20 $\mu$ A        | 8 mA                         | ETM data               |
| ETMDATA[30] /EMIF_DATA[14] /N2HET2[30]/GIOA[3]       | R7      | Output      | Pulldown           | 20 $\mu$ A        | 8 mA                         | ETM data               |
| ETMDATA[31] /EMIF_DATA[15] /N2HET2[31]/GIOA[4]       | R8      | Output      | Pulldown           | 20 $\mu$ A        | 8 mA                         | ETM data               |
| ETMTRACECLKIN /EXTCLKIN2/GIOA[5]                     | R9      | Input       | Pullup             | Fixed, 20 $\mu$ A | -                            | ETM trace clock input  |
| ETMTRACECLKOUT /GIOA[6]                              | R10     | Output      | Pulldown           | 20 $\mu$ A        | 8 mA                         | ETM trace clock output |
| ETMTRACECTL /GIOA[7]                                 | R11     | Output      | Pulldown           | 20 $\mu$ A        | 8 mA                         | ETM trace control      |

### 5.2.1.18 System Module Interface

表 5-20. GWT System Module Interface

| Terminal               |         | Signal Type | Default Pull State | Pull Type   | Output Buffer Drive Strength | Description                |
|------------------------|---------|-------------|--------------------|-------------|------------------------------|----------------------------|
| Signal Name            | 337 GWT |             |                    |             |                              |                            |
| <b>nERROR</b>          | B14     | Output      | Pulldown           | 20 $\mu$ A  | 8 mA                         | ESM error                  |
| GIOB[6]/ <b>nERROR</b> | J2      | Output      | Pulldown           | 20 $\mu$ A  | 8 mA                         | ESM error 1                |
| <b>nPORRST</b>         | W7      | Input       | Pulldown           | 100 $\mu$ A | -                            | Power-on reset, cold reset |
| <b>nRST</b>            | B17     | I/O         | Pullup             | 100 $\mu$ A | 4 mA                         | System reset, warm reset   |

### 5.2.1.19 Clock Inputs and Outputs

**表 5-21. GWT Clock Inputs and Outputs**

| Terminal                                 |         | Signal Type | Default Pull State | Pull Type                | Output Buffer Drive Strength | Description                                              |
|------------------------------------------|---------|-------------|--------------------|--------------------------|------------------------------|----------------------------------------------------------|
| Signal Name                              | 337 GWT |             |                    |                          |                              |                                                          |
| <b>ECLK1</b>                             | A12     | I/O         | Pulldown           | Programmable, 20 $\mu$ A | 2-mA ZD/8 mA                 | External clock output, or GIO                            |
| EMIF_CLK/ <b>ECLK2</b>                   | K3      | I/O         | Pulldown           | Programmable, 20 $\mu$ A | 2-mA ZD/8 mA                 | External clock output, or GIO                            |
| GIOA[5]/ <b>EXTCLKIN1</b> /ePWM1A        | B5      | Input       | Pulldown           | Fixed, 20 $\mu$ A        | -                            | External clock input                                     |
| ETMTRACECLKIN/ <b>EXTCLKIN2</b> /GIOA[5] | R9      | Input       | Pullup             | Fixed, 20 $\mu$ A        | -                            | External clock input # 2                                 |
| <b>KELVIN_GND</b>                        | L2      | Input       | -                  | -                        | -                            | Kelvin ground for oscillator                             |
| <b>OSCIN</b>                             | K1      | Input       | -                  | -                        | -                            | From external crystal/resonator, or external clock input |
| <b>OSCOUT</b>                            | L1      | Output      | -                  | -                        | -                            | To external crystal/resonator                            |

### 5.2.1.20 Test and Debug Modules Interface

表 5-22. GWT Test and Debug Modules Interface

| TERMINAL    |            | SIGNAL<br>TYPE | DEFAULT<br>PULL<br>STATE | PULL TYPE          | OUTPUT<br>BUFFER<br>DRIVE<br>STRENGTH | DESCRIPTION                                                                                          |
|-------------|------------|----------------|--------------------------|--------------------|---------------------------------------|------------------------------------------------------------------------------------------------------|
| SIGNAL NAME | 337<br>GWT |                |                          |                    |                                       |                                                                                                      |
| nTRST       | D18        | Input          | Pulldown                 | 100 $\mu$ A        | -                                     | JTAG test hardware reset                                                                             |
| TCK         | B18        | Input          | Pulldown                 | Fixed, 100 $\mu$ A | -                                     | JTAG test clock                                                                                      |
| TDI         | A17        | Input          | Pullup                   | Fixed, 100 $\mu$ A | -                                     | JTAG test data in                                                                                    |
| TDO         | C18        | Output         | Pulldown                 | Fixed, 100 $\mu$ A | 8 mA                                  | JTAG test data out                                                                                   |
| TEST        | U2         | Input          | Pulldown                 | Fixed, 100 $\mu$ A | -                                     | Test mode enable. This terminal must be connected to ground directly or through a pulldown resistor. |
| TMS         | C19        | Input          | Pullup                   | Fixed, 100 $\mu$ A | -                                     | JTAG test mode select                                                                                |
| RTCK        | A16        | Output         | -                        | -                  | 8 mA                                  | JTAG return test clock                                                                               |

### 5.2.1.21 Flash Supply and Test Pads

**表 5-23. GWT Flash Supply and Test Pads**

| TERMINAL    |         | SIGNAL<br>TYPE | DEFAULT<br>PULL STATE | PULL TYPE | OUTPUT<br>BUFFER<br>DRIVE<br>STRENGTH | DESCRIPTION                                                                                                                                                                       |
|-------------|---------|----------------|-----------------------|-----------|---------------------------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| SIGNAL NAME | 337 GWT |                |                       |           |                                       |                                                                                                                                                                                   |
| VCCP        | F8      | 3.3-V Power    | –                     | –         | –                                     | Flash pump supply                                                                                                                                                                 |
| FLTP1       | J5      | Input          | –                     | –         | –                                     | Flash test pads. These terminals are reserved for TI use only. For proper operation these terminals must connect only to a test pad or not be connected at all [no connect (NC)]. |
| FLTP2       | H5      | Input          | –                     | –         | –                                     |                                                                                                                                                                                   |

### 5.2.1.22 Supply for Core Logic: 1.2-V Nominal

表 5-24. GWT Supply for Core Logic: 1.2-V Nominal

| Terminal    |         | Signal Type | Default Pull State | Pull Type | Output Buffer Drive Strength | Description |
|-------------|---------|-------------|--------------------|-----------|------------------------------|-------------|
| Signal Name | 337 GWT |             |                    |           |                              |             |
| VCC         | P10     | 1.2-V Power | -                  | -         | -                            | Core supply |
| VCC         | L6      |             | -                  | -         | -                            | Core supply |
| VCC         | K6      |             | -                  | -         | -                            | Core supply |
| VCC         | F9      |             | -                  | -         | -                            | Core supply |
| VCC         | F10     |             | -                  | -         | -                            | Core supply |
| VCC         | J14     |             | -                  | -         | -                            | Core supply |
| VCC         | K14     |             | -                  | -         | -                            | Core supply |
| VCC         | M10     |             | -                  | -         | -                            | Core supply |
| VCC         | K8      |             | -                  | -         | -                            | Core supply |
| VCC         | H10     |             | -                  | -         | -                            | Core supply |
| VCC         | K12     |             | -                  | -         | -                            | Core supply |

### 5.2.1.23 Supply for I/O Cells: 3.3-V Nominal

表 5-25. GWT Supply for I/O Cells: 3.3-V Nominal

| Terminal    |         | Signal Type | Default Pull State | Pull Type | Output Buffer Drive Strength | Description               |
|-------------|---------|-------------|--------------------|-----------|------------------------------|---------------------------|
| Signal Name | 337 GWT |             |                    |           |                              |                           |
| VCCIO       | F11     | 3.3-V Power | -                  | -         | -                            | Operating supply for I/Os |
| VCCIO       | F12     |             | -                  | -         | -                            | Operating supply for I/Os |
| VCCIO       | F13     |             | -                  | -         | -                            | Operating supply for I/Os |
| VCCIO       | F14     |             | -                  | -         | -                            | Operating supply for I/Os |
| VCCIO       | G14     |             | -                  | -         | -                            | Operating supply for I/Os |
| VCCIO       | H14     |             | -                  | -         | -                            | Operating supply for I/Os |
| VCCIO       | L14     |             | -                  | -         | -                            | Operating supply for I/Os |
| VCCIO       | M14     |             | -                  | -         | -                            | Operating supply for I/Os |
| VCCIO       | N14     |             | -                  | -         | -                            | Operating supply for I/Os |
| VCCIO       | P14     |             | -                  | -         | -                            | Operating supply for I/Os |
| VCCIO       | P13     |             | -                  | -         | -                            | Operating supply for I/Os |
| VCCIO       | P12     |             | -                  | -         | -                            | Operating supply for I/Os |
| VCCIO       | P9      |             | -                  | -         | -                            | Operating supply for I/Os |
| VCCIO       | P8      |             | -                  | -         | -                            | Operating supply for I/Os |
| VCCIO       | P7      |             | -                  | -         | -                            | Operating supply for I/Os |
| VCCIO       | P6      |             | -                  | -         | -                            | Operating supply for I/Os |
| VCCIO       | N6      |             | -                  | -         | -                            | Operating supply for I/Os |
| VCCIO       | M6      |             | -                  | -         | -                            | Operating supply for I/Os |
| VCCIO       | J6      |             | -                  | -         | -                            | Operating supply for I/Os |
| VCCIO       | H6      |             | -                  | -         | -                            | Operating supply for I/Os |
| VCCIO       | G6      |             | -                  | -         | -                            | Operating supply for I/Os |
| VCCIO       | F6      |             | -                  | -         | -                            | Operating supply for I/Os |
| VCCIO       | F7      |             | -                  | -         | -                            | Operating supply for I/Os |

## 5.2.1.24 Ground Reference for All Supplies Except VCCAD

表 5-26. GWT Ground Reference for All Supplies Except VCCAD

| TERMINAL    |            | SIGNAL<br>TYPE | DEFAULT<br>PULL<br>STATE | PULL TYPE | OUTPUT<br>BUFFER<br>DRIVE<br>STRENGTH | DESCRIPTION      |
|-------------|------------|----------------|--------------------------|-----------|---------------------------------------|------------------|
| SIGNAL NAME | 337<br>GWT |                |                          |           |                                       |                  |
| VSS         | W1         | Ground         | -                        | -         | -                                     | Ground reference |
| VSS         | V1         |                | -                        | -         | -                                     | Ground reference |
| VSS         | W2         |                | -                        | -         | -                                     | Ground reference |
| VSS         | B1         |                | -                        | -         | -                                     | Ground reference |
| VSS         | A1         |                | -                        | -         | -                                     | Ground reference |
| VSS         | A2         |                | -                        | -         | -                                     | Ground reference |
| VSS         | A18        |                | -                        | -         | -                                     | Ground reference |
| VSS         | A19        |                | -                        | -         | -                                     | Ground reference |
| VSS         | B19        |                | -                        | -         | -                                     | Ground reference |
| VSS         | M8         |                | -                        | -         | -                                     | Ground reference |
| VSS         | M9         |                | -                        | -         | -                                     | Ground reference |
| VSS         | M11        |                | -                        | -         | -                                     | Ground reference |
| VSS         | M12        |                | -                        | -         | -                                     | Ground reference |
| VSS         | L8         |                | -                        | -         | -                                     | Ground reference |
| VSS         | L9         |                | -                        | -         | -                                     | Ground reference |
| VSS         | L10        |                | -                        | -         | -                                     | Ground reference |
| VSS         | L11        |                | -                        | -         | -                                     | Ground reference |
| VSS         | L12        |                | -                        | -         | -                                     | Ground reference |
| VSS         | K9         |                | -                        | -         | -                                     | Ground reference |
| VSS         | K10        |                | -                        | -         | -                                     | Ground reference |
| VSS         | K11        |                | -                        | -         | -                                     | Ground reference |
| VSS         | J8         |                | -                        | -         | -                                     | Ground reference |
| VSS         | J9         |                | -                        | -         | -                                     | Ground reference |
| VSS         | J10        |                | -                        | -         | -                                     | Ground reference |
| VSS         | J11        |                | -                        | -         | -                                     | Ground reference |
| VSS         | J12        |                | -                        | -         | -                                     | Ground reference |
| VSS         | H8         |                | -                        | -         | -                                     | Ground reference |
| VSS         | H9         |                | -                        | -         | -                                     | Ground reference |
| VSS         | H11        |                | -                        | -         | -                                     | Ground reference |
| VSS         | H12        |                | -                        | -         | -                                     | Ground reference |

### 5.2.1.25 Other Supplies

表 5-27. Other Supplies

| TERMINAL                      |            | SIGNAL<br>TYPE | DEFAULT<br>PULL STATE | PULL TYPE | OUTPUT<br>BUFFER<br>DRIVE<br>STRENGTH | DESCRIPTION           |
|-------------------------------|------------|----------------|-----------------------|-----------|---------------------------------------|-----------------------|
| SIGNAL NAME                   | 337<br>GWT |                |                       |           |                                       |                       |
| Supply for PLL: 1.2-V nominal |            |                |                       |           |                                       |                       |
| VCCPLL                        | P11        | 1.2-V<br>Power | -                     | -         | -                                     | Core supply for PLL's |

### 5.2.2 Multiplexing

This microcontroller has several interfaces and uses extensive multiplexing to bring out the functions as required by the target application. The multiplexing is mostly on the output signals. A few inputs are also multiplexed to allow the same input signal to be driven in from an alternative terminal. For more information on multiplexing, refer to the IOMM chapter of the device specific technical reference manual.

### 5.2.2.1 Output Multiplexing

表 5-28. Output Multiplexing

| Address Offset | 337 GWT BALL               | DEFAULT FUNCTION | Select Bit | Alternate Function 1 | Select Bit | Alternate Function 2 | Select Bit | Alternate Function 3 | Select Bit | Alternate Function 4 | Select Bit | Alternate Function 5 | Select Bit |
|----------------|----------------------------|------------------|------------|----------------------|------------|----------------------|------------|----------------------|------------|----------------------|------------|----------------------|------------|
| 0x110          | N19                        | AD1EVT           | 0[0]       |                      |            | MII_RX_ER            | 0[2]       | RMII_RX_ER           | 0[3]       |                      |            | nTZ1_1               | 0[5]       |
|                | D4                         | EMIF_ADDR[0]     | 0[8]       |                      |            | N2HET2[1]            | 0[10]      |                      |            |                      |            |                      |            |
|                | D5                         | EMIF_ADDR[1]     | 0[16]      |                      |            | N2HET2[3]            | 0[18]      |                      |            |                      |            |                      |            |
|                | C4                         | EMIF_ADDR[6]     | 0[24]      | RTP_DATA[13]         | 0[25]      | N2HET2[11]           | 0[26]      |                      |            |                      |            |                      |            |
| 0x114          | C5                         | EMIF_ADDR[7]     | 1[0]       | RTP_DATA[12]         | 1[1]       | N2HET2[13]           | 1[2]       |                      |            |                      |            |                      |            |
|                | C6                         | EMIF_ADDR[8]     | 1[8]       | RTP_DATA[11]         | 1[9]       | N2HET2[15]           | 1[10]      |                      |            |                      |            |                      |            |
|                | C7                         | EMIF_ADDR[9]     | 1[16]      | RTP_DATA[10]         | 1[17]      |                      |            |                      |            |                      |            |                      |            |
|                | C8                         | EMIF_ADDR[10]    | 1[24]      | RTP_DATA[9]          | 1[25]      |                      |            |                      |            |                      |            |                      |            |
| 0x118          | C9                         | EMIF_ADDR[11]    | 2[0]       | RTP_DATA[8]          | 2[1]       |                      |            |                      |            |                      |            |                      |            |
|                | C10                        | EMIF_ADDR[12]    | 2[8]       | RTP_DATA[6]          | 2[9]       |                      |            |                      |            |                      |            |                      |            |
|                | C11                        | EMIF_ADDR[13]    | 2[16]      | RTP_DATA[5]          | 2[17]      |                      |            |                      |            |                      |            |                      |            |
|                | C12                        | EMIF_ADDR[14]    | 2[24]      | RTP_DATA[4]          | 2[25]      |                      |            |                      |            |                      |            |                      |            |
| 0x11C          | C13                        | EMIF_ADDR[15]    | 3[0]       | RTP_DATA[3]          | 3[1]       |                      |            |                      |            |                      |            |                      |            |
|                | D14                        | EMIF_ADDR[16]    | 3[8]       | RTP_DATA[2]          | 3[9]       |                      |            |                      |            |                      |            |                      |            |
|                | C14                        | EMIF_ADDR[17]    | 3[16]      | RTP_DATA[1]          | 3[17]      |                      |            |                      |            |                      |            |                      |            |
|                | D15                        | EMIF_ADDR[18]    | 3[24]      | RTP_DATA[0]          | 3[25]      |                      |            |                      |            |                      |            |                      |            |
| 0x120          | C15                        | EMIF_ADDR[19]    | 4[0]       | RTP_nENA             | 4[1]       |                      |            |                      |            |                      |            |                      |            |
|                | C16                        | EMIF_ADDR[20]    | 4[8]       | RTP_nSYNC            | 4[9]       |                      |            |                      |            |                      |            |                      |            |
|                | C17                        | EMIF_ADDR[21]    | 4[16]      | RTP_CLK              | 4[17]      |                      |            |                      |            |                      |            |                      |            |
| 0x124 - 0x12C  | Reserved                   |                  |            |                      |            |                      |            |                      |            |                      |            |                      |            |
| 0x130          | PINMMR8[23:0] are reserved |                  |            |                      |            |                      |            |                      |            |                      |            |                      |            |
| 0x134          | D16                        | EMIF_BA[1]       | 8[24]      |                      | 8[25]      | N2HET2[5]            | 8[26]      |                      |            |                      |            |                      |            |
|                | K3                         | RESERVED         | 9[0]       | EMIF_CLK             | 9[1]       | ECLK2                | 9[2]       |                      |            |                      |            |                      |            |
|                | R4                         | EMIF_nCAS        | 9[8]       |                      |            | GIOB[3]              | 9[10]      |                      |            |                      |            |                      |            |
|                | N17                        | EMIF_nCS[0]      | 9[16]      | RTP_DATA[15]         | 9[17]      | N2HET2[7]            | 9[18]      |                      |            |                      |            |                      |            |
| 0x138          | L17                        | EMIF_nCS[2]      | 9[24]      |                      |            | GIOB[4]              | 9[26]      |                      |            |                      |            |                      |            |
|                | K17                        | EMIF_nCS[3]      | 10[0]      | RTP_DATA[14]         | 10[1]      | N2HET2[9]            | 10[2]      |                      |            |                      |            |                      |            |
|                | M17                        | EMIF_nCS[4]      | 10[8]      | RTP_DATA[7]          | 10[9]      | GIOB[5]              | 10[10]     |                      |            |                      |            |                      |            |
|                | R3                         | EMIF_nRAS        | 10[16]     |                      |            | GIOB[6]              | 10[18]     |                      |            |                      |            |                      |            |
|                | P3                         | EMIF_nWAIT       | 10[24]     |                      |            | GIOB[7]              | 10[26]     |                      |            |                      |            |                      |            |

表 5-28. Output Multiplexing (续)

| Address Offset | 337 GWT BALL | DEFAULT FUNCTION | Select Bit | Alternate Function 1 | Select Bit | Alternate Function 2 | Select Bit | Alternate Function 3 | Select Bit | Alternate Function 4 | Select Bit | Alternate Function 5 | Select Bit |
|----------------|--------------|------------------|------------|----------------------|------------|----------------------|------------|----------------------|------------|----------------------|------------|----------------------|------------|
| 0x13C          | D17          | EMIF_nWE         | 11[0]      | EMIF_RNW             | 11[1]      |                      |            |                      |            |                      |            |                      |            |
|                | E9           | ETMDATA[8]       | 11[8]      | EMIF_ADDR[5]         | 11[9]      |                      |            |                      |            |                      |            |                      |            |
|                | E8           | ETMDATA[9]       | 11[16]     | EMIF_ADDR[4]         | 11[17]     |                      |            |                      |            |                      |            |                      |            |
|                | E7           | ETMDATA[10]      | 11[24]     | EMIF_ADDR[3]         | 11[25]     |                      |            |                      |            |                      |            |                      |            |
| 0x140          | E6           | ETMDATA[11]      | 12[0]      | EMIF_ADDR[2]         | 12[1]      |                      |            |                      |            |                      |            |                      |            |
|                | E13          | ETMDATA[12]      | 12[8]      | EMIF_BA[0]           | 12[9]      |                      |            |                      |            |                      |            |                      |            |
|                | E12          | ETMDATA[13]      | 12[16]     | EMIF_nOE             | 12[17]     |                      |            |                      |            |                      |            |                      |            |
|                | E11          | ETMDATA[14]      | 12[24]     | EMIF_nDQM[1]         | 12[25]     |                      |            |                      |            |                      |            |                      |            |
| 0x144          | E10          | ETMDATA[15]      | 13[0]      | EMIF_nDQM[0]         | 13[1]      |                      |            |                      |            |                      |            |                      |            |
|                | K15          | ETMDATA[16]      | 13[8]      | EMIF_DATA[0]         | 13[9]      |                      |            |                      |            |                      |            |                      |            |
|                | L15          | ETMDATA[17]      | 13[16]     | EMIF_DATA[1]         | 13[17]     |                      |            |                      |            |                      |            |                      |            |
|                | M15          | ETMDATA[18]      | 13[24]     | EMIF_DATA[2]         | 13[25]     |                      |            |                      |            |                      |            |                      |            |
| 0x148          | N15          | ETMDATA[19]      | 14[0]      | EMIF_DATA[3]         | 14[1]      |                      |            |                      |            |                      |            |                      |            |
|                | E5           | ETMDATA[20]      | 14[8]      | EMIF_DATA[4]         | 14[9]      |                      |            |                      |            |                      |            |                      |            |
|                | F5           | ETMDATA[21]      | 14[16]     | EMIF_DATA[5]         | 14[17]     |                      |            |                      |            |                      |            |                      |            |
|                | G5           | ETMDATA[22]      | 14[24]     | EMIF_DATA[6]         | 14[25]     |                      |            |                      |            |                      |            |                      |            |
| 0x14C          | K5           | ETMDATA[23]      | 15[0]      | EMIF_DATA[7]         | 15[1]      |                      |            |                      |            |                      |            |                      |            |
|                | L5           | ETMDATA[24]      | 15[8]      | EMIF_DATA[8]         | 15[9]      | N2HET2[24]           | 15[10]     | MIBSPI5NCS[4]        | 15[11]     |                      |            |                      |            |
|                | M5           | ETMDATA[25]      | 15[16]     | EMIF_DATA[9]         | 15[17]     | N2HET2[25]           | 15[18]     | MIBSPI5NCS[5]        | 15[19]     |                      |            |                      |            |
|                | N5           | ETMDATA[26]      | 15[24]     | EMIF_DATA[10]        | 15[25]     | N2HET2[26]           | 15[26]     |                      |            |                      |            |                      |            |
| 0x150          | P5           | ETMDATA[27]      | 16[0]      | EMIF_DATA[11]        | 16[1]      | N2HET2[27]           | 16[2]      |                      |            |                      |            |                      |            |
|                | R5           | ETMDATA[28]      | 16[8]      | EMIF_DATA[12]        | 16[9]      | N2HET2[28]           | 16[10]     | GIOA[0]              | 16[11]     |                      |            |                      |            |
|                | R6           | ETMDATA[29]      | 16[16]     | EMIF_DATA[13]        | 16[17]     | N2HET2[29]           | 16[18]     | GIOA[1]              | 16[19]     |                      |            |                      |            |
|                | R7           | ETMDATA[30]      | 16[24]     | EMIF_DATA[14]        | 16[25]     | N2HET2[30]           | 16[26]     | GIOA[3]              | 16[27]     |                      |            |                      |            |
| 0x154          | R8           | ETMDATA[31]      | 17[0]      | EMIF_DATA[15]        | 17[1]      | N2HET2[31]           | 17[2]      | GIOA[4]              | 17[3]      |                      |            |                      |            |
|                | R9           | ETMTRACECLKIN    | 17[8]      | EXTCLKIN2            | 17[9]      |                      |            | GIOA[5]              | 17[11]     |                      |            |                      |            |
|                | R10          | ETMTRACECLKOUT   | 17[16]     |                      |            |                      |            | GIOA[6]              | 17[19]     |                      |            |                      |            |
|                | R11          | ETMTRACECTL      | 17[24]     |                      |            |                      |            | GIOA[7]              | 17[27]     |                      |            |                      |            |
| 0x158          | B15          | FRAYTX1          | 18[0]      |                      |            |                      |            | GIOA[2]              | 18[3]      |                      |            |                      |            |
|                | B8           | FRAYTX2          | 18[8]      |                      |            |                      |            | GIOB[0]              | 18[11]     |                      |            |                      |            |
|                | B16          | FRAYTXEN1        | 18[16]     |                      |            |                      |            | GIOB[1]              | 18[19]     |                      |            |                      |            |
|                | B9           | FRAYTXEN2        | 18[24]     |                      |            |                      |            | GIOB[2]              | 18[27]     |                      |            |                      |            |

表 5-28. Output Multiplexing (续)

| Address Offset | 337 GWT BALL | DEFAULT FUNCTION | Select Bit | Alternate Function 1 | Select Bit | Alternate Function 2 | Select Bit | Alternate Function 3 | Select Bit | Alternate Function 4 | Select Bit | Alternate Function 5 | Select Bit |
|----------------|--------------|------------------|------------|----------------------|------------|----------------------|------------|----------------------|------------|----------------------|------------|----------------------|------------|
| 0x15C          | C1           | GIOA[2]          | 19[0]      |                      |            | N2HET2[0]            | 19[2]      |                      |            |                      |            | eQEP2I               | 19[5]      |
|                | E1           | GIOA[3]          | 19[8]      |                      |            | N2HET2[2]            | 19[10]     |                      |            |                      |            |                      |            |
|                | B5           | GIOA[5]          | 19[16]     |                      |            |                      |            | EXTCLKIN1            | 19[19]     |                      |            | ePWM1A               | 19[21]     |
|                | H3           | GIOA[6]          | 19[24]     |                      |            | N2HET2[4]            | 19[26]     |                      |            |                      |            | ePWM1B               | 19[29]     |
| 0x160          | M1           | GIOA[7]          | 20[0]      |                      |            | N2HET2[6]            | 20[2]      |                      |            |                      |            | ePWM2A               | 20[5]      |
|                | F2           | GIOB[2]          | 20[8]      |                      |            |                      |            | DCAN4TX              | 20[11]     |                      |            |                      |            |
|                | W10          | GIOB[3]          | 20[16]     |                      |            |                      |            | DCAN4RX              | 20[19]     |                      |            |                      |            |
|                | J2           | GIOB[6]          | 20[24]     | nERROR               | 20[25]     |                      |            |                      |            |                      |            |                      |            |
| 0x164          | F1           | GIOB[7]          | 21[0]      | RESERVED             | 21[1]      |                      |            |                      |            |                      |            | nTZ1_2               | 21[5]      |
|                | R2           | MIBSPI1NCS[0]    | 21[8]      | MIBSPI1SOMI[1]       | 21[9]      | MII_TXD[2]           | 21[10]     |                      |            |                      |            | ECAP6                | 21[13]     |
|                | F3           | MIBSPI1NCS[1]    | 21[16]     |                      |            | MII_COL              | 21[18]     | N2HET1[17]           | 21[19]     |                      |            | eQEP1S               | 21[21]     |
|                | G3           | MIBSPI1NCS[2]    | 21[24]     |                      |            | MDIO                 | 21[26]     | N2HET1[19]           | 21[27]     |                      |            |                      |            |
| 0x168          | J3           | MIBSPI1NCS[3]    | 22[0]      |                      |            |                      |            | N2HET1[21]           | 22[3]      |                      |            | nTZ1_3               | 22[5]      |
|                | G19          | MIBSPI1NENA      | 22[8]      |                      |            | MII_RXD[2]           | 22[10]     | N2HET1[23]           | 22[11]     |                      |            | ECAP4                | 22[13]     |
|                | V9           | MIBSPI3CLK       | 22[16]     | AD1EXT_SEL[1]        | 22[17]     |                      |            |                      |            |                      |            | eQEP1A               | 22[21]     |
|                | V10          | MIBSPI3NCS[0]    | 22[24]     | AD2EVT               | 22[25]     |                      |            |                      |            |                      |            | eQEP1I               | 22[29]     |
| 0x16C          | V5           | MIBSPI3NCS[1]    | 23[0]      |                      |            | MDCLK                | 23[2]      | N2HET1[25]           | 23[3]      |                      |            |                      |            |
|                | B2           | MIBSPI3NCS[2]    | 23[8]      | I2C1_SDA             | 23[9]      |                      |            | N2HET1[27]           | 23[11]     |                      |            | nTZ1_2               | 23[13]     |
|                | C3           | MIBSPI3NCS[3]    | 23[16]     | I2C1_SCL             | 23[17]     |                      |            | N2HET1[29]           | 23[19]     |                      |            | nTZ1_1               | 23[21]     |
|                | W9           | MIBSPI3NENA      | 23[24]     | MIBSPI3NCS[5]        | 23[25]     |                      |            | N2HET1[31]           | 23[27]     |                      |            | eQEP1B               | 23[29]     |
| 0x170          | W8           | MIBSPI3SIMO      | 24[0]      | AD1EXT_SEL[0]        | 24[1]      |                      |            |                      |            |                      |            | ECAP3                | 24[5]      |
|                | V8           | MIBSPI3SOMI      | 24[8]      | AD1EXT_ENA           | 24[9]      |                      |            |                      |            |                      |            | ECAP2                | 24[13]     |
|                | H19          | MIBSPI5CLK       | 24[16]     | DMM_DATA[4]          | 24[17]     | MII_TXEN             | 24[18]     | RMII_TXEN            | 24[19]     |                      |            |                      |            |
|                | E19          | MIBSPI5NCS[0]    | 24[24]     | DMM_DATA[5]          | 24[25]     |                      |            |                      |            |                      |            | ePWM4A               | 24[29]     |
| 0x174          | B6           | MIBSPI5NCS[1]    | 25[0]      | DMM_DATA[6]          | 25[1]      |                      |            |                      |            |                      |            |                      |            |
|                | W6           | MIBSPI5NCS[2]    | 25[8]      | DMM_DATA[2]          | 25[9]      |                      |            |                      |            |                      |            |                      |            |
|                | T12          | MIBSPI5NCS[3]    | 25[16]     | DMM_DATA[3]          | 25[17]     |                      |            |                      |            |                      |            |                      |            |
|                | H18          | MIBSPI5NENA      | 25[24]     | DMM_DATA[7]          | 25[25]     | MII_RXD[3]           | 25[26]     |                      |            |                      |            | ECAP5                | 25[29]     |
| 0x178          | J19          | MIBSPI5SIMO[0]   | 26[0]      | DMM_DATA[8]          | 26[1]      | MII_TXD[1]           | 26[2]      | RMII_TXD[1]          | 26[3]      |                      |            |                      |            |
|                | E16          | MIBSPI5SIMO[1]   | 26[8]      | DMM_DATA[9]          | 26[9]      |                      |            |                      |            | AD1EXT_SEL[0]        | 26[12]     |                      |            |
|                | H17          | MIBSPI5SIMO[2]   | 26[16]     | DMM_DATA[10]         | 26[17]     |                      |            |                      |            | AD1EXT_SEL[1]        | 26[20]     |                      |            |
|                | G17          | MIBSPI5SIMO[3]   | 26[24]     | DMM_DATA[11]         | 26[25]     | I2C2_SDA             | 26[26]     |                      |            | AD1EXT_SEL[2]        | 26[28]     |                      |            |

**表 5-28. Output Multiplexing (续)**

| Address Offset | 337 GWT BALL | DEFAULT FUNCTION | Select Bit | Alternate Function 1 | Select Bit | Alternate Function 2 | Select Bit | Alternate Function 3 | Select Bit | Alternate Function 4 | Select Bit | Alternate Function 5 | Select Bit |
|----------------|--------------|------------------|------------|----------------------|------------|----------------------|------------|----------------------|------------|----------------------|------------|----------------------|------------|
| 0x17C          | J18          | MIBSPI5SOMI[0]   | 27[0]      | DMM_DATA[12]         | 27[1]      | MII_TXD[0]           | 27[2]      | RMII_TXD[0]          | 27[3]      |                      |            |                      |            |
|                | E17          | MIBSPI5SOMI[1]   | 27[8]      | DMM_DATA[13]         | 27[9]      |                      |            |                      |            | AD1EXT_SEL[3]        | 27[12]     |                      |            |
|                | H16          | MIBSPI5SOMI[2]   | 27[16]     | DMM_DATA[14]         | 27[17]     |                      |            |                      |            | AD1EXT_SEL[4]        | 27[20]     |                      |            |
|                | G16          | MIBSPI5SOMI[3]   | 27[24]     | DMM_DATA[15]         | 27[25]     | I2C2_SCL             | 27[26]     |                      |            | AD1EXT_ENA           | 27[28]     |                      |            |
| 0x180          | K18          | N2HET1[0]        | 28[0]      | MIBSPI4CLK           | 28[1]      |                      |            |                      |            |                      |            | ePWM2B               | 28[5]      |
|                | V2           | N2HET1[1]        | 28[8]      | MIBSPI4NENA          | 28[9]      |                      |            | N2HET2[8]            | 28[11]     |                      |            | eQEP2A               | 28[13]     |
|                | W5           | N2HET1[2]        | 28[16]     | MIBSPI4SIMO          | 28[17]     |                      |            |                      |            |                      |            | ePWM3A               | 28[21]     |
|                | U1           | N2HET1[3]        | 28[24]     | MIBSPI4NCS[0]        | 28[25]     |                      |            | N2HET2[10]           | 28[27]     |                      |            | eQEP2B               | 28[29]     |
| 0x184          | B12          | N2HET1[4]        | 29[0]      | MIBSPI4NCS[1]        | 29[1]      |                      |            |                      |            |                      |            | ePWM4B               | 29[5]      |
|                | V6           | N2HET1[5]        | 29[8]      | MIBSPI4SOMI          | 29[9]      |                      |            | N2HET2[12]           | 29[11]     |                      |            | ePWM3B               | 29[13]     |
|                | W3           | N2HET1[6]        | 29[16]     | SCI3RX               | 29[17]     |                      |            |                      |            |                      |            | ePWM5A               | 29[21]     |
|                | T1           | N2HET1[7]        | 29[24]     | MIBSPI4NCS[2]        | 29[25]     |                      |            | N2HET2[14]           | 29[27]     |                      |            | ePWM7B               | 29[29]     |
| 0x188          | E18          | N2HET1[8]        | 30[0]      | MIBSPI1SIMO[1]       | 30[1]      | MII_TXD[3]           | 30[2]      |                      |            |                      |            |                      |            |
|                | V7           | N2HET1[9]        | 30[8]      | MIBSPI4NCS[3]        | 30[9]      |                      |            | N2HET2[16]           | 30[11]     |                      |            | ePWM7A               | 30[13]     |
|                | D19          | N2HET1[10]       | 30[16]     | MIBSPI4NCS[4]        | 30[17]     | MII_TX_CLK           | 30[18]     | RESERVED             | 30[19]     |                      |            | nTZ1_3               | 30[21]     |
|                | E3           | N2HET1[11]       | 30[24]     | MIBSPI3NCS[4]        | 30[25]     |                      |            | N2HET2[18]           | 30[27]     |                      |            | ePWM1SYNCO           | 30[29]     |
| 0x18C          | B4           | N2HET1[12]       | 31[0]      | MIBSPI4NCS[5]        | 31[1]      | MII_CRS              | 31[2]      | RMII_CRS_DV          | 31[3]      |                      |            |                      |            |
|                | N2           | N2HET1[13]       | 31[8]      | SCI3TX               | 31[9]      |                      |            | N2HET2[20]           | 31[11]     |                      |            | ePWM5B               | 31[13]     |
|                | N1           | N2HET1[15]       | 31[16]     | MIBSPI1NCS[4]        | 31[17]     |                      |            | N2HET2[22]           | 31[19]     |                      |            | ECAP1                | 31[21]     |
|                | A4           | N2HET1[16]       | 31[24]     |                      |            |                      |            | ePWM1SYNCl           | 31[27]     |                      |            | ePWM1SYNCO           | 31[29]     |
| 0x190          | A13          | N2HET1[17]       | 32[0]      | EMIF_nOE             | 32[1]      | SCI4RX               | 32[2]      |                      |            |                      |            |                      |            |
|                | J1           | N2HET1[18]       | 32[8]      | EMIF_RNW             | 32[9]      |                      |            |                      |            |                      |            | ePWM6A               | 32[13]     |
|                | B13          | N2HET1[19]       | 32[16]     | EMIF_nDQM[0]         | 32[17]     | SCI4TX               | 32[18]     |                      |            |                      |            |                      |            |
|                | P2           | N2HET1[20]       | 32[24]     | EMIF_nDQM[1]         | 32[25]     |                      |            |                      |            |                      |            | ePWM6B               | 32[29]     |
| 0x194          | H4           | N2HET1[21]       | 33[0]      | EMIF_nDQM[2]         | 33[1]      |                      |            |                      |            |                      |            |                      |            |
|                | B3           | N2HET1[22]       | 33[8]      | EMIF_nDQM[3]         | 33[9]      |                      |            |                      |            |                      |            |                      |            |
|                | J4           | N2HET1[23]       | 33[16]     | EMIF_BA[0]           | 33[17]     |                      |            |                      |            |                      |            |                      |            |
|                | P1           | N2HET1[24]       | 33[24]     | MIBSPI1NCS[5]        | 33[25]     | MII_RXD[0]           | 33[26]     | RMII_RXD[0]          | 33[27]     |                      |            |                      |            |
| 0x198          | A14          | N2HET1[26]       | 34[0]      |                      |            | MII_RXD[1]           | 34[2]      | RMII_RXD[1]          | 34[3]      |                      |            |                      |            |
|                | K19          | N2HET1[28]       | 34[8]      |                      |            | MII_RXCLK            | 34[10]     | RMII_REFCLK          | 34[11]     | RESERVED             | 34[12]     |                      |            |
|                | B11          | N2HET1[30]       | 34[16]     |                      |            | MII_RX_DV            | 34[18]     |                      |            |                      |            | eQEP2S               | 34[21]     |
|                | D8           | N2HET2[1]        | 34[24]     | N2HET1_NDIS          | 34[25]     |                      |            |                      |            |                      |            |                      |            |

**表 5-28. Output Multiplexing (续)**

| Address Offset | 337 GWT BALL | DEFAULT FUNCTION | Select Bit | Alternate Function 1 | Select Bit | Alternate Function 2 | Select Bit | Alternate Function 3 | Select Bit | Alternate Function 4 | Select Bit | Alternate Function 5 | Select Bit |
|----------------|--------------|------------------|------------|----------------------|------------|----------------------|------------|----------------------|------------|----------------------|------------|----------------------|------------|
| 0x19C          | D7           | N2HET2[2]        | 35[0]      | N2HET2_NDIS          | 35[1]      |                      |            |                      |            |                      |            |                      |            |
|                | D3           | N2HET2[12]       | 35[8]      |                      |            |                      |            |                      |            | MIBSPI2NENA          | 35[12]     | MIBSPI2NCS[1]        | 35[13]     |
|                | D2           | N2HET2[13]       | 35[16]     |                      |            |                      |            |                      |            | MIBSPI2SOMI          | 35[20]     |                      |            |
|                | D1           | N2HET2[14]       | 35[24]     |                      |            |                      |            |                      |            | MIBSPI2SIMO          | 35[28]     |                      |            |
| 0x1A0          | P4           | N2HET2[19]       | 36[0]      | LIN2RX               | 36[1]      |                      |            |                      |            |                      |            |                      |            |
|                | T5           | N2HET2[20]       | 36[8]      | LIN2TX               | 36[9]      |                      |            |                      |            |                      |            |                      |            |
|                | T4           | MII_RXCLK        | 36[16]     |                      |            |                      |            |                      |            | RESERVED             | 36[20]     |                      |            |
|                | U7           | MII_TX_CLK       | 36[24]     |                      |            |                      |            |                      |            | RESERVED             | 36[28]     |                      |            |
| 0x1A4          | E2           | N2HET2[3]        | 37[0]      |                      |            |                      |            |                      |            | MIBSPI2CLK           | 37[4]      |                      |            |
|                | N3           | N2HET2[7]        | 37[8]      |                      |            |                      |            |                      |            | MIBSPI2NCS[0]        | 37[12]     |                      |            |

### 5.2.2.1.1 Notes on Output Multiplexing

表 5-28 lists the output signal multiplexing and control signals for selecting the desired functionality for each pad.

- The pads default to the signal defined by the "Default Function" in 表 5-28.
- The CTRL x columns in 表 5-28 contain a value of type x[y] which indicates the control register PINMMRx, bit y. It indicates the multiplexing control register and the bit that must be set in order to select the corresponding functionality to be output on any particular pad.
  - For example, consider the multiplexing on pin H3 for the 337-GWT package:

| 337<br>GWT<br>BALL | DEFAULT<br>FUNCTION | CTRL1  | OPTION 2 | CTRL2 | OPTION 3  | CTRL3  | OPTION 4 | CTRL4 | OPTION 5 | CTRL5 | OPTION 6 | CTRL6  |
|--------------------|---------------------|--------|----------|-------|-----------|--------|----------|-------|----------|-------|----------|--------|
| H3                 | GIOA[6]             | 19[24] |          |       | N2HET2[4] | 19[26] |          |       |          |       | ePWM1B   | 19[29] |

- When GIOA[6] is configured as an output pin in the GIO module control register, then the programmed output level appears on pin H3 by default. The PINMMR19[24] is set by default to indicate that the GIOA[6] signal is selected to be output.
- If the application must output the N2HET2[4] signal on pin H3, it must clear PINMMR19[24] and set PINMMR19[26].
- Note that the pin is connected as input to both the GIO and N2HET2 modules. That is, there is no input multiplexing on this pin.
- The base address of the IOMM module starts at 0xFFFF\_1C00. The Output mux control registers with the first register PINMMR0 starts at the offset address 0x110 within the IOMM module.

### 5.2.2.2 Input Multiplexing

Some signals are connected to more than one terminals, so that the inputs for these signals can come from either of these terminals. A multiplexor is implemented to let the application choose the terminal that will be used for providing the input signal from among the available options. The input path selection is done based on two bits in the PINMMR control registers as listed in [表 5-29](#).

**表 5-29. Input Multiplexing**

| Address Offset | Signal Name   | Default Terminal | Terminal 1 Input Multiplex Control | Alternate Terminal | Terminal 2 Input Multiplex Control |
|----------------|---------------|------------------|------------------------------------|--------------------|------------------------------------|
| 250h           | AD2EVT        | T10              | PINMMR80[0]                        | V10                | PINMMR80[1]                        |
| 25Ch           | GIOA[0]       | A5               | PINMMR83[24]                       | R5                 | PINMMR83[25]                       |
| 260h           | GIOA[1]       | C2               | PINMMR84[0]                        | R6                 | PINMMR84[1]                        |
|                | GIOA[2]       | C1               | PINMMR84[8]                        | B15                | PINMMR84[9]                        |
|                | GIOA[3]       | E1               | PINMMR84[16]                       | R7                 | PINMMR84[17]                       |
|                | GIOA[4]       | A6               | PINMMR84[24]                       | R8                 | PINMMR84[25]                       |
| 264h           | GIOA[5]       | B5               | PINMMR85[0]                        | R9                 | PINMMR85[1]                        |
|                | GIOA[6]       | H3               | PINMMR85[8]                        | R10                | PINMMR85[9]                        |
|                | GIOA[7]       | M1               | PINMMR85[16]                       | R11                | PINMMR85[17]                       |
|                | GIOB[0]       | M2               | PINMMR85[24]                       | B8                 | PINMMR85[25]                       |
| 268h           | GIOB[1]       | K2               | PINMMR86[0]                        | B16                | PINMMR86[1]                        |
|                | GIOB[2]       | F2               | PINMMR86[8]                        | B9                 | PINMMR86[9]                        |
|                | GIOB[3]       | W10              | PINMMR86[16]                       | R4                 | PINMMR86[17]                       |
|                | GIOB[4]       | G1               | PINMMR86[24]                       | L17                | PINMMR86[25]                       |
| 26Ch           | GIOB[5]       | G2               | PINMMR87[0]                        | M17                | PINMMR87[1]                        |
|                | GIOB[6]       | J2               | PINMMR87[8]                        | R3                 | PINMMR87[9]                        |
|                | GIOB[7]       | F1               | PINMMR87[16]                       | P3                 | PINMMR87[17]                       |
|                | MDIO          | F4               | PINMMR87[24]                       | G3                 | PINMMR87[25]                       |
| 270h           | MIBSPI1NCS[4] | U10              | PINMMR88[0]                        | N1                 | PINMMR88[1]                        |
|                | MIBSPI1NCS[5] | U9               | PINMMR88[8]                        | P1                 | PINMMR88[9]                        |
| 274h           | MII_COL       | W4               | PINMMR89[16]                       | F3                 | PINMMR89[17]                       |
|                | MII_CRS       | V4               | PINMMR89[24]                       | B4                 | PINMMR89[25]                       |
| 278h           | MII_RX_DV     | U6               | PINMMR90[0]                        | B11                | PINMMR90[1]                        |
|                | MII_RX_ER     | U5               | PINMMR90[8]                        | N19                | PINMMR90[9]                        |
|                | MII_RXCLK     | T4               | PINMMR90[16]                       | K19                | PINMMR90[17]                       |
|                | MII_RXD[0]    | U4               | PINMMR90[24]                       | P1                 | PINMMR90[25]                       |
| 27Ch           | MII_RXD[1]    | T3               | PINMMR91[0]                        | A14                | PINMMR91[1]                        |
|                | MII_RXD[2]    | U3               | PINMMR91[8]                        | G19                | PINMMR91[9]                        |
|                | MII_RXD[3]    | V3               | PINMMR91[16]                       | H18                | PINMMR91[17]                       |
|                | MII_TX_CLK    | U7               | PINMMR91[24]                       | D19                | PINMMR91[25]                       |
| 280h           | N2HET1[17]    | A13              | PINMMR92[0]                        | F3                 | PINMMR92[1]                        |
|                | N2HET1[19]    | B13              | PINMMR92[8]                        | G3                 | PINMMR92[9]                        |
|                | N2HET1[21]    | H4               | PINMMR92[16]                       | J3                 | PINMMR92[17]                       |
|                | N2HET1[23]    | J4               | PINMMR92[24]                       | G19                | PINMMR92[25]                       |
| 284h           | N2HET1[25]    | M3               | PINMMR93[0]                        | V5                 | PINMMR93[1]                        |
|                | N2HET1[27]    | A9               | PINMMR93[8]                        | B2                 | PINMMR93[9]                        |
|                | N2HET1[29]    | A3               | PINMMR93[16]                       | C3                 | PINMMR93[17]                       |
|                | N2HET1[31]    | J17              | PINMMR93[24]                       | W9                 | PINMMR93[25]                       |

表 5-29. Input Multiplexing (续)

| Address Offset | Signal Name | Default Terminal | Terminal 1 Input Multiplex Control | Alternate Terminal | Terminal 2 Input Multiplex Control |
|----------------|-------------|------------------|------------------------------------|--------------------|------------------------------------|
| 288h           | N2HET2[0]   | D6               | PINMMR94[0]                        | C1                 | PINMMR94[1]                        |
|                | N2HET2[1]   | D8               | PINMMR94[8]                        | D4                 | PINMMR94[9]                        |
|                | N2HET2[2]   | D7               | PINMMR94[16]                       | E1                 | PINMMR94[17]                       |
|                | N2HET2[3]   | E2               | PINMMR94[24]                       | D5                 | PINMMR94[25]                       |
| 28Ch           | N2HET2[4]   | D13              | PINMMR95[0]                        | H3                 | PINMMR95[1]                        |
|                | N2HET2[5]   | D12              | PINMMR95[8]                        | D16                | PINMMR95[9]                        |
|                | N2HET2[6]   | D11              | PINMMR95[16]                       | M1                 | PINMMR95[17]                       |
|                | N2HET2[7]   | N3               | PINMMR95[24]                       | N17                | PINMMR95[25]                       |
| 290h           | N2HET2[8]   | K16              | PINMMR96[0]                        | V2                 | PINMMR96[1]                        |
|                | N2HET2[9]   | L16              | PINMMR96[8]                        | K17                | PINMMR96[9]                        |
|                | N2HET2[10]  | M16              | PINMMR96[16]                       | U1                 | PINMMR96[17]                       |
|                | N2HET2[11]  | N16              | PINMMR96[24]                       | C4                 | PINMMR96[25]                       |
| 294h           | N2HET2[12]  | D3               | PINMMR97[0]                        | V6                 | PINMMR97[1]                        |
|                | N2HET2[13]  | D2               | PINMMR97[8]                        | C5                 | PINMMR97[9]                        |
|                | N2HET2[14]  | D1               | PINMMR97[16]                       | T1                 | PINMMR97[17]                       |
|                | N2HET2[15]  | K4               | PINMMR97[24]                       | C6                 | PINMMR97[25]                       |
| 298h           | N2HET2[16]  | L4               | PINMMR98[0]                        | V7                 | PINMMR98[1]                        |
|                | N2HET2[18]  | N4               | PINMMR98[8]                        | E3                 | PINMMR98[9]                        |
|                | N2HET2[20]  | T5               | PINMMR98[16]                       | N2                 | PINMMR98[17]                       |
|                | N2HET2[22]  | T7               | PINMMR98[24]                       | N1                 | PINMMR98[25]                       |
| 29Ch           | nTZ1_1      | N19              | PINMMR99[0]                        | C3                 | PINMMR99[1]                        |
|                | nTZ1_2      | F1               | PINMMR99[8]                        | B2                 | PINMMR99[9]                        |
|                | nTZ1_3      | J3               | PINMMR99[16]                       | D19                | PINMMR99[17]                       |

#### 5.2.2.2.1 Notes on Input Multiplexing

- The Terminal x Input Multiplex Control column in 表 5-29 lists the multiplexing control register and the bit that must be set in order to select the terminal for providing the input signal to the system. For example, N2HET2[22] can appear on two different terminals at terminal number T7 and N1. By default PINMMR98[24] is set and PINMMR98[25] is cleared to select T7 for providing N2HET2[22] to the system. If the application chooses to use N1 for providing N2HET2[22] then PINMMR98[24] must be cleared and PINMMR98[25] must be set.
- Base address of the IOMM module starts at 0xFFFF\_1C00. Input mux control registers with the first register PINMMR80 starts at the offset address 0x250 within the IOMM module.

#### 5.2.2.2.2 General Rules for Multiplexing Control Registers

- The PINMMR control registers can only be written in privileged mode. A write in a nonprivileged mode will generate an error response.
- If the application writes all 9' s to any PINMMR control register, then the default functions are selected for the affected pads.
- Each byte in a PINMMR control register is used to select the functionality for a given pad. If the application sets more than one bit within a byte for any pad, then the default function is selected for this pad.
- Several bits in the PINMMR control registers are reserved and are not used to enable any functions. If the application sets only these bits and clears the other bits, then the default functions are selected for the affected pads.

## 6 Specifications

### 6.1 Absolute Maximum Ratings

Over Operating Free-Air Temperature Range<sup>(1)</sup>

|                                          |                                                                                            | MIN   | MAX  | UNIT |
|------------------------------------------|--------------------------------------------------------------------------------------------|-------|------|------|
| Supply voltage                           | $V_{CC}$ <sup>(2)</sup>                                                                    | – 0.3 | 1.43 | V    |
|                                          | $V_{CCIO}$ , $V_{CCP}$ <sup>(2)</sup>                                                      | – 0.3 | 4.6  |      |
|                                          | $V_{CCAD}$                                                                                 | – 0.3 | 6.25 |      |
| Input voltage                            | All input pins, with exception of ADC pins                                                 | – 0.3 | 4.6  | V    |
|                                          | ADC input pins                                                                             | – 0.3 | 6.25 |      |
| Input clamp current:                     | $I_{IK}$ ( $V_I < 0$ or $V_I > V_{CCIO}$ )<br>All pins, except AD1IN[31:0] and AD2IN[24:0] | – 20  | 20   | mA   |
|                                          | $I_{IK}$ ( $V_I < 0$ or $V_I > V_{CCAD}$ )<br>AD1IN[31:0] and AD2IN[24:0]                  | – 10  | 10   |      |
|                                          | Total                                                                                      | – 40  | 40   |      |
| Operating free-air temperature ( $T_A$ ) |                                                                                            | – 55  | 125  | °C   |
| Operating junction temperature ( $T_J$ ) |                                                                                            | – 55  | 150  | °C   |
| Storage temperature ( $T_{stg}$ )        |                                                                                            | – 65  | 150  | °C   |

- (1) Stresses beyond those listed under *Absolute Maximum Ratings* may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under *Recommended Operating Conditions* is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- (2) Maximum-rated conditions for extended periods may affect device reliability. All voltage values are with respect to their associated grounds.

### 6.2 ESD Ratings

|           |                                            |                                                          | MIN   | MAX | UNIT |
|-----------|--------------------------------------------|----------------------------------------------------------|-------|-----|------|
| $V_{ESD}$ | Electrostatic discharge (ESD) performance: | Human Body Model (HBM), per AEC Q100-002D <sup>(1)</sup> | – 2   | 2   | kV   |
|           |                                            | Charged Device Model (CDM), per AEC Q100-011             | – 500 | 500 | V    |
|           |                                            |                                                          |       |     |      |
|           |                                            | Corner balls                                             | – 750 | 750 | V    |

- (1) AEC Q100-002D indicates HBM stressing is done in accordance with the ANSI/ESDA/JEDEC JS-001-2011 specification.

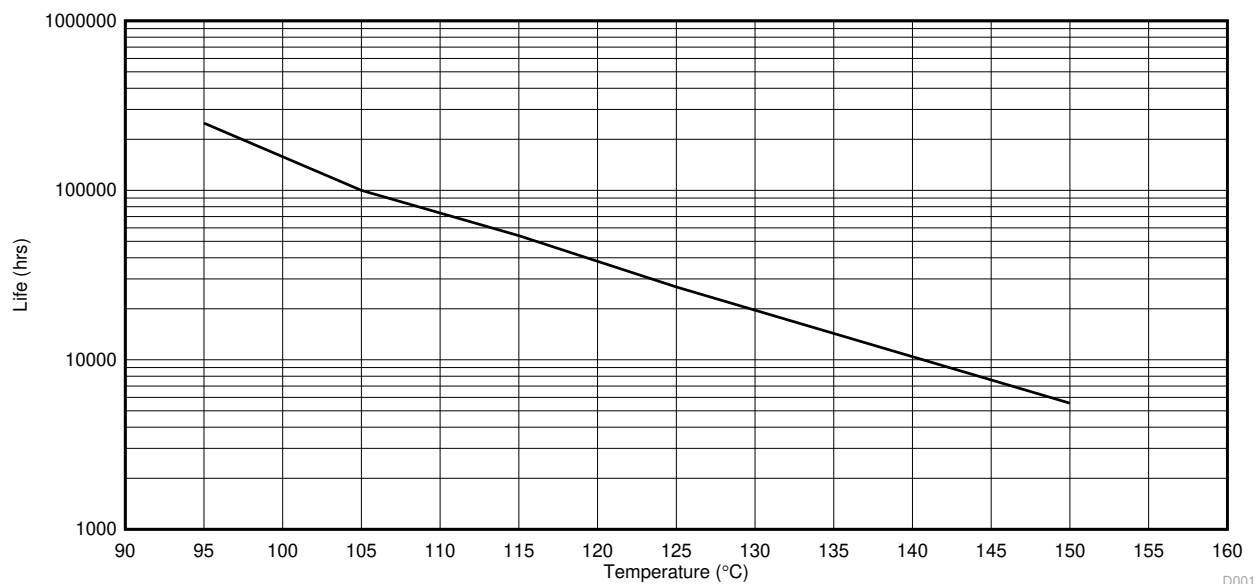
### 6.3 Power-On Hours (POH)

POH is a function of voltage and temperature. Usage at higher voltages and temperatures will result in a reduction in POH to achieve the same reliability performance. The POH information in 表 6-1 is provided solely for convenience and does not extend or modify the warranty provided under TI' s standard terms and conditions for TI Semiconductor Products. To avoid significant device degradation, the device POH must be limited to those listed in 表 6-1. To convert to equivalent POH for a specific temperature profile, see the *Calculating Equivalent Power-on-Hours for Hercules Safety MCUs Application Report (SPNA207)*.

表 6-1. Power-On Hours Limits

| NOMINAL $V_{CC}$ VOLTAGE (V) | JUNCTION TEMPERATURE ( $T_J$ ) | LIFETIME POH <sup>(1)</sup> |
|------------------------------|--------------------------------|-----------------------------|
| 1.2 V                        | 105°C                          | 100k                        |
|                              | 125°C                          | 25k                         |

- (1) POH represents device operation under the specified nominal conditions continuously for the duration of the calculated lifetime.



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- A. Silicon operating life design goal is 100,000 power-on hours (POH) at 105°C junction temperature (does not include package interconnect life).
- B. The predicted operating lifetime versus junction temperature is based on reliability modeling using electromigration as the dominant failure mechanism affecting device wearout for the specific device process and design characteristics.

**图 6-1. TMS570LC4357-SEP Operating Life Derating Chart**

## 6.4 Recommended Operating Conditions

| (1)                  |                                                          | MIN               | NOM | MAX               | UNIT |
|----------------------|----------------------------------------------------------|-------------------|-----|-------------------|------|
| V <sub>CC</sub>      | Digital logic supply voltage (Core)                      | 1.14              | 1.2 | 1.32              | V    |
| V <sub>CCPLL</sub>   | PLL supply voltage                                       | 1.14              | 1.2 | 1.32              | V    |
| V <sub>CCIO</sub>    | Digital logic supply voltage (I/O)                       | 3                 | 3.3 | 3.6               | V    |
| V <sub>CCAD</sub>    | MibADC supply voltage                                    | 3                 |     | 5.25              | V    |
| V <sub>CCP</sub>     | Flash pump supply voltage                                | 3                 | 3.3 | 3.6               | V    |
| V <sub>SS</sub>      | Digital logic supply ground                              |                   | 0   |                   | V    |
| V <sub>SSAD</sub>    | MibADC supply ground                                     | – 0.1             |     | 0.1               | V    |
| V <sub>ADREFHI</sub> | Analog-to-Digital (A-to-D) high-voltage reference source | V <sub>SSAD</sub> |     | V <sub>CCAD</sub> | V    |
| V <sub>ADREFLO</sub> | A-to-D low-voltage reference source                      | V <sub>SSAD</sub> |     | V <sub>CCAD</sub> | V    |
| T <sub>A</sub>       | Operating free-air temperature                           | – 55              |     | 125               | °C   |
| T <sub>J</sub>       | Operating junction temperature                           | – 55              |     | 150               | °C   |

(1) All voltages are with respect to V<sub>SS</sub>, except V<sub>CCAD</sub>, which is with respect to V<sub>SSAD</sub>.

## 6.5 Switching Characteristics Over Recommended Operating Conditions for Clock Domains

**表 6-2. Clock Domain Timing Specifications**

| PARAMETER        |                                                            | TEST CONDITIONS | MIN | MAX        | UNIT |
|------------------|------------------------------------------------------------|-----------------|-----|------------|------|
| $f_{OSC}$        | OSC - oscillator clock frequency using an external crystal |                 | 5   | 20         | MHz  |
| $f_{GCLK1}$      | GCLK - R5F CPU clock frequency                             |                 |     | 300        | MHz  |
| $f_{GCLK2}$      | GCLK - R5F CPU clock frequency                             |                 |     | 300        | MHz  |
| $f_{HCLK}$       | HCLK - System clock frequency                              |                 |     | 150        | MHz  |
| $f_{VCLK}$       | VCLK - Primary peripheral clock frequency                  |                 |     | 110        | MHz  |
| $f_{VCLK2}$      | VCLK2 - Secondary peripheral clock frequency               |                 |     | 110        | MHz  |
| $f_{VCLK3}$      | VCLK3 - Secondary peripheral clock frequency               |                 |     | 150        | MHz  |
| $f_{VCLKA1}$     | VCLKA1 - Primary asynchronous peripheral clock frequency   |                 |     | 110        | MHz  |
| $f_{VCLKA2}$     | VCLKA2 - Secondary asynchronous peripheral clock frequency |                 |     | 110        | MHz  |
| $f_{VCLKA4}$     | VCLKA4 - Secondary asynchronous peripheral clock frequency |                 |     | 110        | MHz  |
| $f_{RTICK1}$     | RTICK1 - clock frequency                                   |                 |     | $f_{VCLK}$ | MHz  |
| $f_{PROG/ERASE}$ | System clock frequency - flash programming/erase           |                 |     | $f_{HCLK}$ | MHz  |
| $f_{ECLK1}$      | External Clock 1                                           |                 |     | 110        | MHz  |
| $f_{ECLK2}$      | External Clock 2                                           |                 |     | 110        | MHz  |
| $f_{ETMCLKOUT}$  | ETM trace clock output                                     |                 |     | 55         | MHz  |
| $f_{ETMCLKIN}$   | ETM trace clock input                                      |                 |     | 110        | MHz  |
| $f_{EXTCLKIN1}$  | External input clock 1                                     |                 |     | 110        | MHz  |
| $f_{EXTCLKIN2}$  | External input clock 2                                     |                 |     | 110        | MHz  |

表 6-2 lists the maximum frequency of the CPU (GLKx), the level-2 memory (HCLK) and the peripheral clocks (VCLKx). It is not always possible to run each clock at its maximum frequency as GCLK must be an integral multiple of HCLK and HCLK must be an integral multiple of VCLKx. Depending on the system, the optimum performance may be obtained by maximizing either the CPU frequency, the level-two RAM interface, the level-two flash interface, or the peripherals.

### 6.6 Wait States Required - L2 Memories

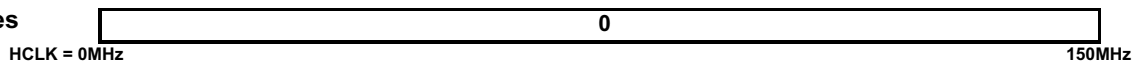
Wait states are cycles the CPU must wait in order to retrieve data from the memories which have access times longer than a CPU clock. Memory wrapper, SCR interconnect and the CPU itself may introduce additional cycles of latency due to logic pipelining and synchronization. Therefore, the total latency cycles as seen by the CPU can be more than the number of wait states to cover the memory access time.

图 6-2 shows only the number of programmable wait states needed for L2 flash memory at different frequencies. The number of wait states is correlated to HCLK frequency. The clock ratio between CPU clock (GCLKx) and HCLK can vary. Therefore, the total number of wait states in terms of GCLKx can be obtained by taking the programmed wait states multiplied by the clock ratio.

There is no user programmable wait state for L2 SRAM access. L2 SRAM is clocked by HCLK and is limited to maximum 150 MHz.

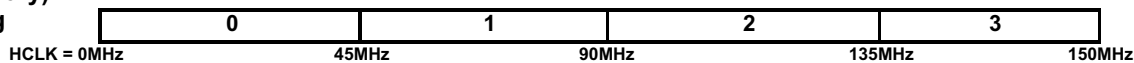
## RAM

## Data Waitstates



## Flash (Main Memory)

## RWAIT Setting



## EEPROM Flash (BUS2)

## EWAIT Setting

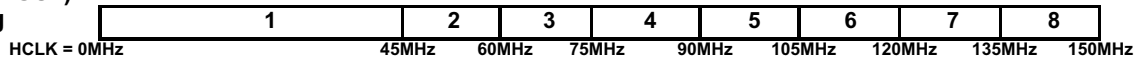


图 6-2. Wait States Scheme

L2 flash is clocked by HCLK and is limited to maximum 150 MHz. The L2 flash can support zero data wait state up to 45 MHz.

## 6.7 Power Consumption Summary

Over Recommended Operating Conditions

| PARAMETER             |                                                                            | TEST CONDITIONS                                                                                                                                             | MIN | TYP <sup>(3)</sup> | MAX                     | UNIT |
|-----------------------|----------------------------------------------------------------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------|-----|--------------------|-------------------------|------|
| I <sub>CC</sub>       | V <sub>CC</sub> digital supply and PLL current (operating mode)            | f <sub>GCLK</sub> = 300 MHz,<br>f <sub>HCLK</sub> = 150 MHz,<br>f <sub>VCLK</sub> = 75 MHz,<br>f <sub>VCLK2</sub> = 75 MHz,<br>f <sub>VCLK3</sub> = 150 MHz |     | 510                | 990 <sup>(1)</sup>      | mA   |
|                       | V <sub>CC</sub> digital supply and PLL current (LBIST mode, or PBIST mode) | LBIST clock rate = 75 MHz<br>PBIST ROM clock frequency = 75 MHz                                                                                             |     | 880                | 1375 <sup>(2) (4)</sup> | mA   |
| I <sub>CCIO</sub>     | V <sub>CCIO</sub> digital supply current (operating mode)                  | No DC load, V <sub>CCmax</sub>                                                                                                                              |     |                    | 15                      | mA   |
| I <sub>CCAD</sub>     | V <sub>CCAD</sub> supply current (operating mode)                          | Single ADC operational, V <sub>CCADmax</sub>                                                                                                                |     |                    | 15                      | mA   |
|                       |                                                                            | Single ADC power down, V <sub>CCADmax</sub>                                                                                                                 |     |                    | 5                       | μA   |
|                       |                                                                            | Both ADCs operational, V <sub>CCADmax</sub>                                                                                                                 |     |                    | 30                      | mA   |
| I <sub>CCREF HI</sub> | AD <sub>REFHI</sub> supply current (operating mode)                        | Single ADC operational, AD <sub>REFHI</sub> max                                                                                                             |     |                    | 5                       | mA   |
|                       |                                                                            | Both ADCs operational, AD <sub>REFHI</sub> max                                                                                                              |     |                    | 10                      | mA   |
| I <sub>CCP</sub>      | V <sub>CCP</sub> pump supply current                                       | Read operation of two banks in parallel, V <sub>CCPmax</sub>                                                                                                |     |                    | 70                      | mA   |
|                       |                                                                            | Read from two banks and program or erase another bank, V <sub>CCPmax</sub>                                                                                  |     |                    | 93                      | mA   |

- (1) The maximum I<sub>CC</sub> value can be derated
  - linearly with voltage
  - by 1.8 mA/MHz for lower GCLK frequency when f<sub>GCLK</sub> = 2 \* f<sub>HCLK</sub> = 4 \* f<sub>VCLK</sub>
  - for lower junction temperature by the equation below where T<sub>JK</sub> is the junction temperature in Kelvin and the result is in milliamperes.  

$$405 - 0.2 e^{0.018 T_{JK}}$$
- (2) The maximum I<sub>CC</sub> value can be derated
  - linearly with voltage
  - by 3.2 mA/MHz for lower GCLK frequency
  - for lower junction temperature by the equation below where T<sub>JK</sub> is the junction temperature in Kelvin and the result is in milliamperes.  

$$405 - 0.2 e^{0.018 T_{JK}}$$
- (3) The typical value is the average current for the nominal process corner and junction temperature of 25°C.
- (4) LBIST and PBIST currents are for a short duration, typically less than 10 ms. They are usually ignored for thermal calculations for the device and the voltage regulator.

## 6.8 Input/Output Electrical Characteristics Over Recommended Operating Conditions

| PARAMETER <sup>(1)</sup>                       |                                                     | TEST CONDITIONS                                                                  | MIN                     | TYP                     | MAX                     | UNIT          |
|------------------------------------------------|-----------------------------------------------------|----------------------------------------------------------------------------------|-------------------------|-------------------------|-------------------------|---------------|
| $V_{\text{hys}}$ Input hysteresis              | All inputs (except FRAYRX1, FRAYRX2)                |                                                                                  | 180                     |                         |                         | mV            |
|                                                | FRAYRX1, FRAYRX2                                    |                                                                                  | 100                     |                         |                         | mV            |
| $V_{\text{IL}}$ Low-level input voltage        | All inputs <sup>(2)</sup> (except FRAYRX1, FRAYRX2) |                                                                                  | - 0.3                   |                         | 0.8                     | V             |
|                                                | FRAYRX1, FRAYRX2                                    |                                                                                  |                         | $0.4 * V_{\text{CCIO}}$ |                         | V             |
| $V_{\text{IH}}$ High-level input voltage       | All inputs <sup>(2)</sup> (except FRAYRX1, FRAYRX2) |                                                                                  | 2                       | $V_{\text{CCIO}} + 0.3$ |                         | V             |
|                                                | FRAYRX1, FRAYRX2                                    |                                                                                  | $0.6 * V_{\text{CCIO}}$ |                         |                         | V             |
| $V_{\text{OL}}$ Low-level output voltage       |                                                     | $I_{\text{OL}} = I_{\text{OLmax}}$                                               |                         |                         | $0.2 * V_{\text{CCIO}}$ | V             |
|                                                |                                                     | $I_{\text{OL}} = 50 \mu\text{A}$ , standard output mode                          |                         |                         | 0.2                     |               |
| $V_{\text{OH}}$ High-level output voltage      |                                                     | $I_{\text{OH}} = I_{\text{OHmax}}$                                               |                         | $0.8 * V_{\text{CCIO}}$ |                         | V             |
|                                                |                                                     | $I_{\text{OH}} = 50 \mu\text{A}$ , standard output mode                          | $V_{\text{CCIO}} - 0.3$ |                         |                         |               |
| $I_{\text{IC}}$ Input clamp current (I/O pins) |                                                     | $V_{\text{I}} < V_{\text{SSIO}} - 0.3$ or $V_{\text{I}} > V_{\text{CCIO}} + 0.3$ | - 3.5                   |                         | 3.5                     | mA            |
| $I_{\text{I}}$ Input current (I/O pins)        | $I_{\text{IH}}$ Pulldown 20 $\mu\text{A}$           | $V_{\text{I}} = V_{\text{CCIO}}$                                                 | 5                       |                         | 40                      | $\mu\text{A}$ |
|                                                | $I_{\text{IH}}$ Pulldown 100 $\mu\text{A}$          | $V_{\text{I}} = V_{\text{CCIO}}$                                                 | 40                      |                         | 195                     |               |
|                                                | $I_{\text{IL}}$ Pullup 20 $\mu\text{A}$             | $V_{\text{I}} = V_{\text{SS}}$                                                   | - 40                    |                         | - 5                     |               |
|                                                | $I_{\text{IL}}$ Pullup 100 $\mu\text{A}$            | $V_{\text{I}} = V_{\text{SS}}$                                                   | - 195                   |                         | - 40                    |               |
|                                                | All other pins                                      | No pullup or pulldown                                                            | - 1                     |                         | 1                       |               |
| $I_{\text{OL}}$ Low-level output current       | Pins with output buffers of 8 mA drive strength     | $V_{\text{OLmax}}$                                                               |                         |                         | 8                       | mA            |
|                                                | Pins with output buffers of 4 mA drive strength     |                                                                                  |                         |                         | 4                       |               |
|                                                | Pins with output buffers of 2 mA drive strength     |                                                                                  |                         |                         | 2                       |               |
| $I_{\text{OH}}$ High-level output current      | Pins with output buffers of 8 mA drive strength     | $V_{\text{OLmin}}$                                                               | - 8                     |                         |                         | mA            |
|                                                | Pins with output buffers of 4 mA drive strength     |                                                                                  | - 4                     |                         |                         |               |
|                                                | Pins with output buffers of 2 mA drive strength     |                                                                                  | - 2                     |                         |                         |               |
| $C_{\text{I}}$ Input capacitance               |                                                     |                                                                                  |                         |                         | 2                       | pF            |
| $C_{\text{O}}$ Output capacitance              |                                                     |                                                                                  |                         |                         | 3                       | pF            |

(1) Source currents (out of the device) are negative while sink currents (into the device) are positive.

(2) This does not apply to the nPORRST pin.

## 6.9 Thermal Resistance Characteristics for the BGA Package (GWT)

Over operating free-air temperature range (unless otherwise noted) <sup>(1)</sup>

|                                                                                                                                                 | °C / W |
|-------------------------------------------------------------------------------------------------------------------------------------------------|--------|
| $R_{\theta JA}$ Junction-to-free air thermal resistance, still air (includes 5×5 thermal via cluster in 2s2p PCB connected to 1st ground plane) | 14.3   |
| $R_{\theta JB}$ Junction-to-board thermal resistance (includes 5×5 thermal via cluster in 2s2p PCB connected to 1st ground plane)               | 5.49   |
| $R_{\theta JC}$ Junction-to-case thermal resistance (2s0p PCB)                                                                                  | 5.02   |
| $\Psi_{JT}$ Junction-to-package top, still air (includes 5×5 thermal via cluster in 2s2p PCB connected to 1st ground plane)                     | 0.29   |
| $\Psi_{JB}$ Junction-to-board, still air (includes 5×5 thermal via cluster in 2s2p PCB connected to 1st ground plane)                           | 6.41   |

(1) For more information about traditional and new thermal metrics, see the *Semiconductor and IC Package Thermal Metrics* application report [SPRA953](#).

## 6.10 Timing and Switching Characteristics

### 6.10.1 Output Buffer Drive Strengths

表 6-3. Output Buffer Drive Strengths

| Low-level Output Current,<br>$I_{OL}$ for $V_I=V_{OLmax}$<br>or<br>High-level Output Current,<br>$I_{OH}$ for $V_I=V_{OHmin}$ | SIGNALS                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                 |
|-------------------------------------------------------------------------------------------------------------------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 8 mA                                                                                                                          | FRAYTX2, FRAYTX1, FRAYTXEN1, FRAYTXEN2,<br>MIBSPI5CLK, MIBSPI5SOMI[0], MIBSPI5SOMI[1], MIBSPI5SOMI[2], MIBSPI5SOMI[3],<br>MIBSPI5SIMO[0], MIBSPI5SIMO[1], MIBSPI5SIMO[2], MIBSPI5SIMO[3],<br>TMS, TDI, TDO, RTCK,<br>SPI4CLK, SPI4SIMO, SPI4SOMI, nERROR,<br>N2HET2[1], N2HET2[3], N2HET2[5], N2HET2[7], N2HET2[9], N2HET2[11], N2HET2[13],<br>N2HET2[15]<br>ECAP1, ECAP4, ECAP5, ECAP6<br>EQEP1I, EQEP1S, EQEP2I, EQEP2S<br>ePWM1A, ePWM1B, ePWM1SYNCO, ePWM2A, ePWM2B, ePWM3A, ePWM3B, ePWM4A,<br>ePWM4B, ePWM5A, ePWM5B, ePWM6A, ePWM6B, ePWM7A, ePWM7B<br>All EMIF Outputs and I/Os |
| 4 mA                                                                                                                          | TEST,<br>MIBSPI3SOMI, MIBSPI3SIMO, MIBSPI3CLK, MIBSPI1SIMO, MIBSPI1SOMI, MIBSPI1CLK,<br>ECAP2, ECAP3<br>nRST                                                                                                                                                                                                                                                                                                                                                                                                                                                                            |
| 2 mA zero-dominant                                                                                                            | AD1EVT,<br>CAN1RX, CAN1TX, CAN2RX, CAN2TX, CAN3RX, CAN3TX,<br>GIOA[0-7], GIOB[0-7],<br>LINRX, LINTX,<br>MIBSPI1NCS[0], MIBSPI1NCS[1-3], MIBSPI1NENA, MIBSPI3NCS[0-3], MIBSPI3NENA,<br>MIBSPI5NCS[0-3], MIBSPI5NENA,<br>N2HET1[0-31], N2HET2[0], N2HET2[2], N2HET2[4], N2HET2[5], N2HET2[6], N2HET2[7],<br>N2HET2[8], N2HET2[9], N2HET2[10], N2HET2[11], N2HET2[12], N2HET2[13], N2HET2[14],<br>N2HET2[15], N2HET2[16], N2HET2[18],<br>SPI2NCS[0], SPI2NENA, SPI4NCS[0], SPI4NENA                                                                                                        |
| selectable 8 mA / 2 mA                                                                                                        | ECLK,<br>SPI2CLK, SPI2SIMO, SPI2SOMI<br>The default output buffer drive strength is 8mA for these signals.                                                                                                                                                                                                                                                                                                                                                                                                                                                                              |

## 6.10.2 Input Timings

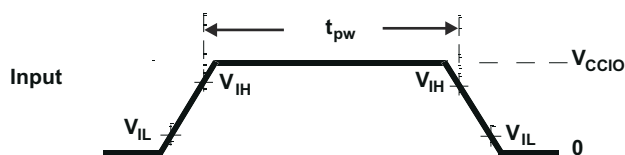


图 6-3. TTL-Level Inputs

表 6-4. Timing Requirements for Inputs

|                                                                                                   | MIN                               | MAX | UNIT |
|---------------------------------------------------------------------------------------------------|-----------------------------------|-----|------|
| $t_{pw}$ Input minimum pulse width                                                                | $t_{c(VCLK)} + 10^{(1)}$<br>$(2)$ |     | ns   |
| $t_{in\_slew}$ Time for input signal to go from $V_{IL}$ to $V_{IH}$ or from $V_{IH}$ to $V_{IL}$ |                                   | 1   | ns   |

(1)  $t_{c(VCLK)}$  = peripheral VBUS clock cycle time =  $1 / f_{(VCLK)}$

(2) The timing shown above is only valid for pin used in general-purpose input mode.

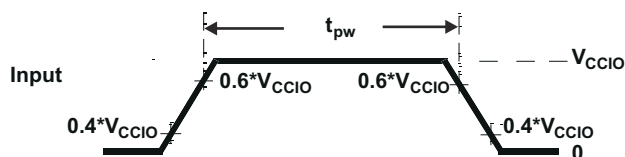


图 6-4. FlexRay Inputs

表 6-5. Timing Requirements for FlexRay Inputs

|                                                                             | MIN                         | MAX | UNIT |
|-----------------------------------------------------------------------------|-----------------------------|-----|------|
| $t_{pw}$ Input minimum pulse width to meet the FlexRay sampling requirement | $t_{c(VCLKA2)} + 2.5^{(1)}$ |     | ns   |

(1)  $t_{c(VCLKA2)}$  = sample clock cycle time for FlexRay =  $1 / f_{(VCLKA2)}$

### 6.10.3 Output Timings

**表 6-6. Switching Characteristics for Output Timings versus Load Capacitance (CL)**

| PARAMETER                 |                             |             | MIN         | MAX  | UNIT |
|---------------------------|-----------------------------|-------------|-------------|------|------|
| Rise time, t <sub>r</sub> | 8 mA low EMI pins           | CL = 15 pF  | 2.5         | ns   |      |
|                           |                             | CL = 50 pF  | 4           |      |      |
|                           |                             | CL = 100 pF | 7.2         |      |      |
|                           |                             | CL = 150 pF | 12.5        |      |      |
| Fall time, t <sub>f</sub> |                             | CL = 15 pF  | 2.5         | ns   |      |
|                           |                             | CL = 50 pF  | 4           |      |      |
|                           |                             | CL = 100 pF | 7.2         |      |      |
|                           |                             | CL = 150 pF | 12.5        |      |      |
| Rise time, t <sub>r</sub> | 4 mA low EMI pins           | CL = 15 pF  | 5.6         | ns   |      |
|                           |                             | CL = 50 pF  | 10.4        |      |      |
|                           |                             | CL = 100 pF | 16.8        |      |      |
|                           |                             | CL = 150 pF | 23.2        |      |      |
| Fall time, t <sub>f</sub> |                             | CL = 15 pF  | 5.6         | ns   |      |
|                           |                             | CL= 50 pF   | 10.4        |      |      |
|                           |                             | CL = 100 pF | 16.8        |      |      |
|                           |                             | CL = 150 pF | 23.2        |      |      |
| Rise time, t <sub>r</sub> | 2 mA-z low EMI pins         | CL = 15 pF  | 8           | ns   |      |
|                           |                             | CL = 50 pF  | 15          |      |      |
|                           |                             | CL = 100 pF | 23          |      |      |
|                           |                             | CL = 150 pF | 33          |      |      |
| Fall time, t <sub>f</sub> |                             | CL = 15 pF  | 8           | ns   |      |
|                           |                             | CL = 50 pF  | 15          |      |      |
|                           |                             | CL = 100 pF | 23          |      |      |
|                           |                             | CL = 150 pF | 33          |      |      |
| Rise time, t <sub>r</sub> | Selectable 8mA / 2mA-z pins | 8 mA mode   | CL = 15 pF  | 2.5  | ns   |
|                           |                             |             | CL = 50 pF  | 4    |      |
|                           |                             |             | CL = 100 pF | 7.2  |      |
|                           |                             |             | CL = 150 pF | 12.5 |      |
| Fall time, t <sub>f</sub> |                             | CL = 15 pF  | 2.5         | ns   |      |
|                           |                             | CL = 50 pF  | 4           |      |      |
|                           |                             | CL = 100 pF | 7.2         |      |      |
|                           |                             | CL = 150 pF | 12.5        |      |      |
| Rise time, t <sub>r</sub> |                             | 2 mA-z mode | CL = 15 pF  | 8    | ns   |
|                           |                             |             | CL = 50 pF  | 15   |      |
|                           |                             |             | CL = 100 pF | 23   |      |
|                           |                             |             | CL = 150 pF | 33   |      |
| Fall time, t <sub>f</sub> |                             |             | CL = 15 pF  | 8    | ns   |
|                           |                             |             | CL = 50 pF  | 15   |      |
|                           |                             |             | CL = 100 pF | 23   |      |
|                           |                             |             | CL = 150 pF | 33   |      |

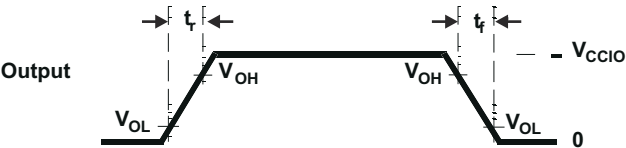


图 6-5. CMOS-Level Outputs

表 6-7. Timing Requirements for Outputs

| (1)                           |                                                                                                                                                                                                                            | MIN | MAX | UNIT |
|-------------------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-----|-----|------|
| $t_{d(\text{parallel\_out})}$ | Delay between low to high, or high to low transition of general-purpose output signals that can be configured by an application in parallel, for example, all signals in a GIOA port, or all N2HET1 signals, and so forth. |     | 6   | ns   |

- (1) This specification does not account for any output buffer drive strength differences or any external capacitive loading differences. Check 表 6-3 for output buffer drive strength information on each signal.

## 7 System Information and Electrical Specifications

### 7.1 Device Power Domains

The device core logic is split up into multiple virtual power domains to optimize the power for a given application use case.

This device has six logic power domains : PD1, PD2, PD3, PD4, PD5, and PD6. PD1 is a domain which cannot turn off of its clocks at once through the Power-Management Module (PMM). However, individual clock domain operating in PD1 can be individually enabled or disabled through the SYS.CDDIS register. Each of the other power domains can be turned ON, IDLE or OFF as per the application requirement through the PMM module.

In this device, a power domain can operate in one of the three possible power states: ON, IDLE and OFF. ON state is the normal operating state where clocks are actively running in the power domain. When clocks are turned off, the dynamic current is removed from the power domain. In this device, both the IDLE and OFF states have the same power characteristic. When put into either the IDLE or the OFF state, only clocks are turned off from the power domain. Leakage current from the power domain still remains. Note that putting a power domain in the OFF state will not remove any leakage current in this device. In changing the power domain states, the user must poll the system status register to check the completion of the transition. From a programmer model perspective, all three power states are available from the PMM module.

The actual management of the power domains and the hand-shaking mechanism is managed by the PMM. Refer to the Power Management Module (PMM) chapter of the device technical reference manual for more details.

## 7.2 Voltage Monitor Characteristics

A voltage monitor is implemented on this device. The purpose of this voltage monitor is to eliminate the requirement for a specific sequence when powering up the core and I/O voltage supplies.

### 7.2.1 Important Considerations

- The voltage monitor does not eliminate the need of a voltage supervisor circuit to ensure that the device is held in reset when the voltage supplies are out of range.
- The voltage monitor only monitors the core supply (VCC) and the I/O supply (VCCIO). The other supplies are not monitored by the VMON. For example, if the VCCAD or VCCP are supplied from a source different from that for VCCIO, then there is no internal voltage monitor for the VCCAD and VCCP supplies.

### 7.2.2 Voltage Monitor Operation

The voltage monitor generates the Power Good MCU signal (PGMCU) as well as the I/Os Power Good IO signal (PGIO) on the device. During power-up or power-down, the PGMCU and PGIO are driven low when the core or I/O supplies are lower than the specified minimum monitoring thresholds. The PGIO and PGMCU being low isolates the core logic as well as the I/O controls during power up or power down of the supplies. This allows the core and I/O supplies to be powered up or down in any order.

When the voltage monitor detects a low voltage on the I/O supply, it will assert a power-on reset. When the voltage monitor detects an out-of-range voltage on the core supply, it asynchronously makes all output pins high impedance, and asserts a power-on reset. The I/O supply must be above the threshold for monitoring the core supply. The voltage monitor is disabled when the device enters a low power mode.

The VMON also incorporates a glitch filter for the nPORRST input. Refer to [节 7.3.3.1](#) for the timing information on this glitch filter.

**表 7-1. Voltage Monitoring Specifications**

| PARAMETER        |                               |                                                                      | MIN  | TYP | MAX  | UNIT |
|------------------|-------------------------------|----------------------------------------------------------------------|------|-----|------|------|
| V <sub>MON</sub> | Voltage monitoring thresholds | VCC low - VCC level below this threshold is detected as too low.     | 0.75 | 0.9 | 1.13 | V    |
|                  |                               | VCC high - VCC level above this threshold is detected as too high.   | 1.40 | 1.7 | 2.1  |      |
|                  |                               | VCCIO low - VCCIO level below this threshold is detected as too low. | 1.85 | 2.4 | 2.99 |      |

### 7.2.3 Supply Filtering

The VMON has the capability to filter glitches on the VCC and VCCIO supplies.

[表 7-2](#) lists the characteristics of the supply filtering. Glitches in the supply larger than the maximum specification cannot be filtered.

**表 7-2. VMON Supply Glitch Filtering Capability**

| PARAMETER                                     | MIN | MAX  | UNIT |
|-----------------------------------------------|-----|------|------|
| Width of glitch on VCC that can be filtered   | 250 | 1000 | ns   |
| Width of glitch on VCCIO that can be filtered | 250 | 1000 | ns   |

## 7.3 Power Sequencing and Power-On Reset

### 7.3.1 Power-Up Sequence

There is no timing dependency between the ramp of the VCCIO and the VCC supply voltage. The power-up sequence starts with the I/O voltage rising above the minimum I/O supply threshold, (for more details, see [表 7-3](#)), core voltage rising above the minimum core supply threshold and the release of power-on reset. The high-frequency oscillator will start up first and its amplitude will grow to an acceptable level. The oscillator start-up time is dependent on the type of oscillator and is provided by the oscillator vendor. The different supplies to the device can be powered up in any order.

The device goes through the following sequential phases during power up.

**表 7-3. Power-Up Phases**

|                                        |                               |
|----------------------------------------|-------------------------------|
| Oscillator start-up and validity check | 1024 oscillator cycles        |
| eFuse autoload                         | 3650 oscillator cycles        |
| Flash pump power-up                    | 250 oscillator cycles         |
| Flash bank power-up                    | 1460 oscillator cycles        |
| <b>Total</b>                           | <b>6384 oscillator cycles</b> |

The CPU reset is released at the end of the above sequence and fetches the first instruction from address 0x00000000.

### 7.3.2 Power-Down Sequence

The different supplies to the device can be powered down in any order.

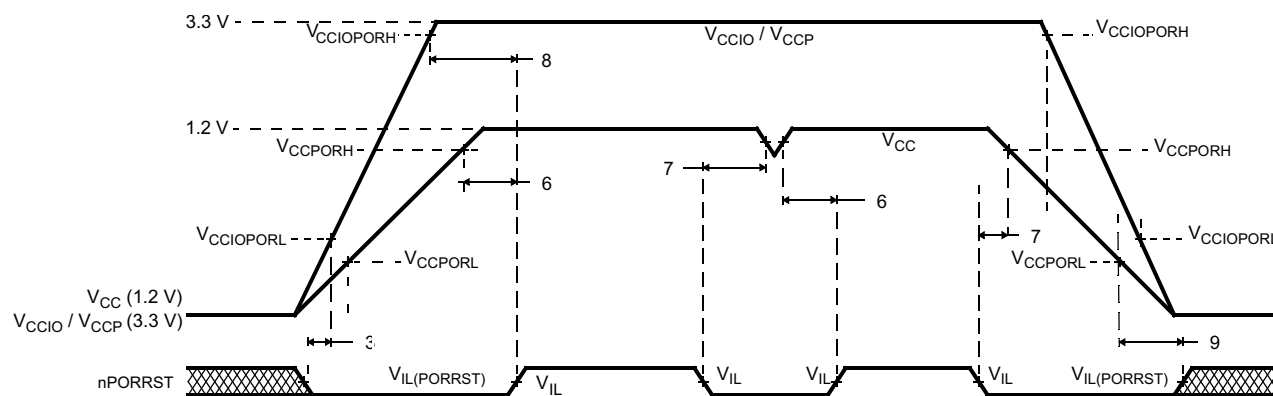
### 7.3.3 Power-On Reset: nPORRST

This is the power-on reset. This reset must be asserted by an external circuitry whenever the I/O or core supplies are outside the specified recommended range. This signal has a glitch filter on it. It also has an internal pulldown.

#### 7.3.3.1 nPORRST Electrical and Timing Requirements

表 7-4. Electrical Requirements for nPORRST

| NO. |                  | MIN                                                                                                                                                                                                | MAX  | UNIT             |
|-----|------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|------|------------------|
|     | $V_{CCPORL}$     | $V_{CC}$ low supply level when nPORRST must be active during power up                                                                                                                              |      | 0.5 V            |
|     | $V_{CCPORH}$     | $V_{CC}$ high supply level when nPORRST must remain active during power up and become active during power down                                                                                     |      | 1.14 V           |
|     | $V_{CCIOPORL}$   | $V_{CCIO} / V_{CCP}$ low supply level when nPORRST must be active during power up                                                                                                                  |      | 1.1 V            |
|     | $V_{CCIOPORH}$   | $V_{CCIO} / V_{CCP}$ high supply level when nPORRST must remain active during power up and become active during power down                                                                         |      | 3.0 V            |
|     | $V_{IL(PORRST)}$ | Low-level input voltage of nPORRST $V_{CCIO} > 2.5$ V                                                                                                                                              |      | $0.2 * V_{CCIO}$ |
|     |                  | Low-level input voltage of nPORRST $V_{CCIO} < 2.5$ V                                                                                                                                              |      | 0.5 V            |
| 3   | $t_{su(PORRST)}$ | Setup time, nPORRST active before $V_{CCIO}$ and $V_{CCP} > V_{CCIOPORL}$ during power up                                                                                                          |      | 0 ms             |
| 6   | $t_h(PORRST)$    | Hold time, nPORRST active after $V_{CC} > V_{CCPORH}$                                                                                                                                              |      | 1 ms             |
| 7   | $t_{su(PORRST)}$ | Setup time, nPORRST active before $V_{CC} < V_{CCPORH}$ during power down                                                                                                                          |      | 2 $\mu$ s        |
| 8   | $t_h(PORRST)$    | Hold time, nPORRST active after $V_{CCIO}$ and $V_{CCP} > V_{CCIOPORH}$                                                                                                                            |      | 1 ms             |
| 9   | $t_h(PORRST)$    | Hold time, nPORRST active after $V_{CC} < V_{CCPORL}$                                                                                                                                              |      | 0 ms             |
|     | $t_f(nPORRST)$   | Filter time nPORRST terminal; pulses less than MIN will be filtered out, pulses greater than MAX will generate a reset. Pulses greater than MIN but less than MAX may or may not generate a reset. |      | 475 ns           |
|     |                  |                                                                                                                                                                                                    | 2000 | ns               |



A. 图 7-1 显示了  $V_{CCIO}$  和  $V_{CC}$  电源电压的斜坡之间没有时间依赖性。

图 7-1. nPORRST Timing Diagram<sup>(A)</sup>

## 7.4 Warm Reset (nRST)

This is a bidirectional reset signal. The internal circuitry drives the signal low on detecting any device reset condition. An external circuit can assert a device reset by forcing the signal low. On this terminal, the output buffer is implemented as an open drain (drives low only). To ensure an external reset is not arbitrarily generated, TI recommends that an external pullup resistor is connected to this terminal.

This terminal has a glitch filter. It also has an internal pullup

### 7.4.1 Causes of Warm Reset

表 7-5. Causes of Warm Reset

| DEVICE EVENT                      | SYSTEM STATUS FLAG                   |
|-----------------------------------|--------------------------------------|
| Power-Up Reset                    | Exception Status Register, bit 15    |
| Oscillator fail                   | Global Status Register, bit 0        |
| PLL slip                          | Global Status Register, bits 8 and 9 |
| Watchdog exception                | Exception Status Register, bit 13    |
| Debugger reset                    | Exception Status Register, bit 11    |
| CPU Reset (driven by the CPU STC) | Exception Status Register, bit 5     |
| Software Reset                    | Exception Status Register, bit 4     |
| External Reset                    | Exception Status Register, bit 3     |

### 7.4.2 nRST Timing Requirements

表 7-6. nRST Timing Requirements

| (1)           |                                                                                                                     | MIN               | MAX  | UNIT |
|---------------|---------------------------------------------------------------------------------------------------------------------|-------------------|------|------|
| $t_{V(RST)}$  | Valid time, nRST active after nPORRST inactive                                                                      | 5032 $t_{c(OSC)}$ |      | ns   |
|               | Valid time, nRST active (all other System reset conditions)                                                         | 32 $t_{c(VCLK)}$  |      |      |
| $t_{f(nRST)}$ | Filter time nRST terminal; pulses less than MIN will be filtered out, pulses greater than MAX will generate a reset | 475               | 2000 | ns   |

(1) Specified values **do not** include rise/fall times. For rise and fall timings, see 表 6-6.

## 7.5 Arm Cortex-R5F CPU Information

### 7.5.1 Summary of Arm Cortex-R5F CPU Features

The features of the Arm Cortex-R5F CPU include:

- An integer unit with integral Embedded ICE-RT logic.
- High-speed Advanced Microprocessor Bus Architecture (AMBA) Advanced eXtensible Interfaces (AXI) for Level two (L2) master and slave interfaces.
- Floating-Point Coprocessor
- Dynamic branch prediction with a global history buffer, and a 4-entry return stack
- Low interrupt latency.
- Nonmaskable interrupt.
- Harvard Level one (L1) memory system with:
  - 32KB of instruction cache and 32KB of data cache implemented . Both Instruction and data cache have ECC support.
  - ARMv7-R architecture Memory Protection Unit (MPU) with 16 regions
- Dual core logic for fault detection in safety-critical applications.
- L2 memory interface:
  - Single 64-bit master AXI interface
  - 64-bit slave AXI interface to cache memories
  - 32-bit AXI\_Per ports to support low latency peripheral ports
- Debug interface to a CoreSight Debug Access Port (DAP).
- Performance Monitoring Unit (PMU).
- Vectored Interrupt Controller (VIC) port.
- AXI accelerator coherency port (ACP) supporting IO coherency with write-through cacheable regions
- Ability to generate ECC on L2 data buses and parity of all control channels
- Both CPU cores in lock-step
- Eight hardware breakpoints
- Eight watchpoints

### 7.5.2 Dual Core Implementation

The device has two Cortex-R5F cores, where the output signals of both CPUs are compared in the CCM-R5F unit. To avoid common mode impacts the signals of the CPUs to be compared are delayed by two clock cycles as shown in [图 7-2](#).

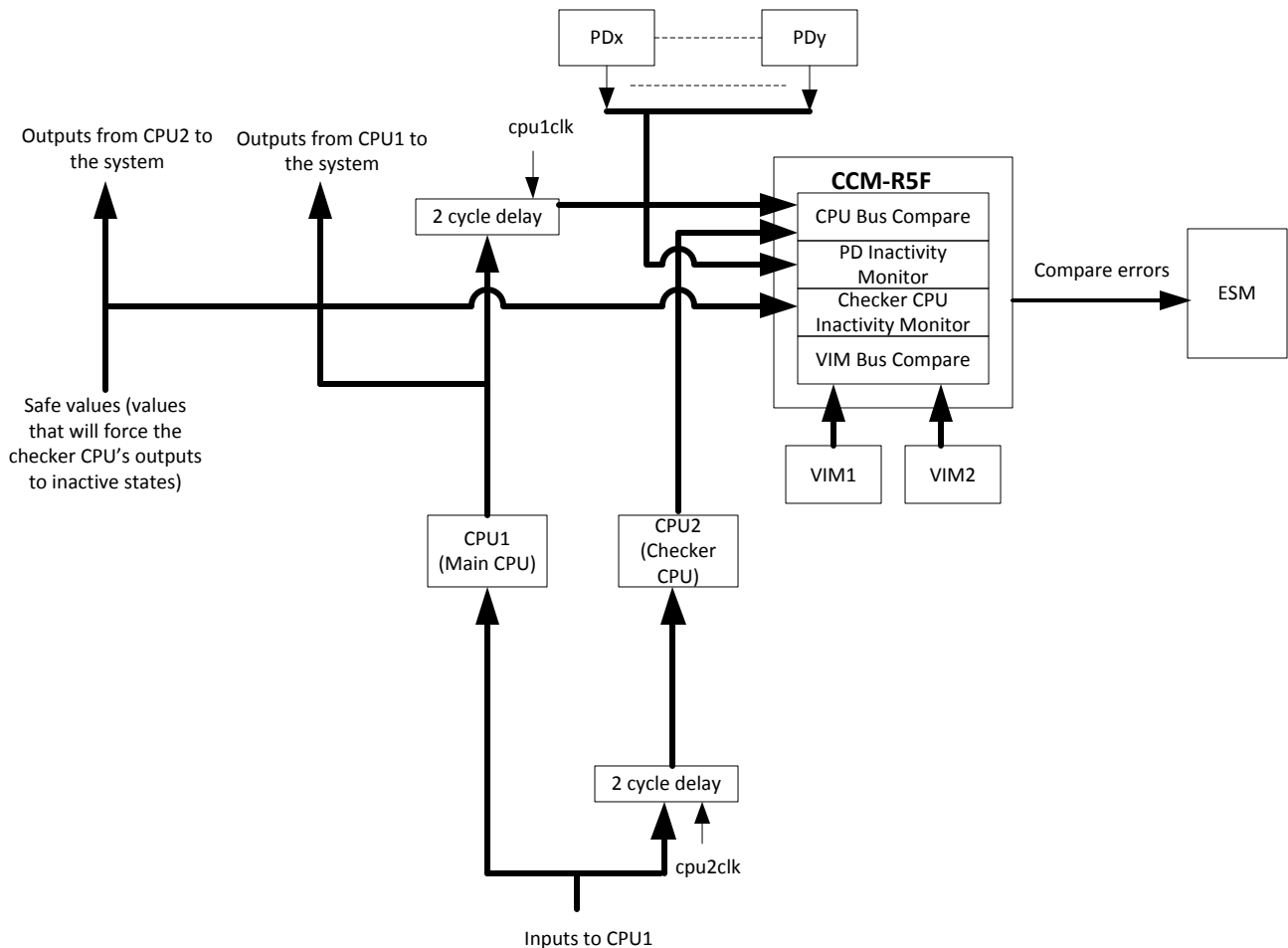


图 7-2. Dual Core Implementation

### 7.5.3 Duplicate Clock Tree After GCLK

The CPU clock domain is split into two clock trees, one for each CPU, with the clock of the second CPU running at the same frequency and in phase to the clock of CPU1. See 图 7-2, *Dual Core Implementation*.

### 7.5.4 Arm Cortex-R5F CPU Compare Module (CCM) for Safety

CCM-R5F has two major functions. One is to compare the outputs of two Cortex-R5F processor cores and the VIM modules. The second function is inactivity monitoring, to detect any faulted transaction initiated by the checker core.

#### 7.5.4.1 Signal Compare Operating Modes

The CCM-R5F module runs in one of four operating modes - active compare lockstep, self-test, error forcing, and self-test error forcing mode. To select an operating mode, a dedicated key must be written to the key register. CPU compare block and VIM compare block have separate key registers to select their operating modes. Status registers are also separate for these blocks.

##### 7.5.4.1.1 Active Compare Lockstep Mode

In this mode the output signals of both CPUs and both VIMs are compared, and a difference in the outputs is indicated by the compare\_error terminal. For more details about CPU and VIM lockstep comparison, refer to the device technical reference manual.

CCM-R5F also produces a signal to ESM GP1.92 to indicate its current status whether it is out of lockstep or is in self-test mode. This ensures that any lock step fault is reported to the CPU.

#### 7.5.4.1.2 Self-Test Mode

In self-test mode the CCM-R5F is checked for faults, by applying internally generated, series of test patterns to look for any hardware faults inside the module. During self-test the compare error signal is deactivated. If a fault on the CCM-R5F module is detected, an error is shown on the selftest\_error pin.

#### 7.5.4.1.3 Error Forcing Mode

In error forcing mode a test pattern is applied to the CPU and VIM related inputs of the compare logic to force an error at the compare error signal of the compare unit. Error forcing mode is done separately for VIM signal compare block and CPU signal compare block. For each block, this mode is enabled by writing the key in corresponding block's key register.

#### 7.5.4.1.4 Self-Test Error Forcing Mode

In self-test error forcing mode an error is forced at the self-test error signal. The compare block is still running in lockstep mode and the key is switched to lockstep after one clock cycle.

**表 7-7. CPU Compare Self-Test Cycles**

| MODE                         | NUMBER OF GCLK CYCLES |
|------------------------------|-----------------------|
| Self-Test Mode               | 4947                  |
| Self-Test Error Forcing Mode | 1                     |
| Error Forcing Mode           | 1                     |

**表 7-8. VIM Compare Self-Test Cycles**

| MODE                         | NUMBER OF VCLK CYCLES |
|------------------------------|-----------------------|
| Self-Test Mode               | 151                   |
| Self-Test Error Forcing Mode | 1                     |
| Error Forcing Mode           | 1                     |

#### 7.5.4.2 Bus Inactivity Monitor

CCM-R5F also monitors the inputs to the interconnect coming from the checker Cortex-R5F core. The input signals to the interconnect are compared against their default clamped values. The checker core must not generate any bus transaction to the interconnect system as all bus transactions are carried out through the main CPU core. If any signal value is different from its clamped value, an error signal is generated. The error response in case of a detected transaction is sent to ESM.

In addition to bus monitoring the checker CPU core, the CCM-R5F will also monitor several other critical signals from other masters residing in other power domains. This is to ensure an inadvertent bus transaction from an unused power domain can be detected. To enable detection of unwanted transaction from an unused master, the power domain in which the master to be monitored will need to be configured in OFF power state through the PMM module.

#### 7.5.4.3 CPU Registers Initialization

To avoid an erroneous CCM-R5F compare error, the application software must ensure that the CPU registers of both CPUs are initialized with the same values before the registers are used, including function calls where the register values are pushed onto the stack.

Example routine for CPU register initialization:

```
.text
.state32
.global __clearRegisters_
.asmfunc
__clearRegisters_:
    mov r0, lr
    mov r1, #0x0000
    mov r2, #0x0000
    mov r3, #0x0000
    mov r4, #0x0000
    mov r5, #0x0000
    mov r6, #0x0000
    mov r7, #0x0000
    mov r8, #0x0000
    mov r9, #0x0000
    mov r10, #0x0000
    mov r11, #0x0000
    mov r12, #0x0000
    mov r1, #0x11
    msr cpsr, r1
    msr spsr, r1
    mov lr, r0
    mov r8, #0x0000
    banked in FIQ mode
    mov r9, #0x0000
    mov r10, #0x0000
    mov r11, #0x0000
    mov r12, #0x0000
    mov r1, #0x13
    msr cpsr, r1
    msr spsr, r1
    mov lr, r0
    mov r1, #0x17
    msr cpsr, r13
    msr spsr, r13
    mov lr, r0
    mov r1, #0x12
    msr cpsr, r13
    msr spsr, r13
    mov lr, r0
    mov r1, #0x1B
    msr cpsr, r13
    msr spsr, r13
    mov lr, r0
    mov r1, #0xDF
    msr cpsr, r13
    msr spsr, r13
    ; FIQ Mode = 10001
    ; Registers R8 to R12 are also
    ; SVC Mode = 10011
    ; ABT Mode = 10111
    ; IRQ Mode = 10010
    ; UDEF Mode = 11011
    ; System Mode = 11011111

; Floating Point Co-Processor Initialization. FPU needs to be enabled first.

    mrc p15, #0x00, r2, c1, c0, #0x02
    orr r2, r2, #0xF00000
    mcr p15, #0x00, r2, c1, c0, #0x02
    mov r2, #0x40000000
    fmrx fpexc, r2

    fmdrr d0, r1, r1
    fmdrr d1, r1, r1
    fmdrr d2, r1, r1
    fmdrr d3, r1, r1
    fmdrr d4, r1, r1
    fmdrr d5, r1, r1
    fmdrr d6, r1, r1
    fmdrr d7, r1, r1
    fmdrr d8, r1, r1
    fmdrr d9, r1, r1
    fmdrr d10, r1, r1
    fmdrr d11, r1, r1
    fmdrr d12, r1, r1
    fmdrr d13, r1, r1
    fmdrr d14, r1, r1
    fmdrr d15, r1, r1
    bl $+4
    bl $+4
    bl $+4
    bl $+4
    bx r0

.endasmfunc
```

### 7.5.5 CPU Self-Test

The CPU STC (Self-Test Controller) is used to test the two Cortex-R5F CPU Cores using the Deterministic Logic BIST Controller as the test engine.

The main features of the self-test controller are:

- Ability to divide the complete test run into independent test intervals
- Capable of running the complete test as well as running few intervals at a time
- Ability to continue from the last executed interval (test set) as well as ability to restart from the beginning (First test set)
- Complete isolation of the self-tested CPU core from rest of the system during the self-test run
- Ability to capture the Failure interval number
- Time-out counter for the CPU self-test run as a fail-safe feature

#### 7.5.5.1 Application Sequence for CPU Self-Test

1. Configure clock domain frequencies.
2. Select number of test intervals to be run.
3. Configure the time-out period for the self-test run.
4. Enable self-test.
5. Wait for CPU reset.
6. In the reset handler, read CPU self-test status to identify any failures.
7. Retrieve CPU state if required.

For more information see the device technical reference manual.

#### 7.5.5.2 CPU Self-Test Clock Configuration

The maximum clock rate for the self-test is 110 MHz. The STCCLK is divided down from the CPU clock. This divider is configured by the STCCLKDIV register at address 0xFFFFE644.

For more information see the device-specific Technical Reference Manual.

#### 7.5.5.3 CPU Self-Test Coverage

The self-test, if enabled, is automatically applied to the entire processor group. Self-test will only start when nCLKSTOPPEDm is asserted which indicates the CPU cores and the ACP interface are in quiescent state. While the processor group is in self-test, other masters can still function normally including accesses to the system memory such as the L2 SRAM. Because uSCU is part of the processor group under self-test, the cache coherency checking will be bypassed.

When the self-test is completed, reset is asserted to all logic subjected to self-test. After self-test is complete, software must invalidate the cache accordingly.

The default value of the CPU LBIST clock prescaler is 'divide-by-1'. A prescaler in the STC module can be used to configure the CPU LBIST frequency with respect to the CPU GCLK frequency.

表 7-9 lists the CPU test coverage achieved for each self-test interval. It also lists the cumulative test cycles. The test time can be calculated by multiplying the number of test cycles with the STC clock period.

**表 7-9. CPU Self-Test Coverage**

| INTERVALS | TEST COVERAGE, % | TEST CYCLES |
|-----------|------------------|-------------|
| 0         | 0                | 0           |
| 1         | 56.85            | 1629        |
| 2         | 64.19            | 3258        |
| 3         | 68.76            | 4887        |
| 4         | 71.99            | 6516        |
| 5         | 75               | 8145        |
| 6         | 76.61            | 9774        |
| 7         | 78.08            | 11403       |
| 8         | 79.2             | 13032       |
| 9         | 80.18            | 14661       |
| 10        | 81.03            | 16290       |
| 11        | 81.9             | 17919       |
| 12        | 82.58            | 19548       |
| 13        | 83.24            | 21177       |
| 14        | 83.73            | 22806       |
| 15        | 84.15            | 24435       |
| 16        | 84.52            | 26064       |
| 17        | 84.9             | 27693       |
| 18        | 85.26            | 29322       |
| 19        | 85.68            | 30951       |
| 20        | 86.05            | 32580       |
| 21        | 86.4             | 34209       |
| 22        | 86.68            | 35838       |
| 23        | 86.94            | 37467       |
| 24        | 87.21            | 39096       |
| 25        | 87.48            | 40725       |
| 26        | 87.74            | 42354       |
| 27        | 87.98            | 43983       |
| 28        | 88.18            | 45612       |
| 29        | 88.38            | 47241       |
| 30        | 88.56            | 48870       |
| 31        | 88.75            | 50499       |
| 32        | 88.93            | 52128       |
| 33        | 89.1             | 53757       |
| 34        | 89.23            | 55386       |
| 35        | 89.41            | 57015       |
| 36        | 89.55            | 58644       |
| 37        | 89.7             | 60273       |
| 38        | 89.83            | 61902       |
| 39        | 89.96            | 63531       |
| 40        | 90.1             | 65160       |

### 7.5.6 N2HET STC / LBIST Self-Test Coverage

Logic BIST self-test capability for N2HETs is available in this device. The STC2 can be configured to perform self-test for both N2HETs at the same time or one at the time. The default value of the N2HET LBIST clock prescaler is divide-by-1. However, the maximum clock rate for the N2HET STC / LBIST is  $VCLK/2$ . N2HET STC test should not be executed concurrently with CPU STC test.

表 7-10. N2HET Self-Test Coverage

| INTERVALS | TEST COVERAGE, % | TEST CYCLES |
|-----------|------------------|-------------|
| 0         | 0                | 0           |
| 1         | 70.01            | 1365        |
| 2         | 77.89            | 2730        |
| 3         | 81.73            | 4095        |
| 4         | 84.11            | 5460        |
| 5         | 86.05            | 6825        |
| 6         | 87.78            | 8190        |
| 7         | 88.96            | 9555        |
| 8         | 89.95            | 10920       |
| 9         | 90.63            | 12285       |

## 7.6 Clocks

### 7.6.1 Clock Sources

表 7-11 lists the available clock sources on the device. Each clock source can be enabled or disabled using the CSDISx registers in the system module. The clock source number in the table corresponds to the control bit in the CSDISx register for that clock source.

表 7-11 also lists the default state of each clock source.

**表 7-11. Available Clock Sources**

| CLOCK SOURCE NO. | NAME      | DESCRIPTION                                            | DEFAULT STATE |
|------------------|-----------|--------------------------------------------------------|---------------|
| 0                | OSCIN     | Main Oscillator                                        | Enabled       |
| 1                | PLL1      | Output From PLL1                                       | Disabled      |
| 2                | Reserved  | Reserved                                               | Disabled      |
| 3                | EXTCLKIN1 | External Clock Input 1                                 | Disabled      |
| 4                | CLK80K    | Low-Frequency Output of Internal Reference Oscillator  | Enabled       |
| 5                | CLK10M    | High-Frequency Output of Internal Reference Oscillator | Enabled       |
| 6                | PLL2      | Output From PLL2                                       | Disabled      |
| 7                | EXTCLKIN2 | External Clock Input 2                                 | Disabled      |

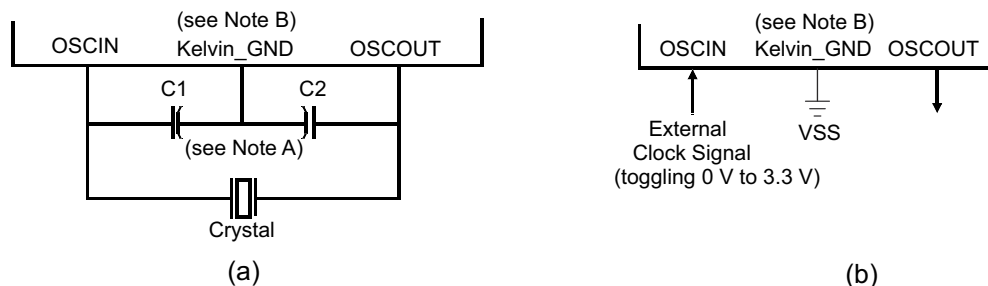
#### 7.6.1.1 Main Oscillator

The oscillator is enabled by connecting the appropriate fundamental resonator/crystal and load capacitors across the external OSCIN and OSCOUT pins as shown in 图 7-3. The oscillator is a single-stage inverter held in bias by an integrated bias resistor. This resistor is disabled during leakage test measurement and low power modes.

#### 备注

TI strongly encourages each customer to submit samples of the device to the resonator/crystal vendors for validation. The vendors are equipped to determine which load capacitors will best tune their resonator/crystal to the microcontroller device for optimum start-up and operation over temperature and voltage extremes.

An external oscillator source can be used by connecting a 3.3-V clock signal to the OSCIN terminal and leaving the OSCOUT terminal unconnected (open) as shown in 图 7-3 .



Note A: The values of C1 and C2 should be provided by the resonator/crystal vendor.

Note B: Kelvin\_GND should not be connected to any other GND when used with a crystal; however, when used with an external clock source, Kelvin\_GND may be tied to VSS.

**图 7-3. Recommended Crystal/Clock Connection**

## 7.6.1.1.1 Timing Requirements for Main Oscillator

表 7-12. Timing Requirements for Main Oscillator

|                   |                                                                       | MIN | NOM | MAX | UNIT |
|-------------------|-----------------------------------------------------------------------|-----|-----|-----|------|
| $t_{c(OSC)}$      | Cycle time, OSCIN (when using a sine-wave input)                      | 50  |     | 200 | ns   |
| $t_{c(OSC\_SQR)}$ | Cycle time, OSCIN, (when input to the OSCIN is a square wave)         | 50  |     | 200 | ns   |
| $t_{w(OSCIL)}$    | Pulse duration, OSCIN low (when input to the OSCIN is a square wave)  | 15  |     |     | ns   |
| $t_{w(OSCIH)}$    | Pulse duration, OSCIN high (when input to the OSCIN is a square wave) | 15  |     |     | ns   |

### 7.6.1.2 Low-Power Oscillator

The Low-Power Oscillator (LPO) is comprised of two oscillators — HF LPO and LF LPO, in a single macro.

#### 7.6.1.2.1 Features

The main features of the LPO are:

- Supplies a clock at extremely low power to reduce power consumption. This is connected as clock source 4 of the Global Clock Module (GCM).
- Supplies a high-frequency clock for nontiming-critical systems. This is connected as clock source 5 of the GCM.
- Provides a comparison clock for the crystal oscillator failure detection circuit.

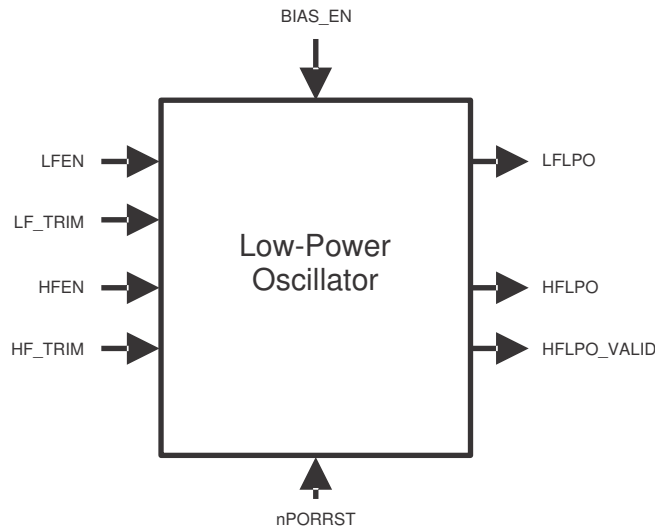


图 7-4. LPO Block Diagram

图 7-4 shows a block diagram of the internal reference oscillator. This is a low-power oscillator (LPO) and provides two clock sources: one nominally 80 kHz and one nominally 10 MHz.

#### 7.6.1.2.2 LPO Electrical and Timing Specifications

表 7-13. LPO Specifications

| PARAMETER           |                                                                          | MIN   | TYP  | MAX   | UNIT    |
|---------------------|--------------------------------------------------------------------------|-------|------|-------|---------|
| Clock detection     | Oscillator fail frequency - lower threshold, using untrimmed LPO output  | 1.375 | 2.4  | 4.875 | MHz     |
|                     | Oscillator fail frequency - higher threshold, using untrimmed LPO output | 22    | 38.4 | 78    | MHz     |
| LPO - HF oscillator | Untrimmed frequency                                                      | 5.5   | 9    | 19.5  | MHz     |
|                     | Trimmed frequency                                                        | 8.0   | 9.6  | 11.0  | MHz     |
|                     | Start-up time from STANDBY (LPO BIAS_EN high for at least 900 $\mu$ s)   |       |      | 10    | $\mu$ s |
|                     | Cold start-up time                                                       |       |      | 900   | $\mu$ s |
| LPO - LF oscillator | Untrimmed frequency                                                      | 36    | 85   | 180   | kHz     |
|                     | Start-up time from STANDBY (LPO BIAS_EN high for at least 900 $\mu$ s)   |       |      | 100   | $\mu$ s |
|                     | Cold start-up time                                                       |       |      | 2000  | $\mu$ s |

### 7.6.1.3 Phase-Locked Loop (PLL) Clock Modules

The PLL is used to multiply the input frequency to some higher frequency.

The main features of the PLL are:

- Frequency modulation can be optionally superimposed on the synthesized frequency of PLL1. The frequency modulation capability of PLL2 is permanently disabled.
- Configurable frequency multipliers and dividers
- Built-in PLL Slip monitoring circuit
- Option to reset the device on a PLL slip detection

#### 7.6.1.3.1 Block Diagram

图 7-5 shows a high-level block diagram of the two PLL macros on this microcontroller. PLLCTL1 and PLLCTL2 are used to configure the multiplier and dividers for the PLL1. PLLCTL3 is used to configure the multiplier and dividers for PLL2.

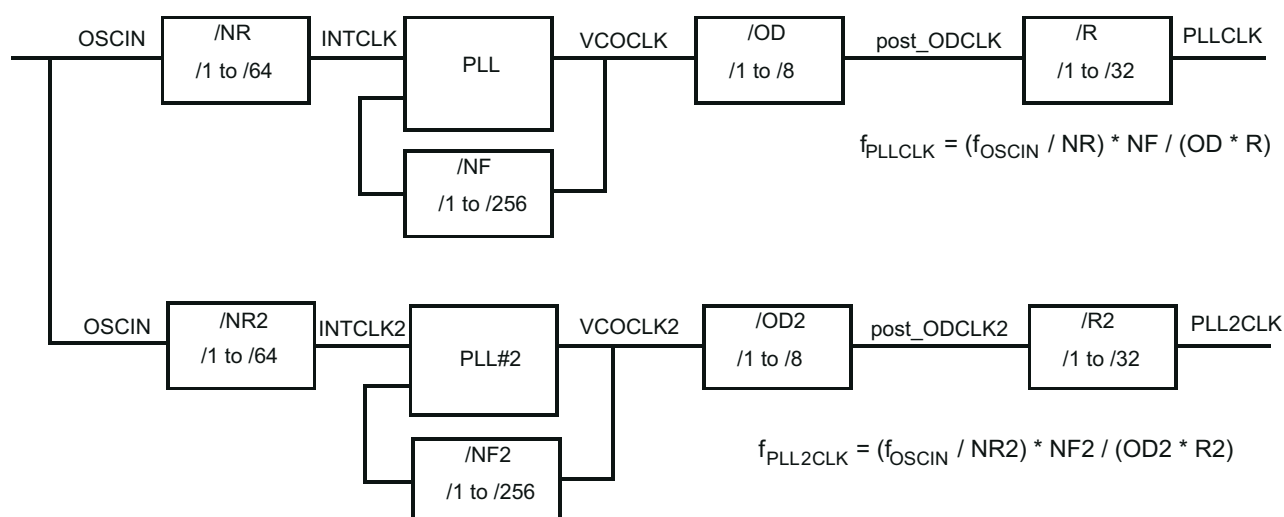


图 7-5. GWT PLLx Block Diagram

#### 7.6.1.3.2 PLL Timing Specifications

表 7-14. PLL Timing Specifications

| PARAMETER                |                                                         | MIN | MAX | UNIT |
|--------------------------|---------------------------------------------------------|-----|-----|------|
| f <sub>INTCLK</sub>      | PLL1 Reference Clock frequency                          | 1   | 20  | MHz  |
| f <sub>post_ODCLK</sub>  | Post-ODCLK – PLL1 Post-divider input clock frequency    |     | 400 | MHz  |
| f <sub>VCOCLK</sub>      | VCOCLK – PLL1 Output Divider (OD) input clock frequency |     | 550 | MHz  |
| f <sub>INTCLK2</sub>     | PLL2 Reference Clock frequency                          | 1   | 20  | MHz  |
| f <sub>post_ODCLK2</sub> | Post-ODCLK – PLL2 Post-divider input clock frequency    |     | 400 | MHz  |
| f <sub>VCOCLK2</sub>     | VCOCLK – PLL2 Output Divider (OD) input clock frequency |     | 550 | MHz  |

### 7.6.1.4 External Clock Inputs

The device supports up to two external clock inputs. This clock input must be a square-wave input. 表 7-15 specifies the electrical and timing requirements for these clock inputs .

**表 7-15. External Clock Timing and Electrical Specifications**

| PARAMETER          |                                | MIN   | MAX              | UNIT |
|--------------------|--------------------------------|-------|------------------|------|
| $f_{EXTCLKx}$      | External clock input frequency |       | 80               | MHz  |
| $t_{w(EXTCLKIN)H}$ | EXTCLK high-pulse duration     | 6     |                  | ns   |
| $t_{w(EXTCLKIN)L}$ | EXTCLK low-pulse duration      | 6     |                  | ns   |
| $V_{iL(EXTCLKIN)}$ | Low-level input voltage        | - 0.3 | 0.8              | V    |
| $V_{iH(EXTCLKIN)}$ | High-level input voltage       | 2     | $V_{CCIO} + 0.3$ | V    |

## 7.6.2 Clock Domains

### 7.6.2.1 Clock Domain Descriptions

表 7-16 lists the device clock domains and their default clock sources. 表 7-16 also lists the system module control register that is used to select an available clock source for each clock domain.

表 7-16. Clock Domain Descriptions

| CLOCK DOMAIN | CLOCK DISABLE BIT | DEFAULT SOURCE | SOURCE SELECTION REGISTER | SPECIAL CONSIDERATIONS                                                                                                                                                                                                                                                                                                                                        |
|--------------|-------------------|----------------|---------------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| GCLK1        | SYS.CDDIS.0       | OSCIN          | SYS.GHVSRC[3:0]           | <ul style="list-style-type: none"> <li>This the main clock from which HCLK is divided down</li> <li>In phase with HCLK</li> <li>Is disabled separately from HCLK through the CDDISx registers bit 0</li> <li>Can be divided-by-1 up to 8 when running CPU self-test (LBIST) using the CLKDIV field of the STCCLKDIV register at address 0xFFFFE108</li> </ul> |
| GCLK2        | SYS.CDDIS.0       | OSCIN          | SYS.GHVSRC[3:0]           | <ul style="list-style-type: none"> <li>Always the same frequency as GCLK1</li> <li>2 cycles delayed from GCLK1</li> <li>Is disabled along with GCLK1</li> <li>Gets divided by the same divider setting as that for GCLK1 when running CPU self-test (LBIST)</li> </ul>                                                                                        |
| HCLK         | SYS.CDDIS.1       | OSCIN          | SYS.GHVSRC[3:0]           | <ul style="list-style-type: none"> <li>Divided from GCLK1 through HCLKCNTL register</li> <li>Allowable clock ratio from 1:1 to 4:1</li> <li>Is disabled through the CDDISx registers bit 1</li> </ul>                                                                                                                                                         |
| VCLK         | SYS.CDDIS.2       | OSCIN          | SYS.GHVSRC[3:0]           | <ul style="list-style-type: none"> <li>Divided down from HCLK through CLKCNTL register</li> <li>Can be HCLK/1, HCLK/2,... or HCLK/16</li> <li>Is disabled separately from HCLK through the CDDISx registers bit 2</li> <li>HCLK:VCLK2:VCLK must be integer ratios of each other</li> </ul>                                                                    |
| VCLK2        | SYS.CDDIS.3       | OSCIN          | SYS.GHVSRC[3:0]           | <ul style="list-style-type: none"> <li>Divided down from HCLK</li> <li>Can be HCLK/1, HCLK/2,... or HCLK/16</li> <li>Frequency must be an integer multiple of VCLK frequency</li> <li>Is disabled separately from HCLK through the CDDISx registers bit 3</li> </ul>                                                                                          |
| VCLK3        | SYS.CDDIS.8       | OSCIN          | SYS.GHVSRC[3:0]           | <ul style="list-style-type: none"> <li>Divided down from HCLK</li> <li>Can be HCLK/1, HCLK/2,... or HCLK/16</li> <li>Is disabled separately from HCLK through the CDDISx registers bit 8</li> </ul>                                                                                                                                                           |
| VCLKA1       | SYS.CDDIS.4       | VCLK           | SYS.VCLKASRC[3:0]         | <ul style="list-style-type: none"> <li>Defaults to VCLK as the source</li> <li>Is disabled through the CDDISx registers bit 4</li> </ul>                                                                                                                                                                                                                      |

**表 7-16. Clock Domain Descriptions (续)**

| CLOCK DOMAIN | CLOCK DISABLE BIT | DEFAULT SOURCE | SOURCE SELECTION REGISTER | SPECIAL CONSIDERATIONS                                                                                                                                                                                                                                                                                                                                                                |
|--------------|-------------------|----------------|---------------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| VCLKA2       | SYS.CDDIS.5       | VCLK           | SYS.VCLKASRC[3:0]         | <ul style="list-style-type: none"> <li>Defaults to VCLK as the source</li> <li>Is disabled through the CDDISx registers bit 5</li> </ul>                                                                                                                                                                                                                                              |
| VCLKA4       | SYS.CDDIS.11      | VCLK           | SYS.VCLKACON1[19:16]      | <ul style="list-style-type: none"> <li>Defaults to VCLK as the source</li> <li>Is disabled through the CDDISx registers bit 11</li> </ul>                                                                                                                                                                                                                                             |
| VCLKA4_DIVR  | SYS.VCLKACON1.20  | VCLK           | SYS.VCLKACON1[19:16]      | <ul style="list-style-type: none"> <li>Divided down from VCLKA4 using the VCLKA4R field of the VCLKACON1 register</li> <li>Frequency can be VCLKA4/1, VCLKA4/2, ..., or VCLKA4/8</li> <li>Default frequency is VCLKA4/2</li> <li>Is disabled separately through the VCLKA4_DIV_CDDIS bit in the VCLKACON1 register, if the VCLKA4 is not already disabled</li> </ul>                  |
| RTICK1       | SYS.CDDIS.6       | VCLK           | SYS.RCLKSRC[3:0]          | <ul style="list-style-type: none"> <li>Defaults to VCLK as the source</li> <li>If a clock source other than VCLK is selected for RTICK1, then the RTICK1 frequency must be less than or equal to VCLK/3</li> <li>Application can ensure this by programming the RT1DIV field of the RCLKSRC register, if necessary</li> <li>Is disabled through the CDDISx registers bit 6</li> </ul> |

### 7.6.2.2 Mapping of Clock Domains to Device Modules

Each clock domain has a dedicated functionality as shown in 图 7-6.

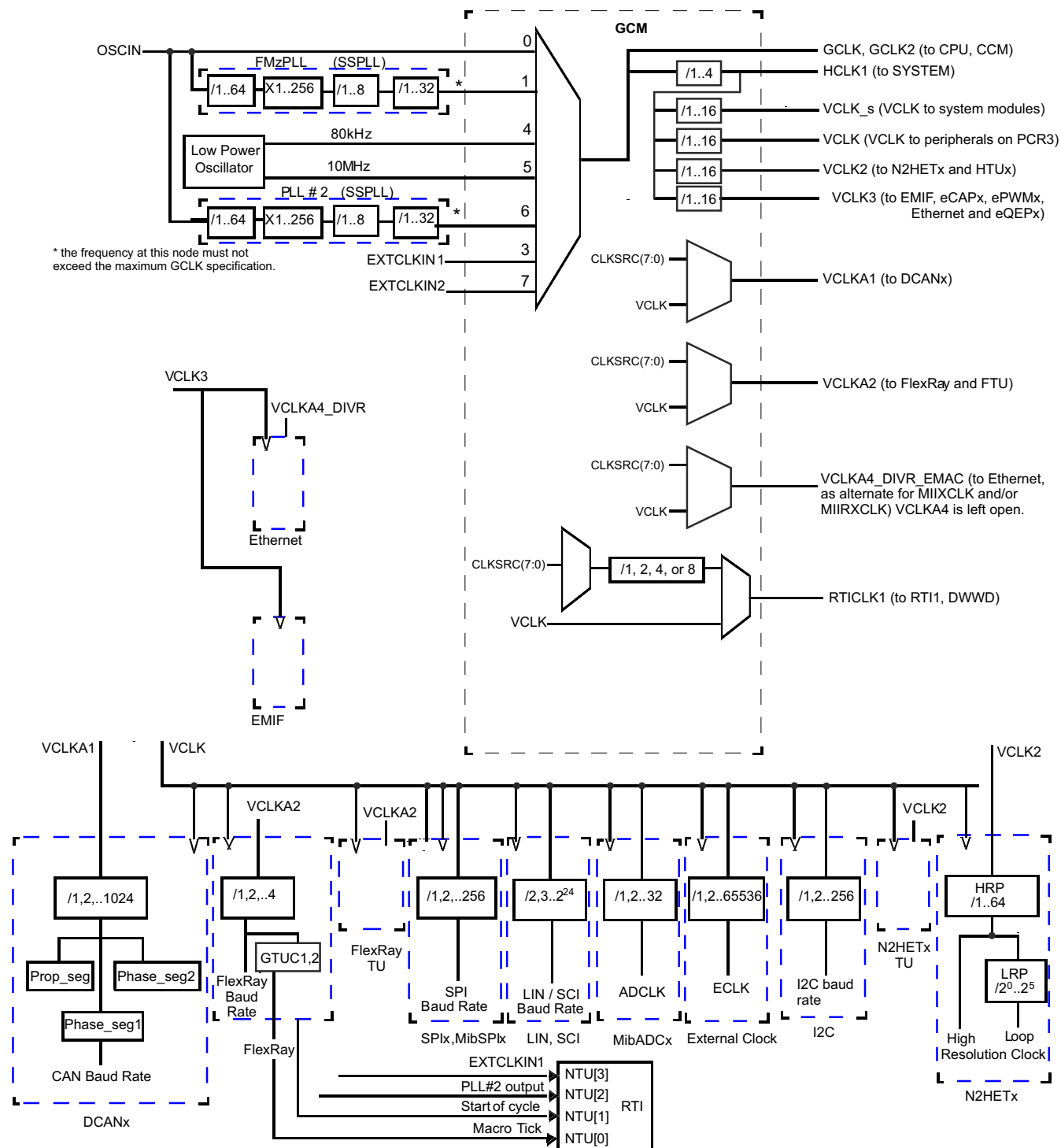


图 7-6. Device Clock Domains

### 7.6.3 Special Clock Source Selection Scheme for VCLKA4\_DIVR\_EMAC

Some applications may need to use both the FlexRay and the Ethernet interfaces. The FlexRay controller requires the VCLKA2 frequency to be 80 MHz, while the MII interface requires VCLKA4\_DIVR\_EMAC to be 25 MHz and the RMII requires VCLKA4\_DIVR\_EAMC to be 50 MHz.

These different frequencies are supported by adding special dedicated clock source selection options for the VCLKA4\_DIVR\_EMAC clock domain. This logic is shown in 图 7-7.

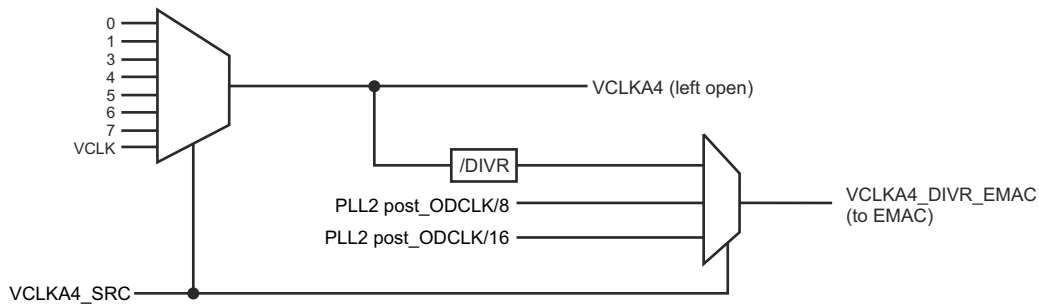


图 7-7. VCLKA4\_DIVR Source Selection Options

The PLL2 post\_ODCLK is brought out as a separate output from the PLL wrapper module. There are two additional dividers implemented at the device-level to divide this PLL2 post\_ODCLK by 8 and by 16.

As shown in 图 7-7, the VCLKA4\_SRC configured through the system module VCLKACON1 control register is used to determine the clock source for the VCLKA4 and VCLKA4\_DIVR. An additional multiplexor is implemented to select between the VCLKA4\_DIVR and the two additional clock sources - PLL2 post\_ODCLK/8 and post\_ODCLK/16.

表 7-17 lists the VCLKA4\_DIVR\_EMAC clock source selections.

表 7-17. VCLKA4\_DIVR\_EMAC Clock Source Selection

| VCLKA4_SRC FROM VCLKACON1[19 - 16] | CLOCK SOURCE FOR VCLKA4_DIVR_EMAC |
|------------------------------------|-----------------------------------|
| 0x0                                | OSCIN / VCLKA4R                   |
| 0x1                                | PLL1CLK / VCLKA4R                 |
| 0x2                                | Reserved                          |
| 0x3                                | EXTCLKIN1 / VCLKA4R               |
| 0x4                                | LF LPO / VCLKA4R                  |
| 0x5                                | HF LPO / VCLKA4R                  |
| 0x6                                | PLL2CLK / VCLKA4R                 |
| 0x7                                | EXTCLKIN2 / VCLKA4R               |
| 0x8 - 0xD                          | VCLK                              |
| 0xE                                | PLL2 post_ODCLK/8                 |
| 0xF                                | PLL2 post_ODCLK/16                |

### 7.6.4 Clock Test Mode

The TMS570 platform architecture defines a special mode that allows various clock signals to be selected and output on the ECLK1 terminal and N2HET1[12] device outputs. This special mode, Clock Test Mode, is very useful for debugging purposes and can be configured through the CLKTEST register in the system module. See [表 7-18](#) and [表 7-19](#) for the CLKTEST bits value and signal selection.

**表 7-18. Clock Test Mode Options for Signals on ECLK1**

| SEL_ECP_PIN = CLKTEST[4-0] | SIGNAL ON ECLK1                                            |
|----------------------------|------------------------------------------------------------|
| 00000                      | Oscillator Clock                                           |
| 00001                      | PLL1 Clock Output                                          |
| 00010                      | Reserved                                                   |
| 00011                      | EXTCLKIN1                                                  |
| 00100                      | Low-Frequency Low-Power Oscillator (LFLPO) Clock [CLK80K]  |
| 00101                      | High-Frequency Low-Power Oscillator (HFLPO) Clock [CLK10M] |
| 00110                      | PLL2 Clock Output                                          |
| 00111                      | EXTCLKIN2                                                  |
| 01000                      | GCLK1                                                      |
| 01001                      | RTI1 Base                                                  |
| 01010                      | Reserved                                                   |
| 01011                      | VCLKA1                                                     |
| 01100                      | VCLKA2                                                     |
| 01101                      | Reserved                                                   |
| 01110                      | VCLKA4_DIVR                                                |
| 01111                      | Flash HD Pump Oscillator                                   |
| 10000                      | Reserved                                                   |
| 10001                      | HCLK                                                       |
| 10010                      | VCLK                                                       |
| 10011                      | VCLK2                                                      |
| 10100                      | VCLK3                                                      |
| 10101                      | Reserved                                                   |
| 10110                      | Reserved                                                   |
| 10111                      | EMAC Clock Output                                          |
| 11000                      | Reserved                                                   |
| 11001                      | Reserved                                                   |
| 11010                      | Reserved                                                   |
| 11011                      | Reserved                                                   |
| 11100                      | Reserved                                                   |
| 11101                      | Reserved                                                   |
| 11110                      | Reserved                                                   |
| 11111                      | Reserved                                                   |

**表 7-19. Clock Test Mode Options for Signals on N2HET1[12]**

| SEL_GIO_PIN = CLKTEST[11-8] | SIGNAL ON N2HET1[12]                     |
|-----------------------------|------------------------------------------|
| 0000                        | Oscillator Valid Status                  |
| 0001                        | PLL1 Valid Status                        |
| 0010                        | Reserved                                 |
| 0011                        | Reserved                                 |
| 0100                        | Reserved                                 |
| 0101                        | HFLPO Clock Output Valid Status [CLK10M] |
| 0110                        | PLL2 Valid Status                        |
| 0111                        | Reserved                                 |
| 1000                        | LFLPO Clock Output Valid Status [CLK80K] |
| 1001                        | Oscillator Valid status                  |
| 1010                        | Oscillator Valid status                  |
| 1011                        | Oscillator Valid status                  |
| 1100                        | Oscillator Valid status                  |
| 1101                        | Reserved                                 |
| 1110                        | VCLKA4                                   |
| 1111                        | Oscillator Valid status                  |

## 7.7 Clock Monitoring

The LPO Clock Detect (LPOCLKDET) module consists of a clock monitor (CLKDET) and an internal LPO.

The LPO provides two different clock sources – a low frequency (CLK80K) and a high frequency (CLK10M).

The CLKDET is a supervisor circuit for an externally supplied clock signal (OSCIN). In case the OSCIN frequency falls out of a frequency window, the CLKDET flags this condition in the global status register (GLBSTAT bit 0: OSC FAIL) and switches all clock domains sourced by OSCIN to the CLK10M clock (limp mode clock).

The valid OSCIN frequency range is defined as:  $f_{\text{CLK10M}} / 4 < f_{\text{OSCIN}} < f_{\text{CLK10M}} * 4$ .

### 7.7.1 Clock Monitor Timings

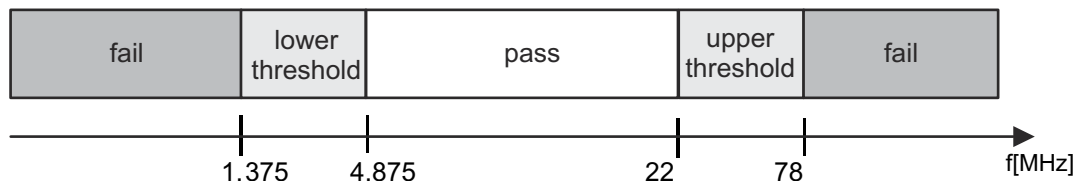


图 7-8. LPO and Clock Detection, Untrimmed CLK10M

### 7.7.2 External Clock (ECLK) Output Functionality

The ECLK1/ECLK2 terminal can be configured to output a prescaled clock signal indicative of an internal device clock. This output can be externally monitored as a safety diagnostic.

### 7.7.3 Dual Clock Comparators

The Dual Clock Comparator (DCC) module determines the accuracy of selectable clock sources by counting the pulses of two independent clock sources (counter 0 and counter 1). If one clock is out of spec, an error signal is generated. For example, the DCC1 can be configured to use CLK10M as the reference clock (for counter 0) and VCLK as the "clock under test" (for counter 1). This configuration allows the DCC1 to monitor the PLL output clock when VCLK is using the PLL output as its source.

An additional use of this module is to measure the frequency of a selectable clock source. For example, the reference clock is connected to Counter 0 and the signal to be measured is connected to Counter 1. Counter 0 is programmed with a start value of known time duration (measurement time) from the reference clock. Counter 1 is programmed with a maximum start value. Start both counter simultaneously. When Counter 0 decrements to zero, both counter will stop and an error signal is generated if Counter 1 does not reach zero. The frequency of the input signals can be calculated from the count value of Counter 1 and the measurement time.

#### 7.7.3.1 Features

- Takes two different clock sources as input to two independent counter blocks.
- One of the clock sources is the known-good, or reference clock; the second clock source is the "clock under test."
- Each counter block is programmable with initial, or seed values.
- The counter blocks start counting down from their seed values at the same time; a mismatch from the expected frequency for the clock under test generates an error signal which is used to interrupt the CPU.

### 7.7.3.2 Mapping of DCC Clock Source Inputs

**表 7-20. DCC1 Counter 0 Clock Sources**

| CLOCK SOURCE[3:0] | CLOCK NAME         |
|-------------------|--------------------|
| Others            | Oscillator (OSCIN) |
| 0x5               | High-frequency LPO |
| 0xA               | Test clock (TCK)   |

**表 7-21. DCC1 Counter 1 Clock Sources**

| KEY[3:0] | CLOCK SOURCE[3:0] | CLOCK NAME                         |
|----------|-------------------|------------------------------------|
| Others   | -                 | N2HET1[31]                         |
|          | 0x0               | Main PLL free-running clock output |
|          | 0x1               | PLL #2 free-running clock output   |
|          | 0x2               | Low-frequency LPO                  |
| 0xA      | 0x3               | High-frequency LPO                 |
|          | 0x4               | Reserved                           |
|          | 0x5               | EXTCLKIN1                          |
|          | 0x6               | EXTCLKIN2                          |
|          | 0x7               | Reserved                           |
|          | 0x8 - 0xF         | VCLK                               |

**表 7-22. DCC2 Counter 0 Clock Sources**

| CLOCK SOURCE[3:0] | CLOCK NAME         |
|-------------------|--------------------|
| Others            | Oscillator (OSCIN) |
| 0xA               | Test clock (TCK)   |

**表 7-23. DCC2 Counter 1 Clock Sources**

| KEY[3:0] | CLOCK SOURCE[3:0] | CLOCK NAME         |
|----------|-------------------|--------------------|
| Others   | -                 | N2HET2[0]          |
| 0xA      | 0x1               | PLL2_post_ODCLK/8  |
|          | 0x2               | PLL2_post_ODCLK/16 |
|          | 0x3 - 0x7         | Reserved           |
|          | 0x8 - 0xF         | VCLK               |

## 7.8 Glitch Filters

表 7-24 lists the signals with glitch filters present .

表 7-24. Glitch Filter Timing Specifications

| TERMINAL | PARAMETER        |                                                                                                                                       | MIN | MAX  | UNIT |
|----------|------------------|---------------------------------------------------------------------------------------------------------------------------------------|-----|------|------|
| nPORRST  | $t_{f(nPORRST)}$ | Filter time nPORRST terminal; pulses less than MIN will be filtered out, pulses greater than MAX will generate a reset <sup>(1)</sup> | 475 | 2000 | ns   |
| nRST     | $t_{f(nRST)}$    | Filter time nRST terminal; pulses less than MIN will be filtered out, pulses greater than MAX will generate a reset                   | 475 | 2000 | ns   |
| TEST     | $t_{f(TEST)}$    | Filter time TEST terminal; pulses less than MIN will be filtered out, pulses greater than MAX will pass through                       | 475 | 2000 | ns   |

- (1) The glitch filter design on the nPORRST signal is designed such that no size pulse will reset any part of the microcontroller (flash pump, I/O pins, forth) without also generating a valid reset signal to the CPU.

## 7.9 Device Memory Map

### 7.9.1 Memory Map Diagram

图 7-9 shows the device memory map.

|              |                                                       |
|--------------|-------------------------------------------------------|
| 0xFFFFFFFF   | <b>SYSTEM Peripherals - Frame 1</b>                   |
| 0xFFFF80000  |                                                       |
| 0xFFFF7FFFF  |                                                       |
| 0xFF000000   | <b>Peripherals - Frame 3</b>                          |
| 0xFEFFFFFFF  |                                                       |
| 0xFE000000   |                                                       |
|              | <b>CRC1</b>                                           |
|              | <b>RESERVED</b>                                       |
| 0xFCFFFFFFF  | <b>Peripherals - Frame 2</b>                          |
| 0xFC000000   |                                                       |
| 0xFBFFFFFFF  |                                                       |
| 0xFB000000   | <b>CRC2</b>                                           |
|              | <b>RESERVED</b>                                       |
| 0xF047FFFF   | <b>Flash<br/>(Flash ECC, OTP and EEPROM accesses)</b> |
| 0xF0000000   |                                                       |
|              |                                                       |
|              | <b>RESERVED</b>                                       |
| 0x87FFFFFFF  | <b>EMIF (128MB)<br/>SDRAM</b>                         |
| 0x80000000   |                                                       |
|              |                                                       |
|              | <b>RESERVED</b>                                       |
| 0x6FFFFFFF   | <b>EMIF (16MB * 3)<br/>Async RAM</b>                  |
|              |                                                       |
|              |                                                       |
| 0x60000000   | <b>RESERVED</b>                                       |
|              | <b>RESERVED</b>                                       |
| 0x37FFFFFFF  | <b>R5F Cache</b>                                      |
| 0x34000000   |                                                       |
| 0x33FFFFFFF  |                                                       |
| 0x30000000   | <b>RESERVED</b>                                       |
|              | <b>RAM - ECC</b>                                      |
| 0x0847FFFF   | <b>RAM (512KB)</b>                                    |
| 0x08400000   |                                                       |
|              |                                                       |
|              | <b>RESERVED</b>                                       |
| 0x0807FFFF   | <b>Flash (4MB)</b>                                    |
| 0x08000000   |                                                       |
|              |                                                       |
| 0x003FFFFFFF |                                                       |
| 0x00000000   |                                                       |

图 7-9. Memory Map

## 7.9.2 Memory Map Table

表 7-25. Module Registers / Memories Memory Map

| TARGET NAME                                          | MEMORY SELECT | ADDRESS RANGE |             | FRAME SIZE | ACTUAL SIZE | RESPONSE FOR ACCESS TO UNIMPLEMENTED LOCATIONS IN FRAME |
|------------------------------------------------------|---------------|---------------|-------------|------------|-------------|---------------------------------------------------------|
|                                                      |               | START         | END         |            |             |                                                         |
| Level 2 Memories                                     |               |               |             |            |             |                                                         |
| Level 2 Flash Data Space                             |               | 0x0000_0000   | 0x003F_FFFF | 4MB        | 4MB         | Abort                                                   |
| Level 2 RAM                                          |               | 0x0800_0000   | 0x083F_FFFF | 4MB        | 512KB       | Abort                                                   |
| Level 2 RAM ECC                                      |               | 0x0840_0000   | 0x087F_FFFF | 4MB        | 512KB       |                                                         |
| Accelerator Coherency Port                           |               |               |             |            |             |                                                         |
| Accelerator Coherency Port                           |               | 0x0800_0000   | 0x087F_FFFF | 8MB        | 512KB       | Abort                                                   |
| Level 1 Cache Memories                               |               |               |             |            |             |                                                         |
| Cortex-R5F Data Cache Memory                         |               | 0x3000_0000   | 0x30FF_FFFF | 16MB       | 32KB        | Abort                                                   |
| Cortex-R5F Instruction Cache Memory                  |               | 0x3100_0000   | 0x31FF_FFFF | 16MB       | 32KB        |                                                         |
| External Memory Accesses                             |               |               |             |            |             |                                                         |
| EMIF Chip Select 2 (asynchronous)                    |               | 0x6000_0000   | 0x63FF_FFFF | 64MB       | 16MB        | Access to "Reserved" space will generate Abort          |
| EMIF Chip Select 3 (asynchronous)                    |               | 0x6400_0000   | 0x67FF_FFFF | 64MB       | 16MB        |                                                         |
| EMIF Chip Select 4 (asynchronous)                    |               | 0x6800_0000   | 0x6BFF_FFFF | 64MB       | 16MB        |                                                         |
| EMIF Chip Select 0 (synchronous)                     |               | 0x8000_0000   | 0x87FF_FFFF | 128MB      | 128MB       |                                                         |
| Flash OTP, ECC, EEPROM Bank                          |               |               |             |            |             |                                                         |
| Customer OTP, Bank0                                  |               | 0xF000_0000   | 0xF000_1FFF | 8KB        | 4KB         | Abort                                                   |
| Customer OTP, Bank1                                  |               | 0xF000_2000   | 0xF000_3FFF | 8KB        | 4KB         |                                                         |
| Customer OTP, EEPROM Bank                            |               | 0xF000_E000   | 0xF000_FFFF | 8KB        | 1KB         |                                                         |
| Customer OTP-ECC, Bank0                              |               | 0xF004_0000   | 0xF004_03FF | 1KB        | 512B        |                                                         |
| Customer OTP-ECC, Bank1                              |               | 0xF004_0400   | 0xF004_07FF | 1KB        | 512B        |                                                         |
| Customer OTP-ECC, EEPROM Bank                        |               | 0xF004_1C00   | 0xF004_1FFF | 1KB        | 128B        |                                                         |
| TI OTP, Bank0                                        |               | 0xF008_0000   | 0xF008_1FFF | 8KB        | 4KB         |                                                         |
| TI OTP, Bank1                                        |               | 0xF008_2000   | 0xF008_3FFF | 8KB        | 4KB         |                                                         |
| TI OTP, EEPROM Bank                                  |               | 0xF008_E000   | 0xF008_FFFF | 8KB        | 1KB         |                                                         |
| TI OTP-ECC, Bank0                                    |               | 0xF00C_0000   | 0xF00C_03FF | 1KB        | 512B        |                                                         |
| TI OTP-ECC, Bank1                                    |               | 0xF00C_0400   | 0xF00C_07FF | 1KB        | 512B        | Abort                                                   |
| TI OTP-ECC, EEPROM Bank                              |               | 0xF00C_1C00   | 0xF00C_1FFF | 1KB        | 128B        |                                                         |
| EEPROM Bank-ECC                                      |               | 0xF010_0000   | 0xF01F_FFFF | 1MB        | 16KB        |                                                         |
| EEPROM Bank                                          |               | 0xF020_0000   | 0xF03F_FFFF | 2MB        | 128KB       |                                                         |
| Flash Data Space ECC                                 |               | 0xF040_0000   | 0xF05F_FFFF | 2MB        | 512KB       |                                                         |
| Interconnect SDC MMR                                 |               |               |             |            |             |                                                         |
| Interconnect SDC MMR                                 |               | 0xFA00_0000   | 0xFAFF_FFFF | 16MB       | 16MB        |                                                         |
| Registers/Memories under PCR2 (Peripheral Segment 2) |               |               |             |            |             |                                                         |
| CPPI Memory Slave (Ethernet RAM)                     | PCS[41]       | 0xFC52_0000   | 0xFC52_1FFF | 8KB        | 8KB         | Abort                                                   |
| CPGMAC Slave (Ethernet Slave)                        | PS[30]-PS[31] | 0xFCF7_8000   | 0xFCF7_87FF | 2KB        | 2KB         | No Error                                                |
| CPGMACSS Wrapper (Ethernet Wrapper)                  | PS[29]        | 0xFCF7_8800   | 0xFCF7_88FF | 256B       | 256B        | No Error                                                |
| Ethernet MDIO Interface                              | PS[29]        | 0xFCF7_8900   | 0xFCF7_89FF | 256B       | 256B        | No Error                                                |

**表 7-25. Module Registers / Memories Memory Map (续)**

| TARGET NAME                                           | MEMORY SELECT     | ADDRESS RANGE |             | FRAME SIZE | ACTUAL SIZE | RESPONSE FOR ACCESS TO UNIMPLEMENTED LOCATIONS IN FRAME |
|-------------------------------------------------------|-------------------|---------------|-------------|------------|-------------|---------------------------------------------------------|
|                                                       |                   | START         | END         |            |             |                                                         |
| ePWM1                                                 | PS[28]            | 0xFCF7_8C00   | 0xFCF7_8CFF | 256B       | 256B        | Abort                                                   |
| ePWM2                                                 |                   | 0xFCF7_8D00   | 0xFCF7_8DFF | 256B       | 256B        | Abort                                                   |
| ePWM3                                                 |                   | 0xFCF7_8E00   | 0xFCF7_8EFF | 256B       | 256B        | Abort                                                   |
| ePWM4                                                 |                   | 0xFCF7_8F00   | 0xFCF7_8FFF | 256B       | 256B        | Abort                                                   |
| ePWM5                                                 | PS[27]            | 0xFCF7_9000   | 0xFCF7_90FF | 256B       | 256B        | Abort                                                   |
| ePWM6                                                 |                   | 0xFCF7_9100   | 0xFCF7_91FF | 256B       | 256B        | Abort                                                   |
| ePWM7                                                 |                   | 0xFCF7_9200   | 0xFCF7_92FF | 256B       | 256B        | Abort                                                   |
| eCAP1                                                 |                   | 0xFCF7_9300   | 0xFCF7_93FF | 256B       | 256B        | Abort                                                   |
| eCAP2                                                 | PS[26]            | 0xFCF7_9400   | 0xFCF7_94FF | 256B       | 256B        | Abort                                                   |
| eCAP3                                                 |                   | 0xFCF7_9500   | 0xFCF7_95FF | 256B       | 256B        | Abort                                                   |
| eCAP4                                                 |                   | 0xFCF7_9600   | 0xFCF7_96FF | 256B       | 256B        | Abort                                                   |
| eCAP5                                                 |                   | 0xFCF7_9700   | 0xFCF7_97FF | 256B       | 256B        | Abort                                                   |
| eCAP6                                                 | PS[25]            | 0xFCF7_9800   | 0xFCF7_98FF | 256B       | 256B        | Abort                                                   |
| eQEP1                                                 |                   | 0xFCF7_9900   | 0xFCF7_99FF | 256B       | 256B        | Abort                                                   |
| eQEP2                                                 |                   | 0xFCF7_9A00   | 0xFCF7_9AFF | 256B       | 256B        | Abort                                                   |
| PCR2 registers                                        | PPSE[4] - PPSE[5] | 0xFCFF_1000   | 0xFCFF_17FF | 2KB        | 2KB         | Reads return zeros, writes have no effect               |
| NMPU (EMAC)                                           | PPSE[6]           | 0xFCFF_1800   | 0xFCFF_18FF | 512B       | 512B        | Abort                                                   |
| EMIF Registers                                        | PPS[2]            | 0xFCFF_E800   | 0xFCFF_E8FF | 256B       | 256B        | Abort                                                   |
| Cyclic Redundancy Checker (CRC) Module Register Frame |                   |               |             |            |             |                                                         |
| CRC1                                                  |                   | 0xFE00_0000   | 0xFEFF_FFFF | 16MB       | 512KB       | Accesses above 0xFE000200 generate abort.               |
| CRC2                                                  |                   | 0xFB00_0000   | 0xFBFF_FFFF | 16MB       | 512KB       | Accesses above 0xFB000200 generate abort.               |

表 7-25. Module Registers / Memories Memory Map (续)

| TARGET NAME                                     | MEMORY SELECT | ADDRESS RANGE |             | FRAME SIZE | ACTUAL SIZE | RESPONSE FOR ACCESS TO UNIMPLEMENTED LOCATIONS IN FRAME                                                                                                                                                            |
|-------------------------------------------------|---------------|---------------|-------------|------------|-------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
|                                                 |               | START         | END         |            |             |                                                                                                                                                                                                                    |
| Memories under User PCR3 (Peripheral Segment 3) |               |               |             |            |             |                                                                                                                                                                                                                    |
| MIBSPI5 RAM                                     | PCS[5]        | 0xFF0A_0000   | 0xFF0B_FFFF | 128KB      | 2KB         | Abort for accesses above 2KB                                                                                                                                                                                       |
| MIBSPI4 RAM                                     | PCS[3]        | 0xFF06_0000   | 0xFF07_FFFF | 128KB      | 2KB         | Abort for accesses above 2KB                                                                                                                                                                                       |
| MIBSPI3 RAM                                     | PCS[6]        | 0xFF0C_0000   | 0xFF0D_FFFF | 128KB      | 2KB         | Abort for accesses above 2KB                                                                                                                                                                                       |
| MIBSPI2 RAM                                     | PCS[4]        | 0xFF08_0000   | 0xFF09_FFFF | 128KB      | 2KB         | Abort for accesses above 2KB                                                                                                                                                                                       |
| MIBSPI1 RAM                                     | PCS[7]        | 0xFF0E_0000   | 0xFF0F_FFFF | 128KB      | 4KB         | Abort for accesses above 4KB                                                                                                                                                                                       |
| DCAN4 RAM                                       | PCS[12]       | 0xFF18_0000   | 0xFF19_FFFF | 128KB      | 8KB         | Abort generated for accesses beyond offset 0x2000                                                                                                                                                                  |
| DCAN3 RAM                                       | PCS[13]       | 0xFF1A_0000   | 0xFF1B_FFFF | 128KB      | 8KB         | Abort generated for accesses beyond offset 0x2000                                                                                                                                                                  |
| DCAN2 RAM                                       | PCS[14]       | 0xFF1C_0000   | 0xFF1D_FFFF | 128KB      | 8KB         | Abort generated for accesses beyond offset 0x2000                                                                                                                                                                  |
| DCAN1 RAM                                       | PCS[15]       | 0xFF1E_0000   | 0xFF1F_FFFF | 128KB      | 8KB         | Abort generated for accesses beyond offset 0x2000.                                                                                                                                                                 |
| MIBADC2 RAM                                     | PCS[29]       | 0xFF3A_0000   | 0xFF3B_FFFF | 128KB      | 8KB         | Wrap around for accesses to unimplemented address offsets lower than 0x1FFF.                                                                                                                                       |
| MIBADC1 RAM                                     | PCS[31]       | 0xFF3E_0000   | 0xFF3F_FFFF | 128KB      | 8KB         | Wrap around for accesses to unimplemented address offsets lower than 0x1FFF.                                                                                                                                       |
| MIBADC1 Look-UP Table                           |               |               |             |            | 384 bytes   | Look-Up Table for ADC1 wrapper. Starts at address offset 0x2000 and ends at address offset 0x217F. Wrap around for accesses between offsets 0x0180 and 0x3FFF. Abort generation for accesses beyond offset 0x4000. |
| NHET2 RAM                                       | PCS[34]       | 0xFF44_0000   | 0xFF45_FFFF | 128KB      | 16KB        | Wrap around for accesses to unimplemented address offsets lower than 0x3FFF. Abort generated for accesses beyond 0x3FFF.                                                                                           |
| NHET1 RAM                                       | PCS[35]       | 0xFF46_0000   | 0xFF47_FFFF | 128KB      | 16KB        | Wrap around for accesses to unimplemented address offsets lower than 0x3FFF. Abort generated for accesses beyond 0x3FFF.                                                                                           |
| HET TU2 RAM                                     | PCS[38]       | 0xFF4C_0000   | 0xFF4D_FFFF | 128KB      | 1KB         | Abort                                                                                                                                                                                                              |

**表 7-25. Module Registers / Memories Memory Map (续)**

| TARGET NAME                                 | MEMORY SELECT | ADDRESS RANGE |             | FRAME SIZE | ACTUAL SIZE | RESPONSE FOR ACCESS TO UNIMPLEMENTED LOCATIONS IN FRAME |
|---------------------------------------------|---------------|---------------|-------------|------------|-------------|---------------------------------------------------------|
|                                             |               | START         | END         |            |             |                                                         |
| HET TU1 RAM                                 | PCS[39]       | 0xFF4E_0000   | 0xFF4F_FFFF | 128KB      | 1KB         | Abort                                                   |
| FlexRay TU RAM                              | PCS[40]       | 0xFF50_0000   | 0xFF51_FFFF | 128KB      | 1KB         | Abort                                                   |
| CoreSight Debug Components                  |               |               |             |            |             |                                                         |
| CoreSight Debug ROM                         | CSCS[0]       | 0xFFA0_0000   | 0xFFA0_0FFF | 4KB        | 4KB         | Reads return zeros, writes have no effect               |
| Cortex-R5F Debug                            | CSCS[1]       | 0xFFA0_1000   | 0xFFA0_1FFF | 4KB        | 4KB         | Reads return zeros, writes have no effect               |
| ETM-R5                                      | CSCS[2]       | 0xFFA0_2000   | 0xFFA0_2FFF | 4KB        | 4KB         | Reads return zeros, writes have no effect               |
| CoreSight TPIU                              | CSCS[3]       | 0xFFA0_3000   | 0xFFA0_3FFF | 4KB        | 4KB         | Reads return zeros, writes have no effect               |
| POM                                         | CSCS[4]       | 0xFFA0_4000   | 0xFFA0_4FFF | 4KB        | 4KB         | Reads return zeros, writes have no effect               |
| CTI1                                        | CSCS[7]       | 0xFFA0_7000   | 0xFFA0_7FFF | 4KB        | 4KB         | Reads return zeros, writes have no effect               |
| CTI3                                        | CSCS[9]       | 0xFFA0_9000   | 0xFFA0_9FFF | 4KB        | 4KB         | Reads return zeros, writes have no effect               |
| CTI4                                        | CSCS[10]      | 0xFFA0_A000   | 0xFFA0_AFFF | 4KB        | 4KB         | Reads return zeros, writes have no effect               |
| CSTF                                        | CSCS[11]      | 0xFFA0_B000   | 0xFFA0_BFFF | 4KB        | 4KB         | Reads return zeros, writes have no effect               |
| Registers under PCR3 (Peripheral Segment 3) |               |               |             |            |             |                                                         |
| PCR3 registers                              | PS[31:30]     | 0xFFF7_8000   | 0xFFF7_87FF | 2KB        | 2KB         | Reads return zeros, writes have no effect               |
| FTU                                         | PS[23]        | 0xFFF7_A000   | 0xFFF7_A1FF | 512B       | 512B        | Reads return zeros, writes have no effect               |
| HTU1                                        | PS[22]        | 0xFFF7_A400   | 0xFFF7_A4FF | 256B       | 256B        | Abort                                                   |
| HTU2                                        | PS[22]        | 0xFFF7_A500   | 0xFFF7_A5FF | 256B       | 256B        | Abort                                                   |
| NHET1                                       | PS[17]        | 0xFFF7_B800   | 0xFFF7_B8FF | 256B       | 256B        | Reads return zeros, writes have no effect               |
| NHET2                                       | PS[17]        | 0xFFF7_B900   | 0xFFF7_B9FF | 256B       | 256B        | Reads return zeros, writes have no effect               |
| GIO                                         | PS[16]        | 0xFFF7_BC00   | 0xFFF7_BCFF | 256B       | 256B        | Reads return zeros, writes have no effect               |
| MIBADC1                                     | PS[15]        | 0xFFF7_C000   | 0xFFF7_C1FF | 512B       | 512B        | Reads return zeros, writes have no effect               |
| MIBADC2                                     | PS[15]        | 0xFFF7_C200   | 0xFFF7_C3FF | 512B       | 512B        | Reads return zeros, writes have no effect               |
| FlexRay                                     | PS[12]+PS[13] | 0xFFF7_C800   | 0xFFF7_CFFF | 2KB        | 2KB         | Reads return zeros, writes have no effect               |
| I2C1                                        | PS[10]        | 0xFFF7_D400   | 0xFFF7_D4FF | 256B       | 256B        | Reads return zeros, writes have no effect               |
| I2C2                                        | PS[10]        | 0xFFF7_D500   | 0xFFF7_D5FF | 256B       | 256B        | Reads return zeros, writes have no effect               |
| DCAN1                                       | PS[8]         | 0xFFF7_DC00   | 0xFFF7_DDFF | 512B       | 512B        | Reads return zeros, writes have no effect               |
| DCAN2                                       | PS[8]         | 0xFFF7_DE00   | 0xFFF7_DFFF | 512B       | 512B        | Reads return zeros, writes have no effect               |
| DCAN3                                       | PS[7]         | 0xFFF7_E000   | 0xFFF7_E1FF | 512B       | 512B        | Reads return zeros, writes have no effect               |
| DCAN4                                       | PS[7]         | 0xFFF7_E200   | 0xFFF7_E3FF | 512B       | 512B        | Reads return zeros, writes have no effect               |
| LIN1                                        | PS[6]         | 0xFFF7_E400   | 0xFFF7_E4FF | 256B       | 256B        | Reads return zeros, writes have no effect               |

表 7-25. Module Registers / Memories Memory Map (续)

| TARGET NAME                                                                     | MEMORY SELECT     | ADDRESS RANGE |             | FRAME SIZE | ACTUAL SIZE | RESPONSE FOR ACCESS TO UNIMPLEMENTED LOCATIONS IN FRAME                      |
|---------------------------------------------------------------------------------|-------------------|---------------|-------------|------------|-------------|------------------------------------------------------------------------------|
|                                                                                 |                   | START         | END         |            |             |                                                                              |
| SCI3                                                                            | PS[6]             | 0xFFF7_E500   | 0xFFF7_E5FF | 256B       | 256B        | Reads return zeros, writes have no effect                                    |
| LIN2                                                                            | PS[6]             | 0xFFF7_E600   | 0xFFF7_E6FF | 256B       | 256B        | Reads return zeros, writes have no effect                                    |
| SCI4                                                                            | PS[6]             | 0xFFF7_E700   | 0xFFF7_E7FF | 256B       | 256B        | Reads return zeros, writes have no effect                                    |
| MibSPI1                                                                         | PS[2]             | 0xFFF7_F400   | 0xFFF7_F5FF | 512B       | 512B        | Reads return zeros, writes have no effect                                    |
| MibSPI2                                                                         | PS[2]             | 0xFFF7_F600   | 0xFFF7_F7FF | 512B       | 512B        | Reads return zeros, writes have no effect                                    |
| MibSPI3                                                                         | PS[1]             | 0xFFF7_F800   | 0xFFF7_F9FF | 512B       | 512B        | Reads return zeros, writes have no effect                                    |
| MibSPI4                                                                         | PS[1]             | 0xFFF7_FA00   | 0xFFF7_FBFF | 512B       | 512B        | Reads return zeros, writes have no effect                                    |
| MibSPI5                                                                         | PS[0]             | 0xFFF7_FC00   | 0xFFF7_FDFD | 512B       | 512B        | Reads return zeros, writes have no effect                                    |
| System Modules Control Registers and Memories under PCR1 (Peripheral Segment 1) |                   |               |             |            |             |                                                                              |
| DMA RAM                                                                         | PPCS[0]           | 0xFFF8_0000   | 0xFFF8_0FFF | 4KB        | 4KB         | Abort                                                                        |
| VIM RAM                                                                         | PPCS[2]           | 0xFFF8_2000   | 0xFFF8_2FFF | 4KB        | 4KB         | Wrap around for accesses to unimplemented address offsets lower than 0x2FFF. |
| RTP RAM                                                                         | PPCS[3]           | 0xFFF8_3000   | 0xFFF8_3FFF | 4KB        | 4KB         | Abort                                                                        |
| Flash Wrapper                                                                   | PPCS[7]           | 0xFFF8_7000   | 0xFFF8_7FFF | 4KB        | 4KB         | Abort                                                                        |
| eFuse Farm Controller                                                           | PPCS[12]          | 0xFFF8_C000   | 0xFFF8_CFFF | 4KB        | 4KB         | Abort                                                                        |
| Power Domain Control (PMM)                                                      | PPSE[0]           | 0xFFFF_0000   | 0xFFFF_01FF | 512B       | 512B        | Abort                                                                        |
| FMTM<br>Note: This module is only used by TI during test                        | PPSE[1]           | 0xFFFF_0400   | 0xFFFF_05FF | 512B       | 512B        | Reads return zeros, writes have no effect                                    |
| STC2 (NHET1/2)                                                                  | PPSE[2]           | 0xFFFF_0800   | 0xFFFF_08FF | 256B       | 256B        | Reads return zeros, writes have no effect                                    |
| SCM                                                                             | PPSE[2]           | 0xFFFF_0A00   | 0xFFFF_0AFF | 256B       | 256B        | Abort                                                                        |
| EPC                                                                             | PPSE[3]           | 0xFFFF_0C00   | 0xFFFF_0FFF | 1KB        | 1KB         | Abort                                                                        |
| PCR1 registers                                                                  | PPSE[4] - PPSE[5] | 0xFFFF_1000   | 0xFFFF_17FF | 2KB        | 2KB         | Reads return zeros, writes have no effect                                    |
| NMPU (PS_SCR_S)                                                                 | PPSE[6]           | 0xFFFF_1800   | 0xFFFF_19FF | 512B       | 512B        | Abort                                                                        |
| NMPU (DMA Port A)                                                               | PPSE[6]           | 0xFFFF_1A00   | 0xFFFF_1BFF | 512B       | 512B        | Abort                                                                        |
| Pin Mux Control (IOMM)                                                          | PPSE[7]           | 0xFFFF_1C00   | 0xFFFF_1FFF | 2KB        | 1KB         | Reads return zeros, writes have no effect                                    |
| System Module - Frame 2<br>(see the TRM <a href="#">SPNU563</a> )               | PPS[0]            | 0xFFFF_E100   | 0xFFFF_E1FF | 256B       | 256B        | Reads return zeros, writes have no effect                                    |
| PBIST                                                                           | PPS[1]            | 0xFFFF_E400   | 0xFFFF_E5FF | 512B       | 512B        | Reads return zeros, writes have no effect                                    |
| STC1 (Cortex-R5F)                                                               | PPS[1]            | 0xFFFF_E600   | 0xFFFF_E6FF | 256B       | 256B        | Reads return zeros, writes have no effect                                    |
| DCC1                                                                            | PPS[3]            | 0xFFFF_EC00   | 0xFFFF_ECFF | 256B       | 256B        | Reads return zeros, writes have no effect                                    |
| DMA                                                                             | PPS[4]            | 0xFFFF_F000   | 0xFFFF_F3FF | 1KB        | 1KB         | Abort                                                                        |
| DCC2                                                                            | PPS[5]            | 0xFFFF_F400   | 0xFFFF_F4FF | 256B       | 256B        | Reads return zeros, writes have no effect                                    |
| ESM register                                                                    | PPS[5]            | 0xFFFF_F500   | 0xFFFF_F5FF | 256B       | 256B        | Reads return zeros, writes have no effect                                    |
| CCM-R5F                                                                         | PPS[5]            | 0xFFFF_F600   | 0xFFFF_F6FF | 256B       | 256B        | Reads return zeros, writes have no effect                                    |

**表 7-25. Module Registers / Memories Memory Map (续)**

| TARGET NAME                                                       | MEMORY SELECT | ADDRESS RANGE |             | FRAME SIZE | ACTUAL SIZE | RESPONSE FOR ACCESS TO UNIMPLEMENTED LOCATIONS IN FRAME |
|-------------------------------------------------------------------|---------------|---------------|-------------|------------|-------------|---------------------------------------------------------|
|                                                                   |               | START         | END         |            |             |                                                         |
| DMM                                                               | PPS[5]        | 0xFFFF_F700   | 0xFFFF_F7FF | 256B       | 256B        | Reads return zeros, writes have no effect               |
| L2RAMW                                                            | PPS[6]        | 0xFFFF_F900   | 0xFFFF_F9FF | 256B       | 256B        | Abort                                                   |
| RTP                                                               | PPS[6]        | 0xFFFF_FA00   | 0xFFFF_FAFF | 256B       | 256B        | Reads return zeros, writes have no effect               |
| RTI + DWWD                                                        | PPS[7]        | 0xFFFF_FC00   | 0xFFFF_FCFE | 256B       | 256B        | Reads return zeros, writes have no effect               |
| VIM                                                               | PPS[7]        | 0xFFFF_FD00   | 0xFFFF_FEFF | 512B       | 512B        | Reads return zeros, writes have no effect               |
| System Module - Frame 1<br>(see the TRM <a href="#">SPNU563</a> ) | PPS[7]        | 0xFFFF_FF00   | 0xFFFF_FFFF | 256B       | 256B        | Reads return zeros, writes have no effect               |

### 7.9.3 Special Consideration for CPU Access Errors Resulting in Imprecise Aborts

Any CPU write access to a Normal or Device type memory, which generates a fault, will generate an imprecise abort. The imprecise abort exception is disabled by default and must be enabled for the CPU to handle this exception. The imprecise abort handling is enabled by clearing the "A" bit in the CPU program status register (CPSR).

### 7.9.4 Master/Slave Access Privileges

表 7-26 和 表 7-27 list the access permissions for each bus master on the device. A bus master is a module that can initiate a read or a write transaction on the device.

Each slave module on either the CPU Interconnect Subsystem or the Peripheral Interconnect Subsystem is listed in 表 7-27. Allowed indicates that the module listed in the MASTERS column can access that slave module.

**表 7-26. Bus Master / Slave Access Matrix for CPU Interconnect Subsystem**

| MASTERS   | SLAVES ON CPU INTERCONNECT SUBSYSTEM |             |         |              |             |
|-----------|--------------------------------------|-------------|---------|--------------|-------------|
|           | L2 Flash OTP, ECC, Bank 7 (EEPROM)   | L2 FLASH    | L2 SRAM | CACHE MEMORY | EMIF        |
| CPU Read  | Allowed                              | Allowed     | Allowed | Allowed      | Allowed     |
| CPU Write | Not allowed                          | Not allowed | Allowed | Allowed      | Allowed     |
| DMA PortA | Allowed                              | Allowed     | Allowed | Not allowed  | Allowed     |
| POM       | Not allowed                          | Not allowed | Allowed | Not allowed  | Allowed     |
| PS_SCR_M  | Allowed                              | Allowed     | Allowed | Not allowed  | Allowed     |
| ACP_M     | Not allowed                          | Not Allowed | Allowed | Not allowed  | Not allowed |

**表 7-27. Bus Master / Slave Access Matrix for Peripheral Interconnect Subsystem**

| MASTER ID TO PCR <sub>x</sub> | MASTERS   | SLAVES ON PERIPHERAL INTERCONNECT SUBSYSTEM |                               |                      |                                                       |
|-------------------------------|-----------|---------------------------------------------|-------------------------------|----------------------|-------------------------------------------------------|
|                               |           | CRC1/CRC2                                   | Resources Under PCR2 and PCR3 | Resources Under PCR1 | CPU Interconnect Subsystem SDC MMR Port (see 节 7.9.6) |
| 0                             | CPU Read  | Allowed                                     | Allowed                       | Allowed              | Allowed                                               |
|                               | CPU Write | Allowed                                     | Allowed                       | Allowed              | Allowed                                               |
| 1                             | Reserved  | –                                           | –                             | –                    | –                                                     |
| 2                             | DMA PortB | Allowed                                     | Allowed                       | Allowed              | Not allowed                                           |
| 3                             | HTU1      | Not allowed                                 | Not allowed                   | Not allowed          | Not allowed                                           |
| 4                             | HTU2      | Not allowed                                 | Not allowed                   | Not allowed          | Not allowed                                           |
| 5                             | FTU       | Not allowed                                 | Not allowed                   | Not allowed          | Not allowed                                           |
| 7                             | DMM       | Allowed                                     | Allowed                       | Allowed              | Allowed                                               |
| 9                             | DAP       | Allowed                                     | Allowed                       | Allowed              | Allowed                                               |
| 10                            | EMAC      | Not allowed                                 | Allowed                       | Not allowed          | Not allowed                                           |

#### 7.9.4.1 Special Notes on Accesses to Certain Slaves

By design only the CPU and debugger can have privileged write access to peripherals under the PCR1 segment. The other masters can only read from these registers.

The master-id filtering check is implemented inside each PCR module of each peripheral segment and can be used to block certain masters from write accesses to certain peripherals. An unauthorized master write access detected by the PCR will result in the transaction being discarded and an error being generated to the ESM module.

The device contains dedicated logic to generate a bus error response on any access to a module that is in a power domain that has been turned off.

### 7.9.5 MasterID to PCR<sub>x</sub>

The MasterID associated with each master port on the Peripheral Interconnect Subsystem contains a 4-bit value. The MasterID is passed along with the address and control signals to three PCR modules. PCR decodes the address and control signals to select the peripheral. In addition, it decodes this 4-bit MasterID value to perform

memory protection. With 4-bit of MasterID, it allows the PCR to distinguish among 16 different masters to allow or disallow access to a given peripheral. Associated with each peripheral a 16-bit MasterID access protection register is defined. Each bit grants or denies the permission of the corresponding binary coded decimal MasterID. For example, if bit 5 of the access permission register is set, it grants MasterID 5 to access the peripheral. If bit 7 is clear, it denies MasterID 7 to access the peripheral. 图 7-10 shows the MasterID filtering scheme. 表 7-27 lists the MasterID of each master, which can access the PCRx.

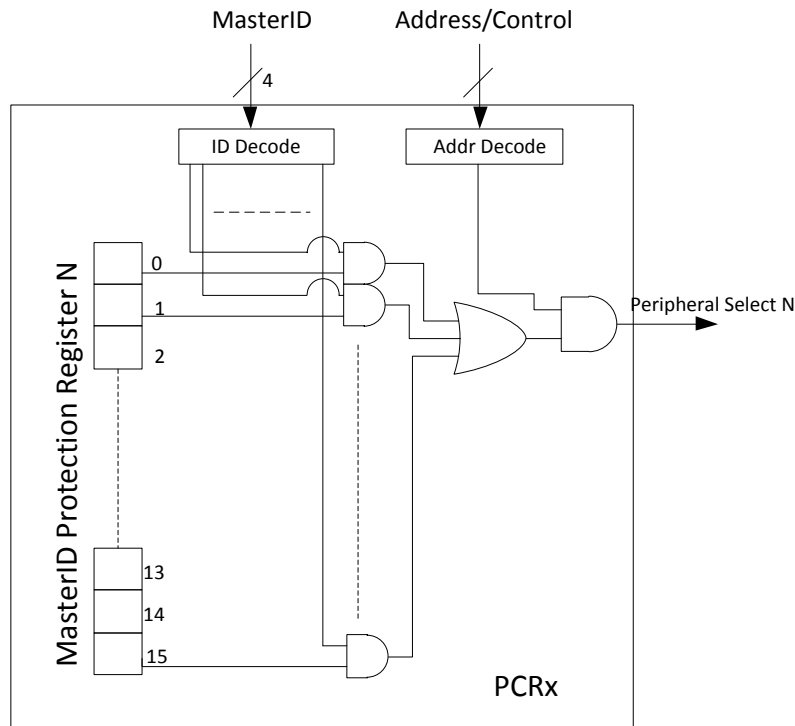


图 7-10. PCR MasterID Filtering

### 7.9.6 CPU Interconnect Subsystem SDC MMR Port

The CPU Interconnect Subsystem SDC MMR Port is a special slave to the Peripheral Interconnect Subsystem. It is memory mapped at starting address of 0xFA00\_0000. Various status registers pertaining to the diagnostics of the CPU Interconnect Subsystem can be access through this slave port. The CPU Interconnect Subsystem contains built-in hardware diagnostic checkers which will constantly watch transactions flowing through the interconnect. There is a checker for each master and slave attached to the CPU Interconnect Subsystem. The checker checks the expected behavior against the generated behavior by the interconnect. For example, if the CPU issues a burst read request to the flash, the checker will ensure that the expected behavior is indeed a burst read request to the proper slave module. If the interconnects generates a transaction which is not a read, or not a burst or not to the flash as the destination, then the checker will flag it one of the registers. The detected error will also be signaled to the ESM module. Refer to the Interconnect chapter of the TRM [SPNU563](#) for details on the registers.

表 7-28. CPU Interconnect Subsystem SDC Register Bit Field Mapping

| Register name              | bit 0          | bit 1                   | bit 2                   | bit 3    | bit 4     | bit 5     | bit 6    | Remark                                                                                                                                                                                                                                                                                    |
|----------------------------|----------------|-------------------------|-------------------------|----------|-----------|-----------|----------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| ERR_GENERIC_PARITY         | PS_SCR_M       | POM                     | DMA_PORTA               | Reserved | CPU AXI-M | ACP-M     | Reserved | <ul style="list-style-type: none"> <li>Each bit indicates the transaction processing block inside the interconnect corresponding to the master that is detected by the interconnect checker to have a fault.</li> <li>error related to parity mismatch in the incoming address</li> </ul> |
| ERR_UNEXPECTED_TRANSACTION | PS_SCR_M       | POM                     | DMA_PORTA               | Reserved | CPU AXI-M | ACP-M     | Reserved | <ul style="list-style-type: none"> <li>error related to unexpected transaction sent by the master</li> </ul>                                                                                                                                                                              |
| ERR_TRANS_ID               | PS_SCR_M       | POM                     | DMA_PORTA               | Reserved | CPU AXI-M | ACP-M     | Reserved | <ul style="list-style-type: none"> <li>error related to mismatch on the transaction ID</li> </ul>                                                                                                                                                                                         |
| ERR_TRANS_SIGNATURE        | PS_SCR_M       | POM                     | DMA_PORTA               | Reserved | CPU AXI-M | ACP-M     | Reserved | <ul style="list-style-type: none"> <li>error related to mismatch on the transaction signature</li> </ul>                                                                                                                                                                                  |
| ERR_TRANS_TYPE             | PS_SCR_M       | POM                     | DMA_PORTA               | Reserved | CPU AXI-M | ACP-M     | Reserved | <ul style="list-style-type: none"> <li>error related to mismatch on the transaction type</li> </ul>                                                                                                                                                                                       |
| ERR_USER_PARITY            | PS_SCR_M       | POM                     | DMA_PORTA               | Reserved | CPU AXI-M | ACP-M     | Reserved | <ul style="list-style-type: none"> <li>error related to mismatch on the parity</li> </ul>                                                                                                                                                                                                 |
| SERR_UNEXPECTED_MID        | L2 RAM Wrapper | L2 Flash Wrapper Port A | L2 Flash Wrapper Port B | EMIF     | Reserved  | CPU AXI-S | ACP-S    | <ul style="list-style-type: none"> <li>Each bit indicates the transaction processing block inside the interconnect corresponding to the slave that is detected by the interconnect checker to have a fault.</li> <li>error related to mismatch on the master ID</li> </ul>                |
| SERR_ADDR_DECODE           | L2 RAM Wrapper | L2 Flash Wrapper Port A | L2 Flash Wrapper Port B | EMIF     | Reserved  | CPU AXI-S | ACP-S    | <ul style="list-style-type: none"> <li>error related to mismatch on the most significant address bits</li> </ul>                                                                                                                                                                          |
| SERR_USER_PARITY           | L2 RAM Wrapper | L2 Flash Wrapper Port A | L2 Flash Wrapper Port B | EMIF     | Reserved  | CPU AXI-S | ACP-S    | <ul style="list-style-type: none"> <li>error related to mismatch on the parity of the most significant address bits</li> </ul>                                                                                                                                                            |

### 7.9.7 Parameter Overlay Module (POM) Considerations

The Parameter Overlay Module (POM) is implemented as part of the L2FMC module. It is used to redirect flash memory accesses to external memory interfaces or internal SRAM. The POM has an OCP master port to redirect accesses. The POM MMRs are located in a separate block and read/writes will happen through the Debug APB port on the L2FMC. The POM master port is capable of read accesses only. Inside the CPU Subsystem SCR, the POM master port is connected to both the L2RAMW and EMIF slaves. The primary roles of the POM are:

- The POM snoops the access on the two flash slave ports to determine if access should be remapped or not. It supports 32 regions among the two slave ports.
- If access is to be remapped, then the POM kills the access to the flash bank, and instead redirects the access through its own master.
- Upon obtaining response, the POM populates the response FIFO of the respective port so that the response is delivered back to the original requester.
- The access is unaffected if the request is not mapped to any region, or if the POM is disabled.
- The POM does not add any latency to the flash access when it is turned off.
- The POM does not add any latency to the remapped access (except the latency, if any, associated with the getting the response from the an alternate slave)

## 7.10 Flash Memory

### 7.10.1 Flash Memory Configuration

**Flash Bank:** A separate block of logic consisting of 1 to 16 sectors. Each flash bank normally has a customer-OTP and a TI-OTP area. These flash sectors share input/output buffers, data paths, sense amplifiers, and control logic.

**Flash Sector:** A contiguous region of flash memory which must be erased simultaneously due to physical construction constraints.

**Flash Pump:** A charge pump which generates all the voltages required for reading, programming, or erasing the flash banks.

**Flash Module:** Interface circuitry required between the host CPU and the flash banks and pump module.

表 7-29. Flash Memory Banks and Sectors

| MEMORY ARRAYS (OR BANKS) | SECTOR NO. | SEGMENT | LOW ADDRESS | HIGH ADDRESS |
|--------------------------|------------|---------|-------------|--------------|
| BANK0 (2.0MB)            | 0          | 16KB    | 0x0000_0000 | 0x0000_3FFF  |
|                          | 1          | 16KB    | 0x0000_4000 | 0x0000_7FFF  |
|                          | 2          | 16KB    | 0x0000_8000 | 0x0000_BFFF  |
|                          | 3          | 16KB    | 0x0000_C000 | 0x0000_FFFF  |
|                          | 4          | 16KB    | 0x0001_0000 | 0x0001_3FFF  |
|                          | 5          | 16KB    | 0x0001_4000 | 0x0001_7FFF  |
|                          | 6          | 32KB    | 0x0001_8000 | 0x0001_FFFF  |
|                          | 7          | 128KB   | 0x0002_0000 | 0x0003_FFFF  |
|                          | 8          | 128KB   | 0x0004_0000 | 0x0005_FFFF  |
|                          | 9          | 128KB   | 0x0006_0000 | 0x0007_FFFF  |
|                          | 10         | 256KB   | 0x0008_0000 | 0x000B_FFFF  |
|                          | 11         | 256KB   | 0x000C_0000 | 0x000F_FFFF  |
|                          | 12         | 256KB   | 0x0010_0000 | 0x0013_FFFF  |
|                          | 13         | 256KB   | 0x0014_0000 | 0x0017_FFFF  |
|                          | 14         | 256KB   | 0x0018_0000 | 0x001B_FFFF  |
|                          | 15         | 256KB   | 0x001C_0000 | 0x001F_FFFF  |
| BANK1 (2.0MB)            | 0          | 128KB   | 0x0020_0000 | 0x0021_FFFF  |
|                          | 1          | 128KB   | 0x0022_0000 | 0x0023_FFFF  |
|                          | 2          | 128KB   | 0x0024_0000 | 0x0025_FFFF  |
|                          | 3          | 128KB   | 0x0026_0000 | 0x0027_FFFF  |
|                          | 4          | 128KB   | 0x0028_0000 | 0x0029_FFFF  |
|                          | 5          | 128KB   | 0x002A_0000 | 0x002B_FFFF  |
|                          | 6          | 128KB   | 0x002C_0000 | 0x002D_FFFF  |
|                          | 7          | 128KB   | 0x002E_0000 | 0x002F_FFFF  |
|                          | 8          | 128KB   | 0x0030_0000 | 0x0031_FFFF  |
|                          | 9          | 128KB   | 0x0032_0000 | 0x0033_FFFF  |
|                          | 10         | 128KB   | 0x0034_0000 | 0x0035_FFFF  |
|                          | 11         | 128KB   | 0x0036_0000 | 0x0037_FFFF  |
|                          | 12         | 128KB   | 0x0038_0000 | 0x0039_FFFF  |
|                          | 13         | 128KB   | 0x003A_0000 | 0x003B_FFFF  |
|                          | 14         | 128KB   | 0x003C_0000 | 0x003D_FFFF  |
|                          | 15         | 128KB   | 0x003E_0000 | 0x003F_FFFF  |

**表 7-30. EEPROM Flash Bank**

| MEMORY ARRAYS (OR BANKS)           | SECTOR NO. | SEGMENT | LOW ADDRESS | HIGH ADDRESS |
|------------------------------------|------------|---------|-------------|--------------|
| BANK7 (128KB) for EEPROM emulation | 0          | 4KB     | 0xF020_0000 | 0xF020_0FFF  |
|                                    | "          | "       | "           | "            |
|                                    | "          | "       | "           | "            |
|                                    | 31         | 4KB     | 0xF021_F000 | 0xF021_FFFF  |

### 7.10.2 Main Features of Flash Module

- Support for multiple flash banks for program and/or data storage
- Simultaneous read accesses on two banks while performing program or erase operation on any other bank
- Integrated state machines to automate flash erase and program operations
- Software interface for flash program and erase operations
- Pipelined mode operation to improve instruction access interface bandwidth
- Support for Single Error Correction Double Error Detection (SECCDED) block inside Cortex-R5F CPU
- Support for a rich set of diagnostic features

### 7.10.3 ECC Protection for Flash Accesses

All accesses to the L2 program flash memory are protected by SECCDED logic embedded inside the CPU. The flash module provides 8 bits of ECC code for 64 bits of instructions or data fetched from the flash memory. The CPU calculates the expected ECC code based on the 64 bits data received and compares it with the ECC code returned by the flash module. A single-bit error is corrected and flagged by the CPU, while a multibit error is only flagged. The CPU signals an ECC error through its Event bus. This signaling mechanism is not enabled by default and must be enabled by setting the 'X' bit of the Performance Monitor Control Register, c9.

```
MRC p15,#0,r1,c9,c12,#0      ;Enabling Event monitor states
ORR r1, r1, #0x00000010
MCR p15,#0,r1,c9,c12,#0      ;Set 4th bit ('X') of PMNC register
MRC p15,#0,r1,c9,c12,#0
```

#### 备注

ECC is permanently enabled in the CPU L2 interface.

### 7.10.4 Flash Access Speeds

For information on flash memory access speeds and the relevant wait states required, refer to [节 6.6, Wait States Required - L2 Memories](#).

## 7.10.5 Flash Program and Erase Timings

### 7.10.5.1 Flash Program and Erase Timings for Program Flash

表 7-31. Timing Requirements for Program Flash

|                                   |                                                            |                                  | MIN | NOM | MAX  | UNIT          |
|-----------------------------------|------------------------------------------------------------|----------------------------------|-----|-----|------|---------------|
| $t_{\text{prog}}(288\text{bits})$ | Wide Word (288-bits) programming time                      |                                  |     | 40  | 300  | $\mu\text{s}$ |
| $t_{\text{prog}}(\text{Total})$   | 4.0MB programming time <sup>(1)</sup>                      | – 40°C to 125°C                  |     |     | 21.3 | s             |
|                                   |                                                            | 0°C to 60°C, for first 25 cycles |     | 5.3 | 10.6 | s             |
| $t_{\text{erase}}$                | Sector/Bank erase time                                     | – 40°C to 125°C                  |     | 0.3 | 4    | s             |
|                                   |                                                            | 0°C to 60°C, for first 25 cycles |     |     | 100  | ms            |
| $t_{\text{wec}}$                  | Write/erase cycles with 15-year Data Retention requirement |                                  |     |     | 1000 | cycles        |

(1) This programming time includes overhead of state machine, but does not include data transfer time. The programming time assumes programming 288 bits at a time at the maximum specified operating frequency.

### 7.10.5.2 Flash Program and Erase Timings for Data Flash

表 7-32. Timing Requirements for Data Flash

|                                                                                   |                                                                 |                                  | MIN | NOM | MAX    | UNIT          |
|-----------------------------------------------------------------------------------|-----------------------------------------------------------------|----------------------------------|-----|-----|--------|---------------|
| $t_{\text{prog}}(72\text{bits})$                                                  | Wide Word (72-bits) programming time                            |                                  |     | 47  | 300    | $\mu\text{s}$ |
| $t_{\text{prog}}(\text{Total})$                                                   | EEPROM Emulation (bank 7) 128KB programming time <sup>(1)</sup> | – 40°C to 125°C                  |     |     | 2.6    | s             |
|                                                                                   |                                                                 | 0°C to 60°C, for first 25 cycles |     | 775 | 1320   | ms            |
| EEPROM Emulation (bank 7) Sector/Bank erase time $t_{\text{erase}}(\text{bank7})$ |                                                                 | – 40°C to 125°C                  |     | 0.2 | 8      | s             |
|                                                                                   |                                                                 | 0°C to 60°C, for first 25 cycles |     | 14  | 100    | ms            |
| $t_{\text{wec}}$                                                                  | Write/erase cycles with 15-year Data Retention requirement      |                                  |     |     | 100000 | cycles        |

(1) This programming time includes overhead of state machine, but does not include data transfer time. The programming time assumes programming 72 bits at a time at the maximum specified operating frequency.

## 7.11 L2RAMW (Level 2 RAM Interface Module)

L2RAMW is the TMS570 level two RAM wrapper. Major features implemented in this device include:

- Supports 512KB of L2 SRAMs
- One 64-bit OCP interface
- Built-in ECC generation and evaluation logic
  - The ECC logic is enabled by default.
  - When enabled, automatic ECC correction on write data from masters on any write sizes (8-,16-,32-,or 64-bit)
  - Less than 64-bit write forces built in read-modify-write
  - When enabled, reads due to read-modify-write go through ECC correction before data merging with the incoming write data
- Redundant address decoding. Same address decode logic block is duplicated and compared to each other
- Data Trace
  - Support tracing of both read and write accesses through RTP module
- Auto initialization of memory banks to known values for both data and their corresponding ECC checksum

### 7.11.1 L2 SRAM Initialization

The entire L2 SRAM can be globally initialized by setting the corresponding bit in SYS.MSINENA register. When initialized, the memory arrays are written with all zeros for the 64-bit data and the corresponding 8-bit ECC checksum. Hardware memory initialization eliminates ECC error when the CPU reads from an un-initialized memory location which can cause an ECC error. For more information, see the device-specific Technical Reference Manual.

## 7.12 ECC / Parity Protection for Accesses to Peripheral RAMs

Accesses to some peripheral RAMs are protected by either odd/even parity checking or ECC checking. During a read access the parity or ECC is calculated based on the data read from the peripheral RAM and compared with the good parity or ECC value stored in the peripheral RAM for that peripheral. If any word fails the parity or ECC check, the module generates a ECC/parity error signal that is mapped to the Error Signaling Module. The module also captures the peripheral RAM address that caused the parity error.

The parity or ECC protection for peripheral RAMs is not enabled by default and must be enabled by the application. Each individual peripheral contains control registers to enable the parity or ECC protection for accesses to its RAM.

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### 备注

For peripherals with parity protection the CPU read access gets the actual data from the peripheral. The application can choose to generate an interrupt whenever a peripheral RAM parity error is detected.

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## 7.13 On-Chip SRAM Initialization and Testing

### 7.13.1 On-Chip SRAM Self-Test Using PBIST

#### 7.13.1.1 Features

- Extensive instruction set to support various memory test algorithms
- ROM-based algorithms allow application to run TI production-level memory tests
- Independent testing of all on-chip SRAM

#### 7.13.1.2 PBIST RAM Groups

表 7-33. PBIST RAM Grouping

| MEMORY               | RAM GROUP | TEST CLOCK    | RGS | RDS   | MEM TYPE | NO. BANKS | TEST PATTERN (ALGORITHM) |                       |                                            |                                               |
|----------------------|-----------|---------------|-----|-------|----------|-----------|--------------------------|-----------------------|--------------------------------------------|-----------------------------------------------|
|                      |           |               |     |       |          |           | TRIPLE READ SLOW READ    | TRIPLE READ FAST READ | March 13N <sup>(1)</sup> TWO PORT (cycles) | March 13N <sup>(1)</sup> SINGLE PORT (cycles) |
|                      |           |               |     |       |          |           | ALGO MASK 0x1            | ALGO MASK 0x2         | ALGO MASK 0x4                              | ALGO MASK 0x8                                 |
| PBIST_ROM            | 1         | GCM_PBIST_ROM | 1   | 1     | ROM      | 1         | 24578                    | 8194                  |                                            |                                               |
| STC1_1_ROM_R5        | 2         | GCM_PBIST_ROM | 14  | 1     | ROM      | 1         | 49154                    | 16386                 |                                            |                                               |
| STC1_2_ROM_R5        | 3         | GCM_PBIST_ROM | 14  | 2     | ROM      | 1         | 49154                    | 16386                 |                                            |                                               |
| STC2_ROM_NHET        | 4         | GCM_PBIST_ROM | 15  | 1     | ROM      | 1         | 46082                    | 15362                 |                                            |                                               |
| AWM1                 | 5         | GCM_VCLKP     | 2   | 1     | 2P       | 1         |                          |                       | 4210                                       |                                               |
| DCAN1                | 6         | GCM_VCLKP     | 3   | 1.6   | 2P       | 2         |                          |                       | 25260                                      |                                               |
| DCAN2                | 7         | GCM_VCLKP     | 4   | 1.6   | 2P       | 2         |                          |                       | 25260                                      |                                               |
| DMA                  | 8         | GCM_HCLK      | 5   | 1.6   | 2P       | 2         |                          |                       | 37740                                      |                                               |
| HTU1                 | 9         | GCM_VCLK2     | 6   | 1.6   | 2P       | 2         |                          |                       | 6540                                       |                                               |
| MIBSPI1              | 10        | GCM_VCLKP     | 8   | 1.4   | 2P       | 2         |                          |                       | 66760                                      |                                               |
| MIBSPI2              | 11        | GCM_VCLKP     | 9   | 1.4   | 2P       | 2         |                          |                       | 33480                                      |                                               |
| MIBSPI3              | 12        | GCM_VCLKP     | 10  | 1.4   | 2P       | 2         |                          |                       | 33480                                      |                                               |
| NHET1                | 13        | GCM_VCLK2     | 11  | 1..12 | 2P       | 4         |                          |                       | 50520                                      |                                               |
| VIM                  | 14        | GCM_VCLK      | 12  | 1..2  | 2P       | 1         |                          |                       | 16740                                      |                                               |
| Reserved             | 15        | -             | -   | -     | -        | -         |                          |                       | -                                          |                                               |
| RTP                  | 16        | GCM_HCLK      | 16  | 1..12 | 2P       | 4         |                          |                       | 50520                                      |                                               |
| ATB <sup>(2)</sup>   | 17        | GCM_GCLK1     | 17  | 1..16 | 2P       | 8         |                          |                       | 133920                                     |                                               |
| AWM2                 | 18        | GCM_VCLKP     | 18  | 1     | 2P       | 1         |                          |                       | 4210                                       |                                               |
| DCAN3                | 19        | GCM_VCLKP     | 19  | 1.6   | 2P       | 2         |                          |                       | 25260                                      |                                               |
| DCAN4                | 20        | GCM_VCLKP     | 20  | 1.6   | 2P       | 2         |                          |                       | 25260                                      |                                               |
| HTU2                 | 21        | GCM_VCLK2     | 21  | 1.6   | 2P       | 2         |                          |                       | 6540                                       |                                               |
| MIBSPI4              | 22        | GCM_VCLKP     | 22  | 1.4   | 2P       | 2         |                          |                       | 33480                                      |                                               |
| MIBSPI5              | 23        | GCM_VCLKP     | 23  | 1.4   | 2P       | 2         |                          |                       | 33480                                      |                                               |
| NHET2                | 24        | GCM_VCLK2     | 24  | 1..12 | 2P       | 4         |                          |                       | 50520                                      |                                               |
| FTU                  | 25        | GCM_VCLKP     | 25  | 1     | 2P       | 1         |                          |                       | 8370                                       |                                               |
| FRAY_INBUF_OUTBUF    | 26        | GCM_VCLKP     | 26  | 1.8   | 2P       | 4         |                          |                       | 33680                                      |                                               |
| CPGMAC_STATE_RX_ADDR | 27        | GCM_VCLK3     | 27  | 1.3   | 2P       | 2         |                          |                       | 6390                                       |                                               |
| CPGMAC_STAT_FIFO     | 28        | GCM_VCLK3     | 27  | 4.6   | 2P       | 3         |                          |                       | 8730                                       |                                               |
| L2RAMW               | 29        | GCM_HCLK      | 7   | 1     | SP       | 4         |                          |                       |                                            | 532580                                        |
|                      |           |               |     | 6     | SP       | 4         |                          |                       |                                            |                                               |

表 7-33. PBIST RAM Grouping (续)

| MEMORY            | RAM GROUP | TEST CLOCK | RGS | RDS   | MEM TYPE | NO. BANKS | TEST PATTERN (ALGORITHM) |                       |                                            |                                               |
|-------------------|-----------|------------|-----|-------|----------|-----------|--------------------------|-----------------------|--------------------------------------------|-----------------------------------------------|
|                   |           |            |     |       |          |           | TRIPLE READ SLOW READ    | TRIPLE READ FAST READ | March 13N <sup>(1)</sup> TWO PORT (cycles) | March 13N <sup>(1)</sup> SINGLE PORT (cycles) |
|                   |           |            |     |       |          |           | ALGO MASK 0x1            | ALGO MASK 0x2         | ALGO MASK 0x4                              | ALGO MASK 0x8                                 |
| L2RAMW            | 30        | GCM_HCLK   | 32  | 1     | SP       | 4         |                          |                       |                                            | 1597740                                       |
|                   |           |            |     | 6     | SP       | 4         |                          |                       |                                            |                                               |
|                   |           |            |     | 11    | SP       | 4         |                          |                       |                                            |                                               |
|                   |           |            |     | 16    | SP       | 4         |                          |                       |                                            |                                               |
|                   |           |            |     | 21    | SP       | 4         |                          |                       |                                            |                                               |
|                   |           |            |     | 26    | SP       | 4         |                          |                       |                                            |                                               |
| R5_ICACHE         | 31        | GCM_GCLK1  | 40  | 1     | SP       | 4         |                          |                       |                                            | 166600                                        |
|                   |           |            |     | 6     | SP       | 4         |                          |                       |                                            |                                               |
|                   |           |            |     | 11    | SP       | 4         |                          |                       |                                            |                                               |
|                   |           |            |     | 16    | SP       | 4         |                          |                       |                                            |                                               |
| R5_DCACHE         | 32        | GCM_GCLK1  | 41  | 1     | SP       | 4         |                          |                       |                                            | 299820                                        |
|                   |           |            |     | 6     | SP       | 4         |                          |                       |                                            |                                               |
|                   |           |            |     | 11    | SP       | 4         |                          |                       |                                            |                                               |
|                   |           |            |     | 16    | SP       | 4         |                          |                       |                                            |                                               |
|                   |           |            |     | 21    | SP       | 4         |                          |                       |                                            |                                               |
|                   |           |            |     | 26    | SP       | 4         |                          |                       |                                            |                                               |
| Reserved          | 33        | GCM_GCLK2  | 43  | 1     | SP       | 4         |                          |                       |                                            | 166600                                        |
|                   |           |            |     | 6     | SP       | 4         |                          |                       |                                            |                                               |
|                   |           |            |     | 11    | SP       | 4         |                          |                       |                                            |                                               |
|                   |           |            |     | 16    | SP       | 4         |                          |                       |                                            |                                               |
| Reserved          | 34        | GCM_GCLK2  | 44  | 1     | SP       | 4         |                          |                       |                                            | 299820                                        |
|                   |           |            |     | 6     | SP       | 4         |                          |                       |                                            |                                               |
|                   |           |            |     | 11    | SP       | 4         |                          |                       |                                            |                                               |
|                   |           |            |     | 16    | SP       | 4         |                          |                       |                                            |                                               |
|                   |           |            |     | 21    | SP       | 4         |                          |                       |                                            |                                               |
|                   |           |            |     | 26    | SP       | 4         |                          |                       |                                            |                                               |
| FRAY_TRBUF_MSGRAM | 35        | GCM_VCLKP  | 26  | 9..11 | SP       | 3         |                          |                       |                                            | 149910                                        |
| CPGMAC_CPPI       | 36        | GCM_VCLK3  | 27  | 7     | SP       | 1         |                          |                       |                                            | 133170                                        |
| R5_DCACHE_Dirty   | 37        | GCM_GCLK1  | 42  | 2     | SP       | 1         |                          |                       |                                            | 16690                                         |
| Reserved          | 38        | -          | -   | -     | -        | -         |                          |                       |                                            | -                                             |

(1) March13N is the only algorithm recommended for application testing of RAM.

(2) ATB RAM is part of the ETM module. PBIST testing of this RAM is limited to 85°C or lower .

Several memory testing algorithms are stored in the PBIST ROM. However, TI only recommends the March13N algorithm for application testing of RAM.

The PBIST ROM clock frequency is limited to the maximum frequency of 82.5 MHz.

The PBIST ROM clock is divided down from HCLK. The divider is selected by programming the ROM\_DIV field of the Memory Self-Test Global Control Register (MSTGCR) at address 0xFFFFF58.

### 7.13.2 On-Chip SRAM Auto Initialization

This microcontroller allows some of the on-chip memories to be initialized through the Memory Hardware Initialization mechanism in the system module. This hardware mechanism allows an application to program the memory arrays with error detection capability to a known state based on their error detection scheme (odd/even parity or ECC).

The MINITGCR register enables the memory initialization sequence, and the MSINENA register selects the memories that are to be initialized.

For more information on these registers, see the device-specific Technical Reference Manual.

The mapping of the different on-chip memories to the specific bits of the MSINENA registers is provided in [表 7-34](#).

**表 7-34. Memory Initialization**

| CONNECTING<br>MODULE <sup>(3) (4)</sup> | ADDRESS RANGE |                | SYS.MSINENA Register<br>Bit # | L2RAMW.MEMINT_ENA<br>Register Bit # <sup>(1)</sup> |
|-----------------------------------------|---------------|----------------|-------------------------------|----------------------------------------------------|
|                                         | BASE ADDRESS  | ENDING ADDRESS |                               |                                                    |
| L2 SRAM                                 | 0x08000000    | 0x0800FFFF     | 0                             | 0                                                  |
| L2 SRAM                                 | 0x08010000    | 0x0801FFFF     | 0                             | 1                                                  |
| L2 SRAM                                 | 0x08020000    | 0x0802FFFF     | 0                             | 2                                                  |
| L2 SRAM                                 | 0x08030000    | 0x0803FFFF     | 0                             | 3                                                  |
| L2 SRAM                                 | 0x08040000    | 0x0804FFFF     | 0                             | 4                                                  |
| L2 SRAM                                 | 0x08050000    | 0x0805FFFF     | 0                             | 5                                                  |
| L2 SRAM                                 | 0x08060000    | 0x0806FFFF     | 0                             | 6                                                  |
| L2 SRAM                                 | 0x08070000    | 0x0807FFFF     | 0                             | 7                                                  |
| MIBSPI5 RAM <sup>(2)</sup>              | 0xFF0A0000    | 0xFF0BFFFF     | 12                            | n/a                                                |
| MIBSPI4 RAM <sup>(2)</sup>              | 0xFF060000    | 0xFF07FFFF     | 19                            | n/a                                                |
| MIBSPI3 RAM <sup>(2)</sup>              | 0xFF0C0000    | 0xFF0DFFFF     | 11                            | n/a                                                |
| MIBSPI2 RAM <sup>(2)</sup>              | 0xFF080000    | 0xFF09FFFF     | 18                            | n/a                                                |
| MIBSPI1 RAM <sup>(2)</sup>              | 0xFF0E0000    | 0xFF0FFFFF     | 7                             | n/a                                                |
| DCAN4 RAM                               | 0xFF180000    | 0xFF19FFFF     | 20                            | n/a                                                |
| DCAN3 RAM                               | 0xFF1A0000    | 0xFF1BFFFF     | 10                            | n/a                                                |
| DCAN2 RAM                               | 0xFF1C0000    | 0xFF1DFFFF     | 6                             | n/a                                                |
| DCAN1 RAM                               | 0xFF1E0000    | 0xFF1FFFFF     | 5                             | n/a                                                |
| MIBADC2 RAM                             | 0xFF3A0000    | 0xFF3BFFFF     | 14                            | n/a                                                |
| MIBADC1 RAM                             | 0xFF3E0000    | 0xFF3FFFFF     | 8                             | n/a                                                |
| NHET2 RAM                               | 0xFF440000    | 0xFF45FFFF     | 15                            | n/a                                                |
| NHET1 RAM                               | 0xFF460000    | 0xFF47FFFF     | 3                             | n/a                                                |
| HET TU2 RAM                             | 0xFF4C0000    | 0xFF4DFFFF     | 16                            | n/a                                                |
| HET TU1 RAM                             | 0xFF4E0000    | 0xFF4FFFFF     | 4                             | n/a                                                |
| DMA RAM                                 | 0xFFF80000    | 0xFFF80FFF     | 1                             | n/a                                                |
| VIM RAM                                 | 0xFFF82000    | 0xFFF82FFF     | 2                             | n/a                                                |
| FlexRay TU RAM                          | 0xFF500000    | 0xFF51FFFF     | 13                            | n/a                                                |

- (1) The L2 SRAM from range 128KB to 512KB is divided into 8 memory regions. Each region has an associated control bit to enable auto-initialization.
- (2) The MibSPiX modules perform an initialization of the transmit and receive RAMs as soon as the multibuffered mode is enabled. This is independent of whether the application has already initialized these RAMs using the auto-initialization method or not. The MibSPiX modules must be released from reset by writing a 1 to the SPIGCR0 registers before starting auto-initialization on the respective RAMs.
- (3) If ECC protection is enabled for the CPU data RAM or peripheral SRAM modules, then the auto-initialization process also initializes the corresponding ECC space.

- (4) If parity protection is enabled for the peripheral SRAM modules, then the parity bits will also be initialized along with the SRAM modules.

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备注

Peripheral memories not listed in the table either do not support auto-initialization or have implemented auto-initialization controlled directly by their respective peripherals.

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## 7.14 External Memory Interface (EMIF)

### 7.14.1 Features

The EMIF includes many features to enhance the ease and flexibility of connecting to external asynchronous memories or SDRAM devices. The EMIF features includes support for:

- 3 addressable chip select for asynchronous memories of up to 16MB each
- 1 addressable chip select space for SDRAMs up to 128MB
- 8 or 16-bit data bus width
- Programmable cycle timings such as setup, strobe, and hold times as well as turnaround time
- Select strobe mode
- Extended Wait mode
- Data bus parking

---

#### 备注

The EMIF is inherently BE8, or byte invariant big endian. This device is BE32, or word invariant big endian. There is no difference when interfacing to RAM or using an 8-bit wide data bus. However, there is an impact when reading from external ROMs or interfacing to hardware registers with a 16-bit wide data bus. The EMIF can be made BE32 by connecting EMIF\_DATA[7:0] to the ROM or ASIC DATA[15:8] and EMIF\_DATA[15:8] to the ROM or ASIC DATA[7:0].

Alternatively, the code stored in the ROM can be linked as -be8 instead of -be32.

---

#### 备注

For a 32-bit access on the 16-bit EMIF interface, the lower 16-bits (the EMIF\_BA[1] will be low) will be put out first followed by the upper 16-bits (EMIF\_BA[1] will be high).

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## 7.14.2 Electrical and Timing Specifications

### 7.14.2.1 Read Timing (Asynchronous RAM)

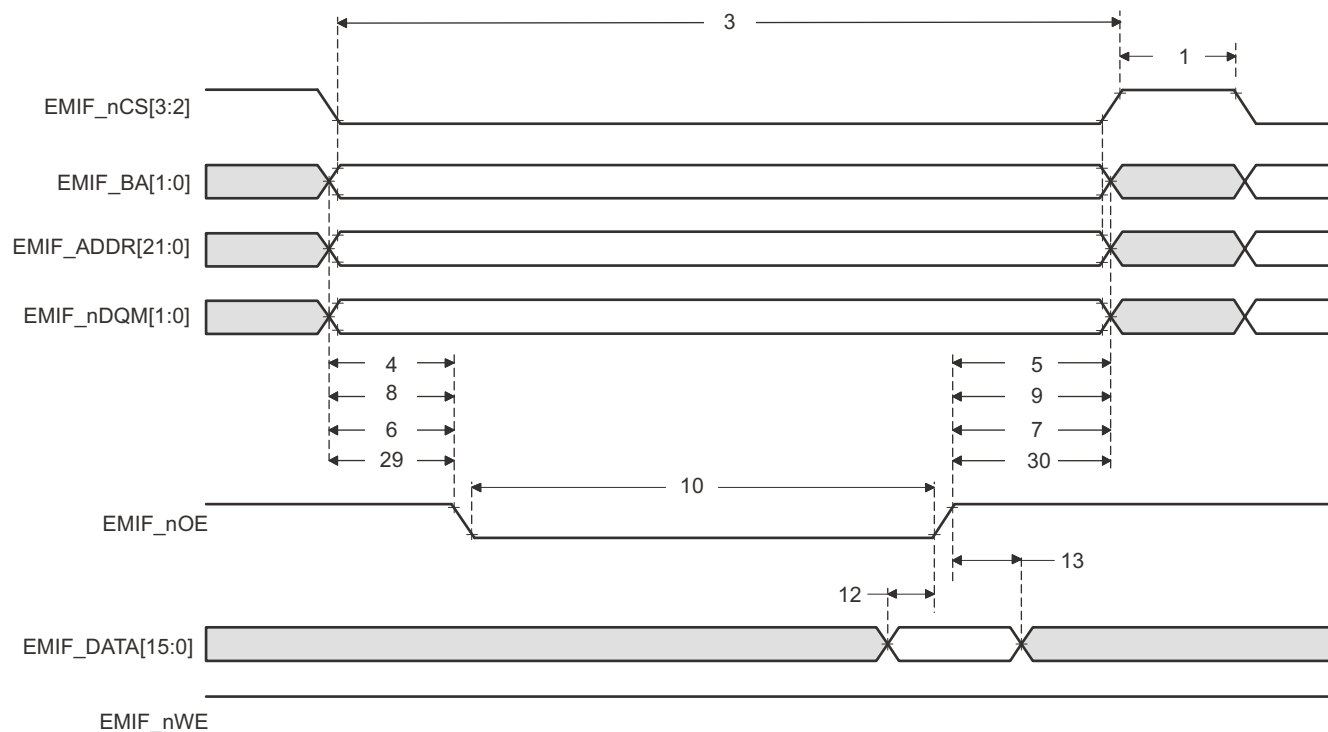


图 7-11. Asynchronous Memory Read Timing

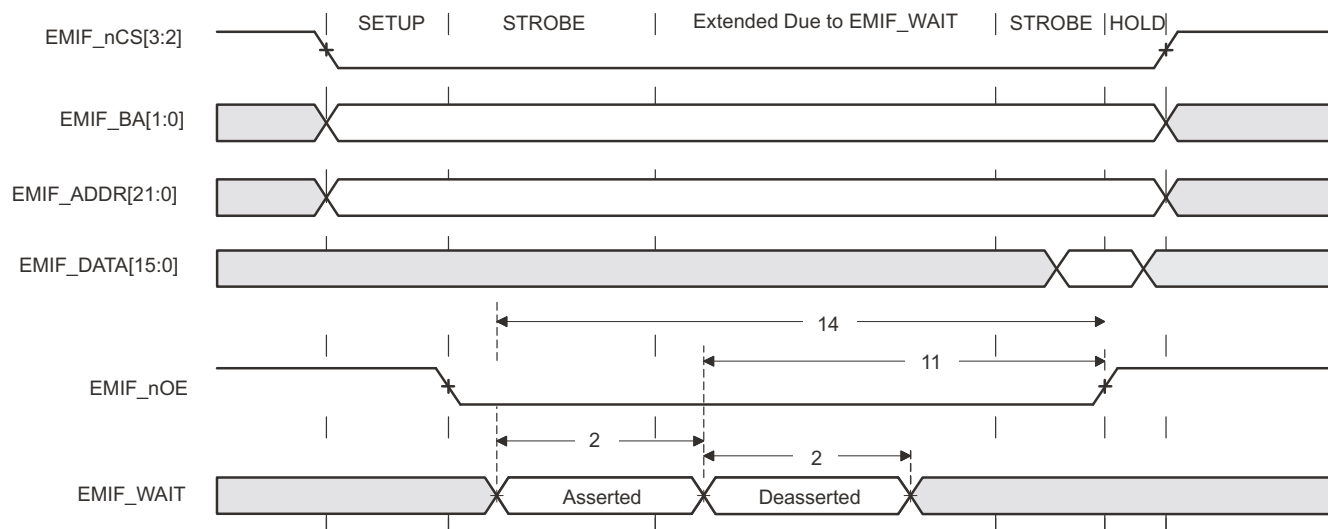


图 7-12. EMIFnWAIT Read Timing Requirements

### 7.14.2.2 Write Timing (Asynchronous RAM)

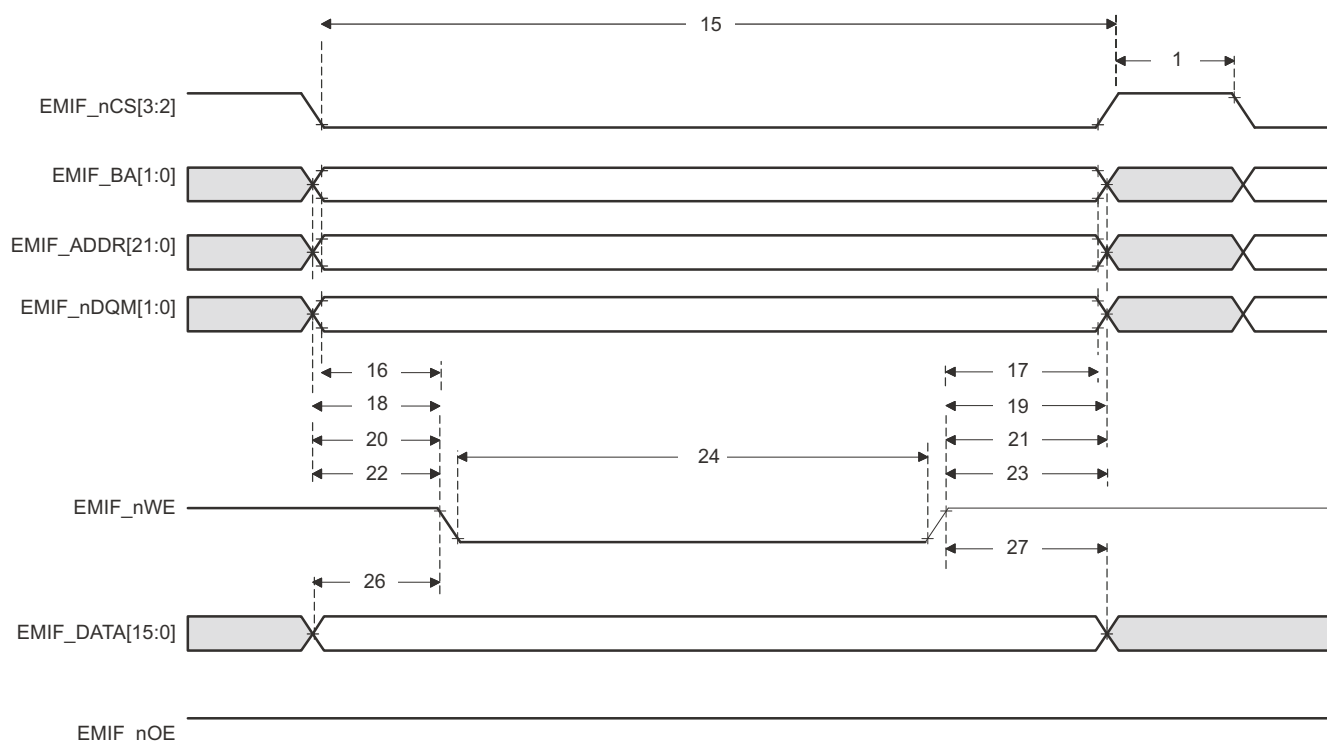


图 7-13. Asynchronous Memory Write Timing

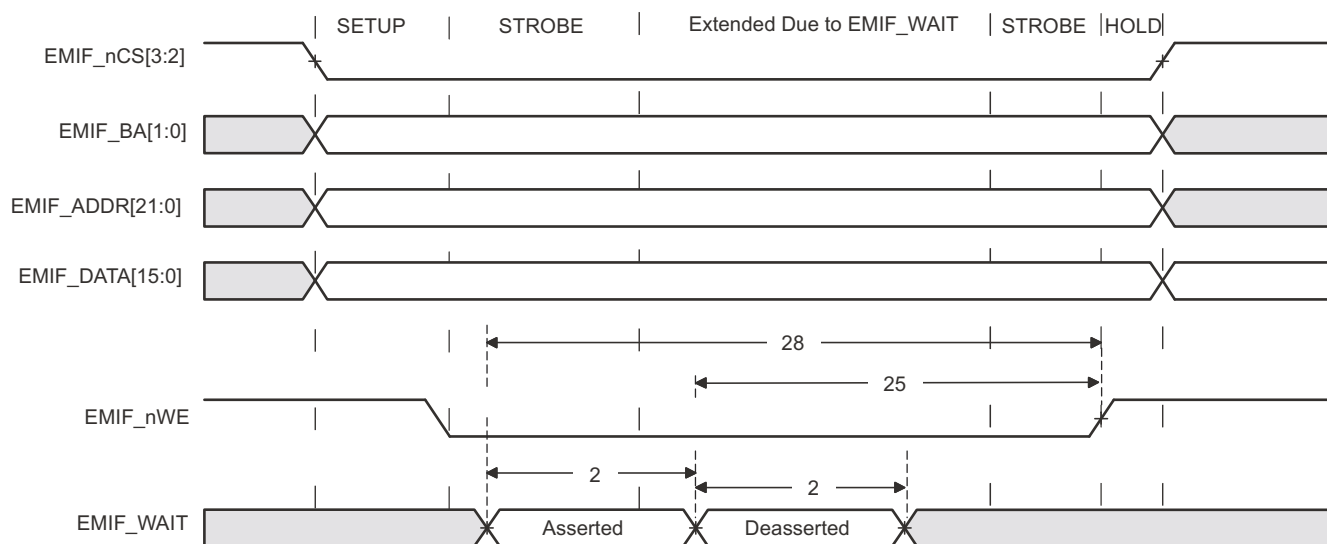


图 7-14. EMIFnWAIT Write Timing Requirements

### 7.14.2.3 EMIF Asynchronous Memory Timing

表 7-35. EMIF Asynchronous Memory Timing Requirements

| NO.                     |                                                                       | MIN <sup>(1)</sup> | NOM | MAX | UNIT |
|-------------------------|-----------------------------------------------------------------------|--------------------|-----|-----|------|
| <b>Reads and Writes</b> |                                                                       |                    |     |     |      |
| 2                       | $t_{w(EM\_WAIT)}$ Pulse duration, EMIFnWAIT assertion and deassertion | 2E                 |     |     | ns   |
| <b>Reads</b>            |                                                                       |                    |     |     |      |

**表 7-35. EMIF Asynchronous Memory Timing Requirements (续)**

| NO.           |                                                                                                 | MIN <sup>(1)</sup> | NOM | MAX | UNIT |
|---------------|-------------------------------------------------------------------------------------------------|--------------------|-----|-----|------|
| 12            | $t_{su}(EMDV-EMOEh)$ Setup time, EMIFDATA[15:0] valid before EMIFnOE high                       | 11                 |     |     | ns   |
| 13            | $t_h(EMOEh-EMDIV)$ Hold time, EMIFDATA[15:0] valid after EMIFnOE high                           | 0.5                |     |     | ns   |
| 14            | $t_{su}(EMOEL-EMWAIT)$ Setup Time, EMIFnWAIT asserted before end of Strobe Phase <sup>(2)</sup> | 4E+14              |     |     | ns   |
| <b>Writes</b> |                                                                                                 |                    |     |     |      |
| 28            | $t_{su}(EMWEL-EMWAIT)$ Setup Time, EMIFnWAIT asserted before end of Strobe Phase <sup>(2)</sup> | 4E+14              |     |     | ns   |

- (1) E = EMIF\_CLK period in ns.  
(2) Setup before end of STROBE phase (if no extended wait states are inserted) by which EMIFnWAIT must be asserted to add extended wait states. 图 7-12 和 图 7-14 描述 EMIF 事务包括在 STROBE 阶段插入的扩展等待状态。然而，在此扩展等待周期中插入的周期不应计数；4E 要求是从开始的地方开始，如果没有扩展等待周期，HOLD 阶段将开始。

**表 7-36. EMIF Asynchronous Memory Switching Characteristics**

| NO.              | PARAMETER <sup>(1) (2) (3)</sup> |                                                                | MIN                   | TYP                | MAX                    | UNIT |
|------------------|----------------------------------|----------------------------------------------------------------|-----------------------|--------------------|------------------------|------|
| Reads and Writes |                                  |                                                                |                       |                    |                        |      |
| 1                | t <sub>d</sub> (TURNAROUND)      | Turn around time                                               | (TA)*E -3             | (TA)*E             | (TA)*E + 3             | ns   |
| Reads            |                                  |                                                                |                       |                    |                        |      |
| 3                | t <sub>c</sub> (EMRCYCLE)        | EMIF read cycle time (EW = 0)                                  | (RS+RST+RH)*E-3       | (RS+RST+RH)*E      | (RS+RST+RH)*E + 3      | ns   |
|                  |                                  | EMIF read cycle time (EW = 1)                                  | (RS+RST+RH+ EWC)*E -3 | (RS+RST+RH+ EWC)*E | (RS+RST+RH+ EWC)*E + 3 | ns   |
| 4                | t <sub>su</sub> (EMCEL-EMOEL)    | Output setup time, EMIF_nCS[4:2] low to EMIF_nOE low (SS = 0)  | (RS)*E-3              | (RS)*E             | (RS)*E+3               | ns   |
|                  |                                  | Output setup time, EMIFnCS[4:2] low to EMIF_nOE low (SS = 1)   | - 3                   | 0                  | 3                      | ns   |
| 5                | t <sub>h</sub> (EMOEh-EMCEH)     | Output hold time, EMIF_nOE high to EMIF_nCS[4:2] high (SS = 0) | (RH)*E -4             | (RH)*E             | (RH)*E + 3             | ns   |
|                  |                                  | Output hold time, EMIF_nOE high to EMIF_nCS[4:2] high (SS = 1) | - 4                   | 0                  | 3                      | ns   |
| 6                | t <sub>su</sub> (EMBAV-EMOEL)    | Output setup time, EMIF_BA[1:0] valid to EMIF_nOE low          | (RS)*E-3              | (RS)*E             | (RS)*E+3               | ns   |
| 7                | t <sub>h</sub> (EMOEh-EMBAIV)    | Output hold time, EMIF_nOE high to EMIF_BA[1:0] invalid        | (RH)*E-4              | (RH)*E             | (RH)*E+3               | ns   |
| 8                | t <sub>su</sub> (EMBAV-EMOEL)    | Output setup time, EMIF_ADDR[21:0] valid to EMIF_nOE low       | (RS)*E-3              | (RS)*E             | (RS)*E+3               | ns   |
| 9                | t <sub>h</sub> (EMOEh-EMAIV)     | Output hold time, EMIF_nOE high to EMIF_ADDR[21:0] invalid     | (RH)*E-4              | (RH)*E             | (RH)*E+3               | ns   |
| 10               | t <sub>w</sub> (EMOEL)           | EMIF_nOE active low width (EW = 0)                             | (RST)*E-3             | (RST)*E            | (RST)*E+3              | ns   |
|                  |                                  | EMIF_nOE active low width (EW = 1)                             | (RST+EWC) *E-3        | (RST+EWC)*E        | (RST+EWC) *E+3         | ns   |
| 11               | t <sub>d</sub> (EMWAITH-EMOEh)   | Delay time from EMIF_nWAIT deasserted to EMIF_nOE high         | 3E-3                  | 4E                 | 4E+5                   | ns   |
| 29               | t <sub>su</sub> (EMDQMv-EMOEL)   | Output setup time, EMIF_nDQM[1:0] valid to EMIF_nOE low        | (RS)*E-5              | (RS)*E             | (RS)*E+3               | ns   |
| 30               | t <sub>h</sub> (EMOEh-EMDQMIV)   | Output hold time, EMIF_nOE high to EMIF_nDQM[1:0] invalid      | (RH)*E-4              | (RH)*E             | (RH)*E+5               | ns   |
| Writes           |                                  |                                                                |                       |                    |                        |      |
| 15               | t <sub>c</sub> (EMWCYCLE)        | EMIF write cycle time (EW = 0)                                 | (WS+WST+WH)* E-3      | (WS+WST+WH)*E      | (WS+WST+WH)* E+3       | ns   |
|                  |                                  | EMIF write cycle time (EW = 1)                                 | (WS+WST+WH+ EWC)*E -3 | (WS+WST+WH+ EWC)*E | (WS+WST+WH+ EWC)*E + 3 | ns   |
| 16               | t <sub>su</sub> (EMCEL-EMWEL)    | Output setup time, EMIF_nCS[4:2] low to EMIF_nWE low (SS = 0)  | (WS)*E -3             | (WS)*E             | (WS)*E + 3             | ns   |
|                  |                                  | Output setup time, EMIF_nCS[4:2] low to EMIF_nWE low (SS = 1)  | - 3                   | 0                  | 3                      | ns   |
| 17               | t <sub>h</sub> (EMWEh-EMCEH)     | Output hold time, EMIF_nWE high to EMIF_nCS[4:2] high (SS = 0) | (WH)*E-3              | (WH)*E             | (WH)*E+3               | ns   |
|                  |                                  | Output hold time, EMIF_nWE high to EMIF_CS[4:2] high (SS = 1)  | - 3                   | 0                  | 3                      | ns   |

表 7-36. EMIF Asynchronous Memory Switching Characteristics (续)

| NO. | PARAMETER <sup>(1)</sup> (2) (3) |                                                            | MIN           | TYP         | MAX           | UNIT |
|-----|----------------------------------|------------------------------------------------------------|---------------|-------------|---------------|------|
| 18  | $t_{su}(EMDQMV-EMWEL)$           | Output setup time, EMIF_nDQM[1:0] valid to EMIF_nWE low    | (WS)*E-3      | (WS)*E      | (WS)*E+3      | ns   |
| 19  | $t_h(EMWEH-EMDQMIV)$             | Output hold time, EMIF_nWE high to EMIF_nDQM[1:0] invalid  | (WH)*E-3      | (WH)*E      | (WH)*E+3      | ns   |
| 20  | $t_{su}(EMBAV-EMWEL)$            | Output setup time, EMIF_BA[1:0] valid to EMIF_nWE low      | (WS)*E-3      | (WS)*E      | (WS)*E+3      | ns   |
| 21  | $t_h(EMWEH-EMBAIV)$              | Output hold time, EMIF_nWE high to EMIF_BA[1:0] invalid    | (WH)*E-3      | (WH)*E      | (WH)*E+3      | ns   |
| 22  | $t_{su}(EMAV-EMWEL)$             | Output setup time, EMIF_ADDR[21:0] valid to EMIF_nWE low   | (WS)*E-3      | (WS)*E      | (WS)*E+3      | ns   |
| 23  | $t_h(EMWEH-EMAIV)$               | Output hold time, EMIF_nWE high to EMIF_ADDR[21:0] invalid | (WH)*E-3      | (WH)*E      | (WH)*E+3      | ns   |
| 24  | $t_w(EMWEL)$                     | EMIF_nWE active low width (EW = 0)                         | (WST)*E-3     | (WST)*E     | (WST)*E+3     | ns   |
|     |                                  | EMIF_nWE active low width (EW = 1)                         | (WST+EWC)*E-3 | (WST+EWC)*E | (WST+EWC)*E+3 | ns   |
| 25  | $t_d(EMWAITH-EMWEH)$             | Delay time from EMIF_nWAIT deasserted to EMIF_nWE high     | 3E+3          | 4E          | 4E+14         | ns   |
| 26  | $t_{su}(EMDV-EMWEL)$             | Output setup time, EMIF_DATA[15:0] valid to EMIF_nWE low   | (WS)*E-3      | (WS)*E      | (WS)*E+3      | ns   |
| 27  | $t_h(EMWEH-EMDIV)$               | Output hold time, EMIF_nWE high to EMIF_DATA[15:0] invalid | (WH)*E-3      | (WH)*E      | (WH)*E+3      | ns   |

- (1) TA = Turn around, RS = Read setup, RST = Read strobe, RH = Read hold, WS = Write setup, WST = Write strobe, WH = Write hold, MEWC = Maximum external wait cycles. These parameters are programmed through the Asynchronous Bank and Asynchronous Wait Cycle Configuration Registers. These support the following ranges of values: TA[4 – 1], RS[16 – 1], RST[64 – 1], RH[8 – 1], WS[16 – 1], WST[64 – 1], WH[8 – 1], and MEWC[1 – 256]. See the EMIF chapter of the TRM [SPNU563](#) for more information.
- (2) E = EMIF\_CLK period in ns.
- (3) EWC = external wait cycles determined by EMIFnWAIT input signal. EWC supports the following range of values. EWC[256 – 1]. Note that the maximum wait time before time-out is specified by bit field MEWC in the Asynchronous Wait Cycle Configuration Register. See the EMIF chapter of the TRM [SPNU563](#) for more information.

#### 7.14.2.4 Read Timing (Synchronous RAM)

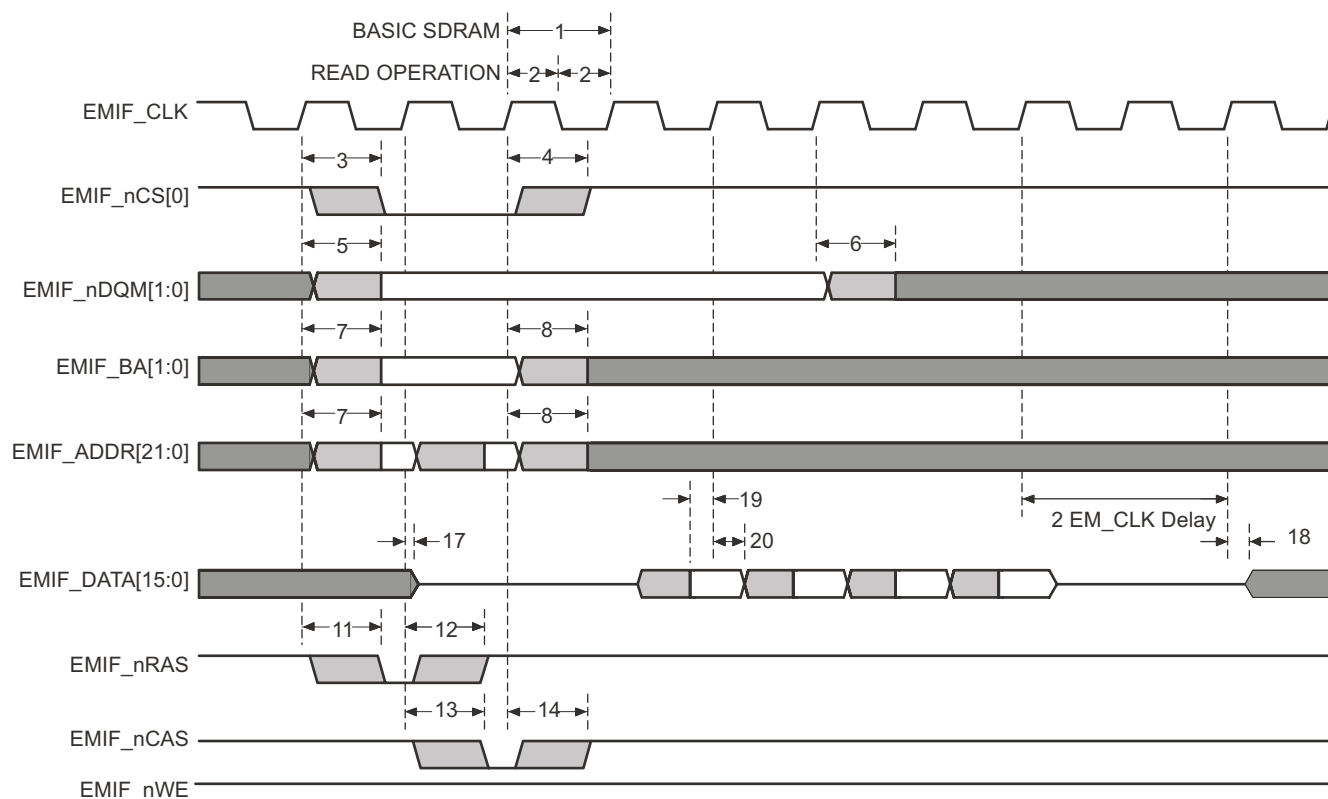


图 7-15. Basic SDRAM Read Operation

### 7.14.2.5 Write Timing (Synchronous RAM)

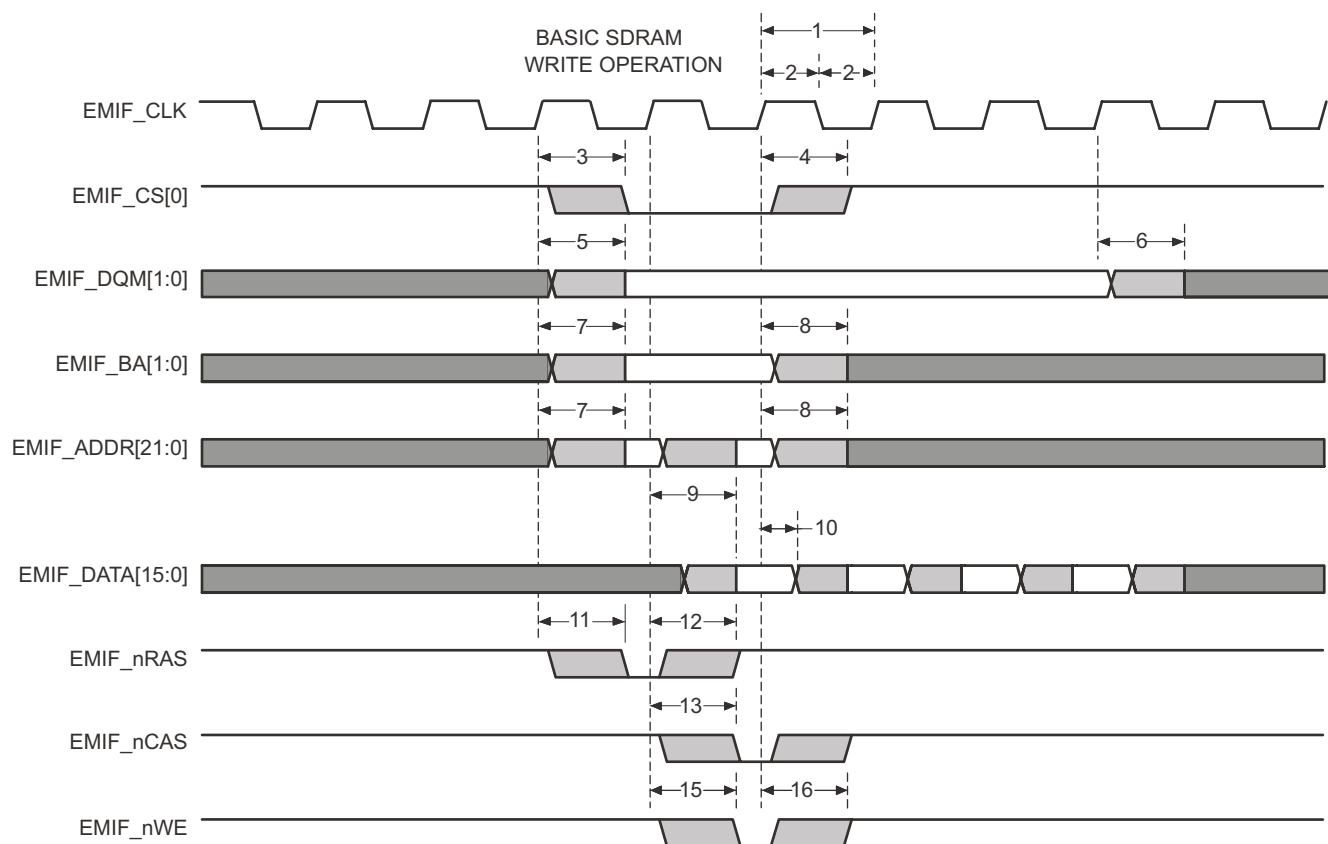


图 7-16. Basic SDRAM Write Operation

### 7.14.2.6 EMIF Synchronous Memory Timing

表 7-37. EMIF Synchronous Memory Timing Requirements

| NO. |                           |                                                                             | MIN | MAX | UNIT |
|-----|---------------------------|-----------------------------------------------------------------------------|-----|-----|------|
| 19  | $t_{su}(EMIFDV-EM\_CLKH)$ | Input setup time, read data valid on EMIF_DATA[15:0] before EMIF_CLK rising | 1   |     | ns   |
| 20  | $t_h(CLKH-DIV)$           | Input hold time, read data valid on EMIF_DATA[15:0] after EMIF_CLK rising   | 2.2 |     | ns   |

表 7-38. EMIF Synchronous Memory Switching Characteristics

| NO. |                      | PARAMETER                                                                     | MIN | MAX | UNIT |
|-----|----------------------|-------------------------------------------------------------------------------|-----|-----|------|
| 1   | $t_c(CLK)$           | Cycle time, EMIF clock EMIF_CLK                                               | 10  |     | ns   |
| 2   | $t_w(CLK)$           | Pulse width, EMIF clock EMIF_CLK high or low                                  | 3   |     | ns   |
| 3   | $t_d(CLKH-CSV)$      | Delay time, EMIF_CLK rising to EMIF_nCS[0] valid                              |     | 7   | ns   |
| 4   | $t_{oh}(CLKH-CSIV)$  | Output hold time, EMIF_CLK rising to EMIF_nCS[0] invalid                      | 1   |     | ns   |
| 5   | $t_d(CLKH-DQMV)$     | Delay time, EMIF_CLK rising to EMIF_nDQM[1:0] valid                           |     | 7   | ns   |
| 6   | $t_{oh}(CLKH-DQMIV)$ | Output hold time, EMIF_CLK rising to EMIF_nDQM[1:0] invalid                   | 1   |     | ns   |
| 7   | $t_d(CLKH-AV)$       | Delay time, EMIF_CLK rising to EMIF_ADDR[21:0] and EMIF_BA[1:0] valid         |     | 7   | ns   |
| 8   | $t_{oh}(CLKH-AIV)$   | Output hold time, EMIF_CLK rising to EMIF_ADDR[21:0] and EMIF_BA[1:0] invalid | 1   |     | ns   |
| 9   | $t_d(CLKH-DV)$       | Delay time, EMIF_CLK rising to EMIF_DATA[15:0] valid                          |     | 7   | ns   |
| 10  | $t_{oh}(CLKH-DIV)$   | Output hold time, EMIF_CLK rising to EMIF_DATA[15:0] invalid                  | 1   |     | ns   |

**表 7-38. EMIF Synchronous Memory Switching Characteristics (续)**

| NO. | PARAMETER                   |                                                              | MIN | MAX | UNIT |
|-----|-----------------------------|--------------------------------------------------------------|-----|-----|------|
| 11  | $t_{d}(\text{CLKH-RASV})$   | Delay time, EMIF_CLK rising to EMIF_nRAS valid               |     | 7   | ns   |
| 12  | $t_{oh}(\text{CLKH-RASIV})$ | Output hold time, EMIF_CLK rising to EMIF_nRAS invalid       | 1   |     | ns   |
| 13  | $t_{d}(\text{CLKH-CASV})$   | Delay time, EMIF_CLK rising to EMIF_nCAS valid               |     | 7   | ns   |
| 14  | $t_{oh}(\text{CLKH-CASIV})$ | Output hold time, EMIF_CLK rising to EMIF_nCAS invalid       | 1   |     | ns   |
| 15  | $t_{d}(\text{CLKH-WEV})$    | Delay time, EMIF_CLK rising to EMIF_nWE valid                |     | 7   | ns   |
| 16  | $t_{oh}(\text{CLKH-WEIV})$  | Output hold time, EMIF_CLK rising to EMIF_nWE invalid        | 1   |     | ns   |
| 17  | $t_{dis}(\text{CLKH-DHZ})$  | Delay time, EMIF_CLK rising to EMIF_DATA[15:0] tri-stated    |     | 7   | ns   |
| 18  | $t_{ena}(\text{CLKH-DLZ})$  | Output hold time, EMIF_CLK rising to EMIF_DATA[15:0] driving | 1   |     | ns   |

## 7.15 Vectored Interrupt Manager

There are two on-chip Vector Interrupt Manager (VIM) modules. The VIM module provides hardware assistance for prioritizing and controlling the many interrupt sources present on a device. Interrupts are caused by events outside of the normal flow of program execution. Normally, these events require a timely response from the CPU; therefore, when an interrupt occurs, the CPU switches execution from the normal program flow to an interrupt service routine (ISR).

### 7.15.1 VIM Features

The VIM module has the following features:

- Supports 128 interrupt channels
- Provides programmable priority for the request lines
- Manages interrupt channels through masking
- Prioritizes interrupt channels to the CPU
- Provides the CPU with the address of the interrupt service routine (ISR) for each interrupt

The two VIM modules are in lockstep. These two VIM modules are memory mapped to the same address space. From a programmer's model point of view it is only one VIM module. Writes to VIM1 registers and memory will be broadcasted to both VIM1 and VIM2. Reads from VIM1 will only read the VIM1 registers and memory. All interrupt requests which go to the VIM1 module will also go to the VIM2 module. Because the VIM1 and VIM2 have the identical setup, both will result in the same output behavior responding to the same interrupt requests. The second VIM module acts as a diagnostic checker module against the first VIM module. The output signals of the two VIM modules are routed to CCM-R5F module and are compared constantly. Mis-compare detected will be signaled as an error to the ESM module. The lockstep VIM pair takes care of the interrupt generation to the lockstep R5F pair.

### 7.15.2 Interrupt Generation

To avoid common mode failures the input and output signals of the two VIMs are delayed in a different way as shown in 图 7-17.

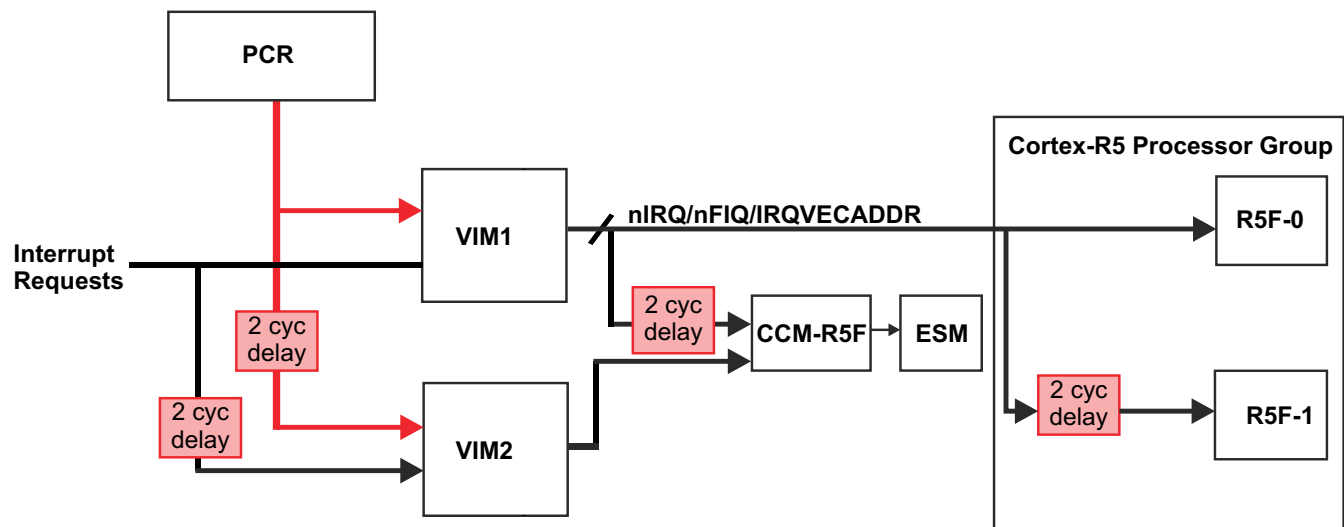


图 7-17. Interrupt Generation

### 7.15.3 Interrupt Request Assignments

表 7-39. Interrupt Request Assignments

| MODULES | VIM INTERRUPT SOURCES          | DEFAULT VIM INTERRUPT CHANNEL |
|---------|--------------------------------|-------------------------------|
| ESM     | ESM high-level interrupt (NMI) | 0                             |

**表 7-39. Interrupt Request Assignments (续)**

| MODULES  | VIM INTERRUPT SOURCES                         | DEFAULT VIM INTERRUPT CHANNEL |
|----------|-----------------------------------------------|-------------------------------|
| Reserved | Reserved                                      | 1                             |
| RTI      | RTI1 compare interrupt 0                      | 2                             |
| RTI      | RTI1 compare interrupt 1                      | 3                             |
| RTI      | RTI1 compare interrupt 2                      | 4                             |
| RTI      | RTI1 compare interrupt 3                      | 5                             |
| RTI      | RTI1 overflow interrupt 0                     | 6                             |
| RTI      | RTI1 overflow interrupt 1                     | 7                             |
| RTI      | RTI1 time-base                                | 8                             |
| GIO      | GIO high level interrupt                      | 9                             |
| NHET1    | NHET1 high-level interrupt (priority level 1) | 10                            |
| HET TU1  | HET TU1 level 0 interrupt                     | 11                            |
| MIBSPI1  | MIBSPI1 level 0 interrupt                     | 12                            |
| LIN1     | LIN1 level 0 interrupt                        | 13                            |
| MIBADC1  | MIBADC1 event group interrupt                 | 14                            |
| MIBADC1  | MIBADC1 software group 1 interrupt            | 15                            |
| DCAN1    | DCAN1 level 0 interrupt                       | 16                            |
| MIBSPI2  | MIBSPI2 level 0 interrupt                     | 17                            |
| FlexRay  | FlexRay level 0 interrupt (CC_int0)           | 18                            |
| CRC1     | CRC1 Interrupt                                | 19                            |
| ESM      | ESM low-level interrupt                       | 20                            |
| SYSTEM   | Software interrupt for Cortex-R5F (SSI)       | 21                            |
| CPU      | Cortex-R5F PMU Interrupt                      | 22                            |
| GIO      | GIO low level interrupt                       | 23                            |
| NHET1    | NHET1 low level interrupt (priority level 2)  | 24                            |
| HET TU1  | HET TU1 level 1 interrupt                     | 25                            |
| MIBSPI1  | MIBSPI1 level 1 interrupt                     | 26                            |
| LIN1     | LIN1 level 1 interrupt                        | 27                            |
| MIBADC1  | MIBADC1 software group 2 interrupt            | 28                            |
| DCAN1    | DCAN1 level 1 interrupt                       | 29                            |
| MIBSPI2  | MIBSPI2 level 1 interrupt                     | 30                            |
| MIBADC1  | MIBADC1 magnitude compare interrupt           | 31                            |
| FlexRay  | FlexRay level 1 interrupt (CC_int1)           | 32                            |
| DMA      | FTCA interrupt                                | 33                            |
| DMA      | LFSA interrupt                                | 34                            |
| DCAN2    | DCAN2 level 0 interrupt                       | 35                            |
| DMM      | DMM level 0 interrupt                         | 36                            |
| MIBSPI3  | MIBSPI3 level 0 interrupt                     | 37                            |
| MIBSPI3  | MIBSPI3 level 1 interrupt                     | 38                            |
| DMA      | HBCA interrupt                                | 39                            |
| DMA      | BTCA interrupt                                | 40                            |
| EMIF     | AEMIFINT                                      | 41                            |
| DCAN2    | DCAN2 level 1 interrupt                       | 42                            |
| DMM      | DMM level 1 interrupt                         | 43                            |
| DCAN1    | DCAN1 IF3 interrupt                           | 44                            |

表 7-39. Interrupt Request Assignments (续)

| MODULES     | VIM INTERRUPT SOURCES                          | DEFAULT VIM INTERRUPT CHANNEL |
|-------------|------------------------------------------------|-------------------------------|
| DCAN3       | DCAN3 level 0 interrupt                        | 45                            |
| DCAN2       | DCAN2 IF3 interrupt                            | 46                            |
| FPU         | FPU interrupt of Cortex-R5F                    | 47                            |
| FlexRay TU  | FlexRay TU Transfer Status interrupt (TU_Int0) | 48                            |
| MIBSPI4     | MIBSPI4 level 0 interrupt                      | 49                            |
| MIBADC2     | MibADC2 event group interrupt                  | 50                            |
| MIBADC2     | MibADC2 software group1 interrupt              | 51                            |
| FlexRay     | FlexRay T0C interrupt (CC_tint0)               | 52                            |
| MIBSPI5     | MIBSPI5 level 0 interrupt                      | 53                            |
| MIBSPI4     | MIBSPI4 level 1 interrupt                      | 54                            |
| DCAN3       | DCAN3 level 1 interrupt                        | 55                            |
| MIBSPI5     | MIBSPI5 level 1 interrupt                      | 56                            |
| MIBADC2     | MibADC2 software group2 interrupt              | 57                            |
| FlexRay TU  | FlexRay TU Error interrupt (TU_Int1)           | 58                            |
| MIBADC2     | MibADC2 magnitude compare interrupt            | 59                            |
| DCAN3       | DCAN3 IF3 interrupt                            | 60                            |
| L2FMC       | FSM_DONE interrupt                             | 61                            |
| FlexRay     | FlexRay T1C interrupt (CC_tint1)               | 62                            |
| NHET2       | NHET2 level 0 interrupt                        | 63                            |
| SCI3        | SCI3 level 0 interrupt                         | 64                            |
| NHET TU2    | NHET TU2 level 0 interrupt                     | 65                            |
| I2C1        | I2C level 0 interrupt                          | 66                            |
| Reserved    | Reserved                                       | 67 - 72                       |
| NHET2       | NHET2 level 1 interrupt                        | 73                            |
| SCI3        | SCI3 level 1 interrupt                         | 74                            |
| NHET TU2    | NHET TU2 level 1 interrupt                     | 75                            |
| Ethernet    | C0_MISC_PULSE                                  | 76                            |
| Ethernet    | C0_TX_PULSE                                    | 77                            |
| Ethernet    | C0_THRESH_PULSE                                | 78                            |
| Ethernet    | C0_RX_PULSE                                    | 79                            |
| HWAG1       | HWA_INT_REQ_H                                  | 80                            |
| HWAG2       | HWA_INT_REQ_H                                  | 81                            |
| DCC1        | DCC1 done interrupt                            | 82                            |
| DCC2        | DCC2 done interrupt                            | 83                            |
| SYSTEM      | Reserved                                       | 84                            |
| PBIST       | PBIST Done                                     | 85                            |
| Reserved    | Reserved                                       | 86 - 87                       |
| HWAG1       | HWA_INT_REQ_L                                  | 88                            |
| HWAG2       | HWA_INT_REQ_L                                  | 89                            |
| ePWM1INTn   | ePWM1 Interrupt                                | 90                            |
| ePWM1TZINTn | ePWM1 Trip Zone Interrupt                      | 91                            |
| ePWM2INTn   | ePWM2 Interrupt                                | 92                            |
| ePWM2TZINTn | ePWM2 Trip Zone Interrupt                      | 93                            |
| ePWM3INTn   | ePWM3 Interrupt                                | 94                            |

**表 7-39. Interrupt Request Assignments (续)**

| MODULES     | VIM INTERRUPT SOURCES               | DEFAULT VIM INTERRUPT CHANNEL |
|-------------|-------------------------------------|-------------------------------|
| ePWM3TZINTn | ePWM3 Trip Zone Interrupt           | 95                            |
| ePWM4INTn   | ePWM4 Interrupt                     | 96                            |
| ePWM4TZINTn | ePWM4 Trip Zone Interrupt           | 97                            |
| ePWM5INTn   | ePWM5 Interrupt                     | 98                            |
| ePWM5TZINTn | ePWM5 Trip Zone Interrupt           | 99                            |
| ePWM6INTn   | ePWM6 Interrupt                     | 100                           |
| ePWM6TZINTn | ePWM6 Trip Zone Interrupt           | 101                           |
| ePWM7INTn   | ePWM7 Interrupt                     | 102                           |
| ePWM7TZINTn | ePWM7 Trip Zone Interrupt           | 103                           |
| eCAP1INTn   | eCAP1 Interrupt                     | 104                           |
| eCAP2INTn   | eCAP2 Interrupt                     | 105                           |
| eCAP3INTn   | eCAP3 Interrupt                     | 106                           |
| eCAP4INTn   | eCAP4 Interrupt                     | 107                           |
| eCAP5INTn   | eCAP5 Interrupt                     | 108                           |
| eCAP6INTn   | eCAP6 Interrupt                     | 109                           |
| eQEP1INTn   | eQEP1 Interrupt                     | 110                           |
| eQEP2INTn   | eQEP2 Interrupt                     | 111                           |
| Reserved    | Reserved                            | 112                           |
| DCAN4       | DCAN4 Level 0 interrupt             | 113                           |
| I2C2        | I2C2 interrupt                      | 114                           |
| LIN2        | LIN2 level 0 interrupt              | 115                           |
| SCI4        | SCI4 level 0 interrupt              | 116                           |
| DCAN4       | DCAN4 Level 1 interrupt             | 117                           |
| LIN2        | LIN2 level 1 interrupt              | 118                           |
| SCI4        | SCI4 level 1 interrupt              | 119                           |
| DCAN4       | DCAN4 IF3 Interrupt                 | 120                           |
| CRC2        | CRC2 Interrupt                      | 121                           |
| Reserved    | Reserved                            | 122                           |
| Reserved    | Reserved                            | 123                           |
| EPC         | EPC FIFO FULL or CAM FULL interrupt | 124                           |
| Reserved    | Reserved                            | 125-127                       |

**备注**

Address location 0x00000000 in the VIM RAM is reserved for the phantom interrupt ISR entry; therefore only request channels 0..126 can be used and are offset by one address in the VIM RAM.

**备注**

The EMIF\_nWAIT signal has a pull-up on it. The EMIF module generates a "Wait Rise" interrupt whenever it detects a rising edge on the EMIF\_nWAIT signal. This interrupt condition is indicated as soon as the device is powered up. This can be ignored if the EMIF\_nWAIT signal is not used in the application. If the EMIF\_nWAIT signal is actually used in the application, then the external slave memory must always drive the EMIF\_nWAIT signal such that an interrupt is not caused due to the default pull-up on this signal.

## 备注

The lower-order interrupt channels are higher priority channels than the higher-order interrupt channels.

## 备注

The application can change the mapping of interrupt sources to the interrupt channels through the interrupt channel control registers (CHANCTRLx) inside the VIM module.

## 7.16 ECC Error Event Monitoring and Profiling

This device includes an Error Profiling Controller (EPC) module. The main goal of this module is to enable the system to tolerate a certain amount of ECC correctable errors on the same address repeatedly in the memory system with minimal runtime overhead. Main features implemented in this device are described below.

- Capture the address of correctable ECC faults from different sources (for example, CPU, L2RAM, Interconnect) into a 16-entry Content Addressable Memory (CAM).
- For correctable faults, the error handling depends on the below conditions:
  - if the incoming address is already in the 16-entry CAM, discard the fail. No error generated to ESM
  - if the address is not in the CAM list, and the CAM has empty entries, add the address into the CAM list. In addition, raise the error signal to the ESM group 1 if enabled.
  - if the address is not in the CAM list, and the CAM has no empty entries, always raise a signal to the ESM group 1.
- A 4-entry FIFO to store correctable error events and addresses for each IP interface.
- For uncorrectable faults of non-CPU access, capture the address and raise a signal to the ESM group 2.
- The CAM is implemented in memory mapped registers. The CPU can read and write to any entry for diagnostic test as if a real CAM memory macro.

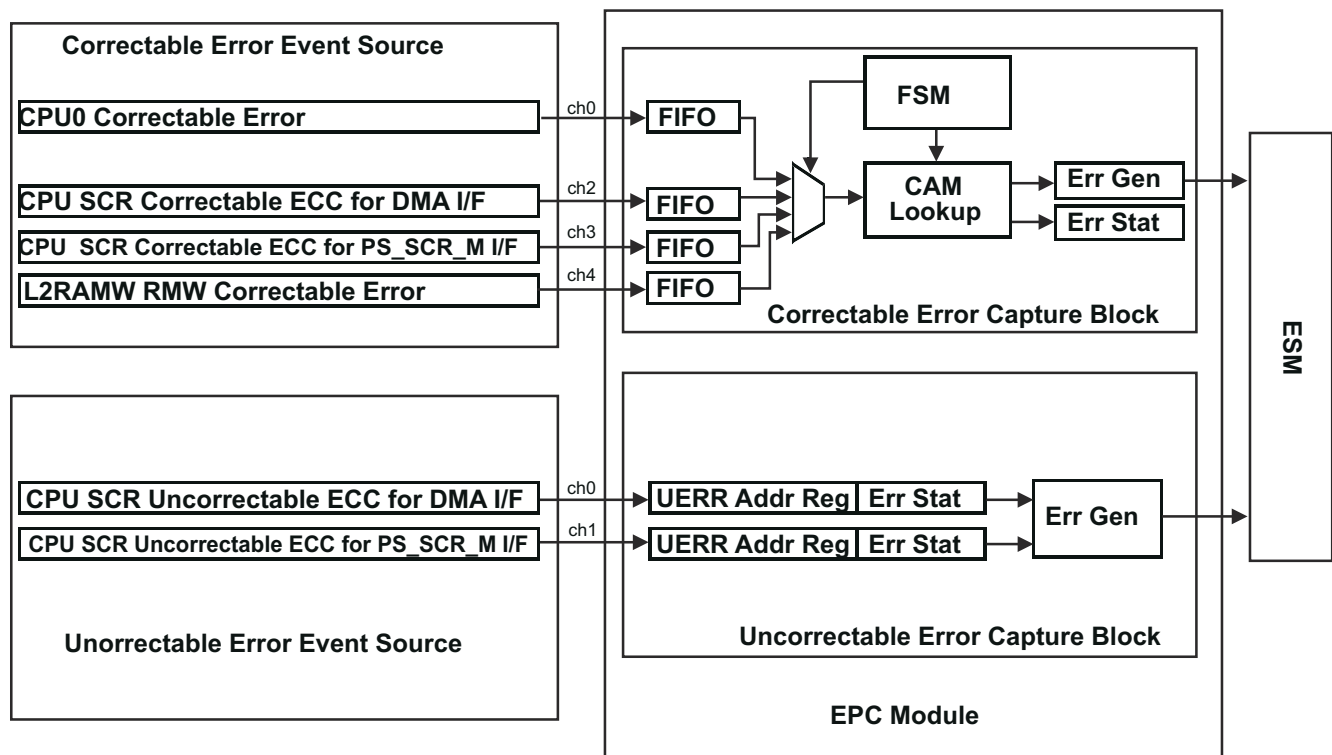


图 7-18. EPC Block Diagram

## **7.16.1 EPC Module Operation**

### **7.16.1.1 Correctable Error Handling**

When a correctable error is detected in the system by an IP, it sends the error signal along with the error address to EPC module. The EPC module will scan this error address in the 16-entry CAM. If there is a match then the address is discarded and no error is generated to ESM by the ECP. It takes one cycle to scan one address at a time through the CAM. The idea is to allow the system to tolerate a correctable error occurring on the same address because this error has been handled before by the CPU. This error scenario is particularly frequent when the software is in a for loop fetching the same address. Because there are multiple IPs which can simultaneously detect correctable errors in the system, the EPC employs a 4-entry FIFO per IP interface so that error addresses are not lost.

If an address is not matched in the CAM then it depends if there is an empty entry in the CAM. If there is an empty entry then the new address is stored into the empty entry. For each entry there is a 4-bit valid key. When a new address is stored the 4-bit key is updated with "1010". It is programmable to generate a correctable error to the ESM if the address is not matched and there is an empty CAM entry. Once CPU is interrupted, it can choose to evaluate the error address and handle it accordingly. The software can also invalidate the entry by writing "0101".

If an address is not matched and there is no empty entry in the CAM then the correctable error is immediately sent to the ESM. The new error address is lost if there is no empty entry left in the CAM.

### **7.16.1.2 Uncorrectable Error Handling**

Uncorrectable errors reported by the IP (non-CPU access) are immediately captured for their error addresses and update to the uncorrectable error status register. For more information see the device specific technical reference guide [SPNU563](#).

## 7.17 DMA Controller

The DMA controller is used to transfer data between two locations in the memory map in the background of CPU operations. Typically, the DMA is used to:

- Transfer blocks of data between external and internal data memories
- Restructure portions of internal data memory
- Continually service a peripheral

### 7.17.1 DMA Features

- 64-bit OCP protocol to perform bus master accesses
- INCR-4 64-bit burst accesses
- Multithreading architecture allowing data of two different channel transfers to be interleaved during nonburst accesses
- 2-port configuration for parallel bus master
- Channels can be assigned to either high-priority queue or low-priority queue. Within each queue, fixed or round-robin priorities can be serviced
- Built-in ECC generation and evaluation logic for internal RAM storing channel transfer information
- Supports multiple interrupt outputs for mapping to multiple interrupt controllers in multicore systems
- 48 requests can be mapped to any 32 channels
- Supports LE endianness
- External ECC Gen/Eval block of DMA support ECC generation for data transactions, and parity for address, and control signals (following Cortex-R5F standard)
- 8 MPU regions
- Channel chaining capability
- Hardware and software DMA requests
- 8-, 16-, 32-, or 64-bit transactions supported
- Multiple addressing modes for source/destination (fixed, increment, offset)
- Auto-initiation

### 7.17.2 DMA Transfer Port Assignment

There are two ports, port A and port B attached to the DMA controller. When configuring a DMA channel for a transfer, the application must also specify the port associated with the transfer source and destination. 表 7-40 lists the mapping between each port and the resources. For example, if a transfer is to be made from the flash to the SRAM, the application will need configure the desired DMA channel in the PARx register to select port A as the target for both the source and destination. If a transfer is to be made from the SRAM to a peripheral or a peripheral memory, the application will need to configure the desired DMA channel in the PARx register to select port A for read and port B for write. Likewise, if a transfer is from a peripheral to the SRAM then the PARx will be configured to select port B for read and port A for write.

表 7-40. DMA Port Assignment

| TARGET NAME                                          | ACCESS PORT OF DMA |
|------------------------------------------------------|--------------------|
| Flash                                                | Port A             |
| SRAM                                                 | Port A             |
| EMIF                                                 | Port A             |
| Flash OTP/ECC/EEPROM                                 | Port A             |
| All other targets (peripherals, peripheral memories) | Port B             |

### 7.17.3 Default DMA Request Map

The DMA module on this microcontroller has 32 channels and up to 48 hardware DMA requests. The module contains DREQAS<sub>ix</sub> registers which are used to map the DMA requests to the DMA channels. By default, channel 0 is mapped to request 0, channel 1 to request 1, and so on.

Some DMA requests have multiple sources, see [表 7-41](#). The application must ensure that only one of these DMA request sources is enabled at any time.

**表 7-41. DMA Request Line Connection**

| MODULES                                  | DMA REQUEST SOURCES                                                         | DMA REQUEST |
|------------------------------------------|-----------------------------------------------------------------------------|-------------|
| MIBSPI1                                  | MIBSPI1[1] <sup>(1)</sup>                                                   | DMAREQ[0]   |
| MIBSPI1                                  | MIBSPI1[0] <sup>(2)</sup>                                                   | DMAREQ[1]   |
| MIBSPI2                                  | MIBSPI2[1] <sup>(1)</sup>                                                   | DMAREQ[2]   |
| MIBSPI2                                  | MIBSPI2[0] <sup>(2)</sup>                                                   | DMAREQ[3]   |
| MIBSPI1 / MIBSPI3 / DCAN2                | MIBSPI1[2] / MIBSPI3[2] / DCAN2 IF3                                         | DMAREQ[4]   |
| MIBSPI1 / MIBSPI3 / DCAN2                | MIBSPI1[3] / MIBSPI3[3] / DCAN2 IF2                                         | DMAREQ[5]   |
| DCAN1 / MIBSPI5                          | DCAN1 IF2 / MIBSPI5[2]                                                      | DMAREQ[6]   |
| MIBADC1 / MIBSPI5                        | MIBADC1 event / MIBSPI5[3]                                                  | DMAREQ[7]   |
| MIBSPI1 / MIBSPI3 / DCAN1                | MIBSPI1[4] / MIBSPI3[4] / DCAN1 IF1                                         | DMAREQ[8]   |
| MIBSPI1 / MIBSPI3 / DCAN2                | MIBSPI1[5] / MIBSPI3[5] / DCAN2 IF1                                         | DMAREQ[9]   |
| MIBADC1 / I2C / MIBSPI5                  | MIBADC1 G1 / I2C receive / MIBSPI5[4]                                       | DMAREQ[10]  |
| MIBADC1 / I2C / MIBSPI5                  | MIBADC1 G2 / I2C transmit / MIBSPI5[5]                                      | DMAREQ[11]  |
| RT11 / MIBSPI1 / MIBSPI3                 | RT11 DMAREQ0 / MIBSPI1[6] / MIBSPI3[6]                                      | DMAREQ[12]  |
| RT11 / MIBSPI1 / MIBSPI3                 | RT11 DMAREQ1 / MIBSPI1[7] / MIBSPI3[7]                                      | DMAREQ[13]  |
| MIBSPI3 / MibADC2 / MIBSPI5              | MIBSPI3[1] <sup>(1)</sup> / MibADC2 event / MIBSPI5[6]                      | DMAREQ[14]  |
| MIBSPI3 / MIBSPI5                        | MIBSPI3[0] <sup>(2)</sup> / MIBSPI5[7]                                      | DMAREQ[15]  |
| MIBSPI1 / MIBSPI3 / DCAN1 / MibADC2      | MIBSPI1[8] / MIBSPI3[8] / DCAN1 IF3 / MibADC2 G1                            | DMAREQ[16]  |
| MIBSPI1 / MIBSPI3 / DCAN3 / MibADC2      | MIBSPI1[9] / MIBSPI3[9] / DCAN3 IF1 / MibADC2 G2                            | DMAREQ[17]  |
| RT11 / MIBSPI5                           | RT11 DMAREQ2 / MIBSPI5[8]                                                   | DMAREQ[18]  |
| RT11 / MIBSPI5                           | RT11 DMAREQ3 / MIBSPI5[9]                                                   | DMAREQ[19]  |
| NHET1 / NHET2 / DCAN3                    | NHET1 DMAREQ[4] / NHET2 DMAREQ[4] / DCAN3 IF2                               | DMAREQ[20]  |
| NHET1 / NHET2 / DCAN3                    | NHET1 DMAREQ[5] / NHET2 DMAREQ[5] / DCAN3 IF3                               | DMAREQ[21]  |
| MIBSPI1 / MIBSPI3 / MIBSPI5              | MIBSPI1[10] / MIBSPI3[10] / MIBSPI5[10]                                     | DMAREQ[22]  |
| MIBSPI1 / MIBSPI3 / MIBSPI5              | MIBSPI1[11] / MIBSPI3[11] / MIBSPI5[11]                                     | DMAREQ[23]  |
| NHET1 / NHET2 / MIBSPI4 / MIBSPI5        | NHET1 DMAREQ[6] / NHET2 DMAREQ[6] / MIBSPI4[1] <sup>(1)</sup> / MIBSPI5[12] | DMAREQ[24]  |
| NHET1 / NHET2 / MIBSPI4 / MIBSPI5        | NHET1 DMAREQ[7] / NHET2 DMAREQ[7] / MIBSPI4[0] <sup>(2)</sup> / MIBSPI5[13] | DMAREQ[25]  |
| CRC1 / MIBSPI1 / MIBSPI3                 | CRC1 DMAREQ[0] / MIBSPI1[12] / MIBSPI3[12]                                  | DMAREQ[26]  |
| CRC1 / MIBSPI1 / MIBSPI3                 | CRC1 DMAREQ[1] / MIBSPI1[13] / MIBSPI3[13]                                  | DMAREQ[27]  |
| LIN1 / MIBSPI5                           | LIN1 receive / MIBSPI5[14]                                                  | DMAREQ[28]  |
| LIN1 / MIBSPI5                           | LIN1 transmit / MIBSPI5[15]                                                 | DMAREQ[29]  |
| MIBSPI1 / MIBSPI3 / SCI3 / MIBSPI5       | MIBSPI1[14] / MIBSPI3[14] / SCI3 receive / MIBSPI5[1] <sup>(1)</sup>        | DMAREQ[30]  |
| MIBSPI1 / MIBSPI3 / SCI3 / MIBSPI5       | MIBSPI1[15] / MIBSPI3[15] / SCI3 transmit / MIBSPI5[0] <sup>(2)</sup>       | DMAREQ[31]  |
| I2C2 / ePWM1 / MIBSPI2 / MIBSPI4 / GIOA  | I2C2 receive / ePWM1_SOC_A / MIBSPI2[2] / MIBSPI4[2] / GIOA[0]              | DMAREQ[32]  |
| I2C2 / ePWM 1 / MIBSPI2 / MIBSPI4 / GIOA | I2C2 transmit / ePWM1_SOC_B / MIBSPI2[3] / MIBSPI4[3] / GIOA[1]             | DMAREQ[33]  |
| ePWM2 / MIBSPI2 / MIBSPI4 / GIOA         | ePWM2_SOC_A / MIBSPI2[4] / MIBSPI4[4] / GIOA[2]                             | DMAREQ[34]  |
| ePWM2 / MIBSPI2 / MIBSPI4 / GIOA         | ePWM2_SOC_B / MIBSPI2[5] / MIBSPI4[5] / GIOA[3]                             | DMAREQ[35]  |
| ePWM3 / MIBSPI2 / MIBSPI4 / GIOA         | ePWM3_SOC_A / MIBSPI2[6] / MIBSPI4[6] / GIOA[4]                             | DMAREQ[36]  |
| ePWM3 / MIBSPI2 / MIBSPI4 / GIOA         | ePWM3_SOC_B / MIBSPI2[7] / MIBSPI4[7] / GIOA[5]                             | DMAREQ[37]  |
| CRC2 / ePWM4 / MIBSPI2 / MIBSPI4 / GIOA  | CRC2 DMAREQ[0] / ePWM4_SOC_A / MIBSPI2[8] / MIBSPI4[8] / GIOA[6]            | DMAREQ[38]  |
| CRC2 / ePWM4 / MIBSPI2 / MIBSPI4 / GIOA  | CRC2 DMAREQ[1] / ePWM4_SOC_B / MIBSPI2[9] / MIBSPI4[9] / GIOA[7]            | DMAREQ[39]  |
| LIN2 / ePWM5 / MIBSPI2 / MIBSPI4 / GIOB  | LIN2 receive / ePWM5_SOC_A / MIBSPI2[10] / MIBSPI4[10] / GIOB[0]            | DMAREQ[40]  |
| LIN2 / ePWM5 / MIBSPI2 / MIBSPI4 / GIOB  | LIN2 transmit / ePWM5_SOC_B / MIBSPI2[11] / MIBSPI4[11] / GIOB[1]           | DMAREQ[41]  |

表 7-41. DMA Request Line Connection (续)

| MODULES                                  | DMA REQUEST SOURCES                                              | DMA REQUEST |
|------------------------------------------|------------------------------------------------------------------|-------------|
| SCI4 / ePWM6 / MIBSPI2 / MIBSPI4 / GIOB  | SCI4 receive / ePWM6_SOCA / MIBSPI2[12] / MIBSPI4[12] / GIOB[2]  | DMAREQ[42]  |
| SCI4 / ePWM6 / MIBSPI2 / MIBSPI4 / GIOB  | SCI4 transmit / ePWM6_SOCB / MIBSPI2[13] / MIBSPI4[13] / GIOB[3] | DMAREQ[43]  |
| ePWM7 / MIBSPI2 / MIBSPI4 / GIOB         | ePWM7_SOCA / MIBSPI2[14] / MIBSPI4[14] / GIOB[4]                 | DMAREQ[44]  |
| ePWM7 / MIBSPI2 / MIBSPI4 / GIOB / DCAN4 | ePWM7_SOCB / MIBSPI2[15] / MIBSPI4[15] / GIOB[5] / DCAN4 IF1     | DMAREQ[45]  |
| GIOB / DCAN4                             | GIOB[6] / DCAN4_IF2                                              | DMAREQ[46]  |
| GIOB / DCAN4                             | GIOB[7] / DCAN4_IF3                                              | DMAREQ[47]  |

- (1) SPI1, SPI2, SPI3, SPI4, SPI5 receive in compatibility mode  
 (2) SPI1, SPI2, SPI3, SPI4, SPI5 transmit in compatibility mode

#### 7.17.4 Using a GIO terminal as a DMA Request Input

Each GIO terminal can also directly be used as DMA request input as listed in 表 7-41. The polarity of the GIO terminal to trigger a DMA request can be selected inside the DMA module. To use the GIO terminal as a DMA request input, the corresponding select bit must be set to low. See 图 7-19 for an illustration. For more information see the technical reference guide SPNU563.

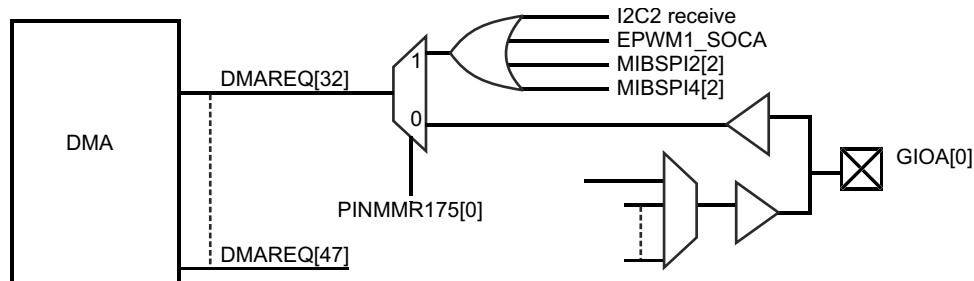


图 7-19. Using a GIO terminal as a DMA Request Input

表 7-42. GIO DMA Request Disable Mapping

| GIO TERMINAL | GIO DMA REQUEST SELECT BIT |
|--------------|----------------------------|
| GIOA[0]      | PINMMR175[0]               |
| GIOA[1]      | PINMMR175[8]               |
| GIOA[2]      | PINMMR175[16]              |
| GIOA[3]      | PINMMR175[24]              |
| GIOA[4]      | PINMMR176[0]               |
| GIOA[5]      | PINMMR176[8]               |
| GIOA[6]      | PINMMR176[16]              |
| GIOA[7]      | PINMMR176[24]              |
| GIOB[0]      | PINMMR177[0]               |
| GIOB[1]      | PINMMR177[8]               |
| GIOB[2]      | PINMMR177[16]              |
| GIOB[3]      | PINMMR177[24]              |
| GIOB[4]      | PINMMR178[0]               |
| GIOB[5]      | PINMMR178[8]               |
| GIOB[6]      | PINMMR178[16]              |
| GIOB[7]      | PINMMR178[24]              |

## 7.18 Real-Time Interrupt Module

The real-time interrupt (RTI) module provides timer functionality for operating systems and for benchmarking code. The RTI module can incorporate several counters that define the time bases needed for scheduling an operating system.

The timers also let you benchmark certain areas of code by reading the values of the counters at the beginning and the end of the desired code range and calculating the difference between the values.

### 7.18.1 Features

The RTI module has the following features:

- Two independent 64-bit counter blocks
- Four configurable compares for generating operating system ticks or DMA requests. Each event can be driven by either counter block 0 or counter block 1.
- Fast enabling/disabling of events
- Two timestamp (capture) functions for system or peripheral interrupts, one for each counter block

### 7.18.2 Block Diagrams

图 7-20 shows a high-level block diagram for one of the two 64-bit counter blocks inside the RTI module. Both the counter blocks are identical except the Network Time Unit (NTUx) inputs are only available as time-base inputs for the counter block 0. 图 7-21 shows the compare unit block diagram of the RTI module.

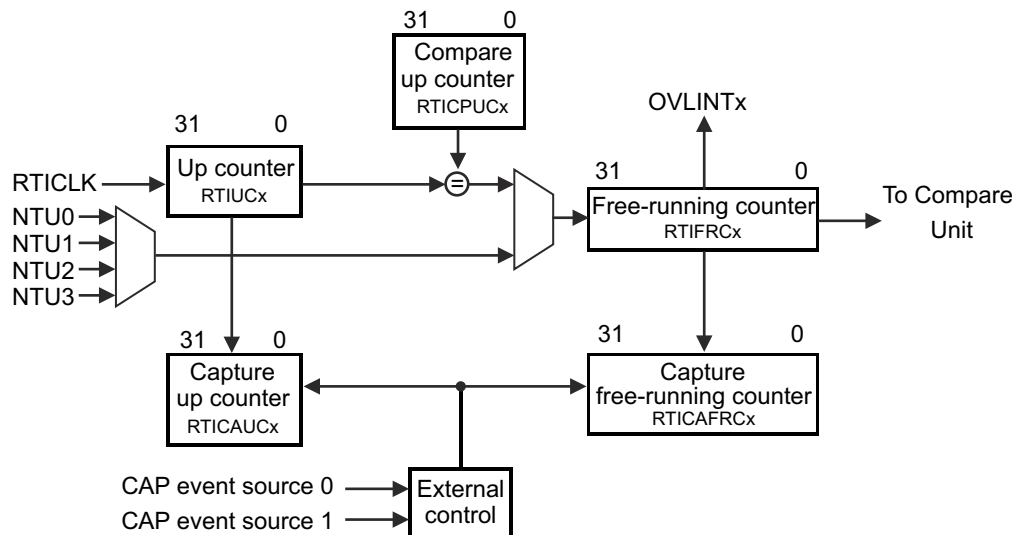


图 7-20. Counter Block Diagram

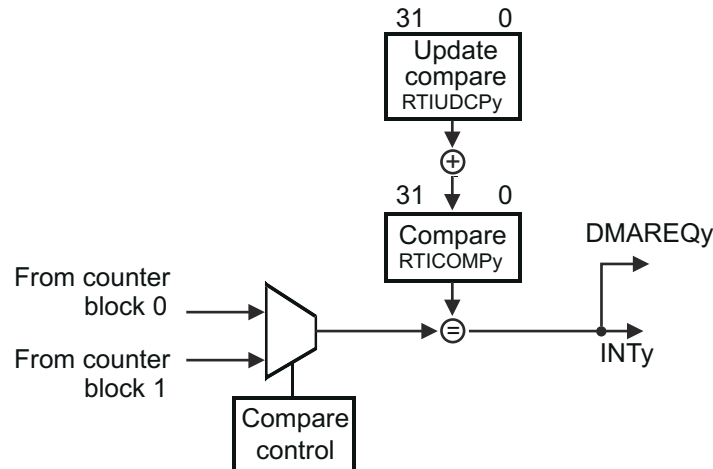


图 7-21. Compare Block Diagram

### 7.18.3 Clock Source Options

The RTI module uses the RTI1CLK clock domain for generating the RTI time bases.

The application can select the clock source for the RTI1CLK by configuring the RCLKSRC register in the system module at address 0xFFFFF50. The default source for RTI1CLK is VCLK.

For more information on clock sources, see 表 7-11 and 表 7-16.

### 7.18.4 Network Time Synchronization Inputs

The RTI module supports four Network Time Unit (NTU) inputs that signal internal system events, and which can be used to synchronize the time base used by the RTI module. On this device, these NTU inputs are connected as shown in 表 7-43.

表 7-43. Network Time Synchronization Inputs

| NTU INPUT | SOURCE                 |
|-----------|------------------------|
| 0         | FlexRay Macrotick      |
| 1         | FlexRay Start of Cycle |
| 2         | PLL2 Clock output      |
| 3         | EXTCLKIN1 clock input  |

## 7.19 Error Signaling Module

The Error Signaling Module (ESM) manages the various error conditions on the TMS570LCx microcontroller. The error condition is handled based on a fixed severity level assigned to it. Any severe error condition can be configured to drive a low level on a dedicated device terminal called nERROR. The nERROR can be used as an indicator to an external monitor circuit to put the system into a safe state.

### 7.19.1 ESM Features

The features of the ESM are:

- 160 interrupt/error channels are supported, divided into three groups
  - 96 channels with maskable interrupt and configurable error terminal behavior
  - 32 error channels with nonmaskable interrupt and predefined error terminal behavior
  - 32 channels with predefined error terminal behavior only
- Error terminal to signal severe device failure
- Configurable time base for error signal
- Error forcing capability

### 7.19.2 ESM Channel Assignments

The ESM integrates all the device error conditions and groups them in the order of severity. Group1 is used for errors of the lowest severity while Group3 is used for errors of the highest severity. The device response to each error is determined by the severity group to which the error is connected. 表 7-45 lists the channel assignment for each group.

表 7-44. ESM Groups

| ERROR GROUP | INTERRUPT CHARACTERISTICS      | INFLUENCE ON ERROR TERMINAL |
|-------------|--------------------------------|-----------------------------|
| Group1      | Maskable, low or high priority | Configurable                |
| Group2      | Nonmaskable, high priority     | Fixed                       |
| Group3      | No interrupt generated         | Fixed                       |

表 7-45. ESM Channel Assignments

| ESM ERROR SOURCES                                     | GROUP  | CHANNELS |
|-------------------------------------------------------|--------|----------|
| <b>Group1</b>                                         |        |          |
| Reserved                                              | Group1 | 0        |
| MibADC2 - parity                                      | Group1 | 1        |
| DMA - MPU error for CPU (DMAOCP_MPVINT(0))            | Group1 | 2        |
| DMA - ECC uncorrectable error                         | Group1 | 3        |
| EPC - Correctable Error                               | Group1 | 4        |
| Reserved                                              | Group1 | 5        |
| L2FMC - correctable error (implicit OTP read).        | Group1 | 6        |
| NHET1 - parity                                        | Group1 | 7        |
| HET TU1/HET TU2 - parity                              | Group1 | 8        |
| HET TU1/HET TU2 - MPU                                 | Group1 | 9        |
| PLL1 - slip                                           | Group1 | 10       |
| LPO Clock Monitor - interrupt                         | Group1 | 11       |
| FlexRay RAM - ECC uncorrectable error                 | Group1 | 12       |
| Reserved                                              | Group1 | 13       |
| FlexRay TU RAM - ECC uncorrectable error (TU_UCT_err) | Group1 | 14       |
| VIM RAM - ECC uncorrectable error                     | Group1 | 15       |

**表 7-45. ESM Channel Assignments (续)**

| ESM ERROR SOURCES                                | GROUP  | CHANNELS |
|--------------------------------------------------|--------|----------|
| FlexRay TU - MPU violation (TU_MPV_err)          | Group1 | 16       |
| MibSPI1 - ECC uncorrectable error                | Group1 | 17       |
| MibSPI3 - ECC uncorrectable error                | Group1 | 18       |
| MibADC1 - parity                                 | Group1 | 19       |
| DMA - Bus Error                                  | Group1 | 20       |
| DCAN1 - ECC uncorrectable error                  | Group1 | 21       |
| DCAN3 - ECC uncorrectable error                  | Group1 | 22       |
| DCAN2 - ECC uncorrectable error                  | Group1 | 23       |
| MibSPI5 - ECC uncorrectable error                | Group1 | 24       |
| Reserved                                         | Group1 | 25       |
| L2RAMW - correctable error                       | Group1 | 26       |
| Cortex-R5F CPU - self-test                       | Group1 | 27       |
| Reserved                                         | Group1 | 28       |
| Reserved                                         | Group1 | 29       |
| DCC1 - error                                     | Group1 | 30       |
| CCM-R5F - self-test                              | Group1 | 31       |
| Reserved                                         | Group1 | 32       |
| Reserved                                         | Group1 | 33       |
| NHET2 - parity                                   | Group1 | 34       |
| Reserved                                         | Group1 | 35       |
| Reserved                                         | Group1 | 36       |
| IOMM - Mux configuration error                   | Group1 | 37       |
| Power domain compare error                       | Group1 | 38       |
| Power domain self-test error                     | Group1 | 39       |
| eFuse farm - EFC error                           | Group1 | 40       |
| eFuse farm - self-test error                     | Group1 | 41       |
| PLL2 - slip                                      | Group1 | 42       |
| Ethernet Controller master interface             | Group1 | 43       |
| Reserved                                         | Group1 | 44       |
| Reserved                                         | Group1 | 45       |
| Cortex-R5F Core - cache correctable error event  | Group1 | 46       |
| ACP d-cache invalidate                           | Group1 | 47       |
| Reserved                                         | Group1 | 48       |
| MibSPI2 - ECC uncorrectable error                | Group1 | 49       |
| MibSPI4 - ECC uncorrectable error                | Group1 | 50       |
| DCAN4 - ECC uncorrectable error                  | Group1 | 51       |
| CPU Interconnect Subsystem - Global error        | Group1 | 52       |
| CPU Interconnect Subsystem - Global Parity Error | Group1 | 53       |
| NHET1/2 - self-test error                        | Group1 | 54       |
| NMPU - EMAC MPU Error                            | Group1 | 55       |
| Reserved                                         | Group1 | 56       |
| Reserved                                         | Group1 | 57       |
| Reserved                                         | Group1 | 58       |
| Reserved                                         | Group1 | 59       |
| Reserved                                         | Group1 | 60       |

表 7-45. ESM Channel Assignments (续)

| ESM ERROR SOURCES                                                                                              |                   |              | GROUP  | CHANNELS |
|----------------------------------------------------------------------------------------------------------------|-------------------|--------------|--------|----------|
| NMPU - PS_SCR_S MPU Error                                                                                      |                   |              | Group1 | 61       |
| DCC2 - error                                                                                                   |                   |              | Group1 | 62       |
| Reserved                                                                                                       |                   |              | Group1 | 63       |
| Reserved                                                                                                       |                   |              | Group1 | 64       |
| Reserved                                                                                                       |                   |              | Group1 | 65       |
| Reserved                                                                                                       |                   |              | Group1 | 66       |
| Reserved                                                                                                       |                   |              | Group1 | 67       |
| Reserved                                                                                                       |                   |              | Group1 | 68       |
| NMPU - DMA Port A MPU Error                                                                                    |                   |              | Group1 | 69       |
| DMA - Transaction Bus Parity Error                                                                             |                   |              | Group1 | 70       |
| FlexRay TU RAM- ECC single bit error (TU_SBE_err)                                                              |                   |              | Group1 | 71       |
| FlexRay - ECC single bit error                                                                                 |                   |              | Group1 | 72       |
| DCAN1 - ECC single bit error                                                                                   |                   |              | Group1 | 73       |
| DCAN2 - ECC single bit error                                                                                   |                   |              | Group1 | 74       |
| DCAN3 - ECC single bit error                                                                                   |                   |              | Group1 | 75       |
| DCAN4 - ECC single bit error                                                                                   |                   |              | Group1 | 76       |
| MIBSPI1 - ECC single bit error                                                                                 |                   |              | Group1 | 77       |
| MIBSPI2 - ECC single bit error                                                                                 |                   |              | Group1 | 78       |
| MIBSPI3 - ECC single bit error                                                                                 |                   |              | Group1 | 79       |
| MIBSPI4 - ECC single bit error                                                                                 |                   |              | Group1 | 80       |
| MIBSPI5 - ECC single bit error                                                                                 |                   |              | Group1 | 81       |
| DMA - ECC single bit error                                                                                     |                   |              | Group1 | 82       |
| VIM - ECC single bit error                                                                                     |                   |              | Group1 | 83       |
| EMIF 64-bit Bridge I/F ECC uncorrectable error                                                                 |                   |              | Group1 | 84       |
| EMIF 64-bit Bridge I/F ECC single bit error                                                                    |                   |              | Group1 | 85       |
| Reserved                                                                                                       |                   |              | Group1 | 86       |
| Reserved                                                                                                       |                   |              | Group1 | 87       |
| DMA - Register Soft Error                                                                                      |                   |              | Group1 | 88       |
| L2FMC - Register Soft Error                                                                                    |                   |              | Group1 | 89       |
| SYS - Register Soft Error                                                                                      |                   |              | Group1 | 90       |
| SCM - Time-out Error                                                                                           |                   |              | Group1 | 91       |
| CCM-R5F - Operating status                                                                                     |                   |              | Group1 | 92       |
| Reserved                                                                                                       |                   |              | Group1 | 93-95    |
| Group2                                                                                                         |                   |              |        |          |
| Reserved                                                                                                       |                   |              | Group2 | 0        |
| Reserved                                                                                                       |                   |              | Group2 | 1        |
| CCM-R5F - CPU compare error                                                                                    |                   |              | Group2 | 2        |
| Cortex-R5F Core - All fatal bus error events. [Commonly caused by improper or incomplete ECC values in Flash.] |                   |              | Group2 | 3        |
|                                                                                                                |                   |              |        |          |
| Event Reference                                                                                                | Event Description | EVNTBUSm bit | Group2 | 3        |
| 0x71                                                                                                           | Bus ECC           | 48           |        |          |
| Reserved                                                                                                       |                   |              | Group2 | 4        |
| Reserved                                                                                                       |                   |              | Group2 | 5        |
| Reserved                                                                                                       |                   |              | Group2 | 6        |
| L2RAMW - Uncorrectable error type B                                                                            |                   |              | Group2 | 7        |

**表 7-45. ESM Channel Assignments (续)**

| ESM ERROR SOURCES                                            |                      |              | GROUP  | CHANNELS |
|--------------------------------------------------------------|----------------------|--------------|--------|----------|
| Reserved                                                     |                      |              | Group2 | 8        |
| Reserved                                                     |                      |              | Group2 | 9        |
| Reserved                                                     |                      |              | Group2 | 10       |
| Reserved                                                     |                      |              | Group2 | 11       |
| Reserved                                                     |                      |              | Group2 | 12       |
| Reserved                                                     |                      |              | Group2 | 13       |
| Reserved                                                     |                      |              | Group2 | 14       |
| Reserved                                                     |                      |              | Group2 | 15       |
| Reserved                                                     |                      |              | Group2 | 16       |
| L2FMC - parity error                                         |                      |              | Group2 | 17       |
| • Mcmd parity error on Idle command                          |                      |              |        |          |
| • POM idle state parity error                                |                      |              |        |          |
| • Port A/B Idle state parity error                           |                      |              |        |          |
| Reserved                                                     |                      |              | Group2 | 18       |
| L2FMC - double bit ECC error-error due to implicit OTP reads |                      |              | Group2 | 19       |
| Reserved                                                     |                      |              | Group2 | 20       |
| EPC - Uncorrectable Error                                    |                      |              | Group2 | 21       |
| Reserved                                                     |                      |              | Group2 | 22       |
| Reserved                                                     |                      |              | Group2 | 23       |
| RTI_WWD_NMI                                                  |                      |              | Group2 | 24       |
| CCM-R5F VIM compare error                                    |                      |              | Group2 | 25       |
| CPU1 AXIM Bus Monitor failure                                |                      |              | Group2 | 26       |
| Reserved                                                     |                      |              | Group2 | 27       |
| CCM-R5F - Power Domain monitor error                         |                      |              | Group2 | 28       |
| Reserved                                                     |                      |              | Group2 | 29       |
| Reserved                                                     |                      |              | Group2 | 30       |
| Reserved                                                     |                      |              | Group2 | 31       |
| <b>Group3</b>                                                |                      |              |        |          |
| Reserved                                                     |                      |              | Group3 | 0        |
| eFuse Farm - autoloader error                                |                      |              | Group3 | 1        |
| Reserved                                                     |                      |              | Group3 | 2        |
| L2RAMW - double bit ECC uncorrectable error                  |                      |              | Group3 | 3        |
| Reserved                                                     |                      |              | Group3 | 4        |
| Reserved                                                     |                      |              | Group3 | 5        |
| Reserved                                                     |                      |              | Group3 | 6        |
| Reserved                                                     |                      |              | Group3 | 7        |
| Reserved                                                     |                      |              | Group3 | 8        |
| Cortex-R5F Core - All fatal events (OR of:                   |                      |              | Group3 | 9        |
| Event Reference Value                                        | Event Description    | EVNTBUSm Bit |        |          |
| 0x60                                                         | Data Cache           | 33           |        |          |
| 0x61                                                         | Data Cache tag/dirty | 34           |        |          |
| Reserved                                                     |                      |              | Group3 | 10       |
| Reserved                                                     |                      |              | Group3 | 11       |
| CPU Interconnect Subsystem - Diagnostic Error                |                      |              | Group3 | 12       |

表 7-45. ESM Channel Assignments (续)

| ESM ERROR SOURCES                                                                                                                                                                 | GROUP  | CHANNELS |
|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--------|----------|
| L2FMC - uncorrectable error due to: <ul style="list-style-type: none"> <li>address parity/internal parity error</li> <li>address tag</li> <li>internal switch time-out</li> </ul> | Group3 | 13       |
| L2RAMW - Uncorrectable error Type A                                                                                                                                               | Group3 | 14       |
| L2RAMW - Address/Control parity error                                                                                                                                             | Group3 | 15       |
| Reserved                                                                                                                                                                          | Group3 | 16       |
| Reserved                                                                                                                                                                          | Group3 | 17       |
| Reserved                                                                                                                                                                          | Group3 | 18       |
| Reserved                                                                                                                                                                          | Group3 | 19       |
| Reserved                                                                                                                                                                          | Group3 | 20       |
| Reserved                                                                                                                                                                          | Group3 | 21       |
| Reserved                                                                                                                                                                          | Group3 | 22       |
| Reserved                                                                                                                                                                          | Group3 | 23       |
| Reserved                                                                                                                                                                          | Group3 | 24       |

## 7.20 Reset / Abort / Error Sources

表 7-46. Reset/Abort/Error Sources

| ERROR SOURCE                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                 | SYSTEM MODE    | ERROR RESPONSE                                  | ESM HOOKUP GROUP.CHANNEL |
|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|----------------|-------------------------------------------------|--------------------------|
| <b>CPU TRANSACTIONS</b>                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                      |                |                                                 |                          |
| Precise write error (NCNB/Strongly Ordered)                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                  | User/Privilege | Precise Abort (CPU)                             | N/A                      |
| Precise read error (NCB/Device or Normal)                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                    | User/Privilege | Precise Abort (CPU)                             | N/A                      |
| Imprecise write error (NCB/Device or Normal)                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                 | User/Privilege | Imprecise Abort (CPU)                           | N/A                      |
| Illegal instruction                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                          | User/Privilege | Undefined Instruction Trap (CPU) <sup>(1)</sup> | N/A                      |
| MPU access violation                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                         | User/Privilege | Abort (CPU)                                     | N/A                      |
| Correctable error                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                            | User/Privilege | ESM                                             | 1.4                      |
| Uncorrectable error                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                          | User/Privilege | ESM => NMI                                      | 2.21                     |
| <b>LEVEL 2 SRAM</b>                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                          |                |                                                 |                          |
| CPU Write ECC single error (correctable)                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                     | User/Privilege | ESM                                             | 1.26                     |
| <b>ECC double bit error:</b><br>Read-Modify-Write (RMW) ECC double error<br>CPU Write ECC double error                                                                                                                                                                                                                                                                                                                                                                                                                                                       | User/Privilege | Bus Error, ESM => nERROR                        | 3.3                      |
| <b>Uncorrectable error Type A:</b><br>Write SECCDED malfunction error<br>Redundant address decode error<br>Read SECCDED malfunction error                                                                                                                                                                                                                                                                                                                                                                                                                    | User/Privilege | Bus Error, ESM => nERROR                        | 3.14                     |
| <b>Uncorrectable error type B:</b><br>Memory scrubbing SECCDED malfunction error<br>Memory scrubbing Redundant address decode error<br>Memory scrubbing address/control parity error<br>Write data merged mux diagnostic error<br>Write SECCDED malfunction diagnostic error<br>Read SECCDED malfunction diagnostic error<br>Write ECC correctable and uncorrectable diagnostic error<br>Read ECC correctable and uncorrectable diagnostic error<br>Write data merged mux error<br>Redundant address decode diagnostic error<br>Command parity error on idle | User/Privilege | ESM => NMI                                      | 2.7                      |
| Address/Control parity error                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                 | User/Privilege | Bus Error, ESM => nERROR                        | 3.15                     |
| Level 2 RAM illegal address error Memory initialization error                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                | User/Privilege | Bus Error                                       | N/A                      |
| <b>FLASH</b>                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                 |                |                                                 |                          |
| L2FMC correctable error - single bit ECC error for implicit OTP read                                                                                                                                                                                                                                                                                                                                                                                                                                                                                         | User/Privilege | ESM                                             | 1.6                      |
| L2FMC uncorrectable error - double bit ECC error for implicit OTP read                                                                                                                                                                                                                                                                                                                                                                                                                                                                                       | User/Privilege | ESM => NMI                                      | 2.19                     |
| <b>L2FMC fatal uncorrectable error:</b><br>address parity error/internal parity error<br>address tag error<br>Internal switch time-out                                                                                                                                                                                                                                                                                                                                                                                                                       | User/Privilege | Bus Error, ESM => nERROR                        | 3.13                     |
| <b>L2FMC parity error:</b><br>Mcmd parity error on Idle command<br>POM idle state parity error<br>Port A/B Idle state parity error                                                                                                                                                                                                                                                                                                                                                                                                                           | User/Privilege | ESM => NMI                                      | 2.17                     |
| <b>L2FMC nonfatal uncorrectable error:</b><br>Response error on POM<br>Response parity error on POM<br>Bank accesses during special operation (program/erase) by the FSM<br>Bank/Pump in sleep<br>Unimplemented special/unavailable space                                                                                                                                                                                                                                                                                                                    | User/Privilege | Bus Error                                       | N/A                      |

表 7-46. Reset/Abort/Error Sources (续)

| ERROR SOURCE                                                    | SYSTEM MODE    | ERROR RESPONSE   | ESM HOOKUP GROUP.CHANNEL |
|-----------------------------------------------------------------|----------------|------------------|--------------------------|
| L2FMC register soft error.                                      | User/Privilege | ESM              | 1.89                     |
| <b>DMA TRANSACTIONS</b>                                         |                |                  |                          |
| Memory access permission violation                              | User/Privilege | ESM              | 1.2                      |
| Memory ECC uncorrectable error                                  | User/Privilege | ESM              | 1.3                      |
| Transaction Error:<br>that is, Bus Parity Error                 | User/Privilege | ESM              | 1.70                     |
| Memory ECC single bit error                                     | User/Privilege | ESM              | 1.82                     |
| DMA register soft error                                         | User/Privilege | ESM              | 1.88                     |
| DMA bus error                                                   | User/Privilege | ESM              | 1.20                     |
| <b>EMIF_ECC</b>                                                 |                |                  |                          |
| 64-bit Bridge I/F ECC uncorrectable error                       | User/Privilege | ESM              | 1.84                     |
| 64-bit Bridge I/F ECC single error                              | User/Privilege | ESM              | 1.85                     |
| <b>HET TU1 (HTU1)</b>                                           |                |                  |                          |
| NCNB (Strongly Ordered) transaction with slave error response   | User/Privilege | Interrupt => VIM | N/A                      |
| External imprecise error (Illegal transaction with ok response) | User/Privilege | Interrupt => VIM | N/A                      |
| Memory access permission violation                              | User/Privilege | ESM              | 1.9                      |
| Memory parity error                                             | User/Privilege | ESM              | 1.8                      |
| <b>HET TU2 (HTU2)</b>                                           |                |                  |                          |
| NCNB (Strongly Ordered) transaction with slave error response   | User/Privilege | Interrupt => VIM | N/A                      |
| External imprecise error (Illegal transaction with ok response) | User/Privilege | Interrupt => VIM | N/A                      |
| Memory access permission violation                              | User/Privilege | ESM              | 1.9                      |
| Memory parity error                                             | User/Privilege | ESM              | 1.8                      |
| <b>N2HET1</b>                                                   |                |                  |                          |
| Memory parity error                                             | User/Privilege | ESM              | 1.7                      |
| <b>N2HET2</b>                                                   |                |                  |                          |
| Memory parity error                                             | User/Privilege | ESM              | 1.34                     |
| <b>MibSPI</b>                                                   |                |                  |                          |
| MibSPI1 memory ECC uncorrectable error                          | User/Privilege | ESM              | 1.17                     |
| MibSPI2 memory ECC uncorrectable error                          | User/Privilege | ESM              | 1.49                     |
| MibSPI3 memory ECC uncorrectable error                          | User/Privilege | ESM              | 1.18                     |
| MibSPI4 memory ECC uncorrectable error                          | User/Privilege | ESM              | 1.50                     |
| MibSPI5 memory ECC uncorrectable error                          | User/Privilege | ESM              | 1.24                     |
| MibSPI1 memory ECC single error                                 | User/Privilege | ESM              | 1.77                     |
| MibSPI2 memory ECC single error                                 | User/Privilege | ESM              | 1.78                     |
| MibSPI3 memory ECC single error                                 | User/Privilege | ESM              | 1.79                     |
| MibSPI4 memory ECC single error                                 | User/Privilege | ESM              | 1.80                     |
| MibSPI5 memory ECC single error                                 | User/Privilege | ESM              | 1.81                     |
| <b>MibADC</b>                                                   |                |                  |                          |
| MibADC1 Memory parity error                                     | User/Privilege | ESM              | 1.19                     |
| MibADC2 Memory parity error                                     | User/Privilege | ESM              | 1.1                      |
| <b>DCAN</b>                                                     |                |                  |                          |
| DCAN1 memory ECC uncorrectable error                            | User/Privilege | ESM              | 1.21                     |
| DCAN2 memory ECC uncorrectable error                            | User/Privilege | ESM              | 1.23                     |
| DCAN3 memory ECC uncorrectable error                            | User/Privilege | ESM              | 1.22                     |

**表 7-46. Reset/Abort/Error Sources (续)**

| ERROR SOURCE                                                                             | SYSTEM MODE    | ERROR RESPONSE   | ESM HOOKUP GROUP.CHANNEL |
|------------------------------------------------------------------------------------------|----------------|------------------|--------------------------|
| DCAN4 memory ECC uncorrectable error                                                     | User/Privilege | ESM              | 1.51                     |
| DCAN1 memory ECC single error                                                            | User/Privilege | ESM              | 1.73                     |
| DCAN2 memory ECC single error                                                            | User/Privilege | ESM              | 1.74                     |
| DCAN3 memory ECC single error                                                            | User/Privilege | ESM              | 1.75                     |
| DCAN4 memory ECC single error                                                            | User/Privilege | ESM              | 1.76                     |
| <b>PLL</b>                                                                               |                |                  |                          |
| PLL1 slip error                                                                          | User/Privilege | ESM              | 1.10                     |
| PLL2 slip error                                                                          | User/Privilege | ESM              | 1.42                     |
| <b>Clock Monitor</b>                                                                     |                |                  |                          |
| Clock monitor interrupt                                                                  | User/Privilege | ESM              | 1.11                     |
| <b>DCC</b>                                                                               |                |                  |                          |
| DCC1 error                                                                               | User/Privilege | ESM              | 1.30                     |
| DCC2 error                                                                               | User/Privilege | ESM              | 1.62                     |
| <b>CCM-R5F</b>                                                                           |                |                  |                          |
| Self-test failure                                                                        | User/Privilege | ESM              | 1.31                     |
| CPU Bus Compare failure                                                                  | User/Privilege | ESM => NMI       | 2.2                      |
| VIM Bus Compare failure                                                                  | User/Privilege | ESM => NMI       | 2.25                     |
| Power Domain Monitor failure                                                             | User/Privilege | ESM => NMI       | 2.28                     |
| CCM-R5F operating status (asserted when not in lockstep or CCM-R5F is in self-test mode) | User/Privilege | ESM              | 1.92                     |
| <b>EPC (Error Profiling Controller)</b>                                                  |                |                  |                          |
| Correctable Error                                                                        | User/Privilege | ESM              | 1.4                      |
| Uncorrectable Error                                                                      | User/Privilege | ESM => NMI       | 2.21                     |
| <b>SCM (SCR Control module)</b>                                                          |                |                  |                          |
| Time-out Error                                                                           | User/Privilege | ESM              | 1.91                     |
| <b>FlexRay</b>                                                                           |                |                  |                          |
| Memory ECC uncorrectable error                                                           | User/Privilege | ESM              | 1.12                     |
| Memory ECC single error                                                                  | User/Privilege | ESM              | 1.72                     |
| <b>FlexRay TU</b>                                                                        |                |                  |                          |
| NCNB (Strongly Ordered) transaction with slave error response                            | User/Privilege | Interrupt => VIM | N/A                      |
| External imprecise error (Illegal transaction with ok response)                          | User/Privilege | Interrupt => VIM | N/A                      |
| Memory access permission violation                                                       | User/Privilege | ESM              | 1.16                     |
| Memory ECC uncorrectable error                                                           | User/Privilege | ESM              | 1.14                     |
| Memory ECC single bit error                                                              | User/Privilege | ESM              | 1.71                     |
| <b>Ethernet master interface</b>                                                         |                |                  |                          |
| Any error reported by slave being accessed                                               | User/Privilege | ESM              | 1.43                     |
| <b>VIM</b>                                                                               |                |                  |                          |
| Memory ECC uncorrectable error                                                           | User/Privilege | ESM              | 1.15                     |
| Memory ECC single bit error                                                              | User/Privilege | ESM              | 1.83                     |
| <b>Voltage Monitor</b>                                                                   |                |                  |                          |
| VMON out of voltage range                                                                | N/A            | Reset            | N/A                      |
| <b>Self-Test (LBIST)</b>                                                                 |                |                  |                          |
| Cortex-R5F CPU self-test (LBIST) error                                                   | User/Privilege | ESM              | 1.27                     |
| NHET Self-test (LBIST) error                                                             | User/Privilege | ESM              | 1.54                     |

表 7-46. Reset/Abort/Error Sources (续)

| ERROR SOURCE                                   | SYSTEM MODE    | ERROR RESPONSE        | ESM HOOKUP GROUP.CHANNEL |
|------------------------------------------------|----------------|-----------------------|--------------------------|
| <b>IOMM (terminal multiplexing control)</b>    |                |                       |                          |
| Mux configuration error                        | User/Privilege | ESM                   | 1.37                     |
| <b>Power Domain Control</b>                    |                |                       |                          |
| Power Domain control access privilege error    | User           | Imprecise Abort (CPU) | N/A                      |
| PSCON compare error                            | User/Privilege | ESM                   | 1.38                     |
| PSCON self-test error                          | User/Privilege | ESM                   | 1.39                     |
| <b>Efuse farm</b>                              |                |                       |                          |
| eFuse farm autoload error                      | User/Privilege | ESM                   | 3.1                      |
| eFuse farm error                               | User/Privilege | ESM                   | 1.40                     |
| eFuse farm self-test error                     | User/Privilege | ESM                   | 1.41                     |
| <b>Windowed Watchdog</b>                       |                |                       |                          |
| WWD Nonmaskable Interrupt Exception            | N/A            | ESM                   | 2.24                     |
| <b>Errors Reflected in the SYSESR Register</b> |                |                       |                          |
| Power-Up Reset                                 | N/A            | Reset                 | N/A                      |
| Oscillator fail / PLL slip <sup>(2)</sup>      | N/A            | Reset                 | N/A                      |
| Watchdog exception                             | N/A            | Reset                 | N/A                      |
| CPUx Reset                                     | N/A            | Reset                 | N/A                      |
| Software Reset                                 | N/A            | Reset                 | N/A                      |
| External Reset                                 | N/A            | Reset                 | N/A                      |
| Register Soft Error                            | User/Privilege | ESM                   | 1.90                     |
| <b>CPU Interconnect Subsystem</b>              |                |                       |                          |
| Diagnostic error                               | User/Privilege | ESM => Error terminal | 3.12                     |
| Global error                                   | User/Privilege | ESM                   | 1.52                     |
| Global Parity error                            | User/Privilege | ESM                   | 1.53                     |
| <b>NMPU for EMAC</b>                           |                |                       |                          |
| MPU Access violation error                     | User/Privilege | ESM                   | 1.55                     |
| <b>NMPU for PS_SCR_S</b>                       |                |                       |                          |
| MPU Access violation error                     | User/Privilege | ESM                   | 1.61                     |
| <b>NMPU for DMA Port A</b>                     |                |                       |                          |
| MPU Access violation error                     | User/Privilege | ESM                   | 1.69                     |
| <b>PCR1</b>                                    |                |                       |                          |
| MasterID filtering MPU Access violation error  | User/Privilege | Bus Error             | N/A                      |
| <b>PCR2</b>                                    |                |                       |                          |
| MasterID filtering MPU Access violation error  | User/Privilege | Bus Error             | N/A                      |
| <b>PCR3</b>                                    |                |                       |                          |
| MasterID filtering MPU Access violation error  | User/Privilege | Bus Error             | N/A                      |

- (1) The Undefined Instruction TRAP is not detectable outside the CPU. The trap is taken only if the instruction reaches the execute stage of the CPU.
- (2) Oscillator fail/PLL slip can be configured in the system register (SYS.PLLCTL1) to generate a reset.

## 7.21 Digital Windowed Watchdog

This device includes a Digital Windowed Watchdog (DWWD) module that protects against runaway code execution (see 图 7-22).

The DWWD module allows the application to configure the time window within which the DWWD module expects the application to service the watchdog. A watchdog violation occurs if the application services the watchdog outside of this window, or fails to service the watchdog at all. The application can choose to generate a system reset or a nonmaskable interrupt to the CPU in case of a watchdog violation.

The watchdog is disabled by default and must be enabled by the application. Once enabled, the watchdog can only be disabled upon a system reset.

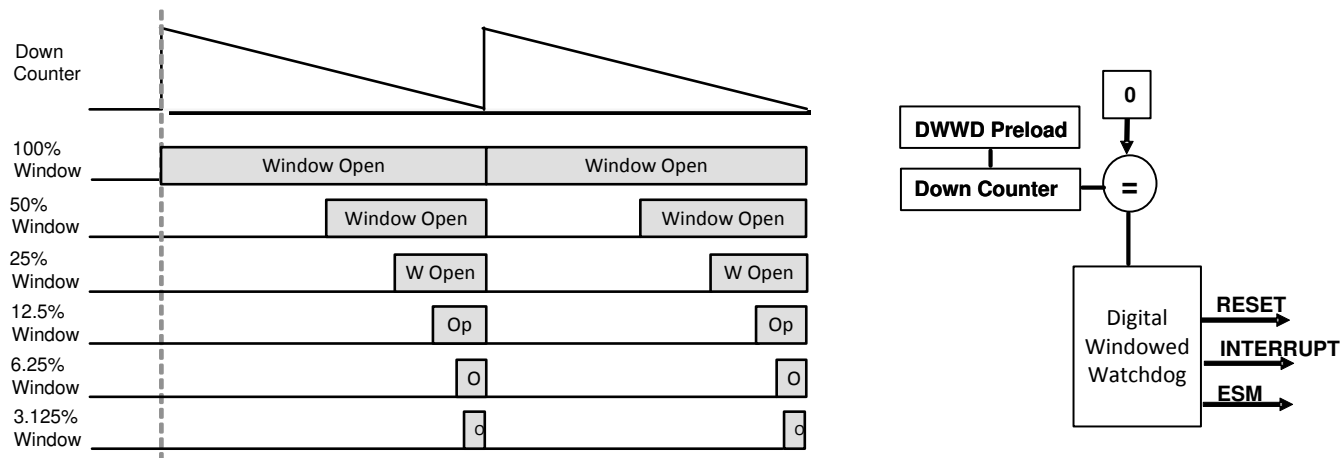


图 7-22. Digital Windowed Watchdog Example

## 7.22 Debug Subsystem

### 7.22.1 Block Diagram

The device contains an ICEPICK module (version C) to allow JTAG access to the scan chains (see 图 7-23).

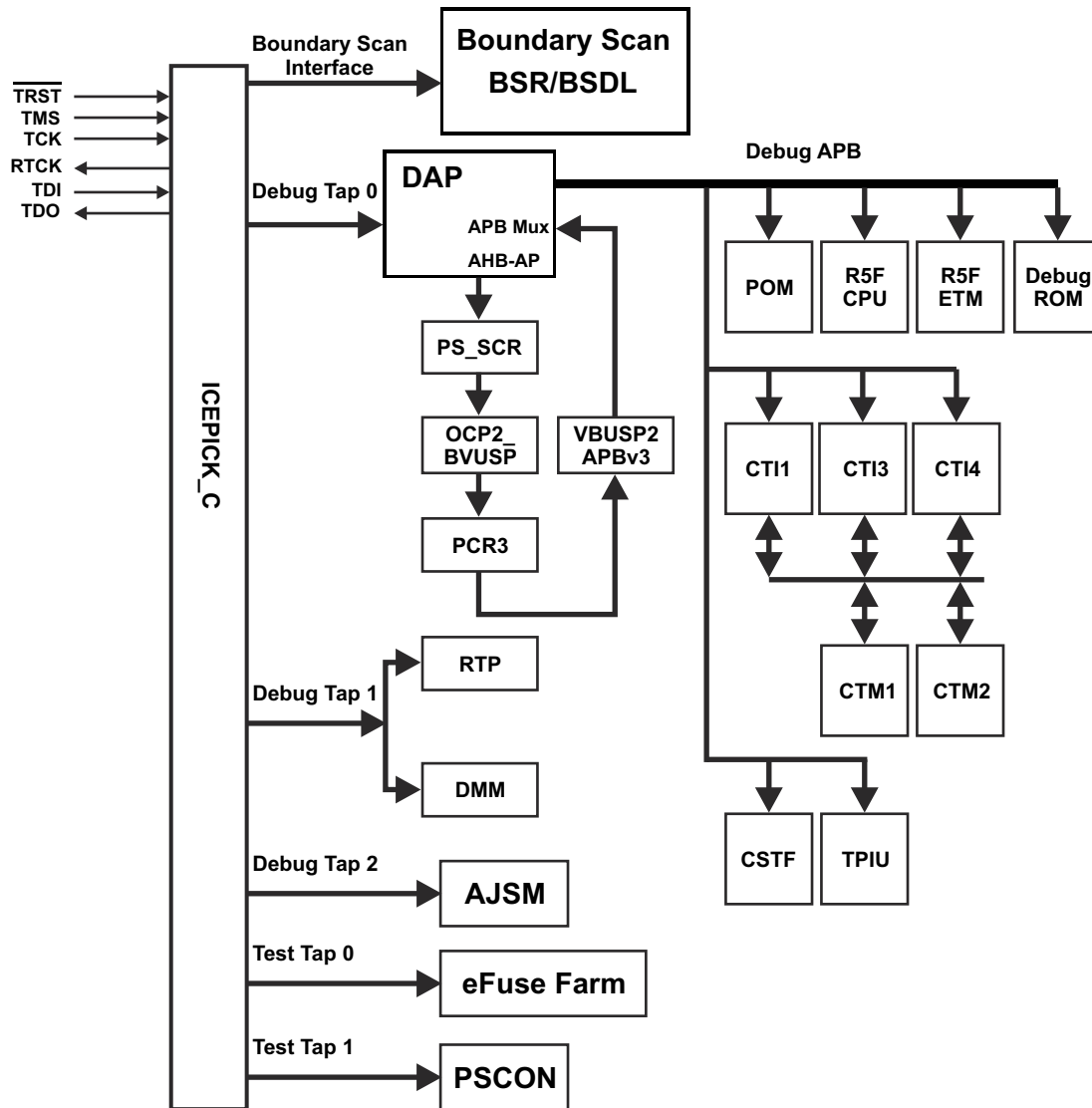


图 7-23. Debug Subsystem Block Diagram

## 7.22.2 Debug Components Memory Map

**表 7-47. Debug Components Memory Map**

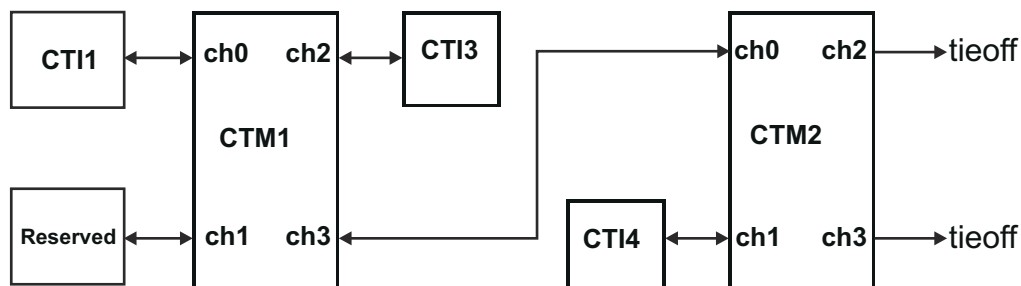
| MODULE NAME         | FRAME CHIP SELECT | FRAME ADDRESS RANGE |             | FRAME SIZE | ACTUAL SIZE | RESPONSE FOR ACCESS TO UNIMPLEMENTED LOCATIONS IN FRAME |
|---------------------|-------------------|---------------------|-------------|------------|-------------|---------------------------------------------------------|
|                     |                   | START               | END         |            |             |                                                         |
| CoreSight Debug ROM | CSCS0             | 0xFFA0_0000         | 0xFFA0_0FFF | 4KB        | 4KB         | Reads return zeros, writes have no effect               |
| Cortex-R5F Debug    | CSCS1             | 0xFFA0_1000         | 0xFFA0_1FFF | 4KB        | 4KB         | Reads return zeros, writes have no effect               |
| ETM-R5              | CSCS2             | 0xFFA0_2000         | 0xFFA0_2FFF | 4KB        | 4KB         | Reads return zeros, writes have no effect               |
| CoreSight TPIU      | CSCS3             | 0xFFA0_3000         | 0xFFA0_3FFF | 4KB        | 4KB         | Reads return zeros, writes have no effect               |
| POM                 | CSCS4             | 0xFFA0_4000         | 0xFFA0_4FFF | 4KB        | 4KB         | Reads return zeros, writes have no effect               |
| CTI1                | CSCS7             | 0xFFA0_7000         | 0xFFA0_7FFF | 4KB        | 4KB         | Reads return zeros, writes have no effect               |
| CTI3                | CSCS9             | 0xFFA0_9000         | 0xFFA0_9FFF | 4KB        | 4KB         | Reads return zeros, writes have no effect               |
| CTI4                | CSCS10            | 0xFFA0_A000         | 0xFFA0_AFFF | 4KB        | 4KB         | Reads return zeros, writes have no effect               |
| CSTF                | CSCS11            | 0xFFA0_B000         | 0xFFA0_BFFF | 4KB        | 4KB         | Reads return zeros, writes have no effect               |

## 7.22.3 Embedded Cross Trigger

The Embedded Cross Trigger (ECT) is a modular component that supports the interaction and synchronization of multiple triggering events within a SoC.

The ECT consists of two modules:

- A (Cross Trigger Interface) CTI. The CTI provides the interface between a component or subsystem and the Cross Trigger Matrix (CTM).
- A CTM. The CTM combines the trigger requests generated from CTIs and broadcasts them to all CTIs as channel triggers. This enables subsystems to interact, cross trigger, with one another.



**图 7-24. CTI/CTM Integration**

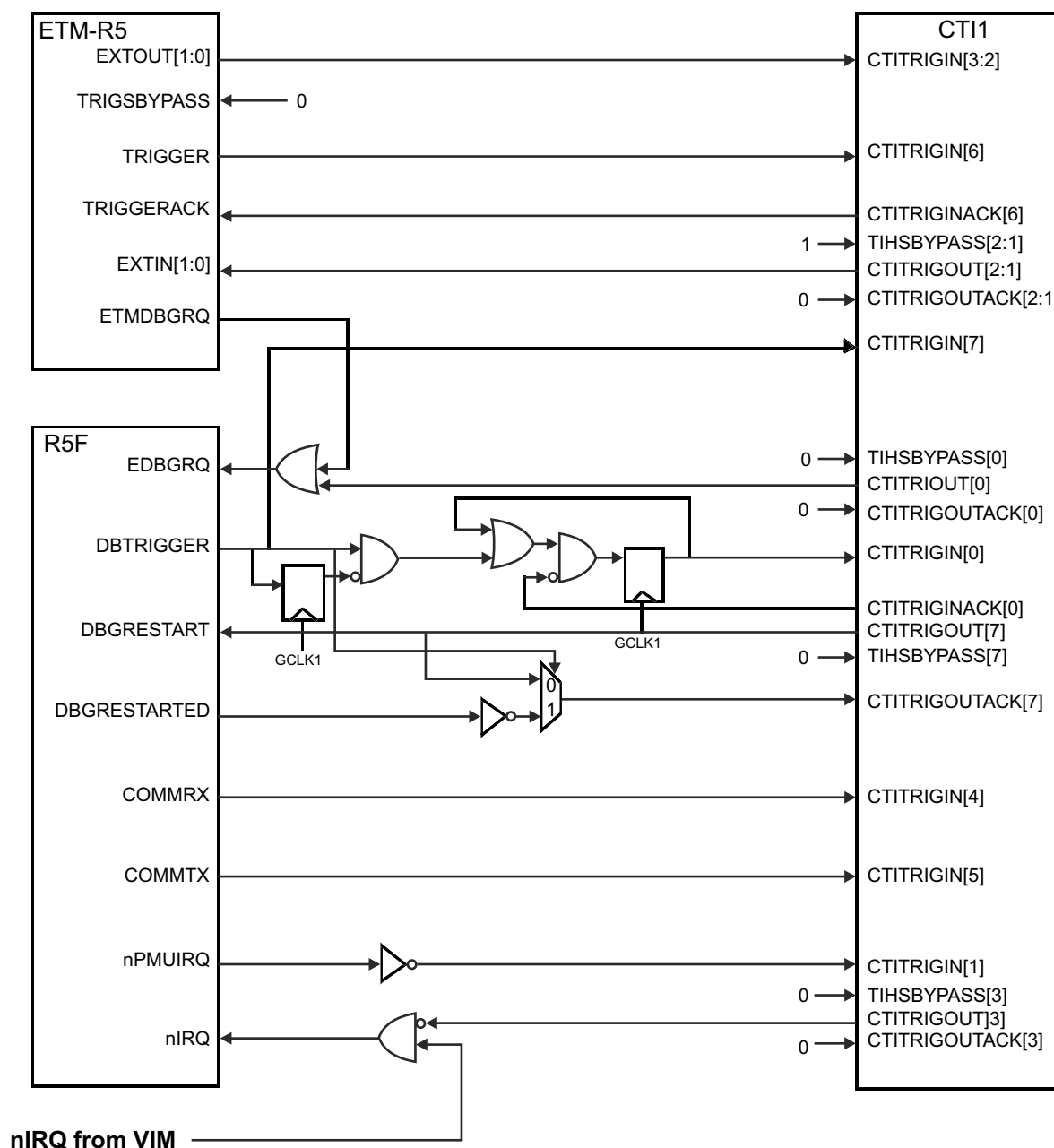


图 7-25. CTI1 Mapping

备注

ETM-R5, Cortex-R5F and CTI1 run at same frequency.

**表 7-48. CTI1 Mapping**

| CTI TRIGGER      | Module Signal              |
|------------------|----------------------------|
| Trigger Input 0  | From Cortex-R5F DBTRIGGER  |
| Trigger Input 1  | From Cortex-R5F nPMUIRQ    |
| Trigger Input 2  | From ETM-R5 EXTOUT[0]      |
| Trigger Input 3  | From ETM-R5 EXTOUT[1]      |
| Trigger Input 4  | From Cortex-R5F COMMRX     |
| Trigger Input 5  | From Cortex-R5F COMMTX     |
| Trigger Input 6  | From ETM-R5 TRIGGER        |
| Trigger Input 7  | From Cortex-R5F DBTRIGGER  |
| Trigger Output 0 | To Cortex-R5F EDBGRRQ      |
| Trigger Output 1 | To ETM-R5 EXTIN[0]         |
| Trigger Output 2 | To ETM-R5 EXTIN[1]         |
| Trigger Output 3 | To Cortex-R5F nIRQ         |
| Trigger Output 4 | Reserved                   |
| Trigger Output 5 | Reserved                   |
| Trigger Output 6 | Reserved                   |
| Trigger Output 7 | To Cortex-R5F DBGRESTARTED |

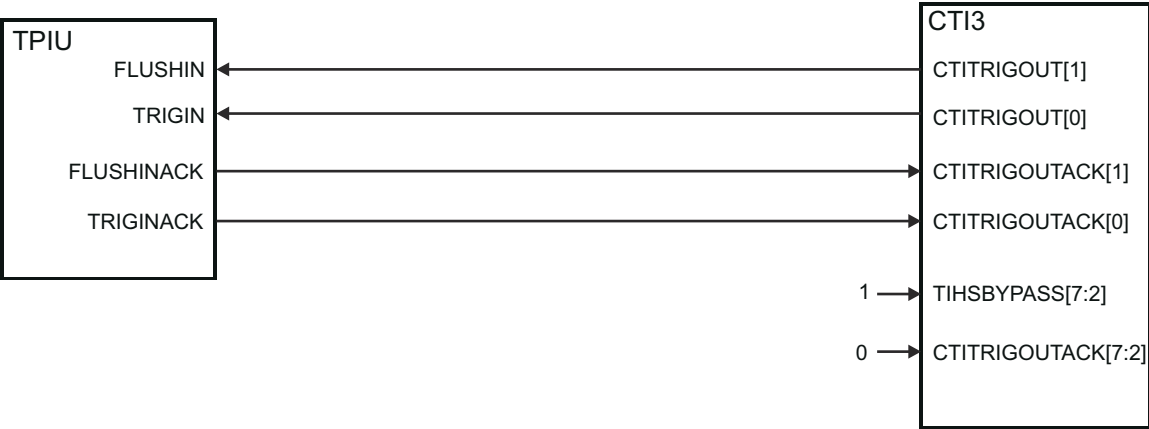


图 7-26. CTI3 Mapping

备注

TPIU and CTI3 run at different frequencies.

表 7-49. CTI3 Mapping

| CTI TRIGGER      | Module Signal   |
|------------------|-----------------|
| Trigger Input 0  | Reserved        |
| Trigger Input 1  | Reserved        |
| Trigger Input 2  | Reserved        |
| Trigger Input 3  | Reserved        |
| Trigger Input 4  | Reserved        |
| Trigger Input 5  | Reserved        |
| Trigger Input 6  | Reserved        |
| Trigger Input 7  | Reserved        |
| Trigger Output 0 | To TPIU TRIGIN  |
| Trigger Output 1 | To TPIU FLUSHIN |
| Trigger Output 2 | Reserved        |
| Trigger Output 3 | Reserved        |
| Trigger Output 4 | Reserved        |
| Trigger Output 5 | Reserved        |
| Trigger Output 6 | Reserved        |
| Trigger Output 7 | Reserved        |

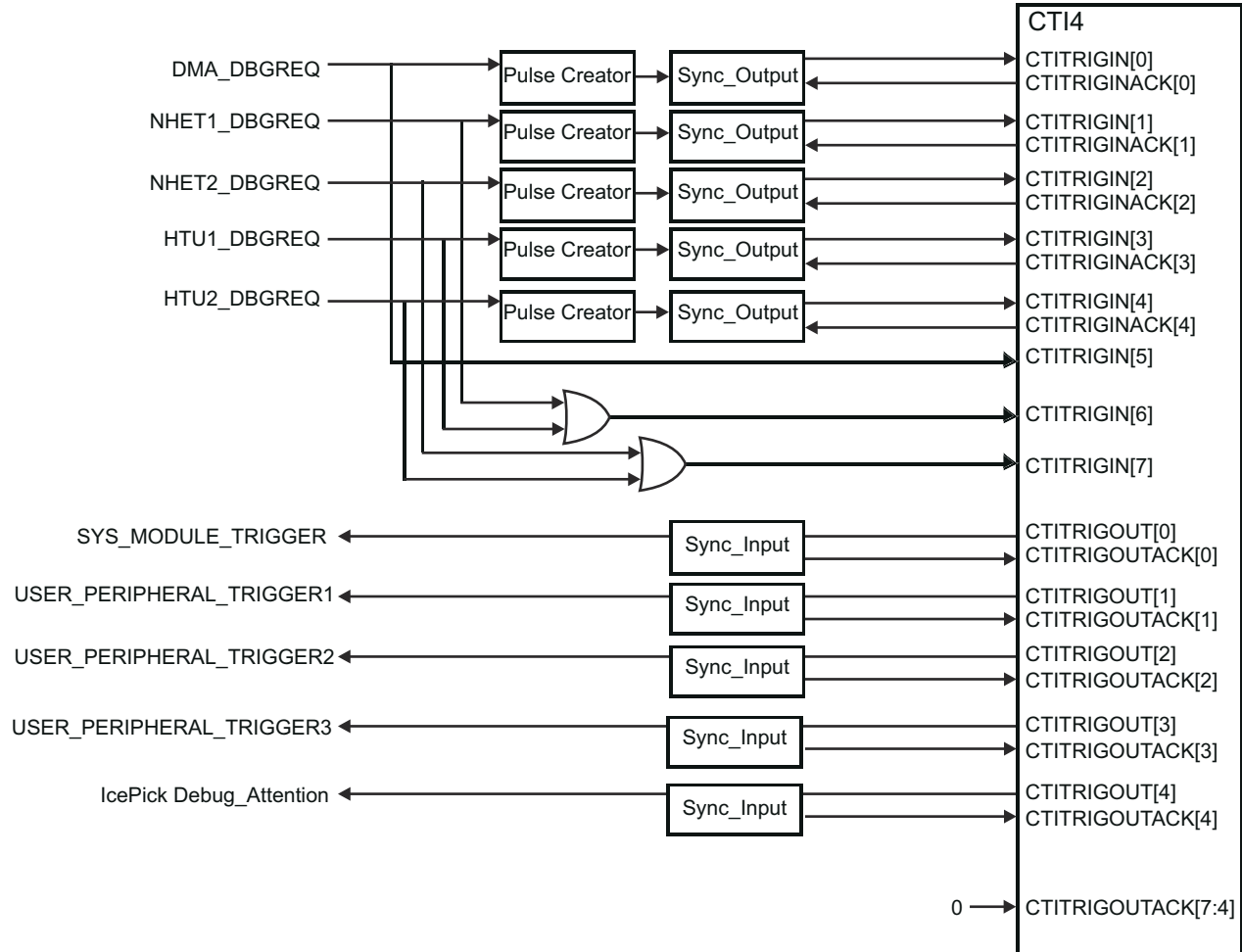


图 7-27. CTI4 Mapping

表 7-50. CTI4 Mapping

| CTI TRIGGER      | Module Signal                     |
|------------------|-----------------------------------|
| Trigger Input 0  | From DMA_DBGREQ                   |
| Trigger Input 1  | From N2HET1_DBGREQ                |
| Trigger Input 2  | From N2HET2_DBGREQ                |
| Trigger Input 3  | From HTU1_DBGREQ                  |
| Trigger Input 4  | From HTU2_DBGREQ                  |
| Trigger Input 5  | From DMA_DBGREQ                   |
| Trigger Input 6  | From N2HET1_DBGREQ or HTU1_DBGREQ |
| Trigger Input 7  | From N2HET2_DBGREQ or HTU2_DBGREQ |
| Trigger Output 0 | To SYS_MODULE_TRIGGER             |
| Trigger Output 1 | To USER_PERIPHERAL_TRIGGER1       |
| Trigger Output 2 | To USER_PERIPHERAL_TRIGGER2       |
| Trigger Output 3 | To USER_PERIPHERAL_TRIGGER3       |
| Trigger Output 4 | To IcePick Debug_Attention        |
| Trigger Output 5 | Reserved                          |
| Trigger Output 6 | Reserved                          |
| Trigger Output 7 | Reserved                          |

表 7-51. Peripheral Suspend Generation

| TRIGGER OUTPUT           | MODULE SIGNAL CONNECTED | DESCRIPTION                                  |
|--------------------------|-------------------------|----------------------------------------------|
| SYS_MODULE_TRIGGER       | L2FMC_CPU_EMUSUSP       | L2FMC Wrapper Suspend                        |
|                          | CCM_R5_CPU_EMUSUSP      | CCM_R5 module suspend                        |
|                          | CRC_CPU_EMUSUSP         | CRC1 / CRC2 module suspend                   |
|                          | SYS_CPU_EMUSUSP         | SYS module Suspend                           |
| USER_PERIPHERAL_TRIGGER1 | DMA_SUSPEND             | DMA Suspend                                  |
|                          | RTI_CPU_SUSPEND         | RTI1 / RTI2 Suspend                          |
|                          | AWM_CPU_SUSPEND         | AWM1 / AWM2 Suspend                          |
|                          | HTU_CPU_EMUSUSP         | HTU1 / HTU2 Suspend                          |
|                          | SCI_CPU_EMUSUSP         | SCI3 / SCI4 Suspend                          |
|                          | LIN_CPU_EMUSUSP         | LIN1 / LIN2 Suspend                          |
|                          | I2C_CPU_EMUSUSP         | I2C1 / I2C2 Suspend                          |
|                          | EMAC_CPU_EMUSUSP        | EMAC Suspend                                 |
|                          | EQEP_CPU_EMUSUSP        | EQEP Suspend                                 |
|                          | ECAP_CPU_EMUSUSP        | ECAP Suspend                                 |
|                          | DMM_CPU_EMUSUSP         | DMM Suspend                                  |
|                          | DCC_CPU_EMUSUSP         | DCC1 / DCC2 Suspend                          |
| USER_PERIPHERAL_TRIGGER2 | DCAN_CPU_EMUSUSP        | DCAN1 / DCAN2 / DCAN3 / DCAN4 Suspend        |
| USER_PERIPHERAL_TRIGGER3 | ePWM_CPU_EMUSUSP        | ePWM1..7 Trip Zone TZ6n and ePWM1..7 Suspend |

#### 7.22.4 JTAG Identification Code

The JTAG ID code for this device is the same as the device ICEPick Identification Code. For the JTAG ID Code per silicon revision, see [表 7-52](#).

**表 7-52. JTAG ID Code**

| SILICON REVISION | ID         |
|------------------|------------|
| Rev A            | 0x0B95A02F |
| Rev B            | 0x1B95A02F |

#### 7.22.5 Debug ROM

The Debug ROM stores the location of the components on the Debug APB bus (see [表 7-53](#)).

**表 7-53. Debug ROM Table**

| ADDRESS | DESCRIPTION  | VALUE      |
|---------|--------------|------------|
| 0x000   | Cortex-R5F   | 0x00001003 |
| 0x004   | ETM-R5       | 0x00002003 |
| 0x008   | TPIU         | 0x00003003 |
| 0x00C   | POM          | 0x00004003 |
| 0x018   | CTI1         | 0x00007003 |
| 0x020   | CTI3         | 0x00009003 |
| 0x024   | CTI4         | 0x0000A003 |
| 0x028   | CSTF         | 0x0000B003 |
| 0x02C   | end of table | 0x00000000 |

## 7.22.6 JTAG Scan Interface Timings

表 7-54. JTAG Scan Interface Timing

| NO. | PARAMETER <sup>(1)</sup> |                                               | MIN | MAX | UNIT |
|-----|--------------------------|-----------------------------------------------|-----|-----|------|
|     | fTCK                     | TCK frequency (at HCLKmax)                    |     | 12  | MHz  |
|     | fRTCK                    | RTCK frequency (at TCKmax and HCLKmax)        | 10  |     | MHz  |
| 1   | td(TCK - RTCK)           | Delay time, TCK to RTCK                       |     | 24  | ns   |
| 2   | tsu(TDI/TMS - RTCKr)     | Setup time, TDI, TMS before RTCK rise (RTCKr) | 26  |     | ns   |
| 3   | th(RTCKr - TDI/TMS)      | Hold time, TDI, TMS after RTCKr               | 0   |     | ns   |
| 4   | th(RTCKr - TDO)          | Hold time, TDO after RTCKf                    | 0   |     | ns   |
| 5   | td(TCKf - TDO)           | Delay time, TDO valid after RTCK fall (RTCKf) |     | 12  | ns   |

(1) Timings for TDO are specified for a maximum of 50-pF load on TDO.

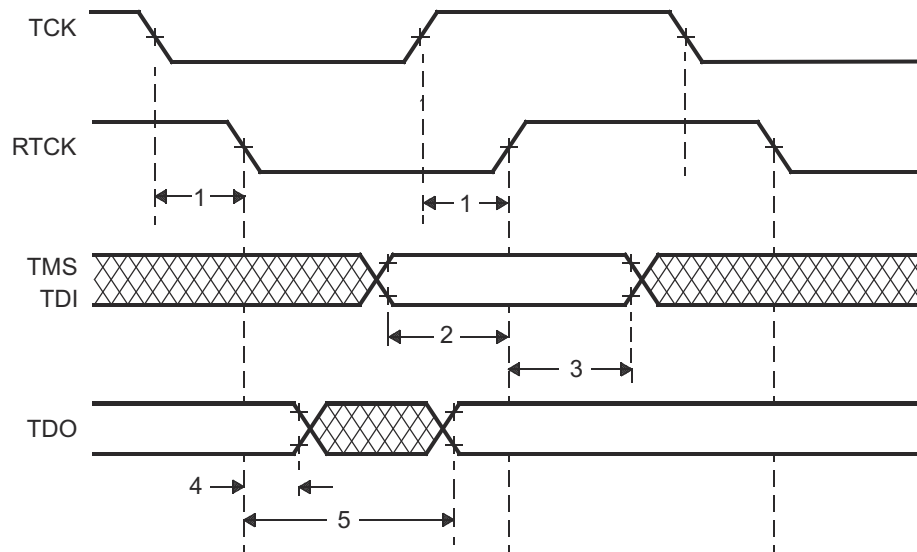


图 7-28. JTAG Timing

### 7.22.7 Advanced JTAG Security Module

This device includes an Advanced JTAG Security Module (AJSM), which lets the user limit JTAG access to the device after programming.

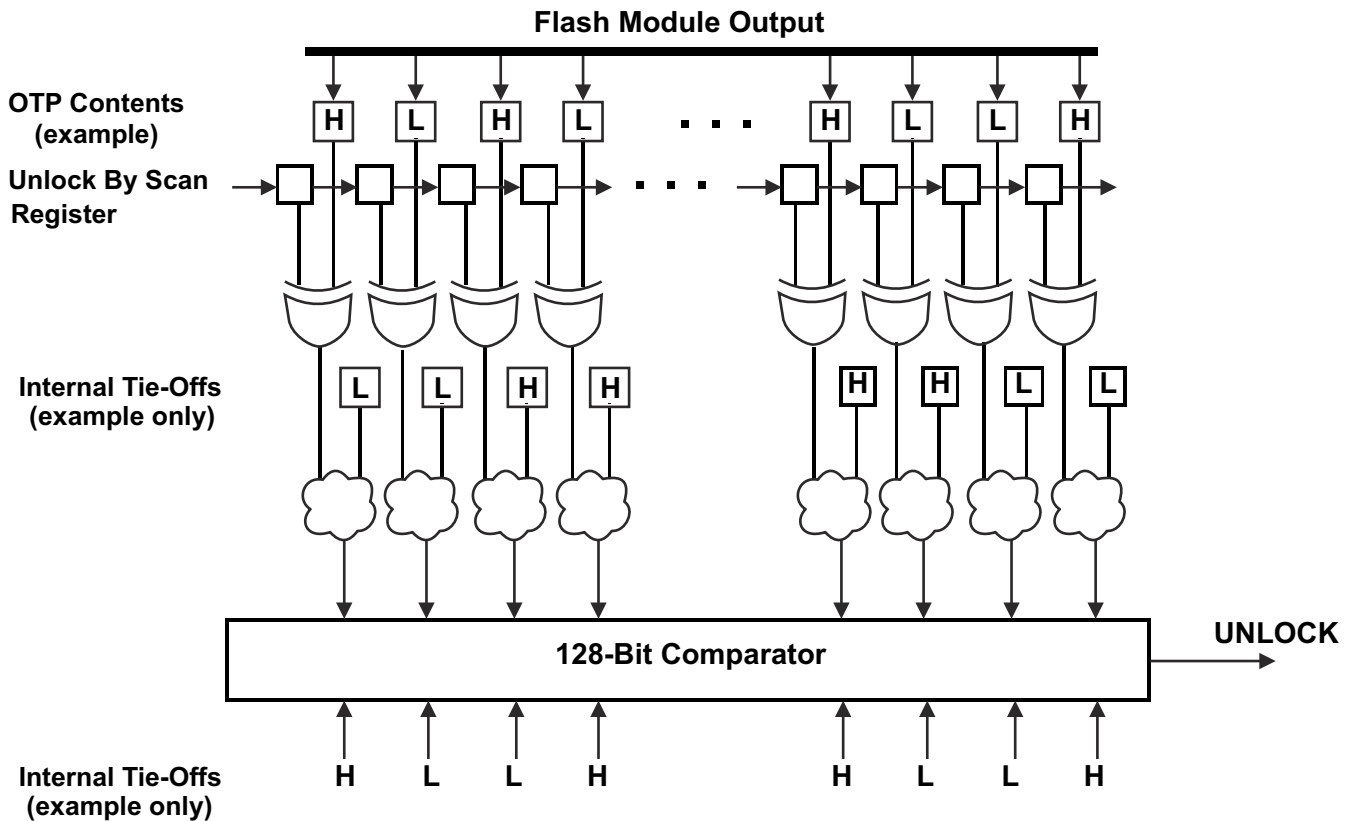


图 7-29. AJSM Unlock

The device is unlocked by default by virtue of a 128-bit visible unlock code programmed in the One-Time Programmable (OTP) address 0xF000 0000. The OTP contents are XOR-ed with the contents of the Unlock-By-Scan register. The outputs of these XOR gates are again combined with a set of secret internal tie-offs. The output of this combinational logic is compared against a secret, hard-wired, 128-bit value. A match asserts the UNLOCK signal, so that the device is now unlocked.

A user can lock the device by changing bits in the visible unlock code from 1 to 0. Changing a 0 to 1 is not possible because the visible unlock code is stored in the OTP flash region. Also, changing all the 128 bits to zeros is not a valid condition and will permanently lock the device.

Once locked, a user can unlock the device by scanning an appropriate value into the Unlock-By-Scan register of the AJSM module. This register is accessible by configuring an IR value of 0b1011 on the AJSM TAP. The value to be scanned is such that the XOR of the OTP contents and the contents of the Unlock-By-Scan register results in the original visible unlock code.

The Unlock-By-Scan register is reset only by asserting power-on reset (nPORRST).

A locked device only permits JTAG accesses to the AJSM scan chain through the Secondary TAP 2 of the ICEPick module. All other secondary TAPs, test TAPs and the boundary scan interface are not accessible in this state.

### 7.22.8 Embedded Trace Macrocell (ETM-R5)

The device contains a ETM-R5 module with a 32-bit internal data port. The ETM-R5 module is connected to a Trace Port Interface Unit (TPIU) with a 32-bit data bus. The TPIU provides a 35-bit (32-bit data, 3-bit control)

external interface for trace. The ETM-R5 is CoreSight compliant and follows the ETM v3 specification. For more details, see the ARM CoreSight ETM-R5 TRM specification.

**7.22.8.1 ETM TRACECLKIN Selection**

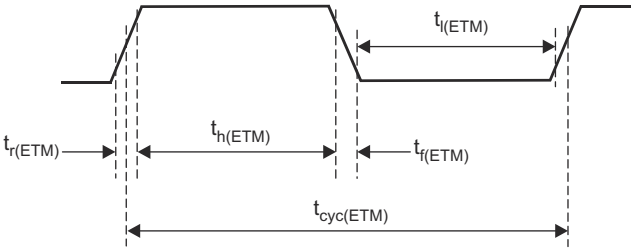
The ETM clock source can be selected as either VCLK or the external ETMTRACECLKIN terminal. The selection is chosen by the EXTCTLOUT[1:0] control bits of the TPIU (default is '00'). The address of this register is the TPIU base address + 0x404.

Before the user begins accessing TPIU registers, the TPIU should be unlocked through the CoreSight key and 1 or 2 written to this register.

**表 7-55. TPIU / TRACECLKIN Selection**

| EXTCTLOUT[1:0] | TPIU/TRACECLKIN |
|----------------|-----------------|
| 00             | Tied-zero       |
| 01             | VCLK            |
| 10             | ETMTRACECLKIN   |
| 11             | Tied-zero       |

**7.22.8.2 Timing Specifications**



**图 7-30. ETMTRACECLKOUT Timing**

**表 7-56. ETMTRACECLK Timing**

| PARAMETER      |                          | MIN   | MAX | UNIT |
|----------------|--------------------------|-------|-----|------|
| $t_{cyc(ETM)}$ | Clock period             | 18.18 |     | ns   |
| $t_{l(ETM)}$   | Low pulse width          | 6     |     | ns   |
| $t_{h(ETM)}$   | High pulse width         | 6     |     | ns   |
| $t_{r(ETM)}$   | Clock and data rise time |       | 3   | ns   |
| $t_{f(ETM)}$   | Clock and data fall time |       | 3   | ns   |

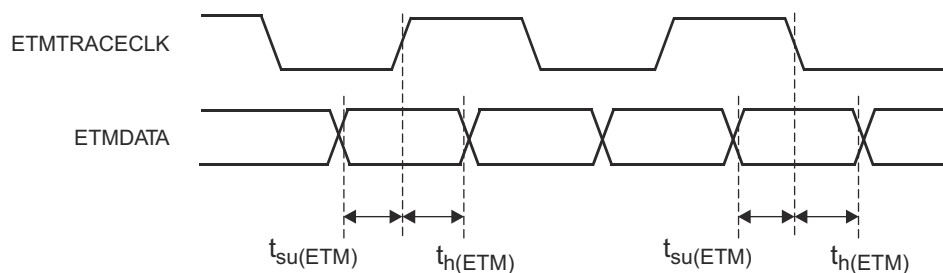


图 7-31. ETMDATA Timing

表 7-57. ETMDATA Timing

| PARAMETER     |                 | MIN | MAX | UNIT |
|---------------|-----------------|-----|-----|------|
| $t_{su(ETM)}$ | Data setup time | 2.5 |     | ns   |
| $t_{h(ETM)}$  | Data hold time  | 1.5 |     | ns   |

备注

The ETMTRACECLK and ETMDATA timing is based on a 15-pF load and for ambient temperatures lower than 85°C.

### 7.22.9 RAM Trace Port (RTP)

The RTP provides the ability to datalog the RAM contents of the TMS570 devices or accesses to peripherals without program intrusion. It can trace all data write or read accesses to internal RAM. In addition, it provides the capability to directly transfer data to a FIFO to support a CPU-controlled transmission of the data. The trace data is transmitted over a dedicated external interface.

#### 7.22.9.1 RTP Features

The RTP offers the following features:

- Two modes of operation - Trace Mode and Direct Data Mode
  - Trace Mode
    - Nonintrusive data trace on write or read operation
    - Visibility of RAM content at any time on external capture hardware
    - Trace of peripheral accesses
    - 2 configurable trace regions for each RAM module to limit amount of data to be traced
    - FIFO to store data and address of data of multiple read/write operations
    - Trace of CPU and/or DMA accesses with indication of the master in the transmitted data packet
  - Direct Data Mode
    - Directly write data with the CPU or trace read operations to a FIFO, without transmitting header and address information
- Dedicated synchronous interface to transmit data to external devices
- Free-running clock generation or clock stop mode between transmissions
- Up to 100 Mbps terminal transfer rate for transmitting data
- Pins not used in functional mode can be used as GPIOs

#### 7.22.9.2 Timing Specifications

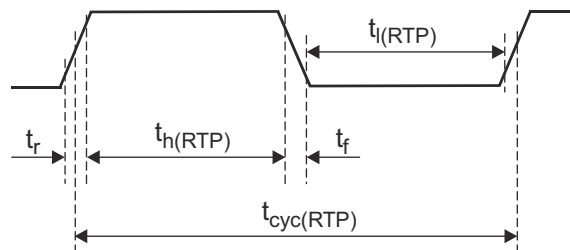


图 7-32. RTPCLK Timing

表 7-58. RTPCLK Timing

| PARAMETER      |                  | MIN                                    | MIN | UNIT |
|----------------|------------------|----------------------------------------|-----|------|
| $t_{cyc(RTP)}$ | Clock period     | 9.09 (= 110 MHz)                       |     | ns   |
| $t_h(RTP)$     | High pulse width | $((t_{cyc(RTP)})/2) - ((t_r + t_f)/2)$ |     | ns   |
| $t_l(RTP)$     | Low pulse width  | $((t_{cyc(RTP)})/2) - ((t_r + t_f)/2)$ |     | ns   |

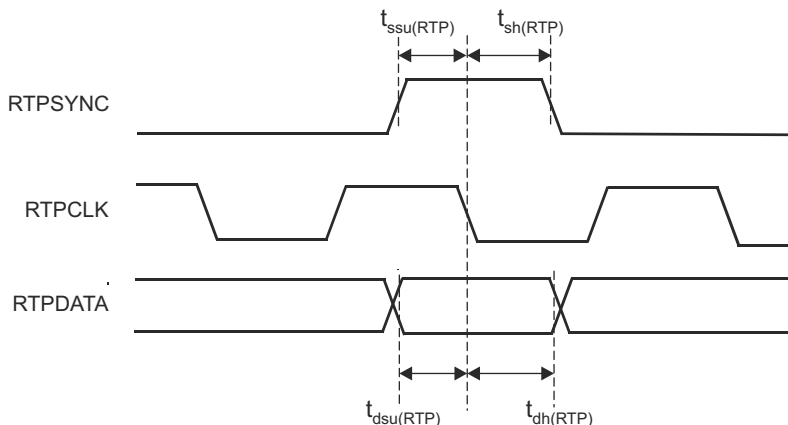


图 7-33. RTPDATA Timing

表 7-59. RTPDATA Timing

| PARAMETER      |                 | MIN | MAX | UNIT |
|----------------|-----------------|-----|-----|------|
| $t_{dsu}(RTP)$ | Data setup time | 3   |     | ns   |
| $t_{dh}(RTP)$  | Data hold time  | 1   |     | ns   |
| $t_{ssu}(RTP)$ | SYNC setup time | 3   |     | ns   |
| $t_{sh}(RTP)$  | SYNC hold time  | 1   |     | ns   |

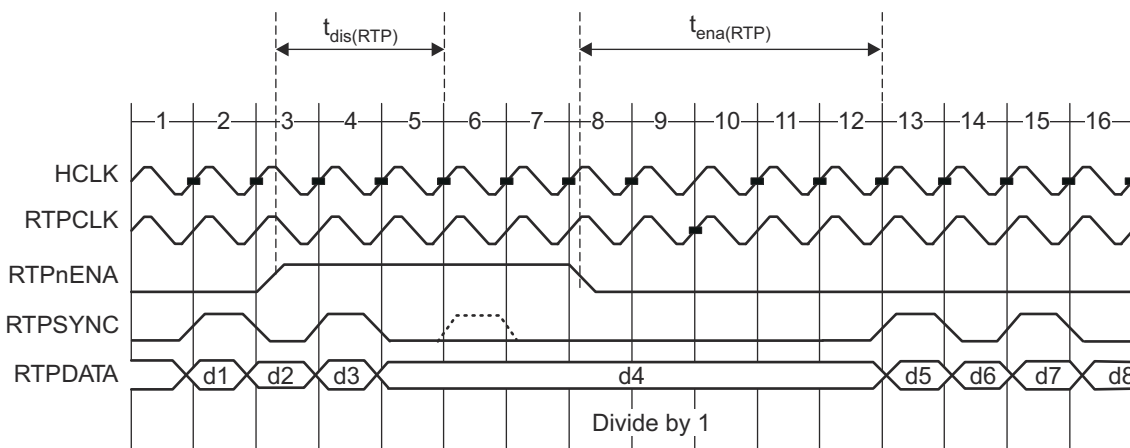


图 7-34. RTPnENA timing

表 7-60. RTPnENA timing

| PARAMETER      |                                                                                                                   | MIN                                  | MAX                                  | UNIT |
|----------------|-------------------------------------------------------------------------------------------------------------------|--------------------------------------|--------------------------------------|------|
| $t_{dis}(RTP)$ | Disable time, time RTPnENA must go high before what would be the next RTPSYNC, to ensure delaying the next packet | $3t_{c(HCLK)} + t_{r(RTPSYNC)} + 12$ |                                      | ns   |
| $t_{ena}(RTP)$ | Enable time, time after RTPnENA goes low before a packet that has been halted, resumes                            | $4t_{c(HCLK)} + t_{r(RTPSYNC)}$      | $5t_{c(HCLK)} + t_{r(RTPSYNC)} + 12$ | ns   |

### 7.22.10 Data Modification Module (DMM)

The Data Modification Module (DMM) provides the capability to modify data in the entire 4GB address space of the TMS570 devices from an external peripheral, with minimal interruption of the application.

#### 7.22.10.1 DMM Features

The DMM module has the following features:

- Acts as a bus master, enabling direct writes to the 4GB address space without CPU intervention
- Writes to memory locations specified in the received packet (leverages packets defined by trace mode of the RAM Trace Port (RTP) module)
- Writes received data to consecutive addresses, which are specified by the DMM module (leverages packets defined by direct data mode of the RTP module)
- Configurable port width (1-, 2-, 4-, 8-, 16-pins)
- Up to 100 Mbps terminal data rate
- Unused pins configurable as GPIO pins

#### 7.22.10.2 Timing Specifications

表 7-61. DMMCLK Timing (see 图 7-35)

| PARAMETER                    |                                 | MIN                                                                  | MAX | UNIT |
|------------------------------|---------------------------------|----------------------------------------------------------------------|-----|------|
| $t_{\text{cyc}}(\text{DMM})$ | Cycle time, DMMCLK clock period | 9.09                                                                 |     | ns   |
| $t_{\text{h}}(\text{DMM})$   | High-pulse width                | $((t_{\text{cyc}}(\text{DMM}))/2) - ((t_{\text{r}}+t_{\text{f}})/2)$ |     | ns   |
| $t_{\text{l}}(\text{DMM})$   | Low-pulse width                 | $((t_{\text{cyc}}(\text{DMM}))/2) - ((t_{\text{r}}+t_{\text{f}})/2)$ |     | ns   |

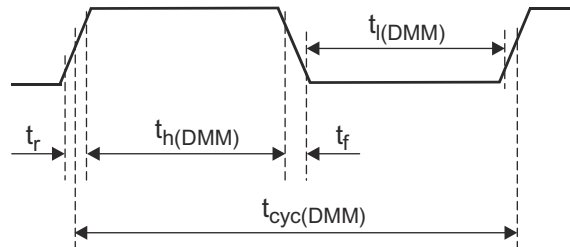


图 7-35. DMMCLK Timing

表 7-62. DMMDATA Timing (see 图 7-36)

| PARAMETER                    |                                                  | MIN | MAX | UNIT |
|------------------------------|--------------------------------------------------|-----|-----|------|
| $t_{\text{ssu}}(\text{DMM})$ | Setup time, SYNC active before clk falling edge  | 2   |     | ns   |
| $t_{\text{sh}}(\text{DMM})$  | Hold time, clk falling edge after SYNC deactive  | 3   |     | ns   |
| $t_{\text{dsu}}(\text{DMM})$ | Setup time, DATA before clk falling edge         | 2   |     | ns   |
| $t_{\text{dh}}(\text{DMM})$  | Hold time, clk falling edge after DATA hold time | 3   |     | ns   |

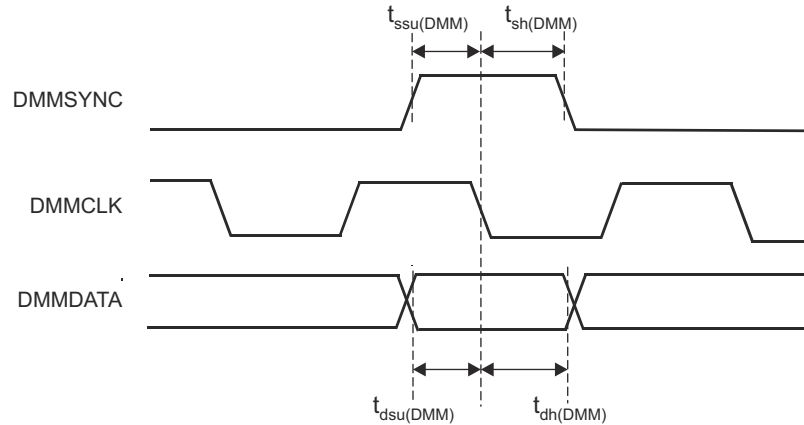


图 7-36. DMMDATA Timing

图 7-37 shows a case with 1 DMM packet per 2 DMMCLK cycles (Mode = Direct Data Mode, data width = 8, portwidth = 4) where none of the packets received by the DMM are sent out, leading to filling up of the internal buffers. The DMMnENA signal is shown asserted, after the first two packets have been received and synchronized to the HCLK domain. Here, the DMM has the capacity to accept packets D4x, D5x, D6x, D7x. Packet D8 would result in an overflow. Once DMMnENA is asserted, the DMM expects to stop receiving packets after 4 HCLK cycles; once DMMnENA is deasserted, the DMM can handle packets immediately (after 0 HCLK cycles).

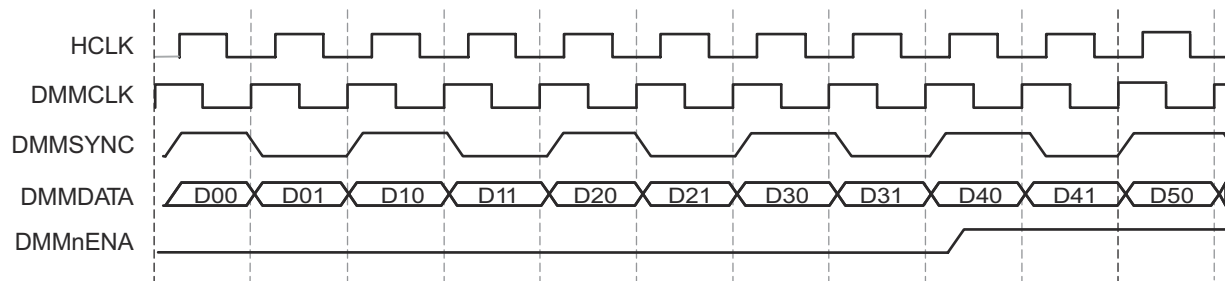


图 7-37. DMMnENA Timing

### 7.22.11 Boundary Scan Chain

The device supports BSDL-compliant boundary scan for testing pin-to-pin compatibility. The boundary scan chain is connected to the Boundary Scan Interface of the ICEPICK module (see 图 7-38).

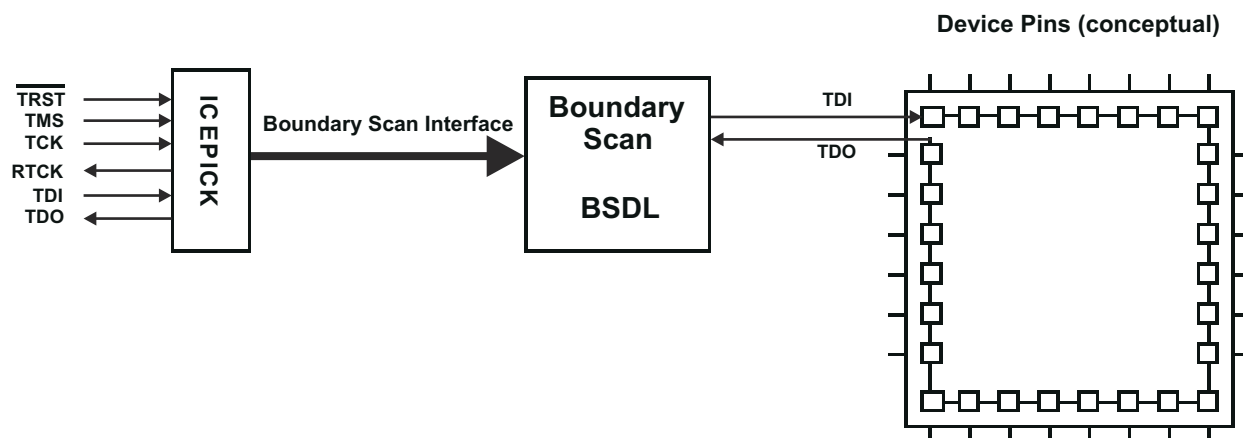


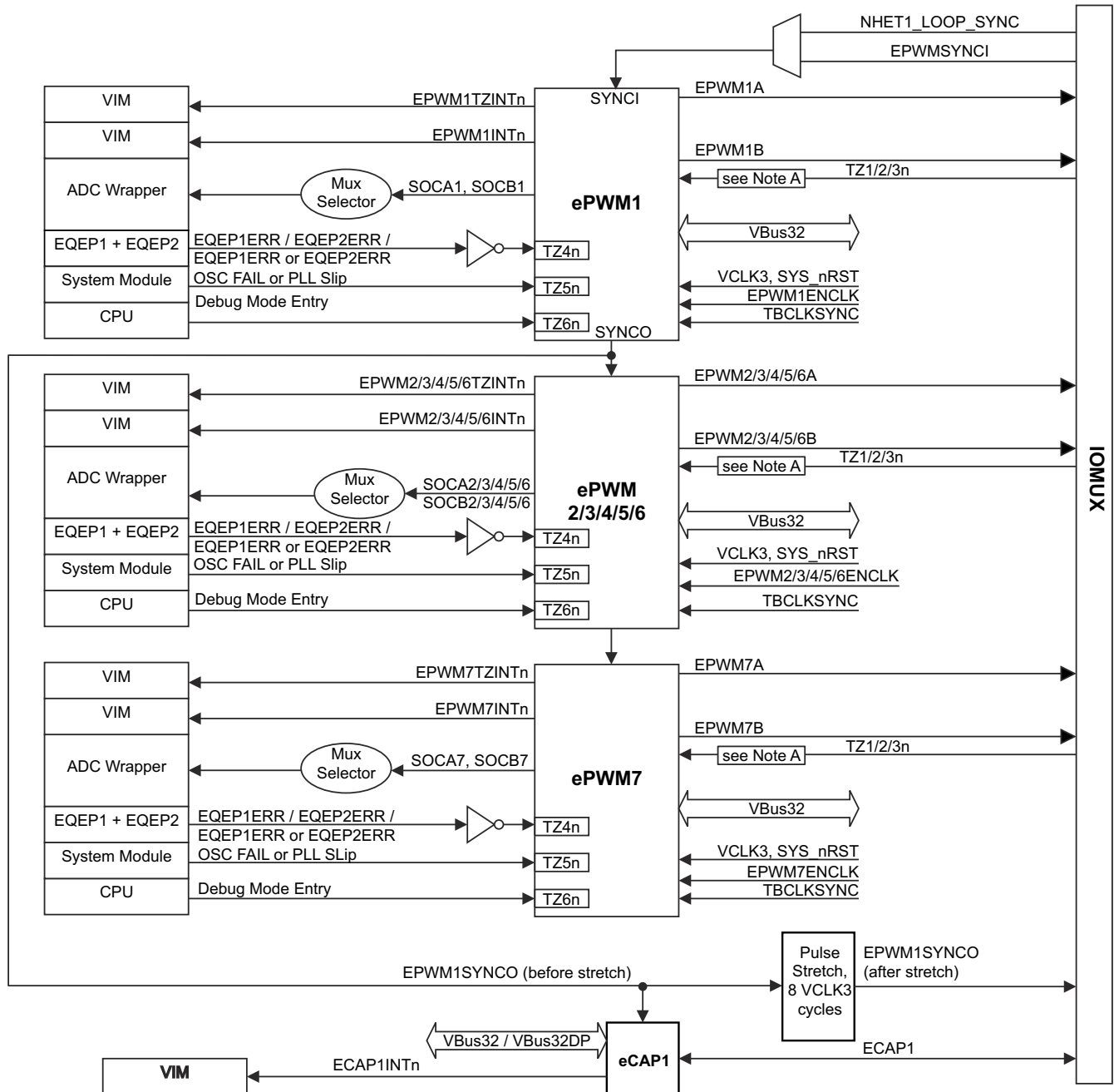
图 7-38. Boundary Scan Implementation (Conceptual Diagram)

Data is serially shifted into all boundary-scan buffers through TDI, and out through TDO.

## 8 Peripheral Information and Electrical Specifications

### 8.1 Enhanced Translator PWM Modules (ePWM)

图 8-1 shows the connections between the seven ePWM modules (ePWM1 – ePWM7) on the device.



A. For more detail on the ePWMx input synchronization selection, see 图 8-2.

图 8-1. ePWMx Module Interconnections

图 8-2 shows the detailed input synchronization selection (asynchronous, double-synchronous, or double synchronous + filter width) for ePWMx.

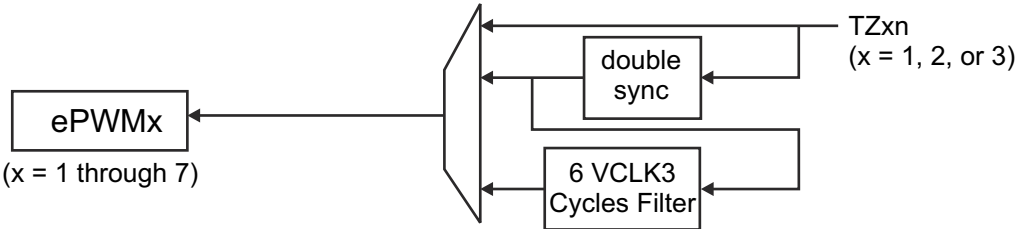


图 8-2. ePWMx Input Synchronization Selection Detail

8.1.1 ePWM Clocking and Reset

Each ePWM module has a clock enable (ePWMxENCLK) which is controlled by its respective Peripheral Power Down bit in the PSPWRDWNCLR<sub>x</sub> register of the PCR2 module. To properly reset the peripherals, the peripherals must be released from reset by setting the PENA bit of the CLKCNTL register in the system module. In addition, the peripherals must be released from their power down state by clearing their respective bit in the PSPWRDWNCLR<sub>x</sub> register. By default after reset, the peripherals are in powerdown state.

ItemizedList example:

- LISTING 2

ABC CODE EXAMPLE

TabbedText example:

XYZ CODE EXAMPLE

LISTING 1

图 8-3. Listing 1 Code Example

表 8-1. ePWMx Clock Enable Control

| ePWM MODULE INSTANCE | CONTROL REGISTER TO ENABLE CLOCK | DEFAULT VALUE |
|----------------------|----------------------------------|---------------|
| ePWM1                | PSPWRDWNCLR3[16]                 | 1             |
| ePWM2                | PSPWRDWNCLR3[17]                 | 1             |
| ePWM3                | PSPWRDWNCLR3[18]                 | 1             |
| ePWM4                | PSPWRDWNCLR3[19]                 | 1             |
| ePWM5                | PSPWRDWNCLR3[12]                 | 1             |
| ePWM6                | PSPWRDWNCLR3[13]                 | 1             |
| ePWM7                | PSPWRDWNCLR3[14]                 | 1             |

8.1.2 Synchronization of ePWMx Time-Base Counters

A time-base synchronization scheme connects all of the ePWM modules on a device. Each ePWM module has a synchronization input (EPWMxSYNCl) and a synchronization output (EPWMxSYNCO). The input synchronization for the first instance (ePWM1) comes from an external pin. 图 8-1 shows the synchronization connections for all the ePWMx modules. Each ePWM module can be configured to use or ignore the synchronization input. For more information, see the ePWM module chapter of the device-specific TRM.

### 8.1.3 Synchronizing all ePWM Modules to the N2HET1 Module Time Base

The connection between the N2HET1\_LOOP\_SYNC and the SYNCI input of ePWM1 module is implemented as shown in 图 8-4.

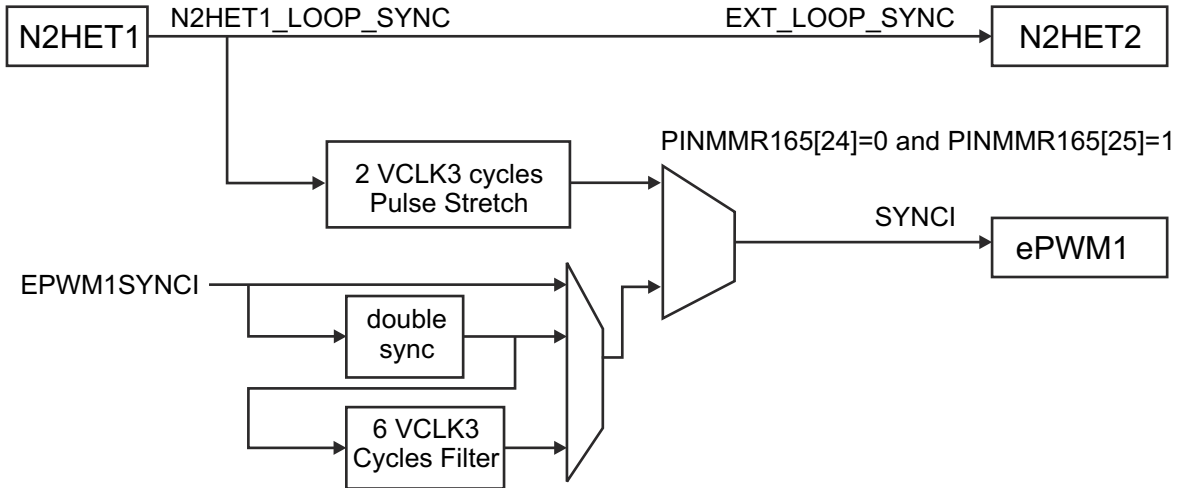


图 8-4. Synchronizing Time Bases Between N2HET1, N2HET2 and ePWMx Modules

### 8.1.4 Phase-Locking the Time-Base Clocks of Multiple ePWM Modules

The TBCLKSYNC bit can be used to globally synchronize the time-base clocks of all enabled ePWM modules on a device. This bit is implemented as PINMMR166[1] register bit 1.

When TBCLKSYNC = 0, the time-base clock of all ePWM modules is stopped. This is the default condition.

When TBCLKSYNC = 1, all ePWM time-base clocks are started with the rising edge of TBCLK aligned.

For perfectly synchronized TBCLKs, the prescaler bits in the TBCTL register of each ePWM module must be set identically. The proper procedure for enabling the ePWM clocks is as follows:

- Each ePWM is individually associated with a power down bit in the PSPWRDWNCLR<sub>x</sub> register of the PCR2 module. Enable the individual ePWM module clocks (if disable) using the control registers in the PCR2.
- Configure TBCLKSYNC = 0. This will stop the time-base clock within any enabled ePWM module.
- Configure the prescaler values and desired ePWM modes.
- Configure TBCLKSYNC = 1.

### 8.1.5 ePWM Synchronization with External Devices

The output sync from the ePWM1 module is also exported to the I/O Mux such that multiple devices can be synchronized together. The signal pulse must be stretched by 8 VCLK3 cycles before being exported on the IO Mux pin as the ePWMSYNCO signal.

### 8.1.6 ePWM Trip Zones

The ePWMx modules have 6 trip zone inputs each. These are active-low signals. The application can control the ePWMx module response to each of the trip zone input separately. The timing requirements from the assertion of the trip zone inputs to the actual response are specified in the electrical and timing section of this document.

#### 8.1.6.1 Trip Zones TZ1n, TZ2n, TZ3n

These 3 trip zone inputs are driven by external circuits and are connected to device-level inputs. These signals are either connected asynchronously to the ePWMx trip zone inputs, or double-synchronized with VCLK3, or double-synchronized and then filtered with a 6-cycle VCLK3-based counter before connecting to the ePWMx (see 图 8-2). By default, the trip zone inputs are asynchronously connected to the ePWMx modules.

表 8-2. Connection to ePWMx Modules for Device-Level Trip Zone Inputs

| TRIP ZONE INPUT | CONTROL FOR ASYNCHRONOUS CONNECTION TO ePWMx | CONTROL FOR DOUBLE-SYNCHRONIZED CONNECTION TO ePWMx | CONTROL FOR DOUBLE-SYNCHRONIZED AND FILTERED CONNECTION TO ePWMx <sup>(1)</sup> |
|-----------------|----------------------------------------------|-----------------------------------------------------|---------------------------------------------------------------------------------|
| TZ1n            | PINMMR172[18:16] = 001                       | PINMMR172[18:16] = 010                              | PINMMR172[18:16] = 100                                                          |
| TZ2n            | PINMMR172[26:24] = 001                       | PINMMR172[26:24] = 010                              | PINMMR172[26:24] = 100                                                          |
| TZ3n            | PINMMR173[2:0] = 001                         | PINMMR173[2:0] = 010                                | PINMMR173[2:0] = 100                                                            |

(1) The filter width is 6 VCLK3 cycles.

#### 8.1.6.2 Trip Zone TZ4n

This trip zone input is dedicated to eQEPx error indications. There are 2 eQEP modules on this device. Each eQEP module indicates a phase error by driving its EQEPxERR output high. The following control registers allow the application to configure the trip zone input (TZ4n) to each ePWMx module based on the requirements of the application's requirements.

表 8-3. TZ4n Connections for ePWMx Modules

| ePWMx | CONTROL FOR TZ4n = NOT(EQEP1ERR OR EQEP2ERR) | CONTROL FOR TZ4n = NOT(EQEP1ERR) | CONTROL FOR TZ4n = NOT(EQEP2ERR) |
|-------|----------------------------------------------|----------------------------------|----------------------------------|
| ePWM1 | PINMMR167[2:0] = 001                         | PINMMR167[2:0] = 010             | PINMMR167[2:0] = 100             |
| ePWM2 | PINMMR167[10:8] = 001                        | PINMMR167[10:8] = 010            | PINMMR167[10:8] = 100            |
| ePWM3 | PINMMR167[18:16] = 001                       | PINMMR167[18:16] = 010           | PINMMR167[18:16] = 100           |
| ePWM4 | PINMMR167[26:24] = 001                       | PINMMR167[26:24] = 010           | PINMMR167[26:24] = 100           |
| ePWM5 | PINMMR168[2:0] = 001                         | PINMMR168[2:0] = 010             | PINMMR168[2:0] = 100             |
| ePWM6 | PINMMR168[10:8] = 001                        | PINMMR168[10:8] = 010            | PINMMR168[10:8] = 100            |
| ePWM7 | PINMMR168[18:16] = 001                       | PINMMR168[18:16] = 010           | PINMMR168[18:16] = 100           |

#### 备注

The EQEPxERR signal is an active high signal coming out of EQEPx module. As listed in 表 8-3, the selected combination of the EQEPxERR signals must be inverted before connecting to the TZ4n input of the ePWMx modules.

### 8.1.6.3 Trip Zone TZ5n

This trip zone input is dedicated to a clock failure on the device. That is, this trip zone input is asserted whenever an oscillator failure or a PLL slip is detected on the device. The application can use this trip zone input for each ePWMx module to prevent the external system from going out of control when the device clocks are not within expected range (system running at limp clock).

The oscillator failure and PLL slip signals used for this trip zone input are taken from the status flags in the system module. These level signals are set until cleared by the application.

### 8.1.6.4 Trip Zone TZ6n

This trip zone input to the ePWMx modules is dedicated to a debug mode entry of the CPU. If enabled, the user can force the PWM outputs to a known state when the emulator stops the CPU. This prevents the external system from going out of control when the CPU is stopped.

#### 备注

There is a signal called DBGACK that the CPU drives when it enters debug mode. This signal must be inverted and used as the Debug Mode Entry signal for the trip zone input.

### 8.1.7 Triggering of ADC Start of Conversion Using ePWMx SOCA and SOCB Outputs

A special scheme is implemented to select the actual signal used for triggering the start of conversion on the two ADCs on this device. This scheme is defined in [节 8.4.2.3](#).

### 8.1.8 Enhanced Translator-Pulse Width Modulator (ePWMx) Electrical Data/Timing

表 8-4. ePWMx Timing Requirements

|                                                   | TEST CONDITIONS               | MIN                                          | MAX | UNIT   |
|---------------------------------------------------|-------------------------------|----------------------------------------------|-----|--------|
| $t_{w(SYNCIN)}$ Synchronization input pulse width | Asynchronous                  | $2 t_{c(VCLK3)}$                             |     | cycles |
|                                                   | Synchronous                   | $2 t_{c(VCLK3)}$                             |     | cycles |
|                                                   | Synchronous with input filter | $2 t_{c(VCLK3)} + \text{filter width}^{(1)}$ |     | cycles |

(1) The filter width is 6 VCLK3 cycles.

表 8-5. ePWMx Switching Characteristics

| PARAMETER                                                                                                               | TEST CONDITIONS | MIN              | MAX | UNIT   |
|-------------------------------------------------------------------------------------------------------------------------|-----------------|------------------|-----|--------|
| $t_{w(PWM)}$ Pulse duration, ePWMx output high or low                                                                   |                 | 33.33            |     | ns     |
| $t_{w(SYNCOUT)}$ Synchronization Output Pulse Width                                                                     |                 | $8 t_{c(VCLK3)}$ |     | cycles |
| $t_{d(PWM)TZA}$ Delay time, trip input active to PWM forced high, OR<br>Delay time, trip input active to PWM forced low | No pin load     |                  | 25  | ns     |
| $t_{d(TZ-PWM)HZ}$ Delay time, trip input active to PWM Hi-Z                                                             |                 |                  | 20  | ns     |

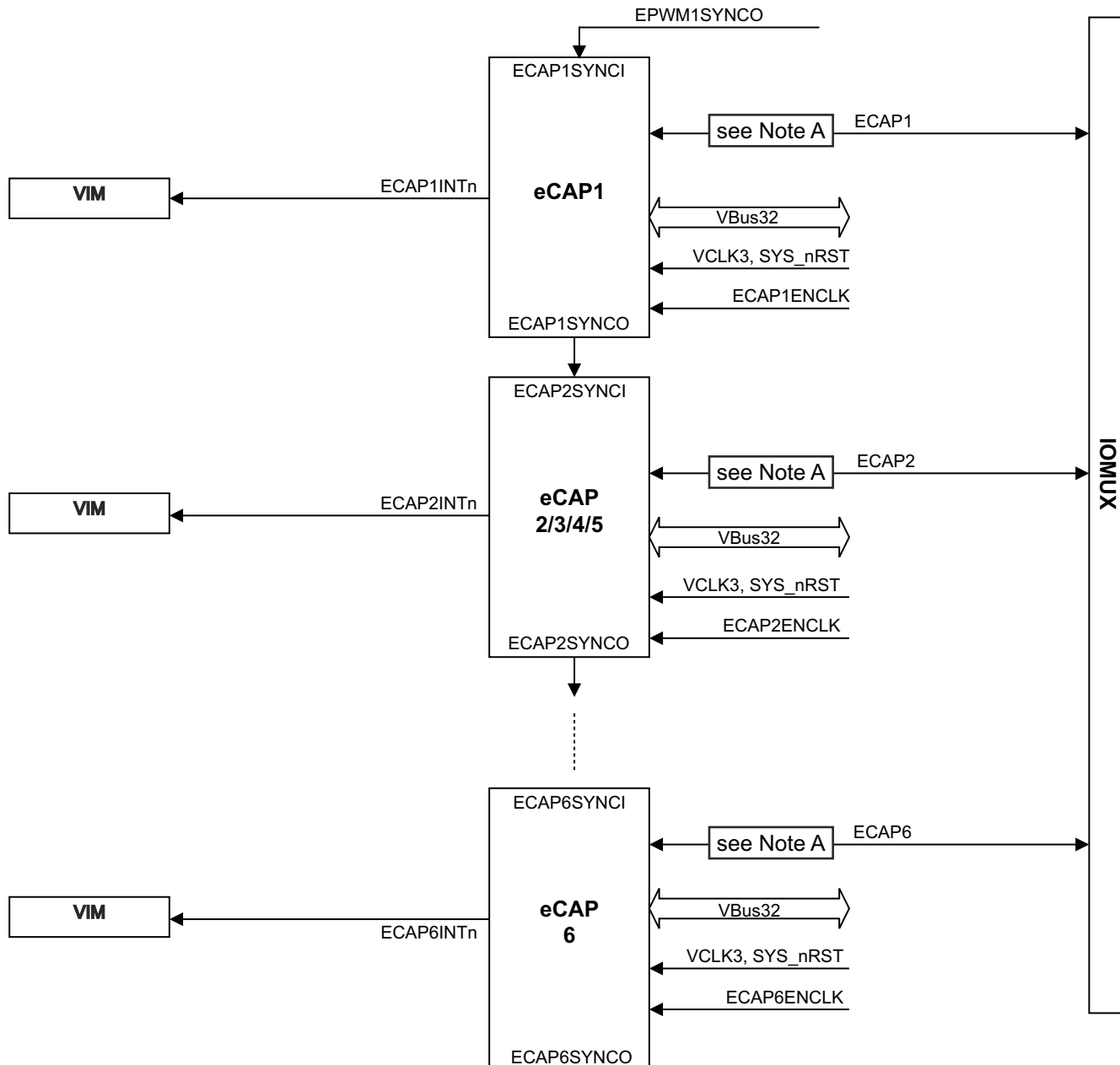
表 8-6. ePWMx Trip-Zone Timing Requirements

|                                           | TEST CONDITIONS               | MIN                                          | MAX | UNIT   |
|-------------------------------------------|-------------------------------|----------------------------------------------|-----|--------|
| $t_{w(TZ)}$ Pulse duration, TZn input low | Asynchronous                  | $2 * T_{BePWMx}$                             |     | cycles |
|                                           | Synchronous                   | $2 t_{c(VCLK3)}$                             |     |        |
|                                           | Synchronous with input filter | $2 t_{c(VCLK3)} + \text{filter width}^{(1)}$ |     |        |

(1) The filter width is 6 VCLK3 cycles.

## 8.2 Enhanced Capture Modules (eCAP)

图 8-5 shows how the eCAP modules are interconnected on this microcontroller.



A. For more detail on the eCAPx input synchronization selection, see 图 8-6.

图 8-5. eCAP Module Connections

图 8-6 shows the detailed input synchronization selection (asynchronous, double-synchronous, or double synchronous + filter width) for eCAPx.

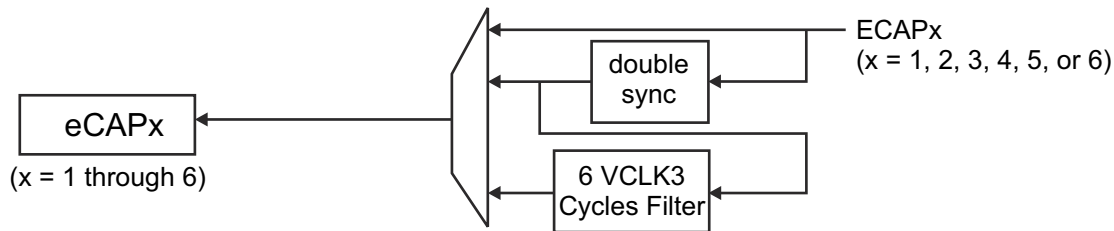


图 8-6. eCAPx Input Synchronization Selection Detail

### 8.2.1 Clock Enable Control for eCAPx Modules

Each of the eCAPx modules has a clock enable (ECAPxENCLK) which is controlled by its respective Peripheral Power Down bit in the PSPWRDWNCLR<sub>x</sub> register of the PCR2 module. To properly reset the peripherals, the peripherals must be released from reset by setting the PENA bit of the CLKCNTL register in the system module. In addition, the peripherals must be released from their power down state by clearing the respective bit in the PSPWRDWNCLR<sub>x</sub> register. By default, after reset, the peripherals are in the power down state.

表 8-7. eCAPx Clock Enable Control

| eCAP MODULE INSTANCE | CONTROL REGISTER TO ENABLE CLOCK | DEFAULT VALUE |
|----------------------|----------------------------------|---------------|
| eCAP1                | PSPWRDWNCLR3[15]                 | 1             |
| eCAP2                | PSPWRDWNCLR3[8]                  | 1             |
| eCAP3                | PSPWRDWNCLR3[9]                  | 1             |
| eCAP4                | PSPWRDWNCLR3[10]                 | 1             |
| eCAP5                | PSPWRDWNCLR3[11]                 | 1             |
| eCAP6                | PSPWRDWNCLR3[4]                  | 1             |

### 8.2.2 PWM Output Capability of eCAPx

When not used in capture mode, each of the eCAPx modules can be used as a single-channel PWM output. This is called the Auxiliary PWM (APWM) mode of operation of the eCAPx modules. For more information, see the eCAP module chapter of the device-specific TRM.

### 8.2.3 Input Connection to eCAPx Modules

The input connection to each of the eCAPx modules can be selected between a double-VCLK3-synchronized input or a double-VCLK3-synchronized and filtered input, as listed in 表 8-8.

表 8-8. Device-Level Input Connection to eCAPx Modules

| INPUT SIGNAL | CONTROL FOR DOUBLE-SYNCHRONIZED CONNECTION TO eCAPx | CONTROL FOR DOUBLE-SYNCHRONIZED AND FILTERED CONNECTION TO eCAPx <sup>(1)</sup> |
|--------------|-----------------------------------------------------|---------------------------------------------------------------------------------|
| eCAP1        | PINMMR169[2:0] = 001                                | PINMMR169[2:0] = 010                                                            |
| eCAP2        | PINMMR169[10:8] = 001                               | PINMMR169[10:8] = 010                                                           |
| eCAP3        | PINMMR169[18:16] = 001                              | PINMMR169[18:16] = 010                                                          |
| eCAP4        | PINMMR169[26:24] = 001                              | PINMMR169[26:24] = 010                                                          |
| eCAP5        | PINMMR170[2:0] = 001                                | PINMMR170[2:0] = 010                                                            |
| eCAP6        | PINMMR170[10:8] = 001                               | PINMMR170[10:8] = 010                                                           |

(1) The filter width is 6 VCLK3 cycles.

## 8.2.4 Enhanced Capture Module (eCAP) Electrical Data/Timing

表 8-9. eCAPx Timing Requirements

|                                         | TEST CONDITIONS               | MIN                                          | MAX | UNIT   |
|-----------------------------------------|-------------------------------|----------------------------------------------|-----|--------|
| $t_{w(CAP)}$ Pulse width, capture input | Synchronous                   | $2 t_{c(VCLK3)}$                             |     | cycles |
|                                         | Synchronous with input filter | $2 t_{c(VCLK3)} + \text{filter width}^{(1)}$ |     | cycles |

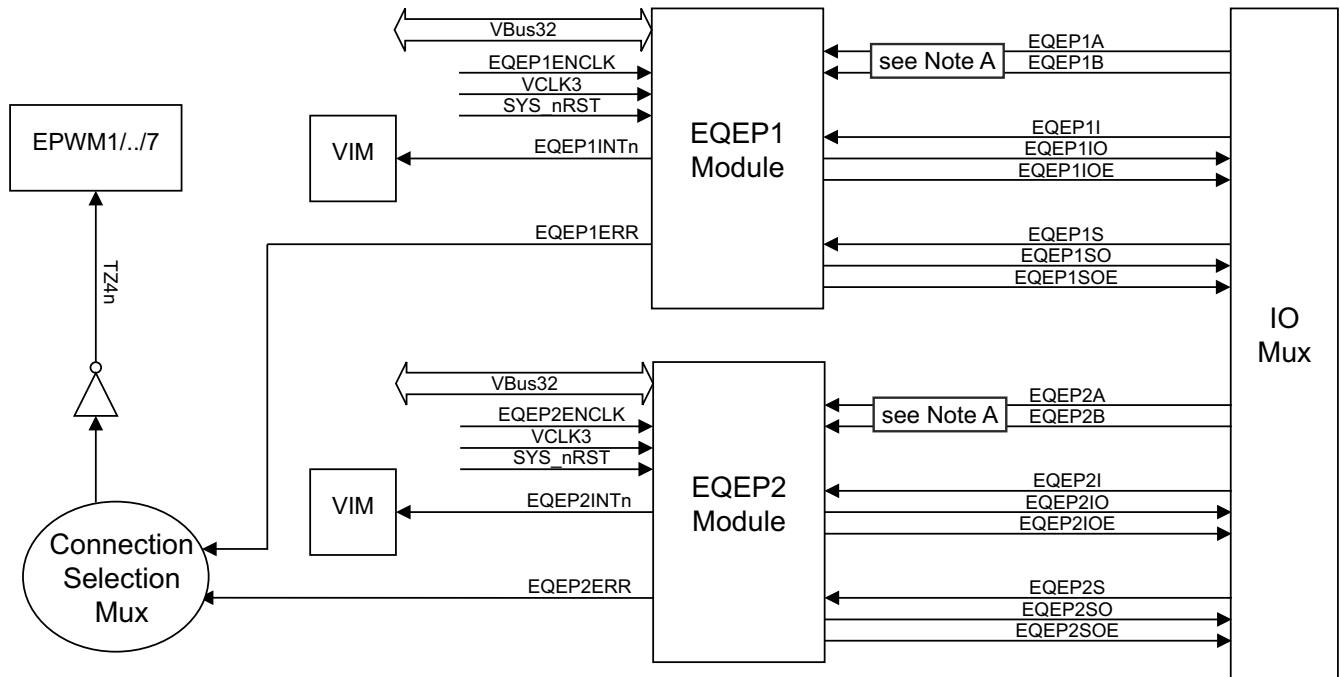
(1) The filter width is 6 VCLK3 cycles.

表 8-10. eCAPx Switching Characteristics

| PARAMETER                                              | TEST CONDITIONS | MIN | MAX | UNIT |
|--------------------------------------------------------|-----------------|-----|-----|------|
| $t_{w(APWM)}$ Pulse duration, APWMx output high or low |                 | 20  |     | ns   |

### 8.3 Enhanced Quadrature Encoder (eQEP)

图 8-7 shows the eQEP module interconnections on the device.



A. For more detail on the eQEPx input synchronization selection, see 图 8-8.

图 8-7. eQEP Module Interconnections

图 8-8 shows the detailed input synchronization selection (asynchronous, double-synchronous, or double synchronous + filter width) for eQEPx.

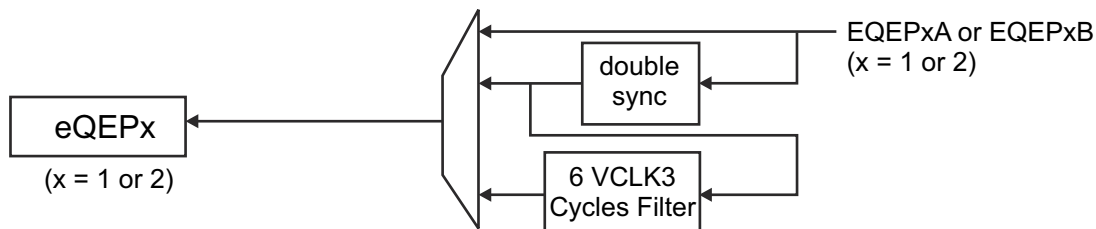


图 8-8. eQEPx Input Synchronization Selection Detail

#### 8.3.1 Clock Enable Control for eQEPx Modules

Each of the EQEPx modules has a clock enable (EQEPxENCLK) which is controlled by its respective Peripheral Power Down bit in the PSPWRDWNCLR<sub>x</sub> register of the PCR2 module. To properly reset the peripherals, the peripherals must be released from reset by setting the PENA bit of the CLKCNTL register in the system module. In addition, the peripherals must be released from their power down state by clearing the respective bit in the PSPWRDWNCLR<sub>x</sub> register. By default after reset, the peripherals are in power down state.

表 8-11. eQEPx Clock Enable Control

| eQEP MODULE INSTANCE | CONTROL REGISTER TO ENABLE CLOCK | DEFAULT VALUE |
|----------------------|----------------------------------|---------------|
| eQEP1                | PSPWRDWNCLR3[5]                  | 1             |
| eQEP2                | PSPWRDWNCLR3[6]                  | 1             |

### 8.3.2 Using eQEPx Phase Error to Trip ePWMx Outputs

The eQEP module sets the EQEPERR signal output whenever a phase error is detected in its inputs EQEPxA and EQEPxB. This error signal from both the eQEP modules is input to the connection selection multiplexer. This multiplexer is defined in 表 8-3. As shown in 图 8-7, the output of this selection multiplexer is inverted and connected to the TZ4n trip-zone input of all ePWMx modules. This connection allows the application to define the response of each ePWMx module on a phase error indicated by the eQEP modules.

### 8.3.3 Input Connection to eQEPx Modules

The input connection to each of the eQEP modules can be selected between a double-VCLK3-synchronized input or a double-VCLK3-synchronized and filtered input, as listed in 表 8-12.

表 8-12. Device-Level Input Connection to eQEPx Modules

| INPUT SIGNAL | CONTROL FOR DOUBLE-SYNCHRONIZED CONNECTION TO eQEPx | CONTROL FOR DOUBLE-SYNCHRONIZED AND FILTERED CONNECTION <sup>(1)</sup> TO eQEPx |
|--------------|-----------------------------------------------------|---------------------------------------------------------------------------------|
| eQEP1A       | PINMMR170[18:16] = 001                              | PINMMR170[18:16] = 010                                                          |
| eQEP1B       | PINMMR170[26:24] = 001                              | PINMMR170[26:24] = 010                                                          |
| eQEP1I       | PINMMR171[2:0] = 001                                | PINMMR171[2:0] = 010                                                            |
| eQEP1S       | PINMMR171[10:8] = 001                               | PINMMR171[10:8] = 010                                                           |
| eQEP2A       | PINMMR171[18:16] = 001                              | PINMMR171[18:16] = 010                                                          |
| eQEP2B       | PINMMR171[26:24] = 001                              | PINMMR171[26:24] = 010                                                          |
| eQEP2I       | PINMMR172[2:0] = 001                                | PINMMR172[2:0] = 010                                                            |
| eQEP2S       | PINMMR172[10:8] = 001                               | PINMMR172[10:8] = 010                                                           |

(1) The filter width is 6 VCLK3 cycles.

### 8.3.4 Enhanced Quadrature Encoder Pulse (eQEPx) Timing

表 8-13. eQEPx Timing Requirements<sup>(1)</sup>

|                 |                            | TEST CONDITIONS               | MIN                                    | MAX | UNIT   |
|-----------------|----------------------------|-------------------------------|----------------------------------------|-----|--------|
| $t_{w(QEPP)}$   | QEP input period           | Synchronous                   | $2 t_{c(VCLK3)}$                       |     | cycles |
|                 |                            | Synchronous with input filter | $2 t_{c(VCLK3)} + \text{filter width}$ |     |        |
| $t_{w(INDEXH)}$ | QEP Index Input High Time  | Synchronous                   | $2 t_{c(VCLK3)}$                       |     | cycles |
|                 |                            | Synchronous with input filter | $2 t_{c(VCLK3)} + \text{filter width}$ |     |        |
| $t_{w(INDEXL)}$ | QEP Index Input Low Time   | Synchronous                   | $2 t_{c(VCLK3)}$                       |     | cycles |
|                 |                            | Synchronous with input filter | $2 t_{c(VCLK3)} + \text{filter width}$ |     |        |
| $t_{w(STROBH)}$ | QEP Strobe Input High Time | Synchronous                   | $2 t_{c(VCLK3)}$                       |     | cycles |
|                 |                            | Synchronous with input filter | $2 t_{c(VCLK3)} + \text{filter width}$ |     |        |
| $t_{w(STROBL)}$ | QEP Strobe Input Low Time  | Synchronous                   | $2 t_{c(VCLK3)}$                       |     | cycles |
|                 |                            | Synchronous with input filter | $2 t_{c(VCLK3)} + \text{filter width}$ |     |        |

(1) The filter width is 6 VCLK3 cycles.

表 8-14. eQEPx Switching Characteristics

| PARAMETER                                                                      | MIN | MAX              | UNIT   |
|--------------------------------------------------------------------------------|-----|------------------|--------|
| $t_{d(CNTR)xin}$ Delay time, external clock to counter increment               |     | $4 t_{c(VCLK3)}$ | cycles |
| $t_{d(PCS-OUT)QEP}$ Delay time, QEP input edge to position compare sync output |     | $6 t_{c(VCLK3)}$ | cycles |

## 8.4 12-bit Multibuffered Analog-to-Digital Converter (MibADC)

The MibADC has a separate power bus for its analog circuitry that enhances the Analog-to-Digital (A-to-D) performance by preventing digital switching noise on the logic circuitry which could be present on  $V_{SS}$  and  $V_{CC}$ .

from coupling into the A-to-D analog stage. All A-to-D specifications are given with respect to  $AD_{REFLO}$ , unless otherwise noted.

**表 8-15. MibADC Overview**

| DESCRIPTION            | VALUE                                                                             |
|------------------------|-----------------------------------------------------------------------------------|
| Resolution             | 12 bits                                                                           |
| Monotonic              | Assured                                                                           |
| Output conversion code | 00h to FFFh [00 for $V_{AI} \leq AD_{REFLO}$ ; FFF for $V_{AI} \geq AD_{REFHI}$ ] |

### 8.4.1 MibADC Features

- 10-/12-bit resolution
- $AD_{REFHI}$  and  $AD_{REFLO}$  pins (high and low reference voltages)
- Total Sample/Hold/Convert time: 600 ns Typical Minimum at 30 MHz ADCLK
- One memory region per conversion group is available (Event Group, Group 1, and Group 2)
- Allocation of channels to conversion groups is completely programmable
- Memory regions are serviced either by interrupt or by DMA
- Programmable interrupt threshold counter is available for each group
- Programmable magnitude threshold interrupt for each group for any one channel
- Option to read either 8-, 10-, or 12-bit values from memory regions
- Single or continuous conversion modes
- Embedded self-test
- Embedded calibration logic
- Enhanced power-down mode
  - Optional feature to automatically power down ADC core when no conversion is in progress
- External event pin (ADEVT) programmable as general-purpose I/O

### 8.4.2 Event Trigger Options

The ADC module supports three conversion groups: Event Group, Group1, and Group2. Each of these three groups can be configured to be triggered by a hardware event. In that case, the application can select from among eight event sources to be the trigger for a group's conversions.

#### 8.4.2.1 MibADC1 Event Trigger Hookup

表 8-16 lists the event sources that can trigger the conversions for the MibADC1 groups.

**表 8-16. MibADC1 Event Trigger Selection**

| GROUP SOURCE SELECT BITS<br>(G1SRC, G2SRC OR EVSRC) | EVENT<br>NO. | PINMMR161[0] | PINMMR161[1] | CONTROL FOR<br>OPTION A | CONTROL FOR<br>OPTION B | TRIGGER SOURCE |
|-----------------------------------------------------|--------------|--------------|--------------|-------------------------|-------------------------|----------------|
| 000                                                 | 1            | x            | x            | —                       | —                       | AD1EVT         |
| 001                                                 | 2            | 1            | 0            | PINMMR161[8] = x        | PINMMR161[9] = x        | N2HET1[8]      |
|                                                     |              | 0            | 1            | PINMMR161[8] = 1        | PINMMR161[9] = 0        | N2HET2[5]      |
|                                                     |              | 0            | 1            | PINMMR161[8] = 0        | PINMMR161[9] = 1        | e_TPWM_B       |
| 010                                                 | 3            | 1            | 0            | —                       | —                       | N2HET1[10]     |
|                                                     |              | 0            | 1            | —                       | —                       | N2HET1[27]     |
| 011                                                 | 4            | 1            | 0            | PINMMR161[16] = x       | PINMMR161[17] = x       | RTI1 Comp0     |
|                                                     |              | 0            | 1            | PINMMR161[16] = 1       | PINMMR161[17] = 0       | RTI1 Comp0     |
|                                                     |              | 0            | 1            | PINMMR161[16] = 0       | PINMMR161[17] = 1       | e_TPWM_A1      |
| 100                                                 | 5            | 1            | 0            | —                       | —                       | N2HET1[12]     |
|                                                     |              | 0            | 1            | —                       | —                       | N2HET1[17]     |
| 101                                                 | 6            | 1            | 0            | PINMMR161[24] = x       | PINMMR161[25] = x       | N2HET1[14]     |
|                                                     |              | 0            | 1            | PINMMR161[24] = 1       | PINMMR161[25] = 0       | N2HET1[19]     |
|                                                     |              | 0            | 1            | PINMMR161[24] = 0       | PINMMR161[25] = 1       | N2HET2[1]      |

表 8-16. MibADC1 Event Trigger Selection (续)

| GROUP SOURCE SELECT BITS<br>(G1SRC, G2SRC OR EVSRC) | EVENT NO. | PINMMR161[0] | PINMMR161[1] | CONTROL FOR<br>OPTION A | CONTROL FOR<br>OPTION B | TRIGGER SOURCE |
|-----------------------------------------------------|-----------|--------------|--------------|-------------------------|-------------------------|----------------|
| 110                                                 | 7         | 1            | 0            | PINMMR162[0] = x        | PINMMR162[1] = x        | GIOB[0]        |
|                                                     |           | 0            | 1            | PINMMR162[0] = 1        | PINMMR162[1] = 0        | N2HET1[11]     |
|                                                     |           | 0            | 1            | PINMMR162[0] = 0        | PINMMR162[1] = 1        | ePWM_A2        |
| 111                                                 | 8         | 1            | 0            | PINMMR162[8] = x        | PINMMR162[9] = x        | GIOB[1]        |
|                                                     |           | 0            | 1            | PINMMR162[8] = 1        | PINMMR162[9] = 0        | N2HET2[13]     |
|                                                     |           | 0            | 1            | PINMMR162[8] = 0        | PINMMR162[9] = 1        | ePWM_AB        |

## 备注

For ADEVT trigger source, the connection to the MibADC1 module trigger input is made from the output side of the input buffer. This way, a trigger condition can be generated either by configuring ADEVT as an output function on to the pad (through the mux control), or by driving the ADEVT signal from an external trigger source as input. If the mux control module is used to select different functionality instead of the ADEVT signal, then care must be taken to disable ADEVT from triggering conversions; there is no multiplexing on the input connection.

If ePWM\_B, ePWM\_A2, ePWM\_AB, N2HET2[1], N2HET2[5], N2HET2[13], N2HET1[11], N2HET1[17], or N2HET1[19] is used to trigger the ADC, the connection to the ADC is made directly from the N2HET or ePWM module outputs. As a result, the ADC can be triggered without having to enable the signal from being output on a device terminal.

## 备注

For N2HETx trigger sources, the connection to the MibADC1 module trigger input is made from the input side of the output buffer (at the N2HETx module boundary). This way, a trigger condition can be generated even if the N2HETx signal is not selected to be output on the pad.

## 备注

For the RTI compare 0 interrupt source, the connection is made directly from the output of the RTI module. That is, the interrupt condition can be used as a trigger source even if the actual interrupt is not signaled to the CPU.

## 8.4.2.2 MibADC2 Event Trigger Hookup

表 8-17 lists the event sources that can trigger the conversions for the MibADC2 groups.

表 8-17. MibADC2 Event Trigger Selection

| GROUP SOURCE SELECT<br>BITS<br>(G1SRC, G2SRC, or EVSRC) | EVENT NO. | PINMMR161[0] | PINMMR161[1] | CONTROL FOR<br>OPTION A | CONTROL FOR<br>OPTION B | TRIGGER<br>SOURCE |
|---------------------------------------------------------|-----------|--------------|--------------|-------------------------|-------------------------|-------------------|
| 000                                                     | 1         | x            | x            | NA                      | NA                      | AD2EVT            |
| 001                                                     | 2         | 1            | 0            | PINMMR162[16] = x       | PINMMR162[17] = x       | N2HET1[8]         |
|                                                         |           | 0            | 1            | PINMMR162[16] = 1       | PINMMR162[17] = 0       | N2HET2[5]         |
|                                                         |           | 0            | 1            | PINMMR162[16] = 0       | PINMMR162[17] = 1       | e_TPWM_B          |
| 010                                                     | 3         | 1            | 0            | NA                      | NA                      | N2HET1[10]        |
|                                                         |           | 0            | 1            | NA                      | NA                      | N2HET1[27]        |

**表 8-17. MibADC2 Event Trigger Selection (续)**

| GROUP SOURCE SELECT<br>BITS<br>(G1SRC, G2SRC, or EVSRC) | EVENT NO. | PINMMR161[<br>0] | PINMMR161[<br>1] | CONTROL FOR<br>OPTION A | CONTROL FOR<br>OPTION B | TRIGGER<br>SOURCE |
|---------------------------------------------------------|-----------|------------------|------------------|-------------------------|-------------------------|-------------------|
| 011                                                     | 4         | 1                | 0                | PINMMR162[24] =<br>x    | PINMMR162[25] =<br>x    | RTI1 Comp0        |
|                                                         |           | 0                | 1                | PINMMR162[24] =<br>1    | PINMMR162[25] =<br>0    | RTI1 Comp0        |
|                                                         |           | 0                | 1                | PINMMR162[24] =<br>0    | PINMMR162[25] =<br>1    | e_TPWM_A1         |
| 100                                                     | 5         | 1                | 0                | NA                      | NA                      | N2HET1[12]        |
|                                                         |           | 0                | 1                | NA                      | NA                      | N2HET1[17]        |
| 101                                                     | 6         | 1                | 0                | PINMMR163[0] = x        | PINMMR163[0] = x        | N2HET1[14]        |
|                                                         |           | 0                | 1                | PINMMR163[0] = 1        | PINMMR163[0] = 0        | N2HET1[19]        |
|                                                         |           | 0                | 1                | PINMMR163[0] = 0        | PINMMR163[0] = 1        | N2HET2[1]         |
| 110                                                     | 7         | 1                | 0                | PINMMR163[8] = x        | PINMMR163[8] = x        | GIOB[0]           |
|                                                         |           | 0                | 1                | PINMMR163[8] = 1        | PINMMR163[8] = 0        | N2HET1[11]        |
|                                                         |           | 0                | 1                | PINMMR163[8] = 0        | PINMMR163[8] = 1        | ePWM_A2           |
| 111                                                     | 8         | 1                | 0                | PINMMR163[16] =<br>x    | PINMMR163[16] =<br>x    | GIOB[1]           |
|                                                         |           | 0                | 1                | PINMMR163[16] =<br>1    | PINMMR163[16] =<br>0    | N2HET2[13]        |
|                                                         |           | 0                | 1                | PINMMR163[16] =<br>0    | PINMMR163[16] =<br>1    | ePWM_AB           |

**备注**

For AD2EVT trigger source, the connection to the MibADC2 module trigger input is made from the output side of the input buffer. This way, a trigger condition can be generated either by configuring AD2EVT as an output function on to the pad (through the mux control), or by driving the AD2EVT signal from an external trigger source as input. If the mux control module is used to select different functionality instead of the AD2EVT signal, then care must be taken to disable AD2EVT from triggering conversions; there is no multiplexing on the input connections.

If ePWM\_B, ePWM\_A2, ePWM\_AB, N2HET2[1], N2HET2[5], N2HET2[13], N2HET1[11], N2HET1[17], or N2HET1[19] is used to trigger the ADC, the connection to the ADC is made directly from the N2HET or ePWM module outputs. As a result, the ADC can be triggered without having to enable the signal from being output on a device terminal.

**备注**

For N2HETx trigger sources, the connection to the MibADC2 module trigger input is made from the input side of the output buffer (at the N2HETx module boundary). This way, a trigger condition can be generated even if the N2HETx signal is not selected to be output on the pad.

**备注**

For the RTI compare 0 interrupt source, the connection is made directly from the output of the RTI module. That is, the interrupt condition can be used as a trigger source even if the actual interrupt is not signaled to the CPU.

#### **8.4.2.3 Controlling ADC1 and ADC2 Event Trigger Options Using SOC Output from ePWM Modules**

As shown in 图 8-9, the ePWMxSOCA and ePWMxSOCB outputs from each ePWM module are used to generate four signals – ePWM\_B, ePWM\_A1, ePWM\_A2, and ePWM\_AB, that are available to trigger the ADC based on the application requirement.

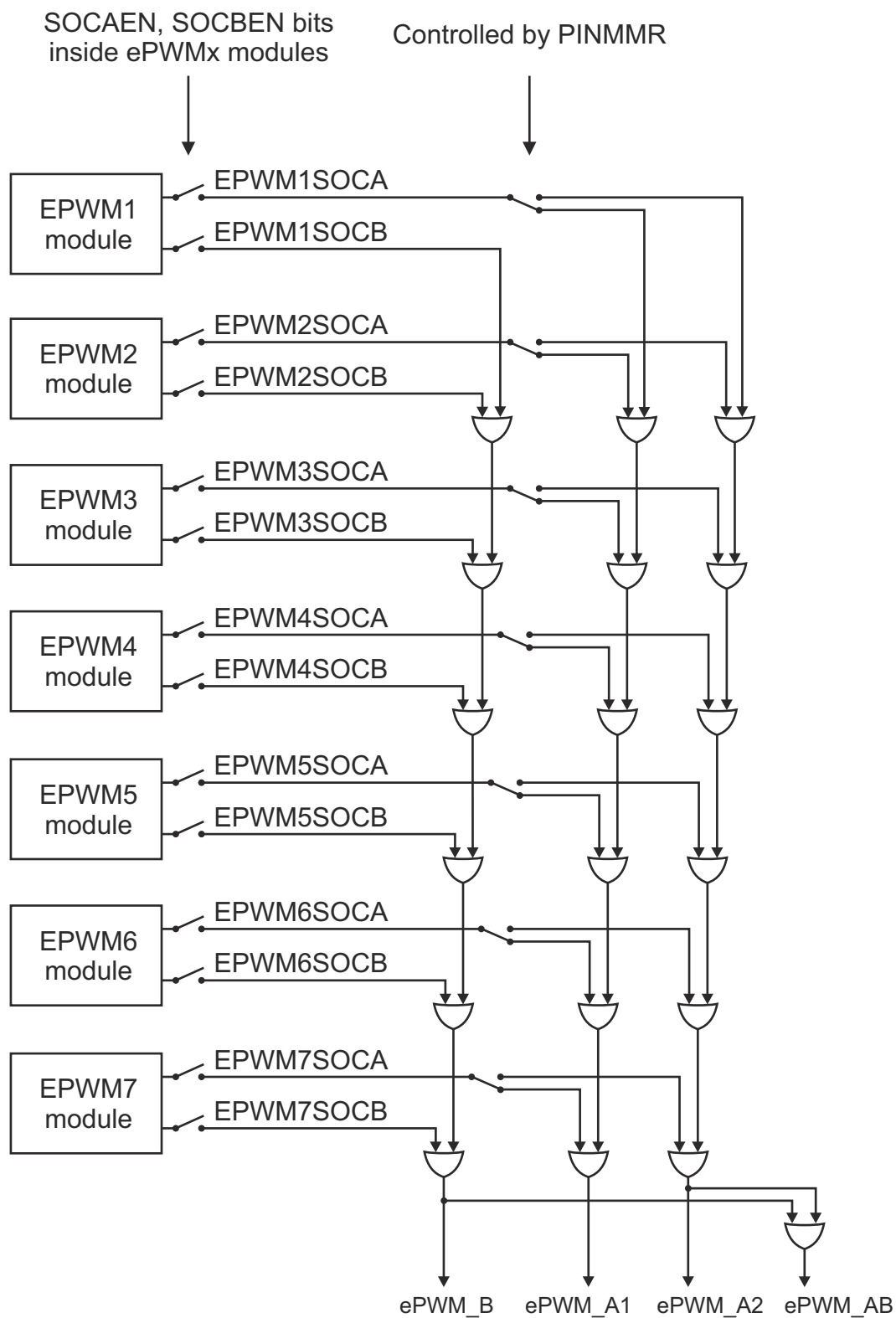


图 8-9. ADC Trigger Source Generation from ePWMx

表 8-18. Control Bit to SOC Output

| CONTROL BIT   | SOC OUTPUT |
|---------------|------------|
| PINMMR164[0]  | SOC1A_SEL  |
| PINMMR164[8]  | SOC2A_SEL  |
| PINMMR164[16] | SOC3A_SEL  |
| PINMMR164[24] | SOC4A_SEL  |
| PINMMR165[0]  | SOC5A_SEL  |
| PINMMR165[8]  | SOC6A_SEL  |
| PINMMR165[16] | SOC7A_SEL  |

The SOCA output from each ePWM module is connected to a "switch" shown in 图 8-9. This switch is implemented by using the control registers in the PINMMR module. 图 8-10 is an example of the implementation is shown for the switch on SOC1A. The switches on the other SOCA signals are implemented in the same way.

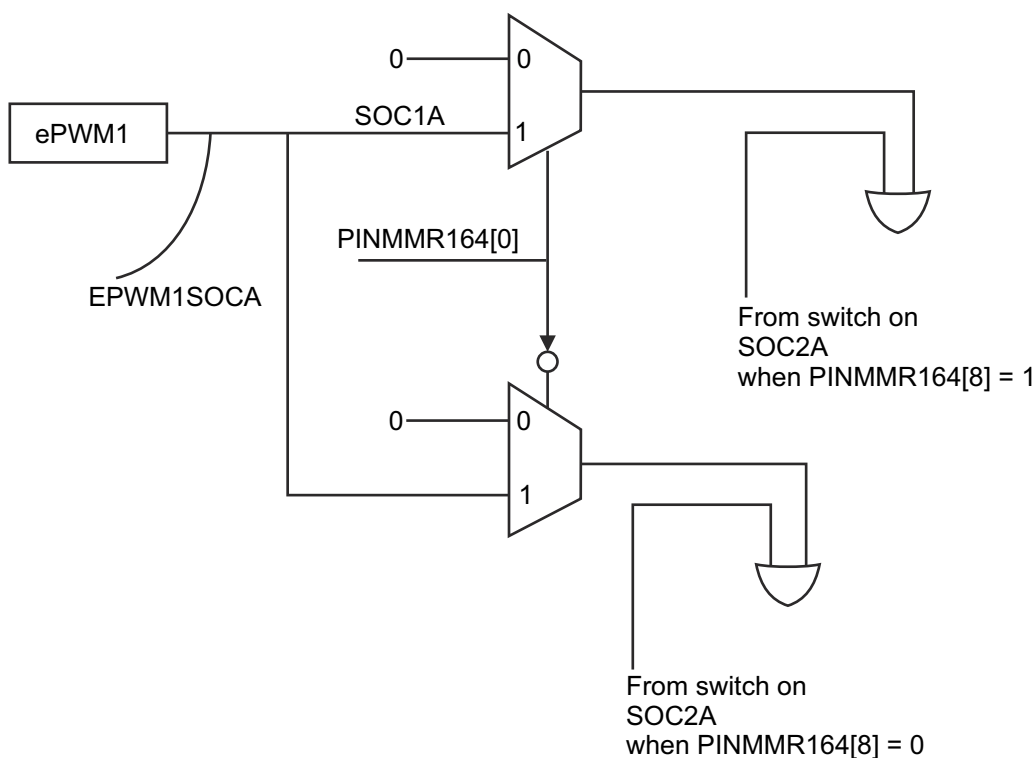


图 8-10. ePWM1SOC1A Switch Implementation

The logic equations for the four outputs from the combinational logic shown in 图 8-9 are:

$$\text{ePWM\_B} = \text{SOC1B or SOC2B or SOC3B or SOC4B or SOC5B or SOC6B or SOC7B} \quad (1)$$

$$\begin{aligned} \text{ePWM\_A1} = & [\text{SOC1A and not(SOC1A\_SEL)}] \text{ or } [\text{SOC2A and not(SOC2A\_SEL)}] \text{ or } [\text{SOC3A and not(SOC3A\_SEL)}] \text{ or } \\ & [\text{SOC4A and not(SOC4A\_SEL)}] \text{ or } [\text{SOC5A and not(SOC5A\_SEL)}] \text{ or } [\text{SOC6A and not(SOC6A\_SEL)}] \text{ or } \\ & [\text{SOC7A and not(SOC7A\_SEL)}] \end{aligned} \quad (2)$$

$$\begin{aligned} \text{ePWM\_A2} = & [\text{SOC1A and SOC1A\_SEL}] \text{ or } [\text{SOC2A and SOC2A\_SEL}] \text{ or } [\text{SOC3A and SOC3A\_SEL}] \text{ or } \\ & [\text{SOC4A and SOC4A\_SEL}] \text{ or } [\text{SOC5A and SOC5A\_SEL}] \text{ or } [\text{SOC6A and SOC6A\_SEL}] \text{ or } \\ & [\text{SOC7A and SOC7A\_SEL}] \end{aligned} \quad (3)$$

$$\text{ePWM\_AB} = \text{ePWM\_B or ePWM\_A2} \quad (4)$$

### 8.4.3 ADC Electrical and Timing Specifications

表 8-19. MibADC Recommended Operating Conditions

| PARAMETER           |                                                                                                                                    | MIN                              | MAX                              | UNIT |
|---------------------|------------------------------------------------------------------------------------------------------------------------------------|----------------------------------|----------------------------------|------|
| AD <sub>REFHI</sub> | A-to-D high-voltage reference source                                                                                               | AD <sub>REFLO</sub>              | V <sub>CCAD</sub> <sup>(1)</sup> | V    |
| AD <sub>REFLO</sub> | A-to-D low-voltage reference source                                                                                                | V <sub>SSAD</sub> <sup>(1)</sup> | AD <sub>REFHI</sub>              | V    |
| V <sub>AI</sub>     | Analog input voltage                                                                                                               | AD <sub>REFLO</sub>              | AD <sub>REFHI</sub>              | V    |
| I <sub>AIC</sub>    | Analog input clamp current <sup>(2)</sup> (V <sub>AI</sub> < V <sub>SSAD</sub> – 0.3 or V <sub>AI</sub> > V <sub>CCAD</sub> + 0.3) | – 2                              | 2                                | mA   |

(1) For V<sub>CCAD</sub> and V<sub>SSAD</sub> recommended operating conditions, see 节 6.4, *Recommended Operating Conditions*.

(2) Input currents into any ADC input channel outside the specified limits could affect conversion results of other channels.

表 8-20. MibADC Electrical Characteristics Over Full Ranges of Recommended Operating Conditions<sup>(2)</sup>

| PARAMETER                        |                                        | DESCRIPTION/CONDITIONS     |                                                                           | MIN    | MAX  | UNIT |
|----------------------------------|----------------------------------------|----------------------------|---------------------------------------------------------------------------|--------|------|------|
| R <sub>mux</sub>                 | Analog input mux on-resistance         | See 图 8-11                 |                                                                           |        | 250  | Ω    |
| R <sub>samp</sub>                | ADC sample switch on-resistance        | See 图 8-11                 |                                                                           |        | 250  | Ω    |
| C <sub>mux</sub>                 | Input mux capacitance                  | See 图 8-11                 |                                                                           |        | 16   | pF   |
| C <sub>samp</sub>                | ADC sample capacitance                 | See 图 8-11                 |                                                                           |        | 13   | pF   |
| I <sub>AIL</sub>                 | Analog off-state input leakage current | V <sub>CCAD</sub> = 3.6 V  | V <sub>SSAD</sub> ≤ V <sub>IN</sub> < V <sub>SSAD</sub> + 100 mV          | – 300  | 200  | nA   |
|                                  |                                        |                            | V <sub>SSAD</sub> + 100 mV ≤ V <sub>IN</sub> ≤ V <sub>CCAD</sub> – 200 mV | – 280  | 280  |      |
|                                  |                                        |                            | V <sub>CCAD</sub> – 200 mV < V <sub>IN</sub> ≤ V <sub>CCAD</sub>          | – 200  | 650  |      |
| I <sub>AIL</sub>                 | Analog off-state input leakage current | V <sub>CCAD</sub> = 5.25 V | V <sub>SSAD</sub> ≤ V <sub>IN</sub> < V <sub>SSAD</sub> + 300 mV          | – 1000 | 250  | nA   |
|                                  |                                        |                            | V <sub>SSAD</sub> + 300 mV ≤ V <sub>IN</sub> ≤ V <sub>CCAD</sub> – 300 mV | – 450  | 450  |      |
|                                  |                                        |                            | V <sub>CCAD</sub> – 300 mV < V <sub>IN</sub> ≤ V <sub>CCAD</sub>          | – 250  | 2000 |      |
| I <sub>AOSB</sub> <sup>(1)</sup> | Analog on-state input bias current     | V <sub>CCAD</sub> = 3.6 V  | V <sub>SSAD</sub> ≤ V <sub>IN</sub> < V <sub>SSAD</sub> + 100 mV          | – 10   | 2    | μA   |
|                                  |                                        |                            | V <sub>SSAD</sub> + 100 mV < V <sub>IN</sub> < V <sub>CCAD</sub> – 200 mV | – 4    | 2    |      |
|                                  |                                        |                            | V <sub>CCAD</sub> – 200 mV < V <sub>IN</sub> < V <sub>CCAD</sub>          | – 4    | 16   |      |
| I <sub>AOSB</sub> <sup>(1)</sup> | Analog on-state input bias current     | V <sub>CCAD</sub> = 5.25 V | V <sub>SSAD</sub> ≤ V <sub>IN</sub> < V <sub>SSAD</sub> + 300 mV          | – 12   | 3    | μA   |
|                                  |                                        |                            | V <sub>SSAD</sub> + 300 mV ≤ V <sub>IN</sub> ≤ V <sub>CCAD</sub> – 300 mV | – 5    | 3    |      |
|                                  |                                        |                            | V <sub>CCAD</sub> – 300 mV < V <sub>IN</sub> ≤ V <sub>CCAD</sub>          | – 5    | 18   |      |

(1) If a shared channel is being converted by both ADC converters at the same time, the on-state leakage is doubled.

(2) For I<sub>CCAD</sub> and I<sub>CCREFHI</sub> see 节 6.7, *Power Consumption Summary*.

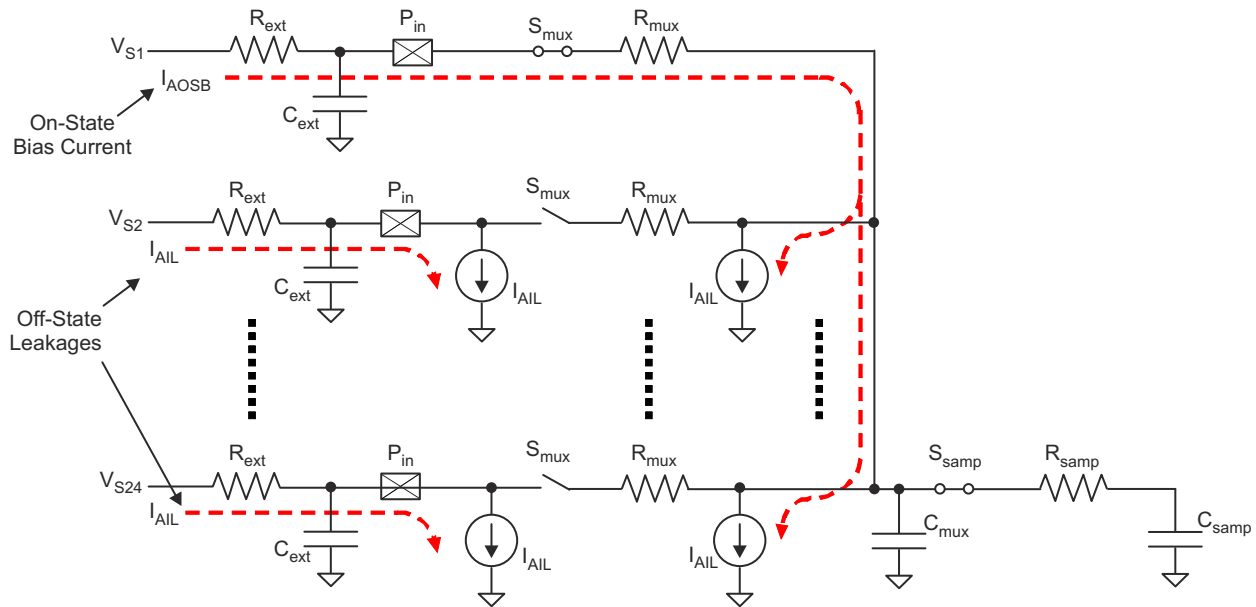


图 8-11. MibADC Input Equivalent Circuit

表 8-21. MibADC Timing Specifications

| PARAMETER                     |                                                   | MIN   | NOM | MAX | UNIT    |
|-------------------------------|---------------------------------------------------|-------|-----|-----|---------|
| $t_{c(ADCLK)}$ <sup>(1)</sup> | Cycle time, MibADC clock                          | 0.033 |     |     | $\mu s$ |
| $t_{d(SH)}$ <sup>(2)</sup>    | Delay time, sample and hold time                  | 0.2   |     |     | $\mu s$ |
| <b>12-BIT MODE</b>            |                                                   |       |     |     |         |
| $t_{d(C)}$                    | Delay time, conversion time                       | 0.4   |     |     | $\mu s$ |
| $t_{d(SHC)}$ <sup>(3)</sup>   | Delay time, total sample/hold and conversion time | 0.6   |     |     | $\mu s$ |
| <b>10-BIT MODE</b>            |                                                   |       |     |     |         |
| $t_{d(C)}$                    | Delay time, conversion time                       | 0.33  |     |     | $\mu s$ |
| $t_{d(SHC)}$ <sup>(3)</sup>   | Delay time, total sample/hold and conversion time | 0.53  |     |     | $\mu s$ |

- (1) The MibADC clock is the ADCLK, generated by dividing down the VCLK1 by a prescale factor defined by the ADCLOCKCR register bits 4:0.
- (2) The sample and hold time for the ADC conversions is defined by the ADCLK frequency and the AD<GP>SAMP register for each conversion group. The sample time must be determined by accounting for the external impedance connected to the input channel as well as the internal impedance of the ADC.
- (3) This is the minimum sample/hold and conversion time that can be achieved. These parameters are dependent on many factors (for example, the prescale settings).

**表 8-22. MibADC Operating Characteristics Over 3.0 V to 3.6 V Operating Conditions<sup>(1) (2)</sup>**

| PARAMETER                    |                                                              | DESCRIPTION/CONDITIONS                                                                                                               |             | MIN | MAX | UNIT |
|------------------------------|--------------------------------------------------------------|--------------------------------------------------------------------------------------------------------------------------------------|-------------|-----|-----|------|
| CR                           | Conversion range over which specified accuracy is maintained | AD <sub>REFHI</sub> - AD <sub>REFLO</sub>                                                                                            |             | 3   | 3.6 | V    |
| Z <sub>SET</sub>             | Zero Scale Offset                                            | Difference between the first ideal transition (from code 000h to 001h) and the actual transition                                     | 10-bit mode |     | 1   | LSB  |
|                              |                                                              |                                                                                                                                      | 12-bit mode |     | 2   | LSB  |
| F <sub>SET</sub>             | Full Scale Offset                                            | Difference between the range of the measured code transitions (from first to last) and the range of the ideal code transitions       | 10-bit mode |     | 2   | LSB  |
|                              |                                                              |                                                                                                                                      | 12-bit mode |     | 3   | LSB  |
| E <sub>DN</sub> <sub>L</sub> | Differential nonlinearity error                              | Difference between the actual step width and the ideal value. (See 图 8-12)                                                           | 10-bit mode | - 1 | 1.5 | LSB  |
|                              |                                                              |                                                                                                                                      | 12-bit mode | - 1 | 2   | LSB  |
| E <sub>INL</sub>             | Integral nonlinearity error                                  | Maximum deviation from the best straight line through the MibADC. MibADC transfer characteristics, excluding the quantization error. | 10-bit mode | - 2 | 2   | LSB  |
|                              |                                                              |                                                                                                                                      | 12-bit mode | - 2 | 2   | LSB  |
| E <sub>TOT</sub>             | Total unadjusted error (after calibration)                   | Maximum value of the difference between an analog value and the ideal midstep value.                                                 | 10-bit mode | - 2 | 2   | LSB  |
|                              |                                                              |                                                                                                                                      | 12-bit mode | - 4 | 4   | LSB  |

(1) 1 LSB = (AD<sub>REFHI</sub> - AD<sub>REFLO</sub>) / 2<sup>12</sup> for 12-bit mode

(2) 1 LSB = (AD<sub>REFHI</sub> - AD<sub>REFLO</sub>) / 2<sup>10</sup> for 10-bit mode

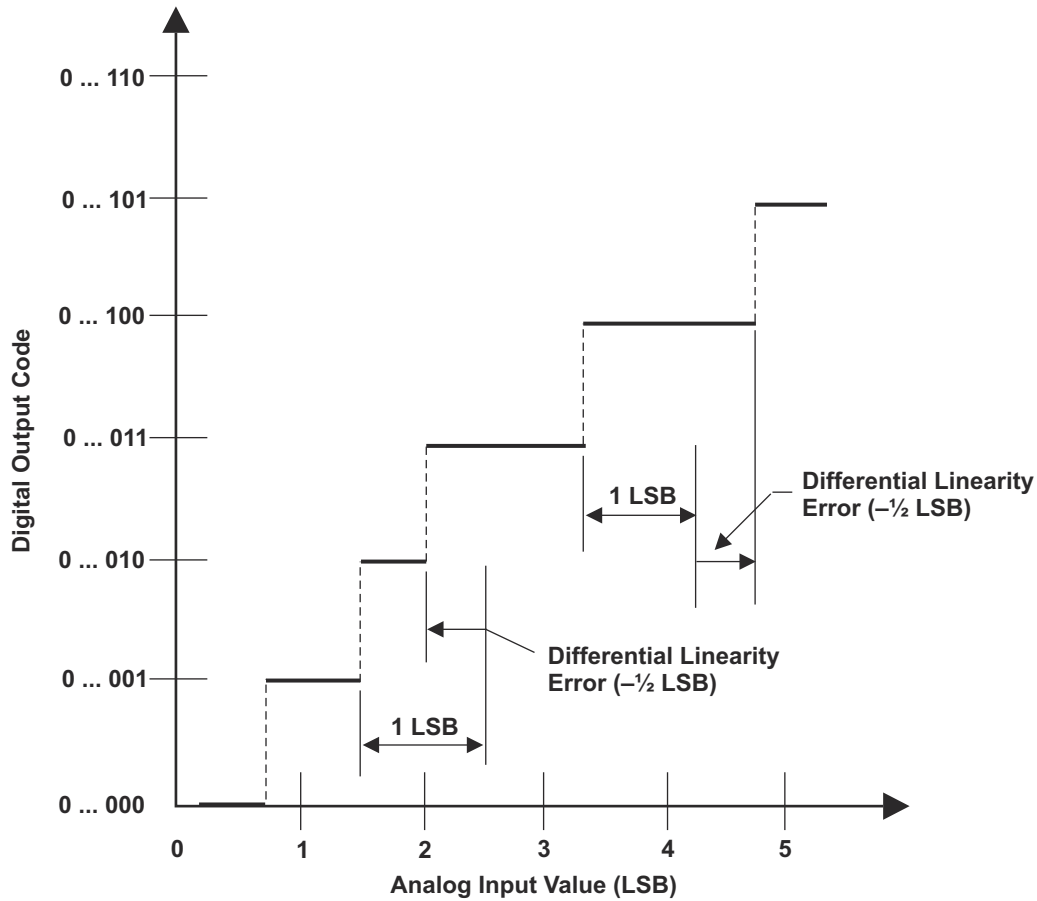
**表 8-23. MibADC Operating Characteristics Over 3.6 V to 5.25 V Operating Conditions<sup>(1) (2)</sup>**

| PARAMETER                    |                                                              | DESCRIPTION/CONDITIONS                                                                                                               |             | MIN   | MAX  | UNIT |
|------------------------------|--------------------------------------------------------------|--------------------------------------------------------------------------------------------------------------------------------------|-------------|-------|------|------|
| CR                           | Conversion range over which specified accuracy is maintained | AD <sub>REFHI</sub> - AD <sub>REFLO</sub>                                                                                            |             | 3.6   | 5.25 | V    |
| Z <sub>SET</sub>             | Zero Scale Offset                                            | Difference between the first ideal transition (from code 000h to 001h) and the actual transition                                     | 10-bit mode |       | 1    | LSB  |
|                              |                                                              |                                                                                                                                      | 12-bit mode |       | 2    | LSB  |
| F <sub>SET</sub>             | Full Scale Offset                                            | Difference between the range of the measured code transitions (from first to last) and the range of the ideal code transitions       | 10-bit mode |       | 2    | LSB  |
|                              |                                                              |                                                                                                                                      | 12-bit mode |       | 3    | LSB  |
| E <sub>DN</sub> <sub>L</sub> | Differential nonlinearity error                              | Difference between the actual step width and the ideal value. (See 图 8-12)                                                           | 10-bit mode | - 1   | 1.5  | LSB  |
|                              |                                                              |                                                                                                                                      | 12-bit mode | - 1   | 3    | LSB  |
| E <sub>INL</sub>             | Integral nonlinearity error                                  | Maximum deviation from the best straight line through the MibADC. MibADC transfer characteristics, excluding the quantization error. | 10-bit mode | - 2   | 2    | LSB  |
|                              |                                                              |                                                                                                                                      | 12-bit mode | - 4.5 | 2    | LSB  |
| E <sub>TOT</sub>             | Total unadjusted error (after calibration)                   | Maximum value of the difference between an analog value and the ideal midstep value.                                                 | 10-bit mode | - 2   | 2    | LSB  |
|                              |                                                              |                                                                                                                                      | 12-bit mode | - 6   | 5    | LSB  |

## 8.4.4 Performance (Accuracy) Specifications

### 8.4.4.1 MibADC Nonlinearity Errors

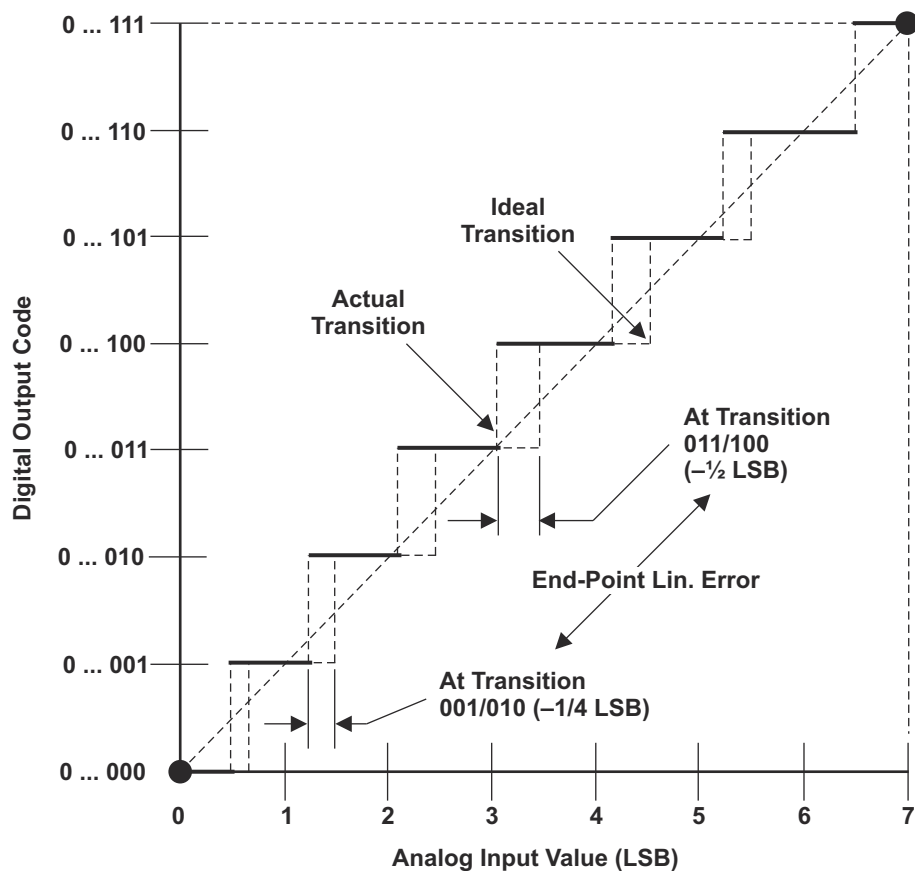
The differential nonlinearity error shown in 图 8-12 (sometimes referred to as differential linearity) is the difference between an actual step width and the ideal value of 1 LSB.



A.  $1 \text{ LSB} = (\text{AD}_{\text{REFHI}} - \text{AD}_{\text{REFLO}})/2^{12}$

图 8-12. Differential Nonlinearity (DNL) Error

The integral nonlinearity error shown in 图 8-13 (sometimes referred to as linearity error) is the deviation of the values on the actual transfer function from a straight line.

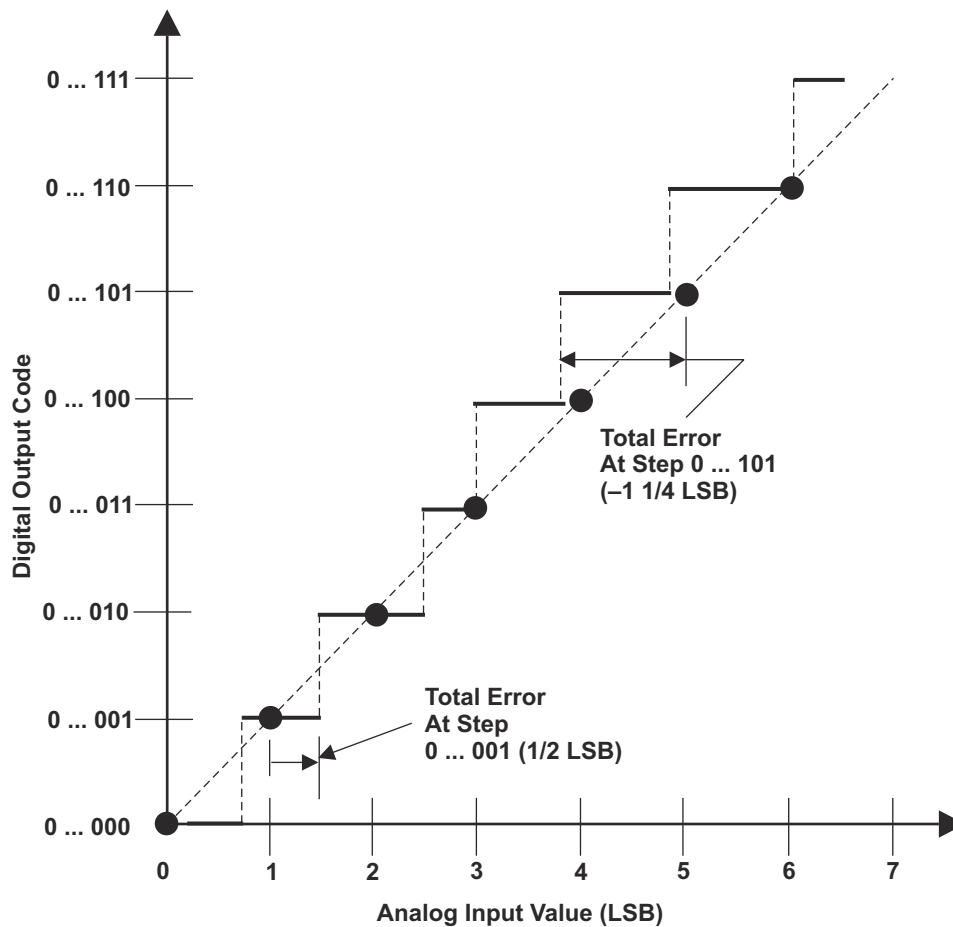


A.  $1 \text{ LSB} = (AD_{\text{REFHI}} - AD_{\text{REFLO}})/2^{12}$

图 8-13. Integral Nonlinearity (INL) Error<sup>(A)</sup>

#### 8.4.4.2 MibADC Total Error

The absolute accuracy or total error of an MibADC as shown in 图 8-14 is the maximum value of the difference between an analog value and the ideal midstep value.



A.  $1 \text{ LSB} = (AD_{\text{REFHI}} - AD_{\text{REFLO}})/2^{12}$

图 8-14. Absolute Accuracy (Total) Error<sup>(A)</sup>

## 8.5 General-Purpose Input/Output

The GPIO module on this device supports two ports, GIOA and GIOB. The I/O pins are bidirectional and bit-programmable. Both GIOA and GIOB support external interrupt capability.

### 8.5.1 Features

The GPIO module has the following features:

- Each I/O pin can be configured as:
  - Input
  - Output
  - Open Drain
- The interrupts have the following characteristics:
  - Programmable interrupt detection either on both edges or on a single edge (set in GIOINTDET)
  - Programmable edge-detection polarity, either rising or falling edge (set in GIOPOL register)
  - Individual interrupt flags (set in GIOFLG register)
  - Individual interrupt enables, set and cleared through GIOENASET and GIOENACLR registers respectively
  - Programmable interrupt priority, set through GIOLVLSET and GIOLVLCLR registers
- Internal pullup/pulldown allows unused I/O pins to be left unconnected

For information on input and output timings see [节 6.10.2](#) and [节 6.10.3](#).

## 8.6 Enhanced High-End Timer (N2HET)

The N2HET is an advanced intelligent timer that provides sophisticated timing functions for real-time applications. The timer is software-controlled, using a reduced instruction set, with a specialized timer micromachine and an attached I/O port. The N2HET can be used for pulse width modulated outputs, capture or compare inputs, or general-purpose I/O.. It is especially well suited for applications requiring multiple sensor information and drive actuators with complex and accurate time pulses.

### 8.6.1 Features

The N2HET module has the following features:

- Programmable timer for input and output timing functions
- Reduced instruction set (30 instructions) for dedicated time and angle functions
- 256 words of instruction RAM protected by parity
- User defined number of 25-bit virtual counters for timer, event counters and angle counters
- 7-bit hardware counters for each pin allow up to 32-bit resolution in conjunction with the 25-bit virtual counters
- Up to 32 pins usable for input signal measurements or output signal generation
- Programmable suppression filter for each input pin with adjustable limiting frequency
- Low CPU overhead and interrupt load
- Efficient data transfer to or from the CPU memory with dedicated High-End-Timer Transfer Unit (HTU) or DMA
- Diagnostic capabilities with different loopback mechanisms and pin status readback functionality

### 8.6.2 N2HET RAM Organization

The timer RAM uses 4 RAM banks, where each bank has two port access capability. This means that one RAM address may be written while another address is read. The RAM words are 96-bits wide, which are split into three 32-bit fields (program, control, and data).

### 8.6.3 Input Timing Specifications

The N2HET instructions PCNT and WCAP impose some timing constraints on the input signals.

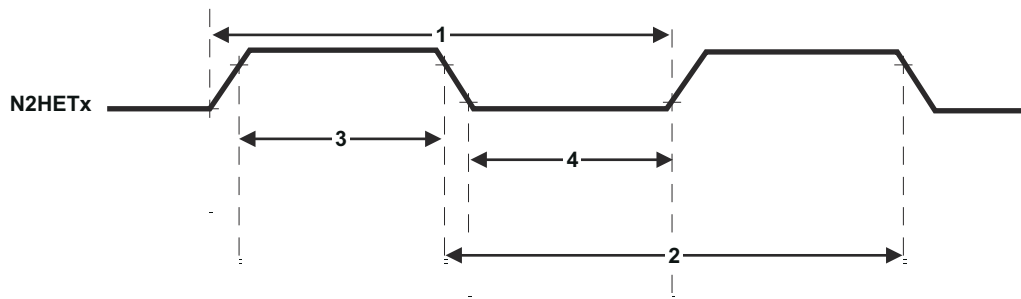


图 8-15. N2HET Input Capture Timings

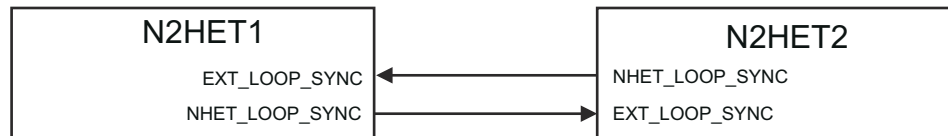
**表 8-24. Dynamic Characteristics for the N2HET Input Capture Functionality**

| PARAMETER |                                                                       | MIN                            | MAX                                     | UNIT |
|-----------|-----------------------------------------------------------------------|--------------------------------|-----------------------------------------|------|
| 1         | Input signal period, PCNT or WCAP for rising edge to rising edge      | (HRP) (LRP) $t_{c(VCLK2)} + 2$ | $2^{25}$ (HRP) (LRP) $t_{c(VCLK2)} - 2$ | ns   |
| 2         | Input signal period, PCNT or WCAP for falling edge to falling edge    | (HRP) (LRP) $t_{c(VCLK2)} + 2$ | $2^{25}$ (HRP) (LRP) $t_{c(VCLK2)} - 2$ | ns   |
| 3         | Input signal high phase, PCNT or WCAP for rising edge to falling edge | $2$ (HRP) $t_{c(VCLK2)} + 2$   | $2^{25}$ (HRP) (LRP) $t_{c(VCLK2)} - 2$ | ns   |
| 4         | Input signal low phase, PCNT or WCAP for falling edge to rising edge  | $2$ (HRP) $t_{c(VCLK2)} + 2$   | $2^{25}$ (HRP) (LRP) $t_{c(VCLK2)} - 2$ | ns   |

#### 8.6.4 N2HET1-N2HET2 Interconnections

In some applications the N2HET resolutions must be synchronized. Some other applications require a single time base to be used for all PWM outputs and input timing captures.

The N2HET provides such a synchronization mechanism. The Clk\_master/slave (HETGCR.16) configures the N2HET in master or slave mode (default is slave mode). A N2HET in master mode provides a signal to synchronize the prescalers of the slave N2HET. The slave N2HET synchronizes its loop resolution to the loop resolution signal sent by the master. The slave does not require this signal after it receives the first synchronization signal. However, anytime the slave receives the resynchronization signal from the master, the slave must synchronize itself again..



**图 8-16. N2HET1 - N2HET2 Synchronization Hookup**

## 8.6.5 N2HET Checking

### 8.6.5.1 Internal Monitoring

To assure correctness of the high-end timer operation and output signals, the two N2HET modules can be used to monitor each other's signals as shown in 图 8-17. The direction of the monitoring is controlled by the I/O multiplexing control module.

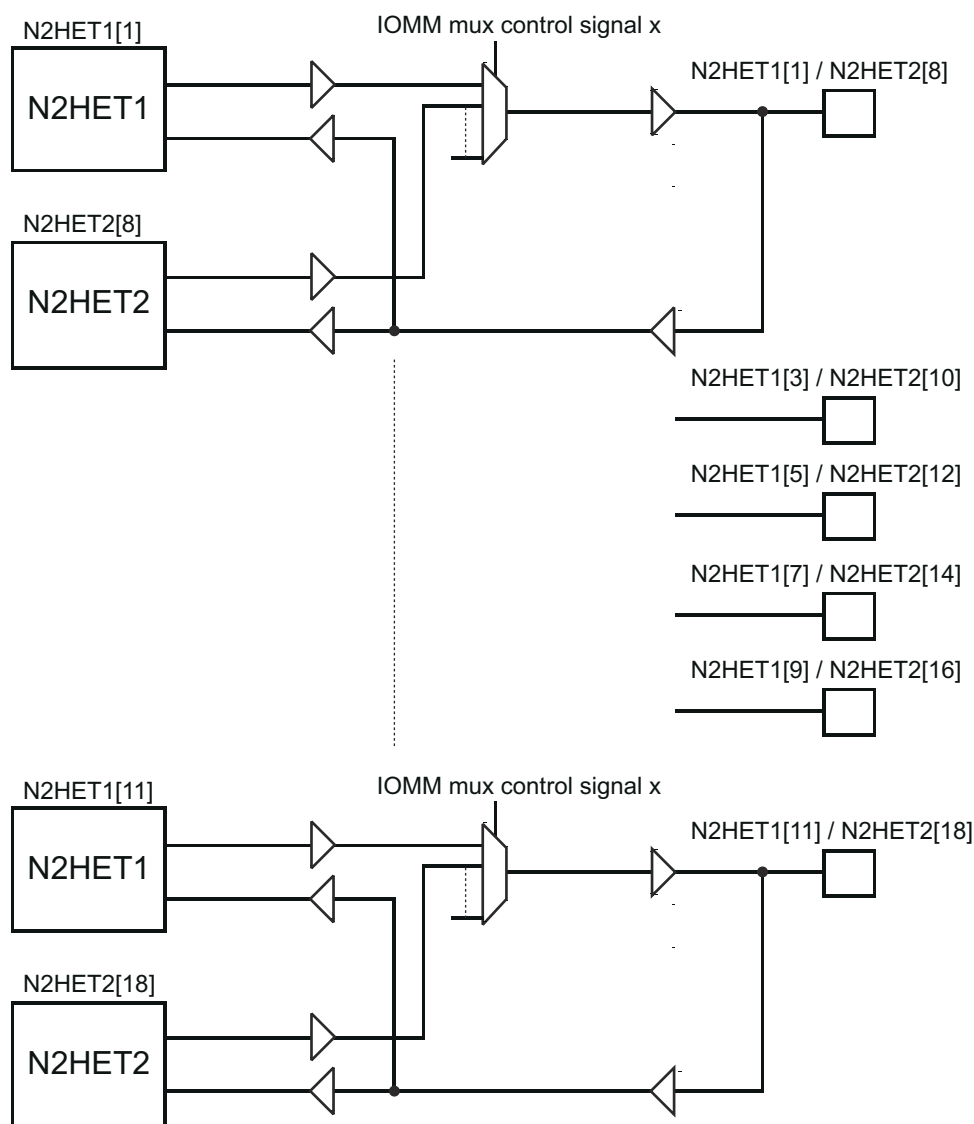


图 8-17. N2HET Monitoring

### 8.6.5.2 Output Monitoring using Dual Clock Comparator (DCC)

N2HET1[31] is connected as a clock source for counter 1 in DCC1. This allows the application to measure the frequency of the pulse-width modulated (PWM) signal on N2HET1[31].

Similarly, N2HET2[0] is connected as a clock source for counter 1 in DCC2. This allows the application to measure the frequency of the pulse-width modulated (PWM) signal on N2HET2[0].

Both N2HET1[31] and N2HET2[0] can be configured to be internal-only channels. That is, the connection to the DCC module is made directly from the output of the N2HETx module (from the input of the output buffer).

For more information on DCC see [节 7.7.3](#).

### 8.6.6 Disabling N2HET Outputs

Some applications require the N2HET outputs to be disabled under some fault condition. The N2HET module provides this capability through the "Pin Disable" input signal. This signal, when driven low, causes the N2HET outputs identified by a programmable register (HETPINDIS) to be tri-stated. Refer to the IOMM chapter in the device specific technical reference manual for more details on the "N2HET Pin Disable" feature.

GIOA[5] is connected to the "Pin Disable" input for N2HET1, and GIOB[2] is connected to the "Pin Disable" input for N2HET2.

### 8.6.7 High-End Timer Transfer Unit (HET-TU)

A High End Timer Transfer Unit (HET-TU) can perform DMA type transactions to transfer N2HET data to or from main memory. A Memory Protection Unit (MPU) is built into the HET-TU.

#### 8.6.7.1 Features

- CPU and DMA independent
- Master Port to access system memory
- 8 control packets supporting dual buffer configuration
- Control packet information is stored in RAM protected by parity
- Event synchronization (HET transfer requests)
- Supports 32 or 64 bit transactions
- Addressing modes for HET address (8 byte or 16 byte) and system memory address (fixed, 32 bit or 64bit)
- One shot, circular and auto switch buffer transfer modes
- Request lost detection

#### 8.6.7.2 Trigger Connections

表 8-25. HET TU1 Request Line Connection

| Modules | Request Source | HET TU1 Request |
|---------|----------------|-----------------|
| N2HET1  | HTUREQ[0]      | HET TU1 DCP[0]  |
| N2HET1  | HTUREQ[1]      | HET TU1 DCP[1]  |
| N2HET1  | HTUREQ[2]      | HET TU1 DCP[2]  |
| N2HET1  | HTUREQ[3]      | HET TU1 DCP[3]  |
| N2HET1  | HTUREQ[4]      | HET TU1 DCP[4]  |
| N2HET1  | HTUREQ[5]      | HET TU1 DCP[5]  |
| N2HET1  | HTUREQ[6]      | HET TU1 DCP[6]  |
| N2HET1  | HTUREQ[7]      | HET TU1 DCP[7]  |

表 8-26. HET TU2 Request Line Connection

| Modules | Request Source | HET TU2 Request |
|---------|----------------|-----------------|
| N2HET2  | HTUREQ[0]      | HET TU2 DCP[0]  |
| N2HET2  | HTUREQ[1]      | HET TU2 DCP[1]  |
| N2HET2  | HTUREQ[2]      | HET TU2 DCP[2]  |
| N2HET2  | HTUREQ[3]      | HET TU2 DCP[3]  |
| N2HET2  | HTUREQ[4]      | HET TU2 DCP[4]  |
| N2HET2  | HTUREQ[5]      | HET TU2 DCP[5]  |
| N2HET2  | HTUREQ[6]      | HET TU2 DCP[6]  |
| N2HET2  | HTUREQ[7]      | HET TU2 DCP[7]  |

## 8.7 FlexRay Interface

The FlexRay module performs communication according to the FlexRay protocol specification v2.1. The sample clock bitrate can be programmed to values up to 10 MBit per second. Additional bus driver (BD) hardware is required for connection to the physical layer.

For communication on a FlexRay network, individual message buffers with up to 254 data bytes are configurable. The message storage consists of a single-ported message RAM that holds up to 128 message buffers. All functions concerning the handling of messages are implemented in the message handler. Those functions are the acceptance filtering, the transfer of messages between the two FlexRay Channel Protocol Controllers and the message RAM, maintaining the transmission schedule as well as providing message status information.

The register set of the FlexRay module can be accessed directly by the CPU through the VBUS interface. These registers are used to control, configure and monitor the FlexRay channel protocol controllers, message handler, global time unit, system universal control, frame/symbol processing, network management, interrupt control, and to access the message RAM through the I/O buffer.

### 8.7.1 Features

The FlexRay module has the following features:

- Conformance with FlexRay protocol specification v2.1
- Data rates of up to 10 Mbps on each channel
- Up to 128 message buffers
- 8KB of message RAM for storage of for example, 128 message buffers with max. 48 byte data section or up to 30 message buffers with 254 byte data section
- Configuration of message buffers with different payload lengths
- One configurable receive FIFO
- Each message buffer can be configured as receive buffer, as transmit buffer or as part of the receive FIFO
- CPU access to message buffers through input and output buffer
- FlexRay Transfer Unit (FTU) for automatic data transfer between data memory and message buffers without CPU interaction
- Filtering for slot counter, cycle counter, and channel ID
- Maskable module interrupts
- Supports Network Management
- ECC protection on the message RAM

### 8.7.2 Electrical and Timing Specifications

表 8-27. Timing Requirements for FlexRay Inputs<sup>(1)</sup>

| Parameter |                                                                    | MIN                         | MAX | UNIT |
|-----------|--------------------------------------------------------------------|-----------------------------|-----|------|
| $t_{pw}$  | Input minimum pulse width to meet the FlexRay sampling requirement | $t_{c(VCLKA2)} + 2.5^{(2)}$ |     | ns   |

(1)  $t_{c(VCLKA2)}$  = sample clock cycle time for FlexRay =  $1 / f_{(VCLKA2)}$

(2)  $t_{RxAsymDelay}$  parameter

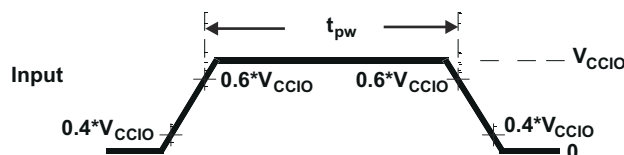


图 8-18. FlexRay Inputs

表 8-28. FlexRay Jitter Timing<sup>(2)</sup>

| PARAMETER                        |                                                                                    | MIN   | MAX    | UNIT |
|----------------------------------|------------------------------------------------------------------------------------|-------|--------|------|
| $t_{Tx1bit}$                     | Clock jitter and signal symmetry                                                   | 98    | 102    | ns   |
| $t_{Tx10bit}$                    | FlexRay BSS (byte start sequence) to BSS                                           | 999   | 1001   | ns   |
| $t_{Tx10bitAvg}$                 | Average over 10000 samples                                                         | 999.5 | 1000.5 | ns   |
| $t_{RxAsymDelay}$ <sup>(1)</sup> | Delay difference between rise and fall from Rx pin to sample point in FlexRay core | –     | 2.5    | ns   |
| $t_{jit}(SCLK)$                  | Jitter for the 80-MHz Sample Clock generated by the PLL                            | –     | 0.5    | ns   |

(1) This value is based on design simulation.

(2) This parameter will be characterized, but not production-tested.

### 8.7.3 FlexRay Transfer Unit

The FlexRay Transfer Unit is able to transfer data between the input buffer (IBF) and output buffer (OBF) of the communication controller and the system memory without CPU interaction.

Because the FlexRay module is accessed through the FTU, the FTU must be powered up by the setting bit 23 in the Peripheral Power Down Registers of the System Module before accessing any FlexRay module register.

For more information on the FTU see the device specific technical reference manual.

## 8.8 Controller Area Network (DCAN)

The DCAN supports the CAN 2.0B protocol standard and uses a serial, multimaster communication protocol that efficiently supports distributed real-time control with robust communication rates of up to 1 megabit per second (Mbps). The DCAN is ideal for applications operating in noisy and harsh environments (e.g., automotive and industrial fields) that require reliable serial communication or multiplexed wiring.

### 8.8.1 Features

Features of the DCAN module include:

- Supports CAN protocol version 2.0 part A, B
- Bit rates up to 1 MBit/s
- The CAN kernel can be clocked by the oscillator for baud-rate generation.
- 64 mailboxes on each DCAN
- Individual identifier mask for each message object
- Programmable FIFO mode for message objects
- Programmable loop-back modes for self-test operation
- Automatic bus on after Bus-Off state by a programmable 32-bit timer
- Message RAM protected by ECC
- Direct access to Message RAM during test mode
- CAN Rx / Tx pins configurable as general purpose IO pins
- Message RAM Auto Initialization
- DMA support

### 8.8.2

For more information on the DCAN see the device specific technical reference manual.

### 8.8.3 Electrical and Timing Specifications

**表 8-29. Dynamic Characteristics for the DCANx TX and RX pins**

| Parameter       |                                                                  | MIN | MAX | Unit |
|-----------------|------------------------------------------------------------------|-----|-----|------|
| $t_{d(CANnTX)}$ | Delay time, transmit shift register to CANnTX pin <sup>(1)</sup> |     | 15  | ns   |
| $t_{d(CANnRX)}$ | Delay time, CANnRX pin to receive shift register                 |     | 5   | ns   |

(1) These values do not include rise/fall times of the output buffer.

## 8.9 Local Interconnect Network Interface (LIN)

The SCI/LIN module can be programmed to work either as an SCI or as a LIN. The core of the module is an SCI. The SCI's hardware features are augmented to achieve LIN compatibility.

The SCI module is a universal asynchronous receiver-transmitter that implements the standard nonreturn to zero format. The SCI can be used to communicate, for example, through an RS-232 port or over a K-line.

The LIN standard is based on the SCI (UART) serial data link format. The communication concept is single-master/multiple-slave with a message identification for multicast transmission between any network nodes.

### 8.9.1 LIN Features

The following are features of the LIN module:

- Compatible to LIN 1.3, 2.0 and 2.1 protocols
- Multibuffered receive and transmit units DMA capability for minimal CPU intervention
- Identification masks for message filtering
- Automatic Master Header Generation
  - Programmable Synch Break Field
  - Synch Field
  - Identifier Field
- Slave Automatic Synchronization
  - Synch break detection
  - Optional baudrate update
  - Synchronization Validation
- $2^{31}$  programmable transmission rates with 7 fractional bits
- Error detection
- 2 Interrupt lines with priority encoding

## 8.10 Serial Communication Interface (SCI)

### 8.10.1 Features

- Standard universal asynchronous receiver-transmitter (UART) communication
- Supports full- or half-duplex operation
- Standard nonreturn to zero (NRZ) format
- Double-buffered receive and transmit functions
- Configurable frame format of 3 to 13 bits per character based on the following:
  - Data word length programmable from one to eight bits
  - Additional address bit in address-bit mode
  - Parity programmable for zero or one parity bit, odd or even parity
  - Stop programmable for one or two stop bits
- Asynchronous or isosynchronous communication modes
- Two multiprocessor communication formats allow communication between more than two devices.
- Sleep mode is available to free CPU resources during multiprocessor communication.
- The 24-bit programmable baud rate supports  $2^{24}$  different baud rates provide high accuracy baud rate selection.
- Four error flags and Five status flags provide detailed information regarding SCI events.
- Capability to use DMA for transmit and receive data.

## 8.11 Inter-Integrated Circuit (I2C)

The inter-integrated circuit (I2C) module is a multimaster communication module providing an interface between the TMS570 microcontroller and devices compliant with Philips Semiconductor I2C-bus specification version 2.1 and connected by an I2C-bus. This module will support any slave or master I2C compatible device.

### 8.11.1 Features

The I2C has the following features:

- Compliance to the Philips I2C bus specification, v2.1 (The I2C Specification, Philips document number 9398 393 40011)
  - Bit/Byte format transfer
  - 7-bit and 10-bit device addressing modes
  - General call
  - START byte
  - Multimaster transmitter/ slave receiver mode
  - Multimaster receiver/ slave transmitter mode
  - Combined master transmit/receive and receive/transmit mode
  - Transfer rates of 10 kbps up to 400 kbps (Phillips fast-mode rate)
- Free data format
- Two DMA events (transmit and receive)
- DMA event enable/disable capability
- Seven interrupts that can be used by the CPU
- Module enable/disable capability
- The SDA and SCL are optionally configurable as general purpose I/O
- Slew rate control of the outputs
- Open drain control of the outputs
- Programmable pullup/pulldown capability on the inputs
- Supports Ignore NACK mode

---

#### 备注

This I2C module does not support:

- High-speed (HS) mode
  - C-bus compatibility mode
  - The combined format in 10-bit address mode (the I2C sends the slave address second byte every time it sends the slave address first byte)
-

## 8.11.2 I2C I/O Timing Specifications

表 8-30. I2C Signals (SDA and SCL) Switching Characteristics<sup>(1)</sup>

| PARAMETER            |                                                                      | STANDARD MODE |                     | FAST MODE |     | UNIT    |
|----------------------|----------------------------------------------------------------------|---------------|---------------------|-----------|-----|---------|
|                      |                                                                      | MIN           | MAX                 | MIN       | MAX |         |
| $t_{c(I2CCLK)}$      | Cycle time, Internal Module clock for I2C, prescaled from VCLK       | 75.2          | 149                 | 75.2      | 149 | ns      |
| $f_{(SCL)}$          | SCL Clock frequency                                                  | 0             | 100                 | 0         | 400 | kHz     |
| $t_{c(SCL)}$         | Cycle time, SCL                                                      | 10            |                     | 2.5       |     | $\mu$ s |
| $t_{su(SCLH-SDAL)}$  | Setup time, SCL high before SDA low (for a repeated START condition) | 4.7           |                     | 0.6       |     | $\mu$ s |
| $t_{h(SCLL-SDAL)}$   | Hold time, SCL low after SDA low (for a repeated START condition)    | 4             |                     | 0.6       |     | $\mu$ s |
| $t_{w(SCLL)}$        | Pulse duration, SCL low                                              | 4.7           |                     | 1.3       |     | $\mu$ s |
| $t_{w(SCLH)}$        | Pulse duration, SCL high                                             | 4             |                     | 0.6       |     | $\mu$ s |
| $t_{su(SDA-SCLH)}$   | Setup time, SDA valid before SCL high                                | 250           |                     | 100       |     | ns      |
| $t_{h(SDA-SCLL)}$    | Hold time, SDA valid after SCL low (for I2C bus devices)             | 0             | 3.45 <sup>(2)</sup> | 0         | 0.9 | $\mu$ s |
| $t_{w(SDAH)}$        | Pulse duration, SDA high between STOP and START conditions           | 4.7           |                     | 1.3       |     | $\mu$ s |
| $t_{su(SCLH-SDAH)}$  | Setup time, SCL high before SDA high (for STOP condition)            | 4.0           |                     | 0.6       |     | $\mu$ s |
| $t_{w(SP)}$          | Pulse duration, spike (must be suppressed)                           |               |                     | 0         | 50  | ns      |
| $C_b$ <sup>(3)</sup> | Capacitive load for each bus line                                    |               | 400                 |           | 400 | pF      |

- (1) The I2C pins SDA and SCL do not feature fail-safe I/O buffers. These pins could potentially draw current when the device is powered down.
- (2) The maximum  $t_{h(SDA-SCLL)}$  for I2C bus devices has only to be met if the device does not stretch the low period ( $t_{w(SCLL)}$ ) of the SCL signal.
- (3)  $C_b$  = The total capacitance of one bus line in pF.

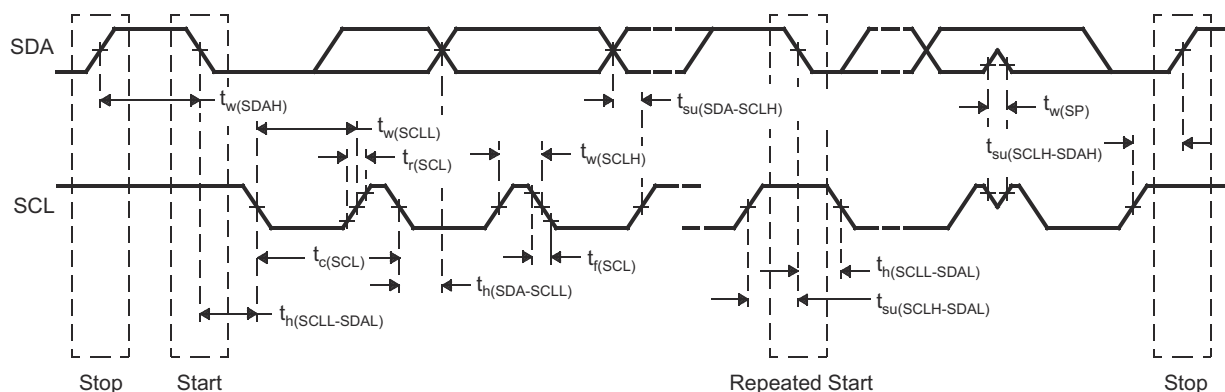


图 8-19. I2C Timings

## 备注

- A device must internally provide a hold time of at least 300 ns for the SDA signal (referred to the VIHmin of the SCL signal) to bridge the undefined region of the falling edge of SCL.
- The maximum  $t_{h(SDA-SCLL)}$  has only to be met if the device does not stretch the LOW period ( $t_{w(SCLL)}$ ) of the SCL signal.
- A Fast-mode I2C-bus device can be used in a Standard-mode I2C-bus system, but the requirement  $t_{su(SDA-SCLH)} \geq 250$  ns must then be met. This will automatically be the case if the device does not stretch the LOW period of the SCL signal. If such a device does stretch the LOW period of the SCL signal, it must output the next data bit to the SDA line  $t_{rmax} + t_{su(SDA-SCLH)}$ .
- $C_b$  = total capacitance of one bus line in pF. If mixed with fast-mode devices, faster fall-times are allowed.

## 8.12 Multibuffered / Standard Serial Peripheral Interface

The MibSPI is a high-speed synchronous serial input/output port that allows a serial bit stream of programmed length (2 to 16 bits) to be shifted in and out of the device at a programmed bit-transfer rate. Typical applications for the SPI include interfacing to external peripherals, such as I/Os, memories, display drivers, and analog-to-digital converters.

### 8.12.1 Features

Both Standard and MibSPI modules have the following features:

- 16-bit shift register
- Receive buffer register
- 11-bit baud clock generator
- SPICLK can be internally-generated (master mode) or received from an external clock source (slave mode)
- Each word transferred can have a unique format
- SPI I/Os not used in the communication can be used as digital input/output signals

**表 8-31. MibSPI Configurations**

| MibSPIx/SPIx | I/Os                                                                         |
|--------------|------------------------------------------------------------------------------|
| MibSPI1      | MIBSPI1SIMO[1:0], MIBSPI1SOMI[1:0], MIBSPI1CLK, MIBSPI1nCS[5:0], MIBSPI1nENA |
| MibSPI3      | MIBSPI3SIMO, MIBSPI3SOMI, MIBSPI3CLK, MIBSPI3nCS[5:0], MIBSPI3nENA           |
| MibSPI5      | MIBSPI5SIMO[3:0], MIBSPI5SOMI[3:0], MIBSPI5CLK, MIBSPI5nCS[5:0], MIBSPI5nENA |
| MibSPI2      | MIBSPI2SIMO, MIBSPI2SOMI, MIBSPI2CLK, MIBSPI2nCS[1:0], MIBSPI2nENA           |
| MibSPI4      | MIBSPI4SIMO, MIBSPI4SOMI, MIBSPI4CLK, MIBSPI4nCS[5:0], MIBSPI4nENA           |

### 8.12.2 MibSPI Transmit and Receive RAM Organization

The Multibuffer RAM is comprised of 256 buffers for MibSPI1 and 128 buffers for all other MibSPI. Each entry in the Multibuffer RAM consists of 4 parts: a 16-bit transmit field, a 16-bit receive field, a 16-bit control field and a 16-bit status field. The Multibuffer RAM can be partitioned into multiple transfer groups with a variable number of buffers each.

**表 8-32. Multibuffered RAM Transfer Groups**

| MibSPIx/SPIx<br>MODULES | NO OF CHIP<br>SELECTS | MIBSPIxnCS[x]   | NO. OF RAM<br>BUFFERS | NO. OF TRANSFER<br>GROUPS |
|-------------------------|-----------------------|-----------------|-----------------------|---------------------------|
| MibSPI1                 | 6                     | MIBSPI1nCS[5:0] | 256                   | 8                         |
| MibSPI2                 | 2                     | MIBSPI2nCS[1:0] | 128                   | 8                         |
| MibSPI3                 | 6                     | MIBSPI3nCS[5:0] | 128                   | 8                         |
| MibSPI4                 | 6                     | MIBSPI4nCS[5:0] | 128                   | 8                         |
| MibSPI5                 | 6                     | MIBSPI5nCS[5:0] | 128                   | 8                         |

### 8.12.3 MibSPI Transmit Trigger Events

Each of the transfer groups can be configured individually. For each of the transfer groups a trigger event and a trigger source can be chosen. A trigger event can be for example a rising edge or a permanent low level at a selectable trigger source. For example, up to 15 trigger sources are available which can be used by each transfer group.

### 8.12.3.1 MIBSPI1 Event Trigger Hookup

表 8-33. MIBSPI1 Event Trigger Hookup

| Event #  | TGxCTRL TRIGSRC[3:0] | Trigger             |
|----------|----------------------|---------------------|
| Disabled | 0000                 | No trigger source   |
| EVENT0   | 0001                 | GIOA[0]             |
| EVENT1   | 0010                 | GIOA[1]             |
| EVENT2   | 0011                 | GIOA[2]             |
| EVENT3   | 0100                 | GIOA[3]             |
| EVENT4   | 0101                 | GIOA[4]             |
| EVENT5   | 0110                 | GIOA[5]             |
| EVENT6   | 0111                 | GIOA[6]             |
| EVENT7   | 1000                 | GIOA[7]             |
| EVENT8   | 1001                 | N2HET1[8]           |
| EVENT9   | 1010                 | N2HET1[10]          |
| EVENT10  | 1011                 | N2HET1[12]          |
| EVENT11  | 1100                 | N2HET1[14]          |
| EVENT12  | 1101                 | N2HET1[16]          |
| EVENT13  | 1110                 | N2HET1[18]          |
| EVENT14  | 1111                 | Intern Tick counter |

#### 备注

For N2HET1 trigger sources, the connection to the MibSPI1 module trigger input is made from the input side of the output buffer (at the N2HET1 module boundary). This way, a trigger condition can be generated even if the N2HET1 signal is not selected to be output on the pad.

#### 备注

For GIOx trigger sources, the connection to the MibSPI1 module trigger input is made from the output side of the input buffer. This way, a trigger condition can be generated either by selecting the GIOx pin as an output pin plus selecting the pin to be a GIOx pin, or by driving the GIOx pin from an external trigger source. If the mux control module is used to select different functionality instead of the GIOx signal, then care must be taken to disable GIOx from triggering MibSPI1 transfers; there is no multiplexing on the input connections.

### 8.12.3.2 MIBSPI2 Event Trigger Hookup

表 8-34. MIBSPI2 Event Trigger Hookup

| Event #  | TGxCTRL TRIGSRC[3:0] | Trigger             |
|----------|----------------------|---------------------|
| Disabled | 0000                 | No trigger source   |
| EVENT0   | 0001                 | GIOA[0]             |
| EVENT1   | 0010                 | GIOA[1]             |
| EVENT2   | 0011                 | GIOA[2]             |
| EVENT3   | 0100                 | GIOA[3]             |
| EVENT4   | 0101                 | GIOA[4]             |
| EVENT5   | 0110                 | GIOA[5]             |
| EVENT6   | 0111                 | GIOA[6]             |
| EVENT7   | 1000                 | GIOA[7]             |
| EVENT8   | 1001                 | N2HET1[8]           |
| EVENT9   | 1010                 | N2HET1[10]          |
| EVENT10  | 1011                 | N2HET1[12]          |
| EVENT11  | 1100                 | N2HET1[14]          |
| EVENT12  | 1101                 | N2HET1[16]          |
| EVENT13  | 1110                 | N2HET1[18]          |
| EVENT14  | 1111                 | Intern Tick counter |

#### 备注

For N2HET1 trigger sources, the connection to the MibSPI1 module trigger input is made from the input side of the output buffer (at the N2HET1 module boundary). This way, a trigger condition can be generated even if the N2HET1 signal is not selected to be output on the pad.

#### 备注

For GIOx trigger sources, the connection to the MibSPI1 module trigger input is made from the output side of the input buffer. This way, a trigger condition can be generated either by selecting the GIOx pin as an output pin plus selecting the pin to be a GIOx pin, or by driving the GIOx pin from an external trigger source. If the mux control module is used to select different functionality instead of the GIOx signal, then care must be taken to disable GIOx from triggering MibSPI1 transfers; there is no multiplexing on the input connections.

### 8.12.3.3 MIBSPI3 Event Trigger Hookup

表 8-35. MIBSPI3 Event Trigger Hookup

| Event #  | TGxCTRL TRIGSRC[3:0] | Trigger           |
|----------|----------------------|-------------------|
| Disabled | 0000                 | No trigger source |
| EVENT0   | 0001                 | GIOA[0]           |
| EVENT1   | 0010                 | GIOA[1]           |
| EVENT2   | 0011                 | GIOA[2]           |
| EVENT3   | 0100                 | GIOA[3]           |
| EVENT4   | 0101                 | GIOA[4]           |
| EVENT5   | 0110                 | GIOA[5]           |
| EVENT6   | 0111                 | GIOA[6]           |
| EVENT7   | 1000                 | GIOA[7]           |
| EVENT8   | 1001                 | H2ET1[8]          |

表 8-35. MIBSPI3 Event Trigger Hookup ( 续 )

| Event # | TGxCTRL TRIGSRC[3:0] | Trigger             |
|---------|----------------------|---------------------|
| EVENT9  | 1010                 | N2HET1[10]          |
| EVENT10 | 1011                 | N2HET1[12]          |
| EVENT11 | 1100                 | N2HET1[14]          |
| EVENT12 | 1101                 | N2HET1[16]          |
| EVENT13 | 1110                 | N2HET1[18]          |
| EVENT14 | 1111                 | Intern Tick counter |

## 备注

For N2HET1 trigger sources, the connection to the MibSPI3 module trigger input is made from the input side of the output buffer (at the N2HET1 module boundary). This way, a trigger condition can be generated even if the N2HET1 signal is not selected to be output on the pad.

## 备注

For GIOx trigger sources, the connection to the MibSPI3 module trigger input is made from the output side of the input buffer. This way, a trigger condition can be generated either by selecting the GIOx pin as an output pin plus selecting the pin to be a GIOx pin, or by driving the GIOx pin from an external trigger source. If the mux control module is used to select different functionality instead of the GIOx signal, then care must be taken to disable GIOx from triggering MibSPI3 transfers; there is no multiplexing on the input connections.

### 8.12.3.4 MIBSPI4 Event Trigger Hookup

表 8-36. MIBSPI4 Event Trigger Hookup

| Event #  | TGxCTRL TRIGSRC[3:0] | Trigger             |
|----------|----------------------|---------------------|
| Disabled | 0000                 | No trigger source   |
| EVENT0   | 0001                 | GIOA[0]             |
| EVENT1   | 0010                 | GIOA[1]             |
| EVENT2   | 0011                 | GIOA[2]             |
| EVENT3   | 0100                 | GIOA[3]             |
| EVENT4   | 0101                 | GIOA[4]             |
| EVENT5   | 0110                 | GIOA[5]             |
| EVENT6   | 0111                 | GIOA[6]             |
| EVENT7   | 1000                 | GIOA[7]             |
| EVENT8   | 1001                 | N2HET1[8]           |
| EVENT9   | 1010                 | N2HET1[10]          |
| EVENT10  | 1011                 | N2HET1[12]          |
| EVENT11  | 1100                 | N2HET1[14]          |
| EVENT12  | 1101                 | N2HET1[16]          |
| EVENT13  | 1110                 | N2HET1[18]          |
| EVENT14  | 1111                 | Intern Tick counter |

#### 备注

For N2HET1 trigger sources, the connection to the MibSPI1 module trigger input is made from the input side of the output buffer (at the N2HET1 module boundary). This way, a trigger condition can be generated even if the N2HET1 signal is not selected to be output on the pad.

#### 备注

For GIOx trigger sources, the connection to the MibSPI1 module trigger input is made from the output side of the input buffer. This way, a trigger condition can be generated either by selecting the GIOx pin as an output pin plus selecting the pin to be a GIOx pin, or by driving the GIOx pin from an external trigger source. If the mux control module is used to select different functionality instead of the GIOx signal, then care must be taken to disable GIOx from triggering MibSPI1 transfers; there is no multiplexing on the input connections.

### 8.12.3.5 MIBSPI5 Event Trigger Hookup

表 8-37. MIBSPI5 Event Trigger Hookup

| Event #  | TGxCTRL TRIGSRC[3:0] | Trigger           |
|----------|----------------------|-------------------|
| Disabled | 0000                 | No trigger source |
| EVENT0   | 0001                 | GIOA[0]           |
| EVENT1   | 0010                 | GIOA[1]           |
| EVENT2   | 0011                 | GIOA[2]           |
| EVENT3   | 0100                 | GIOA[3]           |
| EVENT4   | 0101                 | GIOA[4]           |
| EVENT5   | 0110                 | GIOA[5]           |
| EVENT6   | 0111                 | GIOA[6]           |
| EVENT7   | 1000                 | GIOA[7]           |
| EVENT8   | 1001                 | N2HET1[8]         |

表 8-37. MIBSPI5 Event Trigger Hookup ( 续 )

|         |      |                     |
|---------|------|---------------------|
| EVENT9  | 1010 | N2HET1[10]          |
| EVENT10 | 1011 | N2HET1[12]          |
| EVENT11 | 1100 | N2HET1[14]          |
| EVENT12 | 1101 | N2HET1[16]          |
| EVENT13 | 1110 | N2HET1[18]          |
| EVENT14 | 1111 | Intern Tick counter |

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**备注**

For N2HET1 trigger sources, the connection to the MibSPI5 module trigger input is made from the input side of the output buffer (at the N2HET1 module boundary). This way, a trigger condition can be generated even if the N2HET1 signal is not selected to be output on the pad.

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**备注**

For GIOx trigger sources, the connection to the MibSPI5 module trigger input is made from the output side of the input buffer. This way, a trigger condition can be generated either by selecting the GIOx pin as an output pin + selecting the pin to be a GIOx pin, or by driving the GIOx pin from an external trigger source. If the mux control module is used to select different functionality instead of the GIOx signal, then care must be taken to disable GIOx from triggering MibSPI5 transfers; there is no multiplexing on the input connections.

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## 8.12.4 MibSPI/SPI Master Mode I/O Timing Specifications

**表 8-38. SPI Master Mode External Timing Parameters (CLOCK PHASE = 0, SPICLK = output, SPISIMO = output, and SPISOMI = input)<sup>(1) (2) (3)</sup>**

| NO.              | Parameter                                |                                                                       |            | MIN                                                                                                                                                | MAX                                                                                                                                                 | Unit |
|------------------|------------------------------------------|-----------------------------------------------------------------------|------------|----------------------------------------------------------------------------------------------------------------------------------------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------|------|
| 1                | t <sub>c</sub> (SPC) <sub>M</sub>        | Cycle time, SPICLK <sup>(4)</sup>                                     |            | 40                                                                                                                                                 | 256t <sub>c</sub> (VCLK)                                                                                                                            | ns   |
| 2 <sup>(5)</sup> | t <sub>w</sub> (SPCH) <sub>M</sub>       | Pulse duration, SPICLK high (clock polarity = 0)                      |            | 0.5t <sub>c</sub> (SPC) <sub>M</sub> - t <sub>r</sub> (SPC) <sub>M</sub> - 3                                                                       | 0.5t <sub>c</sub> (SPC) <sub>M</sub> + 3                                                                                                            | ns   |
|                  | t <sub>w</sub> (SPCL) <sub>M</sub>       | Pulse duration, SPICLK low (clock polarity = 1)                       |            | 0.5t <sub>c</sub> (SPC) <sub>M</sub> - t <sub>r</sub> (SPC) <sub>M</sub> - 3                                                                       | 0.5t <sub>c</sub> (SPC) <sub>M</sub> + 3                                                                                                            |      |
| 3 <sup>(5)</sup> | t <sub>w</sub> (SPCL) <sub>M</sub>       | Pulse duration, SPICLK low (clock polarity = 0)                       |            | 0.5t <sub>c</sub> (SPC) <sub>M</sub> - t <sub>r</sub> (SPC) <sub>M</sub> - 3                                                                       | 0.5t <sub>c</sub> (SPC) <sub>M</sub> + 3                                                                                                            | ns   |
|                  | t <sub>w</sub> (SPCH) <sub>M</sub>       | Pulse duration, SPICLK high (clock polarity = 1)                      |            | 0.5t <sub>c</sub> (SPC) <sub>M</sub> - t <sub>r</sub> (SPC) <sub>M</sub> - 3                                                                       | 0.5t <sub>c</sub> (SPC) <sub>M</sub> + 3                                                                                                            |      |
| 4 <sup>(5)</sup> | t <sub>d</sub> (SPCH-SIMO) <sub>M</sub>  | Delay time, SPISIMO valid before SPICLK low (clock polarity = 0)      |            | 0.5t <sub>c</sub> (SPC) <sub>M</sub> - 6                                                                                                           |                                                                                                                                                     | ns   |
|                  | t <sub>d</sub> (SPCL-SIMO) <sub>M</sub>  | Delay time, SPISIMO valid before SPICLK high (clock polarity = 1)     |            | 0.5t <sub>c</sub> (SPC) <sub>M</sub> - 6                                                                                                           |                                                                                                                                                     |      |
| 5 <sup>(5)</sup> | t <sub>v</sub> (SPCL-SIMO) <sub>M</sub>  | Valid time, SPISIMO data valid after SPICLK low (clock polarity = 0)  |            | 0.5t <sub>c</sub> (SPC) <sub>M</sub> - t <sub>f</sub> (SPC) - 4                                                                                    |                                                                                                                                                     | ns   |
|                  | t <sub>v</sub> (SPCH-SIMO) <sub>M</sub>  | Valid time, SPISIMO data valid after SPICLK high (clock polarity = 1) |            | 0.5t <sub>c</sub> (SPC) <sub>M</sub> - t <sub>r</sub> (SPC) - 4                                                                                    |                                                                                                                                                     |      |
| 6 <sup>(5)</sup> | t <sub>su</sub> (SOMI-SPCL) <sub>M</sub> | Setup time, SPISOMI before SPICLK low (clock polarity = 0)            |            | t <sub>r</sub> (SPC) + 2.2                                                                                                                         |                                                                                                                                                     | ns   |
|                  | t <sub>su</sub> (SOMI-SPCH) <sub>M</sub> | Setup time, SPISOMI before SPICLK high (clock polarity = 1)           |            | t <sub>r</sub> (SPC) + 2.2                                                                                                                         |                                                                                                                                                     |      |
| 7 <sup>(5)</sup> | t <sub>h</sub> (SPCL-SOMI) <sub>M</sub>  | Hold time, SPISOMI data valid after SPICLK low (clock polarity = 0)   |            | 10                                                                                                                                                 |                                                                                                                                                     | ns   |
|                  | t <sub>h</sub> (SPCH-SOMI) <sub>M</sub>  | Hold time, SPISOMI data valid after SPICLK high (clock polarity = 1)  |            | 10                                                                                                                                                 |                                                                                                                                                     |      |
| 8 <sup>(6)</sup> | t <sub>C2TDELAY</sub>                    | Setup time CS active until SPICLK high (clock polarity = 0)           | CSHOLD = 0 | C2TDELAY*t <sub>c</sub> (VCLK) + 2*t <sub>c</sub> (VCLK) - t <sub>f</sub> (SPICS) + t <sub>r</sub> (SPC) - 7                                       | (C2TDELAY+2) * t <sub>c</sub> (VCLK) - t <sub>f</sub> (SPICS) + t <sub>r</sub> (SPC) + 5.5                                                          | ns   |
|                  |                                          |                                                                       | CSHOLD = 1 | C2TDELAY*t <sub>c</sub> (VCLK) + 3*t <sub>c</sub> (VCLK) - t <sub>f</sub> (SPICS) + t <sub>r</sub> (SPC) - 7                                       | (C2TDELAY+3) * t <sub>c</sub> (VCLK) - t <sub>f</sub> (SPICS) + t <sub>r</sub> (SPC) + 5.5                                                          |      |
|                  | t <sub>C2TDELAY</sub>                    | Setup time CS active until SPICLK low (clock polarity = 1)            | CSHOLD = 0 | C2TDELAY*t <sub>c</sub> (VCLK) + 2*t <sub>c</sub> (VCLK) - t <sub>f</sub> (SPICS) + t <sub>f</sub> (SPC) - 7                                       | (C2TDELAY+2) * t <sub>c</sub> (VCLK) - t <sub>f</sub> (SPICS) + t <sub>f</sub> (SPC) + 5.5                                                          | ns   |
|                  |                                          |                                                                       | CSHOLD = 1 | C2TDELAY*t <sub>c</sub> (VCLK) + 3*t <sub>c</sub> (VCLK) - t <sub>f</sub> (SPICS) + t <sub>f</sub> (SPC) - 7                                       | (C2TDELAY+3) * t <sub>c</sub> (VCLK) - t <sub>f</sub> (SPICS) + t <sub>f</sub> (SPC) + 5.5                                                          |      |
| 9 <sup>(6)</sup> | t <sub>T2CDELAY</sub>                    | Hold time SPICLK low until CS inactive (clock polarity = 0)           |            | 0.5*t <sub>c</sub> (SPC) <sub>M</sub> + T2CDELAY*t <sub>c</sub> (VCLK) + t <sub>c</sub> (VCLK) - t <sub>r</sub> (SPC) + t <sub>r</sub> (SPICS) - 7 | 0.5*t <sub>c</sub> (SPC) <sub>M</sub> + T2CDELAY*t <sub>c</sub> (VCLK) + t <sub>c</sub> (VCLK) - t <sub>r</sub> (SPC) + t <sub>r</sub> (SPICS) + 11 | ns   |
|                  |                                          | Hold time SPICLK high until CS inactive (clock polarity = 1)          |            | 0.5*t <sub>c</sub> (SPC) <sub>M</sub> + T2CDELAY*t <sub>c</sub> (VCLK) + t <sub>c</sub> (VCLK) - t <sub>r</sub> (SPC) + t <sub>r</sub> (SPICS) - 7 | 0.5*t <sub>c</sub> (SPC) <sub>M</sub> + T2CDELAY*t <sub>c</sub> (VCLK) + t <sub>c</sub> (VCLK) - t <sub>r</sub> (SPC) + t <sub>r</sub> (SPICS) + 11 | ns   |
| 10               | t <sub>SPIENA</sub>                      | SPIENAn Sample point                                                  |            | (C2TDELAY+1) * t <sub>c</sub> (VCLK) - t <sub>f</sub> (SPICS) - 29                                                                                 | (C2TDELAY+1)*t <sub>c</sub> (VCLK)                                                                                                                  | ns   |
| 11               | t <sub>SPIENAW</sub>                     | SPIENAn Sample point from write to buffer                             |            |                                                                                                                                                    | (C2TDELAY+2)*t <sub>c</sub> (VCLK)                                                                                                                  | ns   |

(1) The MASTER bit (SPIGCR1.0) is set and the CLOCK PHASE bit (SPIFMTx.16) is cleared.

(2)  $t_{c(VCLK)}$  = interface clock cycle time =  $1 / f_{(VCLK)}$

(3) For rise and fall timings, see 表 6-6, *Switching Characteristics for Output Timings versus Load Capacitance (LC)*.

(4) When the SPI is in Master mode, the following must be true:

For PS values from 1 to 255:  $t_{c(SPC)M} \geq (PS + 1)t_{c(VCLK)} \geq 40ns$ , where PS is the prescale value set in the SPIFMTx.[15:8] register bits.

For PS values of 0:  $t_{c(SPC)M} = 2t_{c(VCLK)} \geq 40ns$ .

The external load on the SPICLK pin must be less than 60pF.

- (5) The active edge of the SPICLK signal referenced is controlled by the CLOCK POLARITY bit (SPIFMTx.17).  
 (6) C2DELAY and T2CDELAY is programmed in the SPIDELAY register

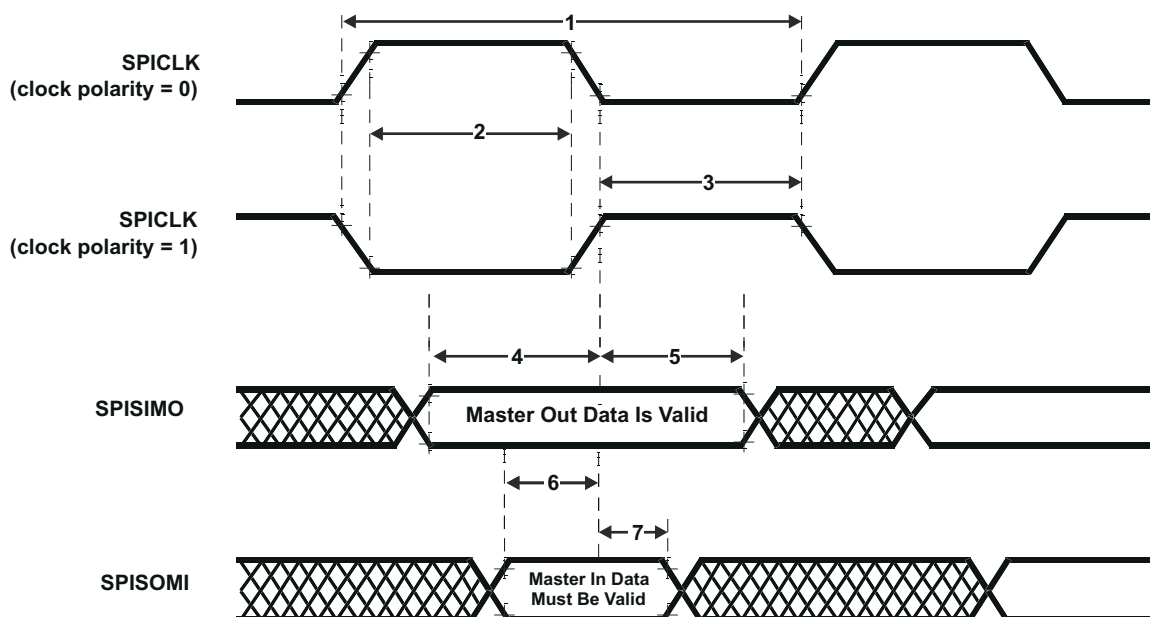


图 8-20. SPI Master Mode External Timing (CLOCK PHASE = 0)

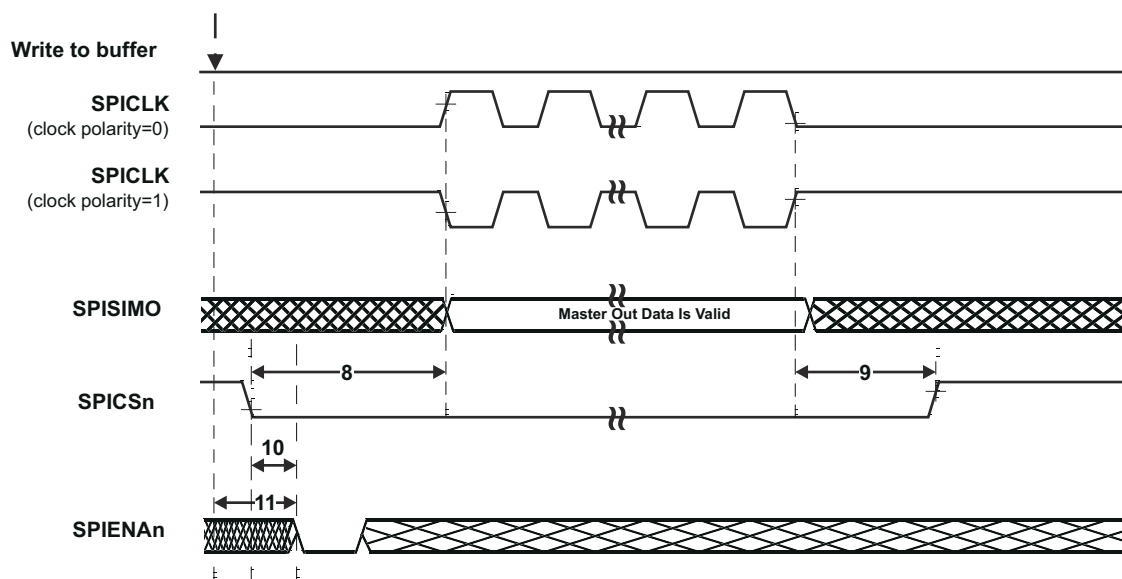


图 8-21. SPI Master Mode Chip Select Timing (CLOCK PHASE = 0)

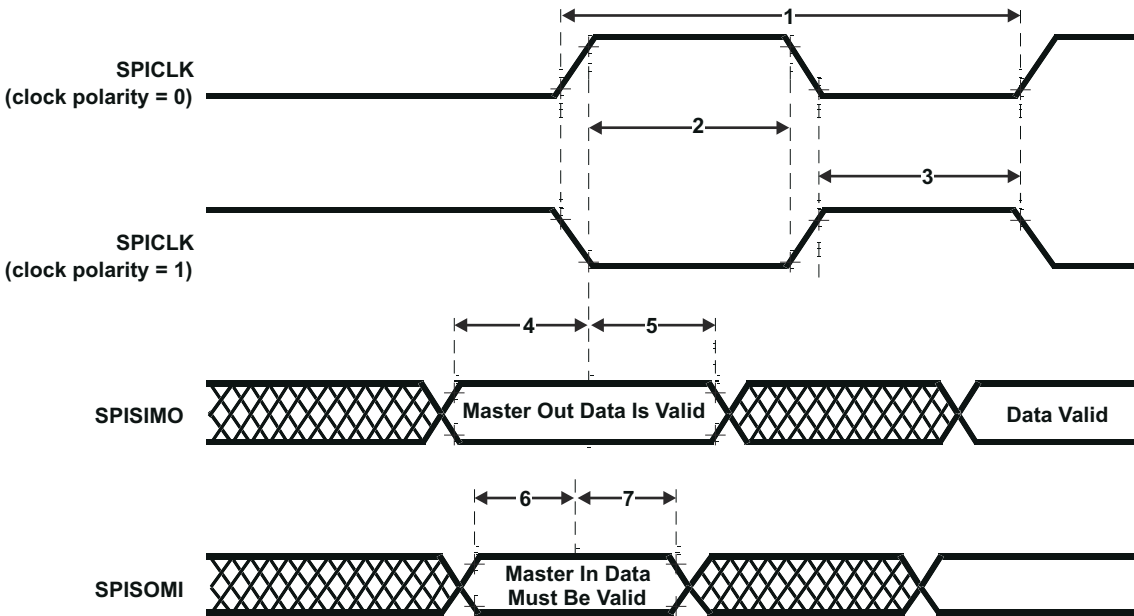
**表 8-39. SPI Master Mode External Timing Parameters (CLOCK PHASE = 1, SPICLK = output, SPISIMO = output, and SPISOMI = input)<sup>(1) (2) (3)</sup>**

| NO.              | Parameter            |                                                                       | MIN                                                                    | MAX                                                                                | Unit |
|------------------|----------------------|-----------------------------------------------------------------------|------------------------------------------------------------------------|------------------------------------------------------------------------------------|------|
| 1                | $t_{c(SPC)M}$        | Cycle time, SPICLK <sup>(4)</sup>                                     | 40                                                                     | $256t_{c(VCLK)}$                                                                   | ns   |
| 2 <sup>(5)</sup> | $t_{w(SPCH)M}$       | Pulse duration, SPICLK high (clock polarity = 0)                      | $0.5t_{c(SPC)M} - t_{f(SPC)M} - 3$                                     | $0.5t_{c(SPC)M} + 3$                                                               | ns   |
|                  | $t_{w(SPCL)M}$       | Pulse duration, SPICLK low (clock polarity = 1)                       | $0.5t_{c(SPC)M} - t_{f(SPC)M} - 3$                                     | $0.5t_{c(SPC)M} + 3$                                                               |      |
| 3 <sup>(5)</sup> | $t_{w(SPCL)M}$       | Pulse duration, SPICLK low (clock polarity = 0)                       | $0.5t_{c(SPC)M} - t_{f(SPC)M} - 3$                                     | $0.5t_{c(SPC)M} + 3$                                                               | ns   |
|                  | $t_{w(SPCH)M}$       | Pulse duration, SPICLK high (clock polarity = 1)                      | $0.5t_{c(SPC)M} - t_{f(SPC)M} - 3$                                     | $0.5t_{c(SPC)M} + 3$                                                               |      |
| 4 <sup>(5)</sup> | $t_{v(SIMO-SPCH)M}$  | Valid time, SPICLK high after SPISIMO data valid (clock polarity = 0) | $0.5t_{c(SPC)M} - 6$                                                   |                                                                                    | ns   |
|                  | $t_{v(SIMO-SPCL)M}$  | Valid time, SPICLK low after SPISIMO data valid (clock polarity = 1)  | $0.5t_{c(SPC)M} - 6$                                                   |                                                                                    |      |
| 5 <sup>(5)</sup> | $t_{v(SPCH-SIMO)M}$  | Valid time, SPISIMO data valid after SPICLK high (clock polarity = 0) | $0.5t_{c(SPC)M} - t_{f(SPC)} - 4$                                      |                                                                                    | ns   |
|                  | $t_{v(SPCL-SIMO)M}$  | Valid time, SPISIMO data valid after SPICLK low (clock polarity = 1)  | $0.5t_{c(SPC)M} - t_{f(SPC)} - 4$                                      |                                                                                    |      |
| 6 <sup>(5)</sup> | $t_{su(SOMI-SPCH)M}$ | Setup time, SPISOMI before SPICLK high (clock polarity = 0)           | $t_{f(SPC)} + 2.2$                                                     |                                                                                    | ns   |
|                  | $t_{su(SOMI-SPCL)M}$ | Setup time, SPISOMI before SPICLK low (clock polarity = 1)            | $t_{f(SPC)} + 2.2$                                                     |                                                                                    |      |
| 7 <sup>(5)</sup> | $t_{v(SPCH-SOMI)M}$  | Valid time, SPISOMI data valid after SPICLK high (clock polarity = 0) | 10                                                                     |                                                                                    | ns   |
|                  | $t_{v(SPCL-SOMI)M}$  | Valid time, SPISOMI data valid after SPICLK low (clock polarity = 1)  | 10                                                                     |                                                                                    |      |
| 8 <sup>(6)</sup> | $t_{C2TDELAY}$       | Setup time CS active until SPICLK high (clock polarity = 0)           | CSHOLD = 0                                                             | $0.5 * t_{c(SPC)M} + (C2TDELAY + 2) * t_{c(VCLK)} - t_{f(SPICS)} + t_{f(SPC)} - 7$ | ns   |
|                  |                      |                                                                       | CSHOLD = 1                                                             | $0.5 * t_{c(SPC)M} + (C2TDELAY + 3) * t_{c(VCLK)} - t_{f(SPICS)} + t_{f(SPC)} - 7$ |      |
|                  |                      | Setup time CS active until SPICLK low (clock polarity = 1)            | CSHOLD = 0                                                             | $0.5 * t_{c(SPC)M} + (C2TDELAY + 2) * t_{c(VCLK)} - t_{f(SPICS)} + t_{f(SPC)} - 7$ | ns   |
|                  |                      |                                                                       | CSHOLD = 1                                                             | $0.5 * t_{c(SPC)M} + (C2TDELAY + 3) * t_{c(VCLK)} - t_{f(SPICS)} + t_{f(SPC)} - 7$ |      |
| 9 <sup>(6)</sup> | $t_{T2CDELAY}$       | Hold time SPICLK low until CS inactive (clock polarity = 0)           | $T2CDELAY * t_{c(VCLK)} + t_{c(VCLK)} - t_{f(SPC)} + t_{f(SPICS)} - 7$ | $T2CDELAY * t_{c(VCLK)} + t_{c(VCLK)} - t_{f(SPC)} + t_{f(SPICS)} + 11$            | ns   |
|                  |                      | Hold time SPICLK high until CS inactive (clock polarity = 1)          | $T2CDELAY * t_{c(VCLK)} + t_{c(VCLK)} - t_{f(SPC)} + t_{f(SPICS)} - 7$ | $T2CDELAY * t_{c(VCLK)} + t_{c(VCLK)} - t_{f(SPC)} + t_{f(SPICS)} + 11$            | ns   |
| 10               | $t_{SPIENA}$         | SPIENAn Sample Point                                                  | $(C2TDELAY + 1) * t_{c(VCLK)} - t_{f(SPICS)} - 29$                     | $(C2TDELAY + 1) * t_{c(VCLK)}$                                                     | ns   |

**表 8-39. SPI Master Mode External Timing Parameters (CLOCK PHASE = 1, SPICLK = output, SPISIMO = output, and SPISOMI = input)<sup>(1) (2) (3)</sup> (续)**

| NO. | Parameter            | MIN                                       | MAX                                              | Unit |
|-----|----------------------|-------------------------------------------|--------------------------------------------------|------|
| 11  | $t_{\text{SPHENAW}}$ | SPIENAn Sample point from write to buffer | $(\text{C2TDELAY} + 2) \cdot t_{\text{c(VCLK)}}$ | ns   |

- (1) The MASTER bit (SPIGCR1.0) is set and the CLOCK PHASE bit (SPIFMTx.16) is set.  
 (2)  $t_{\text{c(VCLK)}}$  = interface clock cycle time =  $1 / f_{\text{(VCLK)}}$   
 (3) For rise and fall timings, see the 表 6-6, *Switching Characteristics for Output Timings versus Load Capacitance (LC)*.  
 (4) When the SPI is in Master mode, the following must be true:  
 For PS values from 1 to 255:  $t_{\text{c(SPC)M}} \geq (\text{PS} + 1) t_{\text{c(VCLK)}} \geq 40\text{ns}$ , where PS is the prescale value set in the SPIFMTx.[15:8] register bits.  
 For PS values of 0:  $t_{\text{c(SPC)M}} = 2 t_{\text{c(VCLK)}} \geq 40\text{ns}$ .  
 The external load on the SPICLK pin must be less than 60pF.  
 (5) The active edge of the SPICLK signal referenced is controlled by the CLOCK POLARITY bit (SPIFMTx.17).  
 (6) C2TDELAY and T2CDELAY is programmed in the SPIDELAY register



**图 8-22. SPI Master Mode External Timing (CLOCK PHASE = 1)**

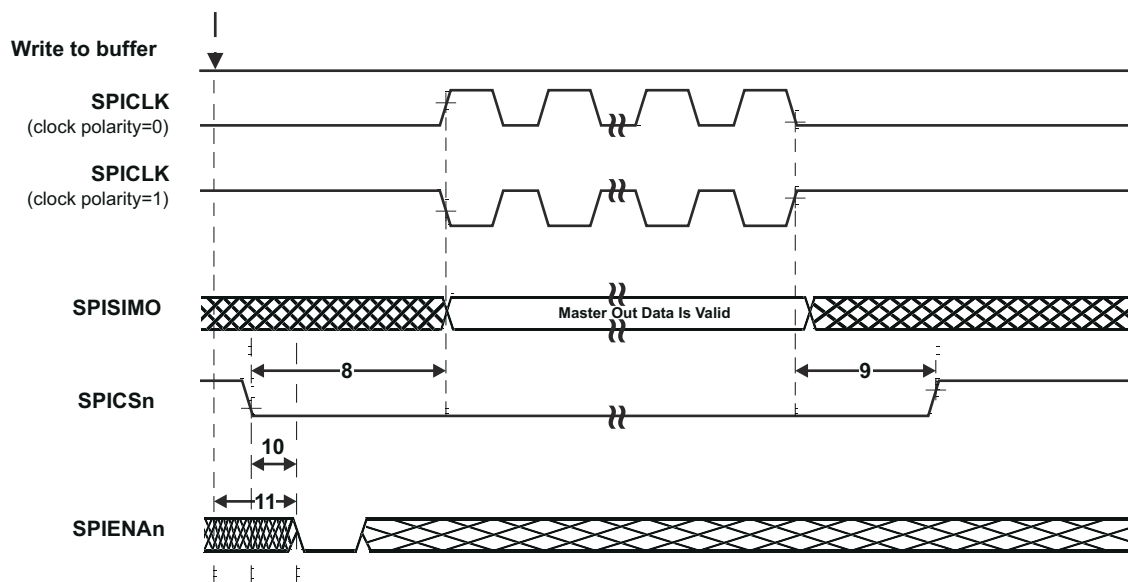


图 8-23. SPI Master Mode Chip Select Timing (CLOCK PHASE = 1)

### 8.12.5 SPI Slave Mode I/O Timings

**表 8-40. SPI Slave Mode External Timing Parameters (CLOCK PHASE = 0, SPICLK = input, SPISIMO = input, and SPISOMI = output)<sup>(1) (2) (3) (4)</sup>**

| NO.              | Parameter            |                                                                                           | MIN              | MAX                                 | Unit |
|------------------|----------------------|-------------------------------------------------------------------------------------------|------------------|-------------------------------------|------|
| 1                | $t_{c(SPC)}S$        | Cycle time, SPICLK <sup>(5)</sup>                                                         | 40               |                                     | ns   |
| 2 <sup>(6)</sup> | $t_{w(SPCH)}S$       | Pulse duration, SPICLK high (clock polarity = 0)                                          | 14               |                                     | ns   |
|                  | $t_{w(SPCL)}S$       | Pulse duration, SPICLK low (clock polarity = 1)                                           | 14               |                                     |      |
| 3 <sup>(6)</sup> | $t_{w(SPCL)}S$       | Pulse duration, SPICLK low (clock polarity = 0)                                           | 14               |                                     | ns   |
|                  | $t_{w(SPCH)}S$       | Pulse duration, SPICLK high (clock polarity = 1)                                          | 14               |                                     |      |
| 4 <sup>(6)</sup> | $t_{d(SPCH-SOMI)}S$  | Delay time, SPISOMI valid after SPICLK high (clock polarity = 0)                          |                  | $t_{r(SOMI)} + 20$                  | ns   |
|                  | $t_{d(SPCL-SOMI)}S$  | Delay time, SPISOMI valid after SPICLK low (clock polarity = 1)                           |                  | $t_{r(SOMI)} + 20$                  |      |
| 5 <sup>(6)</sup> | $t_{h(SPCH-SOMI)}S$  | Hold time, SPISOMI data valid after SPICLK high (clock polarity = 0)                      | 2                |                                     | ns   |
|                  | $t_{h(SPCL-SOMI)}S$  | Hold time, SPISOMI data valid after SPICLK low (clock polarity = 1)                       | 2                |                                     |      |
| 6 <sup>(6)</sup> | $t_{su(SIMO-SPCL)}S$ | Setup time, SPISIMO before SPICLK low (clock polarity = 0)                                | 4                |                                     | ns   |
|                  | $t_{su(SIMO-SPCH)}S$ | Setup time, SPISIMO before SPICLK high (clock polarity = 1)                               | 4                |                                     |      |
| 7 <sup>(6)</sup> | $t_{h(SPCL-SIMO)}S$  | Hold time, SPISIMO data valid after SPICLK low (clock polarity = 0)                       | 2                |                                     | ns   |
|                  | $t_{h(SPCH-SIMO)}S$  | Hold time, SPISIMO data valid after SPICLK high (clock polarity = 1)                      | 2                |                                     |      |
| 8                | $t_{d(SPCL-SENAn)}S$ | Delay time, SPIENAn high after last SPICLK low (clock polarity = 0)                       | $1.5t_{c(VCLK)}$ | $2.5t_{c(VCLK)} + t_{r(ENAn)} + 22$ | ns   |
|                  | $t_{d(SPCH-SENAn)}S$ | Delay time, SPIENAn high after last SPICLK high (clock polarity = 1)                      | $1.5t_{c(VCLK)}$ | $2.5t_{c(VCLK)} + t_{r(ENAn)} + 22$ |      |
| 9                | $t_{d(SCSL-SENAL)}S$ | Delay time, SPIENAn low after SPICSn low (if new data has been written to the SPI buffer) | $t_{r(ENAn)}$    | $t_{c(VCLK)} + t_{r(ENAn)} + 27$    | ns   |

(1) The MASTER bit (SPIGCR1.0) is cleared and the CLOCK PHASE bit (SPIFMTx.16) is cleared.

(2) If the SPI is in slave mode, the following must be true:  $t_{c(SPC)}S \geq (PS + 1)t_{c(VCLK)}$ , where PS = prescale value set in SPIFMTx.[15:8].

(3) For rise and fall timings, see 表 6-6, *Switching Characteristics for Output Timings versus Load Capacitance (LC)*.

(4)  $t_{c(VCLK)}$  = interface clock cycle time =  $1/f_{i(VCLK)}$

(5) When the SPI is in Slave mode, the following must be true:

For PS values from 1 to 255:  $t_{c(SPC)}S \geq (PS + 1)t_{c(VCLK)} \geq 40ns$ , where PS is the prescale value set in the SPIFMTx.[15:8] register bits.

For PS values of 0:  $t_{c(SPC)}S = 2t_{c(VCLK)} \geq 40ns$ .

(6) The active edge of the SPICLK signal referenced is controlled by the CLOCK POLARITY bit (SPIFMTx.17).

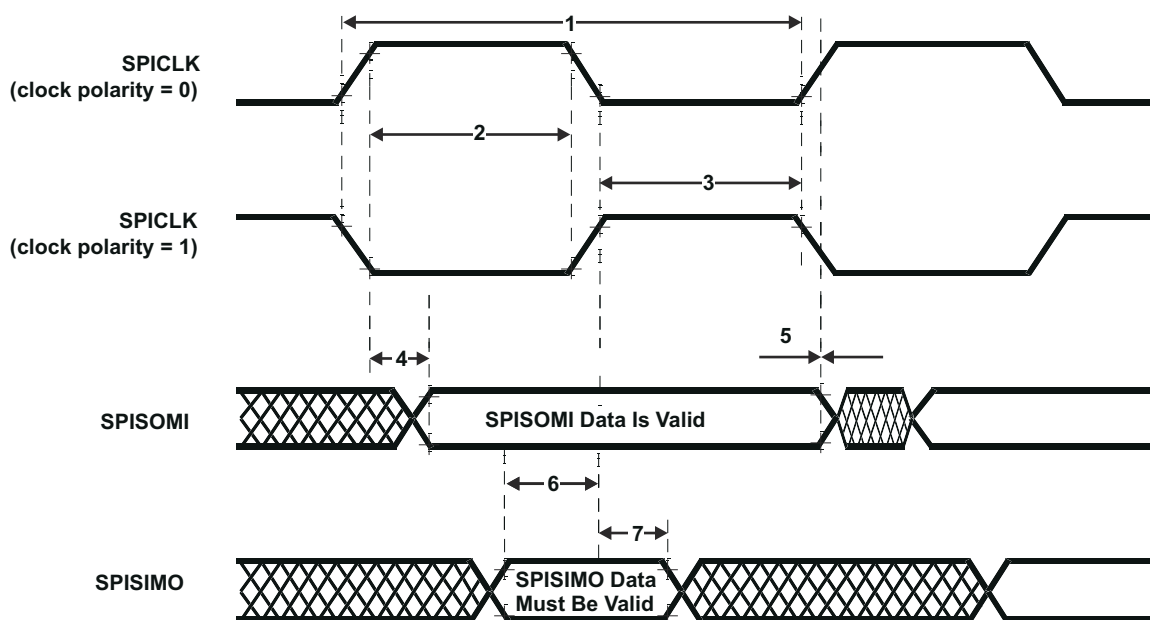


图 8-24. SPI Slave Mode External Timing (CLOCK PHASE = 0)

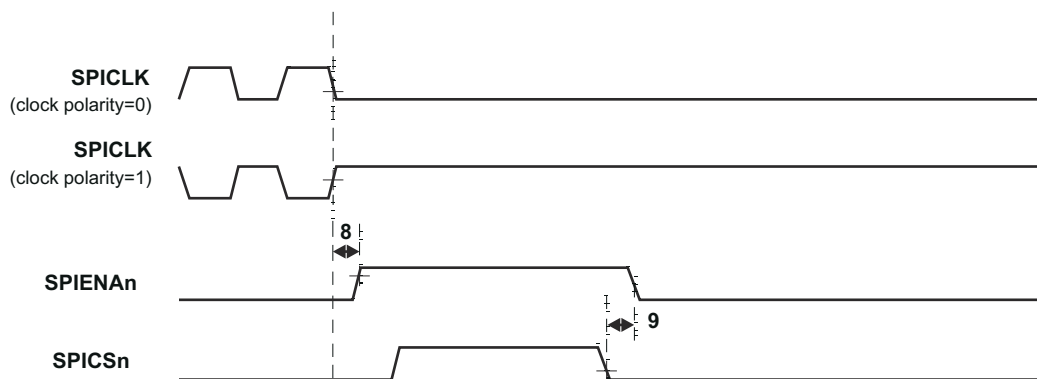


图 8-25. SPI Slave Mode Enable Timing (CLOCK PHASE = 0)

**表 8-41. SPI Slave Mode External Timing Parameters (CLOCK PHASE = 1, SPICLK = input, SPISIMO = input, and SPISOMI = output)<sup>(1) (2) (3) (4)</sup>**

| NO.              | Parameter                                                                                                    | MIN              | MAX                                 | Unit |
|------------------|--------------------------------------------------------------------------------------------------------------|------------------|-------------------------------------|------|
| 1                | $t_{c(SPC)}S$ Cycle time, SPICLK <sup>(5)</sup>                                                              | 40               |                                     | ns   |
| 2 <sup>(6)</sup> | $t_{w(SPCH)}S$ Pulse duration, SPICLK high (clock polarity = 0)                                              | 14               |                                     | ns   |
|                  | $t_{w(SPCL)}S$ Pulse duration, SPICLK low (clock polarity = 1)                                               | 14               |                                     |      |
| 3 <sup>(6)</sup> | $t_{w(SPCL)}S$ Pulse duration, SPICLK low (clock polarity = 0)                                               | 14               |                                     | ns   |
|                  | $t_{w(SPCH)}S$ Pulse duration, SPICLK high (clock polarity = 1)                                              | 14               |                                     |      |
| 4 <sup>(6)</sup> | $t_{d(SOMI-SPCL)}S$ Delay time, SPISOMI data valid after SPICLK low (clock polarity = 0)                     |                  | $t_{rf(SOMI)} + 20$                 | ns   |
|                  | $t_{d(SOMI-SPCH)}S$ Delay time, SPISOMI data valid after SPICLK high (clock polarity = 1)                    |                  | $t_{rf(SOMI)} + 20$                 |      |
| 5 <sup>(6)</sup> | $t_h(SPCL-SOMI)S$ Hold time, SPISOMI data valid after SPICLK high (clock polarity = 0)                       | 2                |                                     | ns   |
|                  | $t_h(SPCH-SOMI)S$ Hold time, SPISOMI data valid after SPICLK low (clock polarity = 1)                        | 2                |                                     |      |
| 6 <sup>(6)</sup> | $t_{su(SIMO-SPCH)}S$ Setup time, SPISIMO before SPICLK high (clock polarity = 0)                             | 4                |                                     | ns   |
|                  | $t_{su(SIMO-SPCL)}S$ Setup time, SPISIMO before SPICLK low (clock polarity = 1)                              | 4                |                                     |      |
| 7 <sup>(6)</sup> | $t_v(SPCH-SIMO)S$ High time, SPISIMO data valid after SPICLK high (clock polarity = 0)                       | 2                |                                     | ns   |
|                  | $t_v(SPCL-SIMO)S$ High time, SPISIMO data valid after SPICLK low (clock polarity = 1)                        | 2                |                                     |      |
| 8                | $t_d(SPCH-SENAn)S$ Delay time, SPIENAn high after last SPICLK high (clock polarity = 0)                      | $1.5t_{c(VCLK)}$ | $2.5t_{c(VCLK)} + t_{r(ENAn)} + 22$ | ns   |
|                  | $t_d(SPCL-SENAn)S$ Delay time, SPIENAn high after last SPICLK low (clock polarity = 1)                       | $1.5t_{c(VCLK)}$ | $2.5t_{c(VCLK)} + t_{r(ENAn)} + 22$ |      |
| 9                | $t_d(SCSL-SENAL)S$ Delay time, SPIENAn low after SPICSn low (if new data has been written to the SPI buffer) | $t_{f(ENAn)}$    | $t_{c(VCLK)} + t_{f(ENAn)} + 27$    | ns   |
| 10               | $t_d(SCSL-SOMI)S$ Delay time, SOMI valid after SPICSn low (if new data has been written to the SPI buffer)   | $t_{c(VCLK)}$    | $2t_{c(VCLK)} + t_{f(SOMI)} + 28$   | ns   |

- (1) The MASTER bit (SPIGCR1.0) is cleared and the CLOCK PHASE bit (SPIFMTx.16) is set.
- (2) If the SPI is in slave mode, the following must be true:  $t_{c(SPC)}S \leq (PS + 1) t_{c(VCLK)}$ , where PS = prescale value set in SPIFMTx.[15:8].
- (3) For rise and fall timings, see 表 6-6, *Switching Characteristics for Output Timings versus Load Capacitance (LC)*.
- (4)  $t_{c(VCLK)}$  = interface clock cycle time =  $1 / f_{i(VCLK)}$
- (5) When the SPI is in Slave mode, the following must be true:  
For PS values from 1 to 255:  $t_{c(SPC)}S \geq (PS + 1)t_{c(VCLK)} \geq 40ns$ , where PS is the prescale value set in the SPIFMTx.[15:8] register bits.  
For PS values of 0:  $t_{c(SPC)}S = 2t_{c(VCLK)} \geq 40ns$ .
- (6) The active edge of the SPICLK signal referenced is controlled by the CLOCK POLARITY bit (SPIFMTx.17).

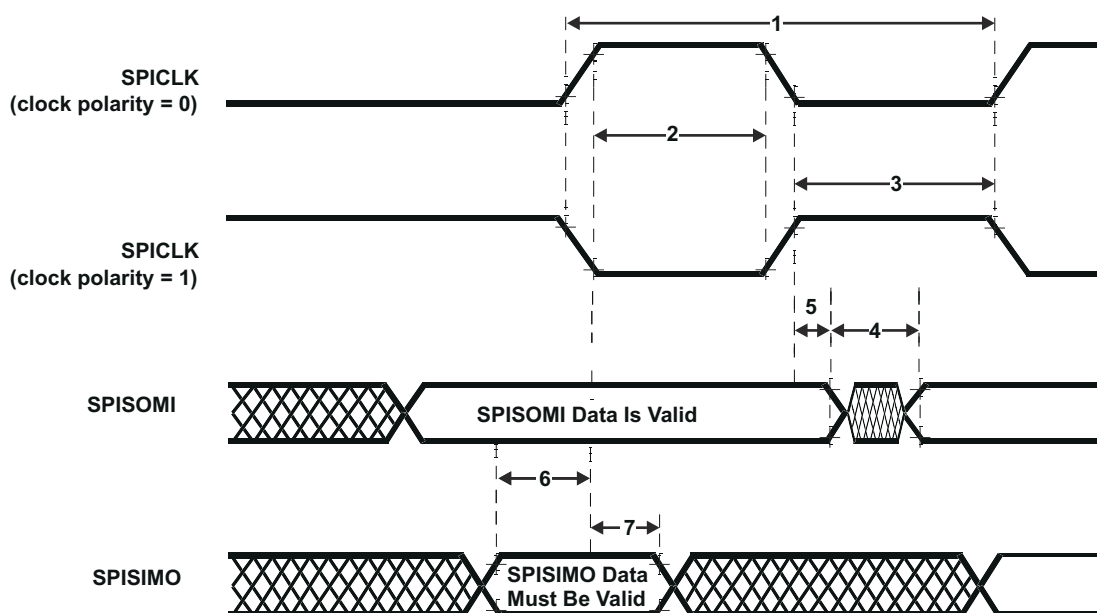


图 8-26. SPI Slave Mode External Timing (CLOCK PHASE = 1)

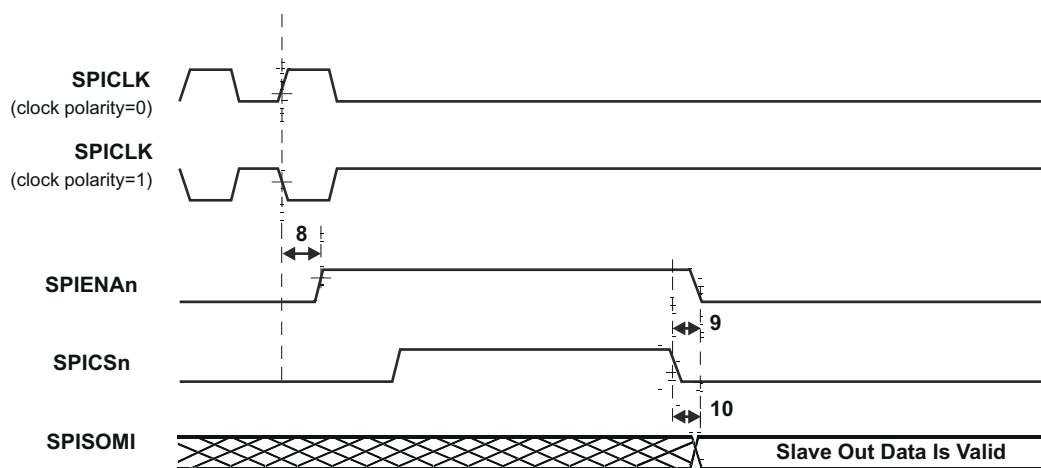


图 8-27. SPI Slave Mode Enable Timing (CLOCK PHASE = 1)

### 8.13 Ethernet Media Access Controller

The Ethernet Media Access Controller (EMAC) provides an efficient interface between the device and the network. The EMAC supports both 10Base-T and 100Base-TX, or 10 Mbits/second (Mbps) and 100 Mbps in either half- or full-duplex mode, with hardware flow control and quality of service (QoS) support.

The EMAC controls the flow of packet data from the device to the PHY. The MDIO module controls PHY configuration and status monitoring.

Both the EMAC and the MDIO modules interface to the device through a custom interface that allows efficient data transmission and reception. This custom interface is referred to as the EMAC control module, and is considered integral to the EMAC/MDIO peripheral. The control module is also used to multiplex and control interrupts.

#### 8.13.1 Ethernet MII Electrical and Timing Specifications

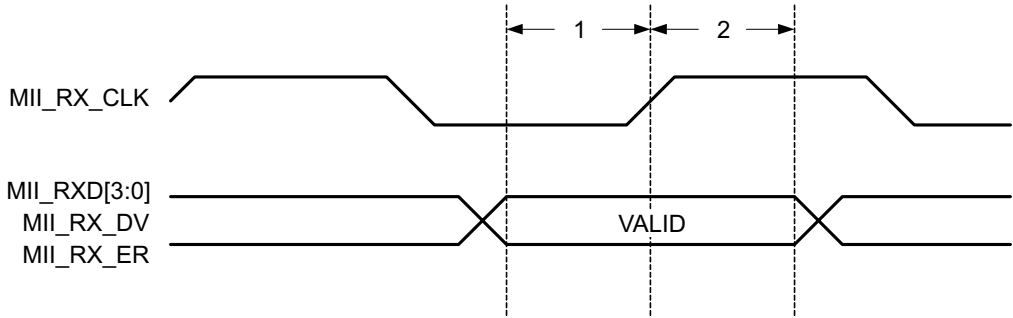


图 8-28. MII Receive Timing

表 8-42. Timing Requirements for EMAC MII Receive

| NO. |                               |                                                            | MIN | MAX | UNIT |
|-----|-------------------------------|------------------------------------------------------------|-----|-----|------|
| 1   | $t_{su}(MIIRXD - MIIRXCLKH)$  | Setup time, MII_RXD[3:0] before MII_RX_CLK rising edge     | 8   |     | ns   |
|     | $t_{su}(MIIRXDV - MIIRXCLKH)$ | Setup time, MII_RX_DV before MII_RX_CLK rising edge        | 8   |     | ns   |
|     | $t_{su}(MIIRXER - MIIRXCLKH)$ | Setup time, MII_RX_ER before MII_RX_CLK rising edge        | 8   |     | ns   |
| 2   | $t_h(MIIRXCLKH - MIIRXD)$     | Hold time, MII_RXD[3:0] valid after MII_RX_CLK rising edge | 8   |     | ns   |
|     | $t_h(MIIRXCLKH - MIIRXDV)$    | Hold time, MII_RX_DV valid after MII_RX_CLK rising edge    | 8   |     | ns   |
|     | $t_h(MIIRXCLKH - MIIRXER)$    | Hold time, MII_RX_ER valid after MII_RX_CLK rising edge    | 8   |     | ns   |

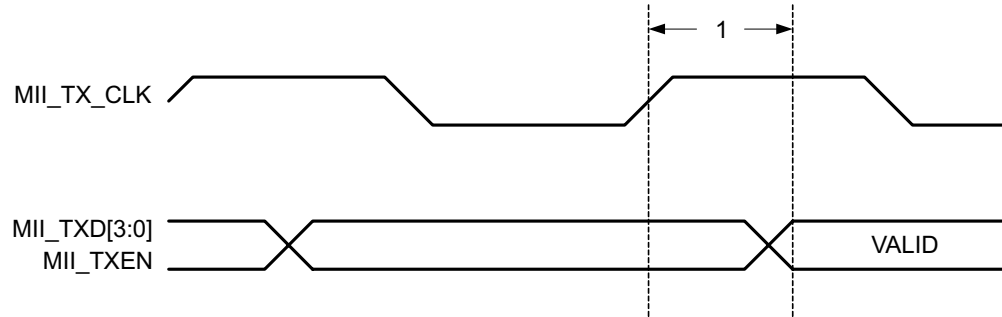


图 8-29. MII Transmit Timing

表 8-43. Switching Characteristics Over Recommended Operating Conditions for EMAC MII Transmit

| NO. | PARAMETER                    |                                                          | MIN | MAX | UNIT |
|-----|------------------------------|----------------------------------------------------------|-----|-----|------|
| 1   | $t_{d(MIIRXCLKH - MIITXD)}$  | Delay time, MII_TX_CLK rising edge to MII_TXD[3:0] valid | 5   | 25  | ns   |
|     | $t_{d(MIIRXCLKH - MIITXEN)}$ | Delay time, MII_TX_CLK rising edge to MII_TXEN valid     | 5   | 25  | ns   |

### 8.13.2 Ethernet RMII Electrical and Timing Specifications

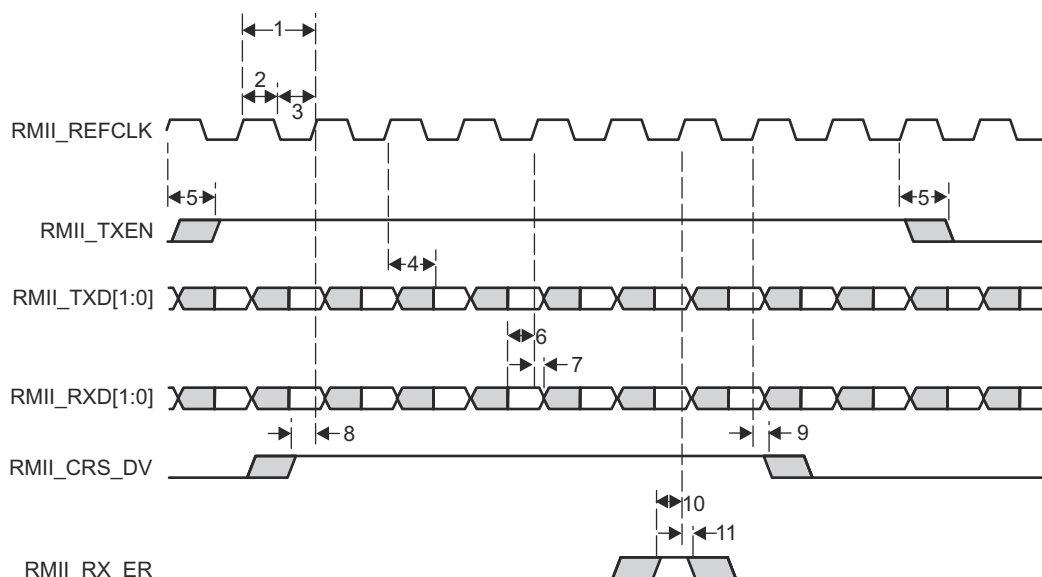


图 8-30. RMII Timing Diagram

表 8-44. Timing Requirements for EMAC RMII Receive and RMII\_REFCLK

| NO. |                                                                                    | MIN | NOM | MAX | UNIT |
|-----|------------------------------------------------------------------------------------|-----|-----|-----|------|
| 1   | $t_{c(REFCLK)}$ Cycle time, RMII_REFCLK                                            |     | 20  |     | ns   |
| 2   | $t_{w(REFCLKH)}$ Pulse width, RMII_REFCLK high                                     | 7   |     | 13  | ns   |
| 3   | $t_{w(REFCLKL)}$ Pulse width, RMII_REFCLK low                                      | 7   |     | 13  | ns   |
| 6   | $t_{su(RXD-REFCLK)}$ Input setup time, RMII_RXD[1:0] valid before RMII_REFCLK high | 4   |     |     | ns   |
| 7   | $t_{h(REFCLK-RXD)}$ Input hold time, RMII_RXD[1:0] valid after RMII_REFCLK high    | 2   |     |     | ns   |
| 8   | $t_{su(CRSDV-REFCLK)}$ Input setup time, RMII_CRSDV valid before RMII_REFCLK high  | 4   |     |     | ns   |
| 9   | $t_{h(REFCLK-CRSDV)}$ Input hold time, RMII_CRSDV valid after RMII_REFCLK high     | 2   |     |     | ns   |
| 10  | $t_{su(RXER-REFCLK)}$ Input setup time, RMII_RX_ER valid before RMII_REFCLK high   | 4   |     |     | ns   |
| 11  | $t_{h(REFCLK-RXER)}$ Input hold time, RMII_RX_ER valid after RMII_REFCLK high      | 2   |     |     | ns   |

表 8-45. Switching Characteristics Over Recommended Operating Conditions for EMAC RMII Transmit

| NO. | PARAMETER            |                                                              | MIN | MAX | UNIT |
|-----|----------------------|--------------------------------------------------------------|-----|-----|------|
| 4   | $t_{d(REFCLK-TXD)}$  | Output delay time, RMII_REFCLK high to RMII_TXD[1:0] invalid | 2   |     | ns   |
|     |                      | Output delay time, RMII_REFCLK high to RMII_TXD[1:0] valid   |     | 16  | ns   |
| 5   | $t_{d(REFCLK-TXEN)}$ | Output delay time, RMII_REFCLK high to RMII_TXEN invalid     | 2   |     | ns   |
|     |                      | Output delay time, RMII_REFCLK high to RMII_TXEN valid       |     | 16  | ns   |

### 8.13.3 Management Data Input/Output (MDIO)

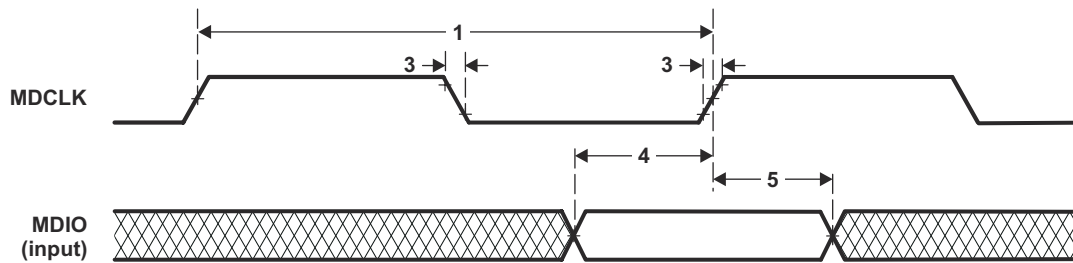


图 8-31. MDIO Input Timing

表 8-46. MDIO Input Timing Requirements

| NO. | Parameter        |                                                     | Value             |     | Unit |
|-----|------------------|-----------------------------------------------------|-------------------|-----|------|
|     |                  |                                                     | MIN               | MAX |      |
| 1   | tc(MDCLK)        | Cycle time, MDCLK                                   | 400               | -   | ns   |
| 2   | tw(MDCLK)        | Pulse duration, MDCLK high/low                      | 180               | -   | ns   |
| 3   | tt(MDCLK)        | Transition time, MDCLK                              | -                 | 5   | ns   |
| 4   | tsu(MDIO-MDCLKH) | Setup time, MDIO data input valid before MDCLK High | 12 <sup>(1)</sup> | -   | ns   |
| 5   | th(MDCLKH-MDIO)  | Hold time, MDIO data input valid after MDCLK High   | 1                 | -   | ns   |

(1) This is a discrepancy to IEEE 802.3, but is compatible with many PHY devices.

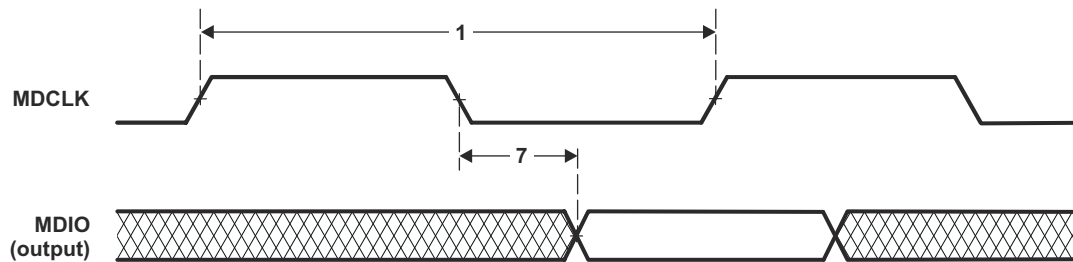


图 8-32. MDIO Output Timing

表 8-47. MDIO Output Timing Requirements

| NO. | Parameter       |                                                 | Value |     | Unit |
|-----|-----------------|-------------------------------------------------|-------|-----|------|
|     |                 |                                                 | MIN   | MAX |      |
| 1   | tc(MDCLK)       | Cycle time, MDCLK                               | 400   | -   | ns   |
| 7   | td(MDCLKL-MDIO) | Delay time, MDCLK low to MDIO data output valid | 0     | 100 | ns   |

## 9 Applications, Implementation, and Layout

---

### 备注

Information in the following sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

---

### 9.1 TI Design or Reference Design

TI Designs Reference Design Library is a robust reference design library spanning analog, embedded processor, and connectivity. Created by TI experts to help you jump start your system design, all TI Designs include schematic or block diagrams, BOMs, and design files to speed your time to market. Search and download designs at [TIDesigns](#).

## 10 Device and Documentation Support

### 10.1 Device Support

#### 10.1.1 Development Support

Texas Instruments (TI) offers an extensive line of development tools for the Hercules™ Safety generation of MCUs, including tools to evaluate the performance of the processors, generate code, develop algorithm implementations, and fully integrate and debug software and hardware modules.

The following products support development of Hercules™-based applications:

##### Software Development Tools

- Code Composer Studio™ Integrated Development Environment (IDE)
  - C/C++ Compiler
  - Code generation tools
  - Assembler/Linker
  - Cycle Accurate Simulator
- Application algorithms
- Sample applications code

##### Hardware Development Tools

- Development and evaluation boards
- JTAG-based emulators - XDS100 v2, XDS200, XDS560™ v2 emulator
- Flash programming tools
- Power supply
- Documentation and cables

#### 10.1.2 Device and Development-Support Tool Nomenclature

To designate the stages in the product development cycle, TI assigns prefixes to the part numbers of all devices. Each commercial family member has one of three prefixes: TMX, TMP, or TMS. These prefixes represent evolutionary stages of product development from engineering prototypes (TMX) through fully qualified production devices (TMS).

Device development evolutionary flow:

**TMX** Experimental device that is not necessarily representative of the final device's electrical specifications.

**TMP** Final silicon die that conforms to the device's electrical specifications but has not completed quality and reliability verification.

**TMS** Fully-qualified production device.

TMX and TMP devices are shipped against the following disclaimer:

"Developmental product is intended for internal evaluation purposes."

TMS devices have been characterized fully, and the quality and reliability of the device have been demonstrated fully. TI's standard warranty applies.

Predictions show that prototype devices (TMX or TMP) have a greater failure rate than the standard production devices. Texas Instruments recommends that these devices not be used in any production system because their expected end-use failure rate still is undefined. Only qualified production devices are to be used.

图 10-1 shows the numbering and symbol nomenclature for the TMS570LC4357-SEP.

| Full Part #      | TMS | 570 | LC | 43 | 5 | 7 | B | GWT | SEP | R |
|------------------|-----|-----|----|----|---|---|---|-----|-----|---|
| Orderable Part # | TMX | 570 |    | 43 | 5 | 7 | B | GWT | SEP | R |

**Prefix: TM**

TMS = Fully Qualified  
 TMP = Prototype  
 TMX = Samples

**Core Technology:**

570 = Cortex R5F

**Architecture:**

LC = Dual CPUs in Lockstep with caches  
 (not included in orderable part #)

**Flash Memory Size:**

43 = 4MB

**RAM Size:**

5 = 512KB

**Peripheral Set:**

7 = FlexRay, Ethernet

**Die Revision:**

B = 2nd Die Revision

**Package Type:**

GWT = 337 BGA Package

**Temperature Range:**

SEP = -55°C to 150°C (T<sub>J</sub>)

**Shipping Options:**

R = Tape and Reel

**图 10-1. TMS570LC4357-SEP Device Numbering Conventions**

## 10.2 Documentation Support

### 10.2.1 Related Documentation from Texas Instruments

The following documents describe the *TMS570LC4357* microcontroller. .

[SPNU563](#) *TMS570LC43x 16/32-Bit RISC Flash Microcontroller Technical Reference Manual* details the integration, the environment, the functional description, and the programming models for each peripheral and subsystem in the device.

[SPNZ232](#) *TMS570LC4x Microcontroller, Silicon Revision B, Silicon Errata* describes the usage notes and known exceptions to the functional specifications for the device silicon revision(s).

[SPNA249](#) SEL report

[SPNK004](#) Radiation report

### 10.2.2 Receiving Notification of Documentation Updates

To receive notification of documentation updates, navigate to the device product folder on [ti.com](#). In the upper right corner, click on Alert me to register and receive a weekly digest of any product information that has changed. For change details, review the revision history included in any revised document.

## 10.3 支持资源

[TI E2E™ 中文支持论坛](#)是工程师的重要参考资料，可直接从专家处获得快速、经过验证的解答和设计帮助。搜索现有解答或提出自己的问题，获得所需的快速设计帮助。

链接的内容由各个贡献者“按原样”提供。这些内容并不构成 TI 技术规范，并且不一定反映 TI 的观点；请参阅 TI 的[使用条款](#)。

## 10.4 Trademarks

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## 10.5 静电放电警告



静电放电 (ESD) 会损坏这个集成电路。德州仪器 (TI) 建议通过适当的预防措施处理所有集成电路。如果不遵守正确的处理和安装程序，可能会损坏集成电路。

ESD 的损坏小至导致微小的性能降级，大至整个器件故障。精密的集成电路可能更容易受到损坏，这是因为非常细微的参数更改都可能会导致器件与其发布的规格不相符。

## 10.6 术语表

### TI 术语表

本术语表列出并解释了术语、首字母缩略词和定义。

## 10.7 Device Identification

### 10.7.1 Device Identification Code Register

The device identification code register is memory mapped to address FFFF FFF0h and identifies several aspects of the device including the silicon version. The details of the device identification code register are provided in 表 10-1. The device identification code register value for this device is:

- Rev A = 0x8044AD05
- Rev B = 0x8044AD0D

图 10-2. Device ID Bit Allocation Register

|       |    |                  |             |    |               |           |    |         |         |         |    |    |    |    |      |     |     |
|-------|----|------------------|-------------|----|---------------|-----------|----|---------|---------|---------|----|----|----|----|------|-----|-----|
| 31    | 30 | 29               | 28          | 27 | 26            | 25        | 24 | 23      | 22      | 21      | 20 | 19 | 18 | 17 | 16   |     |     |
| CP-15 |    | UNIQUE ID        |             |    |               |           |    |         |         |         |    |    |    |    | TECH |     |     |
| R-1   |    | R-00000000100010 |             |    |               |           |    |         |         |         |    |    |    |    | R-0  |     |     |
| 15    | 14 | 13               | 12          | 11 | 10            | 9         | 8  | 7       | 6       | 5       | 4  | 3  | 2  | 1  | 0    |     |     |
| TECH  |    |                  | I/O VOLTAGE |    | PERIPH PARITY | FLASH ECC |    | RAM ECC | VERSION |         |    |    |    | 1  | 0    | 1   |     |
| R-101 |    |                  | R-0         |    | R-1           | R-10      |    | R-1     |         | R-00000 |    |    |    |    | R-1  | R-0 | R-1 |

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

|       |           |                  |             |               |           |   |         |         |   |   |   |   |     |     |      |     |
|-------|-----------|------------------|-------------|---------------|-----------|---|---------|---------|---|---|---|---|-----|-----|------|-----|
| CP-15 | UNIQUE ID |                  |             |               |           |   |         |         |   |   |   |   |     |     | TECH |     |
| R-1   |           | R-00000000100010 |             |               |           |   |         |         |   |   |   |   |     |     |      | R-0 |
| 15    | 14        | 13               | 12          | 11            | 10        | 9 | 8       | 7       | 6 | 5 | 4 | 3 | 2   | 1   | 0    |     |
| TECH  |           |                  | I/O VOLTAGE | PERIPH PARITY | FLASH ECC |   | RAM ECC | VERSION |   |   |   |   | 1   | 0   | 1    |     |
| R-101 |           |                  | R-0         | R-1           | R-10      |   | R-1     | R-00000 |   |   |   |   | R-1 | R-0 | R-1  |     |

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

表 10-1. Device ID Bit Allocation Register Field Descriptions

| Bit   | Field             | Value  | Description                                                                                                         |
|-------|-------------------|--------|---------------------------------------------------------------------------------------------------------------------|
| 31    | CP15              | 1      | Indicates the presence of coprocessor 15<br>CP15 present                                                            |
| 30-17 | UNIQUE ID         | 100011 | Silicon version (revision) bits.<br>This bitfield holds a unique number for a dedicated device configuration (die). |
| 16-13 | TECH              | 0101   | Process technology on which the device is manufactured.<br>F021                                                     |
| 12    | I/O VOLTAGE       | 0      | I/O voltage of the device.<br>I/O are 3.3v                                                                          |
| 11    | PERIPHERAL PARITY | 1      | Peripheral Parity<br>Parity on peripheral memories                                                                  |
| 10-9  | FLASH ECC         | 10     | Flash ECC<br>Program memory with ECC                                                                                |
| 8     | RAM ECC           | 1      | Indicates if RAM ECC is present.<br>ECC implemented                                                                 |

表 10-1. Device ID Bit Allocation Register Field Descriptions ( 续 )

| Bit | Field    | Value | Description                            |
|-----|----------|-------|----------------------------------------|
| 7-3 | REVISION |       | Revision of the Device.                |
| 2-0 | 101      |       | The platform family ID is always 0b101 |

### 10.7.2 Die Identification Registers

The two die ID registers at addresses 0xFFFFF7C and 0xFFFFF80 form a 64-bit die id with the information as listed in [表 10-2](#).

**表 10-2. Die-ID Registers**

| Item              | # of Bits | Bit Location     |
|-------------------|-----------|------------------|
| X Coord. on Wafer | 12        | 0xFFFFF7C[11:0]  |
| Y Coord. on Wafer | 12        | 0xFFFFF7C[23:12] |
| Wafer #           | 8         | 0xFFFFF7C[31:24] |
| Lot #             | 24        | 0xFFFFF80[23:0]  |
| Reserved          | 8         | 0xFFFFF80[31:24] |

## 10.8 Module Certifications

The following communications modules have received certification of adherence to a standard.

### 10.8.1 FlexRay Certifications

# FlexRay™ Protocol Conformance Certificate

**Device (IUT):**  
**Name:** TMS570LC4357 Rev B  
**Package:** ZWT (S-PBGA-N337) Plastic Ball Grid Array  
**Version:** Core Release Register: 0x10390206 (CREL[31:0])  
Device Identification Code: 0x8044AD0D (DEVID[31:0])  
**Vendor:** Texas Instruments Incorporated  
12500 TI Boulevard  
Dallas, Texas 75243  
USA

**Test basis:**  
FlexRay™ protocol version: 2.1 / 2.1RevA  
Test specification version: 2.1.2

**Test execution:**  
Date: 24.09.2015  
Hour of completion: 14:01

**Test results:**  
Test cases executed: 275  
Test cases passed: 275  
Test cases failed: 0

**Test report:**  
Execution ID:  
TMS570LS4355BZWT201509241401

Essen, 19.10.2015  
**Michael Pluta**  
*Digitally signed by Michael Pluta  
DN: cn=Michael Pluta, o=TÜV NORD Mobilität,  
ou=IT, email=pluta@tuev-nord.de, c=DE  
Date: 2015.10.20 12:26:14 +0200*  
**TÜV NORD Mobilität GmbH & Co.KG**  
Institute for Vehicle Technology and Mobility

---

**IUT-Details – According to the vendor's data sheet, the IUT has the following peculiarities and optional features:**

| Peculiarity                                            | Value       |
|--------------------------------------------------------|-------------|
| MTS transmission activation adjustment time-string     | 0:x:x:0:0:0 |
| MTS transmission deactivation adjustment time-string   | 0:x:x:0:0:0 |
| MTS transmission deactivation required                 | False       |
| cIntDecoderDelay [ST]                                  | 8           |
| cColdstartCollisionAbortDelay [µT]                     | 10          |
| Message ID filtering impl. Via valid message indicator | False       |

| Optional feature                                | Supported/Unsupported |
|-------------------------------------------------|-----------------------|
| Message ID filtering                            | Unsupported           |
| Relative timer                                  | Supported             |
| Network Management Vector                       | Supported             |
| (Re)setting of the 'transmit buffer valid flag' | Supported             |

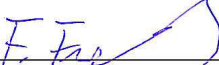
This certificate is valid for the hardware and software configuration documented in the test report.



GWT is identical to ZWT package with the exception of the use of lead solder balls.

**图 10-3. FlexRay Certification for GWT Package**

## 10.8.2 DCAN Certification

|                                                                                                                                                                                                                                                                                                                                                                               |                                                                                                                                                                                                                                                                                                                                                                                                                                                               |                                                                                                                                                                            |
|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| <b>Testhouse</b><br>C&S group GmbH<br>Am Exer 19b<br>D-38302 Wolfenbuettel<br>Phone: +49 5331/90 555-0<br>Fax: +49 5331/90 555-110                                                                                                                                                                                                                                            |                                                                                                                                                                                                                                                                                                                                                                                                                                                               | <br> |
| <b>Authentication</b><br>on CAN Conformance                                                                                                                                                                                                                                                                                                                                   |                                                                                                                                                                                                                                                                                                                                                                                                                                                               | <b>Texas Instruments</b><br>P10_0294_021_CAN_DL_Test_Authentication_r01.doc<br>Date of Approval: 2011-Feb-08                                                               |
| C&S is worldwide recognized as a neutral expert in testing of communication systems such as CAN Transceiver, CAN, CAN Software Drivers, (CAN) Network Management, FlexRay and LIN.<br>Herewith C&S group is proud to confirm that the followings tests on the subsequently specified device implementations have been performed by C&S resulting in the findings given below: |                                                                                                                                                                                                                                                                                                                                                                                                                                                               |                                                                                                                                                                            |
| <h3>C&amp;S Conformance Test Results</h3>                                                                                                                                                                                                                                                                                                                                     |                                                                                                                                                                                                                                                                                                                                                                                                                                                               |                                                                                                                                                                            |
| <b>Manufacturer</b>                                                                                                                                                                                                                                                                                                                                                           | Texas Instruments                                                                                                                                                                                                                                                                                                                                                                                                                                             |                                                                                                                                                                            |
| <b>Component/Part Number</b>                                                                                                                                                                                                                                                                                                                                                  | TMSx70 x021 Microcontroller Family, DCAN Core Release<br>0xA3170504, 980 A2C0007940000 X470MUF C63C1<br>P80576 24 YFB-08A9X6W                                                                                                                                                                                                                                                                                                                                 |                                                                                                                                                                            |
| <b>Date of Tests</b>                                                                                                                                                                                                                                                                                                                                                          | February 2011                                                                                                                                                                                                                                                                                                                                                                                                                                                 |                                                                                                                                                                            |
| <b>Version of Test Specification</b>                                                                                                                                                                                                                                                                                                                                          | CAN Conformance Test<br>1 ISO CAN Conformance Tests according to "ISO 16845:2004 Road vehicles - Controller area network (CAN) - Conformance test plan" and C&S enhancement/ corrections according to "CAN CONFORMANCE TESTING Test Specification C&S Version 2.0 RC"<br>2 C&S Register Functionality Tests according to "C&S Register Functionality Test Specification V2.0"<br>3 C&S Robustness Tests according to "C&S Robustness Test Specification V1.4" |                                                                                                                                                                            |
| <b>Corresponding Test Report</b>                                                                                                                                                                                                                                                                                                                                              | P10_0294_020_CAN_DL_Test_report_r01                                                                                                                                                                                                                                                                                                                                                                                                                           |                                                                                                                                                                            |
| 1 ISO CAN conformance tests                                                                                                                                                                                                                                                                                                                                                   | Pass                                                                                                                                                                                                                                                                                                                                                                                                                                                          |                                                                                                                                                                            |
| 2 C&S Register Functionality tests                                                                                                                                                                                                                                                                                                                                            | Pass                                                                                                                                                                                                                                                                                                                                                                                                                                                          |                                                                                                                                                                            |
| 3 C&S Robustness tests                                                                                                                                                                                                                                                                                                                                                        | Pass                                                                                                                                                                                                                                                                                                                                                                                                                                                          |                                                                                                                                                                            |
| • Further Observations                                                                                                                                                                                                                                                                                                                                                        | None                                                                                                                                                                                                                                                                                                                                                                                                                                                          |                                                                                                                                                                            |
| <br>Frank Fischer, CTO                                                                                                                                                                                                                                                                     |                                                                                                                                                                                                                                                                                                                                                                                                                                                               | <br>Lothar Kukla, Project Manager                                                      |

Quote No. P10\_0294 R01

图 10-4. DCAN Certification

## 10.8.3 LIN Certification

### 10.8.3.1 LIN Master Mode



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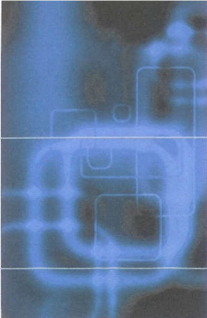


LOCAL INTERCONNECT NETWORK



**DAKKS**  
Deutsche  
Akkreditierungsstelle  
D-PL-17201-01-01

Accredited test lab by DAKKS GmbH according DIN ISO/IEC 17025.  
The accreditation is valid for all test methods stated in the certificate.



## Test Summary

for

# LIN 2.1 Conformance Test - Master

|                                                                                                                                                                                                                                                                                                                                                                                               |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                               |
|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| <p><i>Client / Manufacturer:</i></p> <p><i>Implementation Under Test:</i></p> <p><i>Part Number:</i></p> <p><i>Revision:</i></p> <p><i>Test Sample Marking:</i></p> <p><i>Test Board:</i></p> <p><i>Performed Tests:</i></p> <p><i>Specification References:</i></p> <p><i>Result / Status:</i></p> <p><i>Version / Date:</i></p> <p><i>Document Number:</i></p> <p><i>ihr Reference:</i></p> | <p><b>Texas Instruments</b></p> <p>Automotive Applications</p> <p>12500 TI Boulevard</p> <p>75243 DALLAS, TEXAS</p> <p>UNITED STATES OF AMERICA</p> <p><b>Microcontroller TMS570LS3137</b></p> <p><b>LIN Master Mode</b></p> <p>SW: : 2013-05-31_IHR_LIN</p> <p>TMX570LS 3137 CZWTQQ1 YFC-2AAQ32W</p> <p>Gladiator 337 SN# 58 rev. B</p> <p><b>LIN OSI Layer 2 – Data Link Layer</b></p> <p><b>Node Configuration / Network Management</b></p> <p><b>LIN Conformance Test Specification, 10-Oct-2008</b></p> <p>for the LIN Specification Package Revision 2.1 , 24-Nov-2006</p> <p><b>The device has <span style="color: green;">passed</span> the test.</b></p> <p>1.0 / 13-May-2013</p> <p>Test Summary_DLL21_Master_20121130_130513_TMS570LS_V1.0.doc</p> <p>20121130</p> |
|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|

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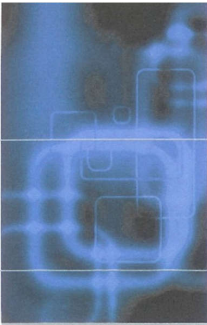
图 10-5. LIN Certification - Master Mode

### 10.8.3.2 LIN Slave Mode - Fixed Baud Rate

  
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LOCAL INTERCONNECT NETWORK

  
Deutsche  
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Accredited test lab by DAKKS GmbH according DIN ISO/IEC 17025.  
The accreditation is valid for all test methods stated in the certificate.



## Test Summary

for

# LIN 2.1 Conformance Test - Slave

**Client / Manufacturer:** **Texas Instruments**  
 Automotive Applications  
 12500 TI Boulevard  
 75243 DALLAS, TEXAS  
 UNITED STATES OF AMERICA

**Implementation Under Test:** **Microcontroller TMS570LS3137**  
**LIN Slave Mode - Fixed Baud Rate Mode**

**Revision:** SW: 2013-05-31\_IHR\_LIN

**Test Sample Marking:** TMX570LS 3137 CZWTQQ1 YFC-2AAQ32W

**Test Board:** Gladiator 337 SN# 58 rev. B

**Performed Tests:** **LIN OSI Layer 2 – Data Link Layer**  
**Node Configuration / Network Management**

**Specification References:** **LIN Conformance Test Specification, 10-Oct-2008**  
 for the LIN Specification Package Revision 2.1 , 24-Nov-2006

**Result / Status:** **The device has passed the test.**

**Version / Date:** 1.0 / 13-May-2013

**Document Number:** Test Summary\_DLL21\_Slave\_Fixed\_20121130\_130513\_TMS570LS\_V1.0.doc

**ihr Reference:** 20121130

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 Konto: 1376209  
 BLZ: 66291400  
 UST-Id-Nr. DE177221429

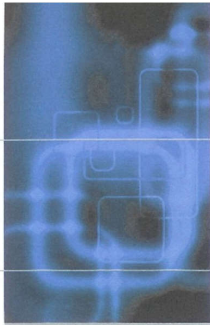
**Geschäftsführer: Jörg Holzberg**  
 Gerichtsstand: Bühl  
 Handelsreg.: Baden-Baden HRB908BH  
 eMail: [info@ihr.de](mailto:info@ihr.de)  
 Internet: [www.ihr.de](http://www.ihr.de)

图 10-6. LIN Certification - Slave Mode - Fixed Baud Rate

### 10.8.3.3 LIN Slave Mode - Adaptive Baud Rate

  
  
LOCAL INTERCONNECT NETWORK

  
  
Deutsche  
Akkreditierungsstelle  
D-PL-17201-01-01  
Accredited test lab by DAKKS GmbH according DIN ISO/IEC 17025.  
The accreditation is valid for all test methods stated in the certificate.



## Test Summary

for

# LIN 2.1 Conformance Test - Slave

|                                   |                                                                                                                              |
|-----------------------------------|------------------------------------------------------------------------------------------------------------------------------|
| <i>Client / Manufacturer:</i>     | <b>Texas Instruments</b><br>Automotive Applications<br>12500 TI Boulevard<br>75243 DALLAS, TEXAS<br>UNITED STATES OF AMERICA |
| <i>Implementation Under Test:</i> | <b>Microcontroller TMS570LS3137</b><br><b>LIN Slave Mode - Adaptive Baud Rate Mode</b>                                       |
| <i>Revision:</i>                  | SW: 2013-05-31_IHR_LIN                                                                                                       |
| <i>Test Sample Marking:</i>       | TMX570LS 3137 CZWTQQ1 YFC-2AAQ32W                                                                                            |
| <i>Test Board:</i>                | Gladiator 337 SN# 58 rev. B                                                                                                  |
| <i>Performed Tests:</i>           | <b>LIN OSI Layer 2 – Data Link Layer</b><br><b>Node Configuration / Network Management</b>                                   |
| <i>Specification References:</i>  | <b>LIN Conformance Test Specification, 10-Oct-2008</b><br>for the LIN Specification Package Revision 2.1 , 24-Nov-2006       |
| <i>Result / Status:</i>           | <b>The device has <span style="color: green;">passed</span> the test.</b>                                                    |
| <i>Version / Date:</i>            | 1.0 / 13-May-2013                                                                                                            |
| <i>Document Number:</i>           | Test Summary_DLL21_Slave_Adapt_TI_TMS570LS_130513_V1.0.doc                                                                   |
| <i>ihr Reference:</i>             | 20121130                                                                                                                     |

**This test summary don't represent a complete test report according the LIN consortium.**  
It contains 16 pages and shall not be reproduced except in full without written approval of the **ihr** Test Center.  
All performed test results concerns the above mentioned IUT revision only.

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图 10-7. LIN Certification - Slave Mode - Adaptive Baud Rate

## 11 Revision History

### Changes from June 30, 2022 to March 6, 2024 (from Revision \* (June 2022) to Revision A (March 2024))

|                                                                                                                         | Page |
|-------------------------------------------------------------------------------------------------------------------------|------|
| • 将 VID 更新为 VID - V62/18621.....                                                                                        | 1    |
| • 删除了“在高达 30krad (Si) 的条件下无 ELDRS” .....                                                                                | 1    |
| • 将每个晶圆批次的 RLAT 总电离剂量 (TID) 从 20krad 更新至 30krad.....                                                                    | 1    |
| • 将等级更新为 30krad.....                                                                                                    | 3    |
| • Deleted extraneous row for MIBSPI1NCS[1]/N2HET1[17] in the GWT Enhanced High-End Timer Modules (N2HET) table.....     | 11   |
| • Added missing section for ethernet controller to the <i>GWT Package</i> section.....                                  | 29   |
| • Added missing section for external memory interface (EMIF) to the <i>GWT Package</i> section.....                     | 32   |
| • Changed operating free-air temperature minimum from – 40°C to – 55°C in <i>Absolute Maximum Ratings</i> ...           | 53   |
| • Changed operating free-air temperature minimum from – 40°C to – 55°C in <i>Recommended Operating Conditions</i> ..... | 54   |
| • Changed operating junction temperature maximum from 125°C to 150°C in <i>Recommended Operating Conditions</i> .....   | 54   |
| • Added SEL Report and Radiation Report .....                                                                           | 213  |

## 12 Mechanical, Packaging, and Orderable Information

The following pages include mechanical packaging and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

## 12.1 Package Option Addendum

### Packaging Information

| Orderable Device  | Status <sup>(1)</sup> | Package Type | Package Drawing | Pins | Package Qty | Eco Plan <sup>(2)</sup> | Lead/Ball Finish <sup>(6)</sup> | MSL Peak Temp <sup>(3)</sup> | Op Temp (°C) | Device Marking <sup>(4) (5)</sup> |
|-------------------|-----------------------|--------------|-----------------|------|-------------|-------------------------|---------------------------------|------------------------------|--------------|-----------------------------------|
| TMS5704357BGWTSEP | PREVIEW               | NFBGA        | GWT             | 337  | TBD         | RoHS & Exempt           | SNPB                            | Level-3-220C-168 HR          | – 55 to 125  | TMS570<br>4357BGWTSEP             |

(1) The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PRE\_PROD** Unannounced device, not in production, not available for mass market, nor on the web, samples not available.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check [www.ti.com/productcontent](http://www.ti.com/productcontent) for the latest availability information and additional product content details.

**TBD:** The Pb-Free/Green conversion plan has not been defined.

**Pb-Free (RoHS):** TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

**Green (RoHS & no Sb/Br):** TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material).

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

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In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

## PACKAGING INFORMATION

| Orderable part number             | Status<br>(1) | Material type<br>(2) | Package   Pins    | Package qty   Carrier | RoHS<br>(3) | Lead finish/<br>Ball material<br>(4) | MSL rating/<br>Peak reflow<br>(5) | Op temp (°C) | Part marking<br>(6)   |
|-----------------------------------|---------------|----------------------|-------------------|-----------------------|-------------|--------------------------------------|-----------------------------------|--------------|-----------------------|
| <a href="#">TMS5704357BGWTSEP</a> | Active        | Production           | NFBGA (GWT)   337 | 1   JEDEC TRAY (10+1) | No          | SNPB                                 | Level-3-220C-168 HR               | -55 to 125   | TMS570<br>4357BGWTSEP |
| V62/18621-01XF                    | Active        | Production           | NFBGA (GWT)   337 | 1   JEDEC TRAY (10+1) | No          | SNPB                                 | Level-3-220C-168 HR               | -55 to 125   | TMS570<br>4357BGWTSEP |

<sup>(1)</sup> **Status:** For more details on status, see our [product life cycle](#).

<sup>(2)</sup> **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

<sup>(3)</sup> **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

<sup>(4)</sup> **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

<sup>(5)</sup> **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

<sup>(6)</sup> **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "-" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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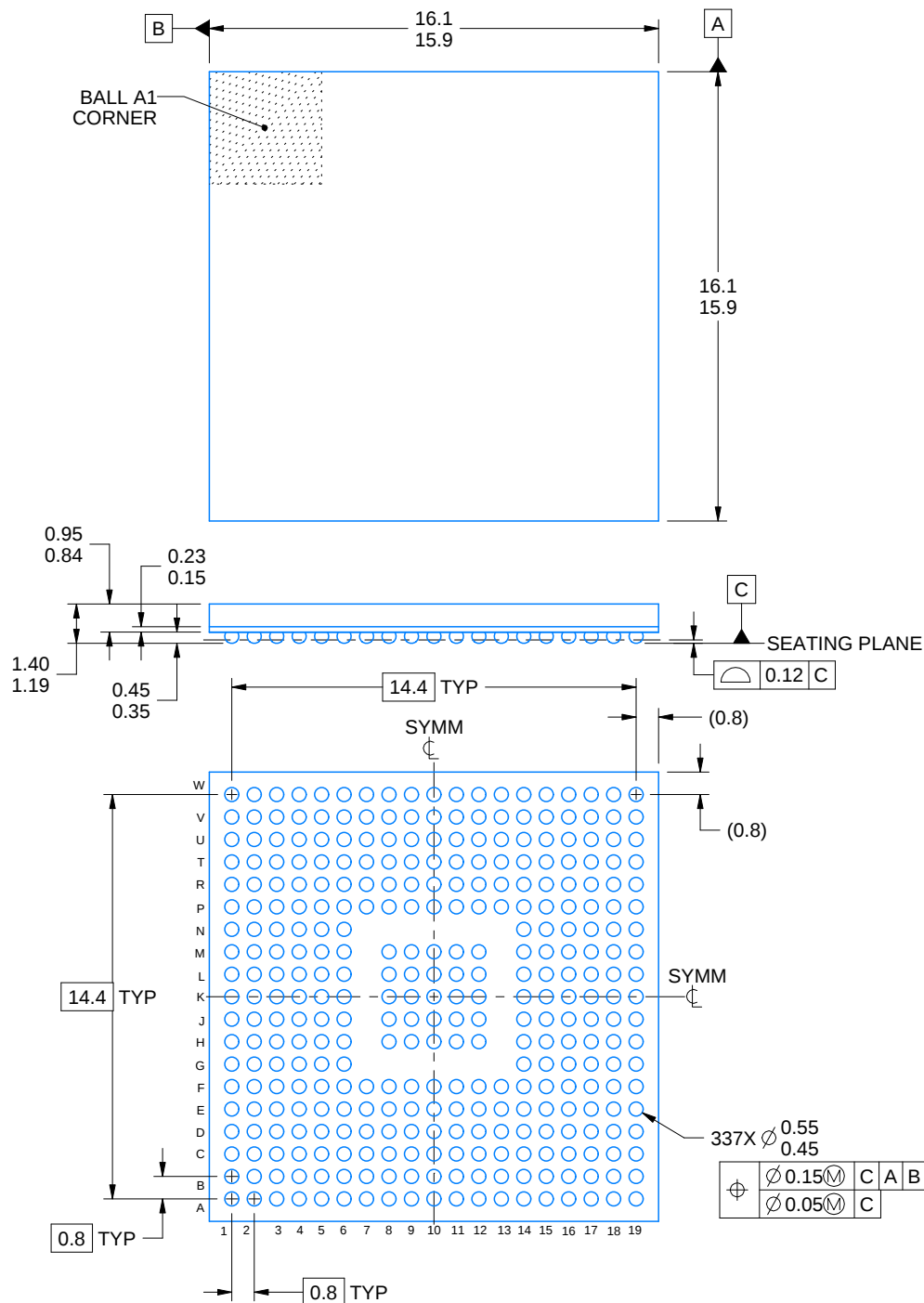
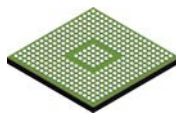
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**OTHER QUALIFIED VERSIONS OF TMS570LC4357-SEP :**

- Enhanced Product : [TMS570LC4357-EP](#)

NOTE: Qualified Version Definitions:

- Enhanced Product - Supports Defense, Aerospace and Medical Applications



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## NOTES:

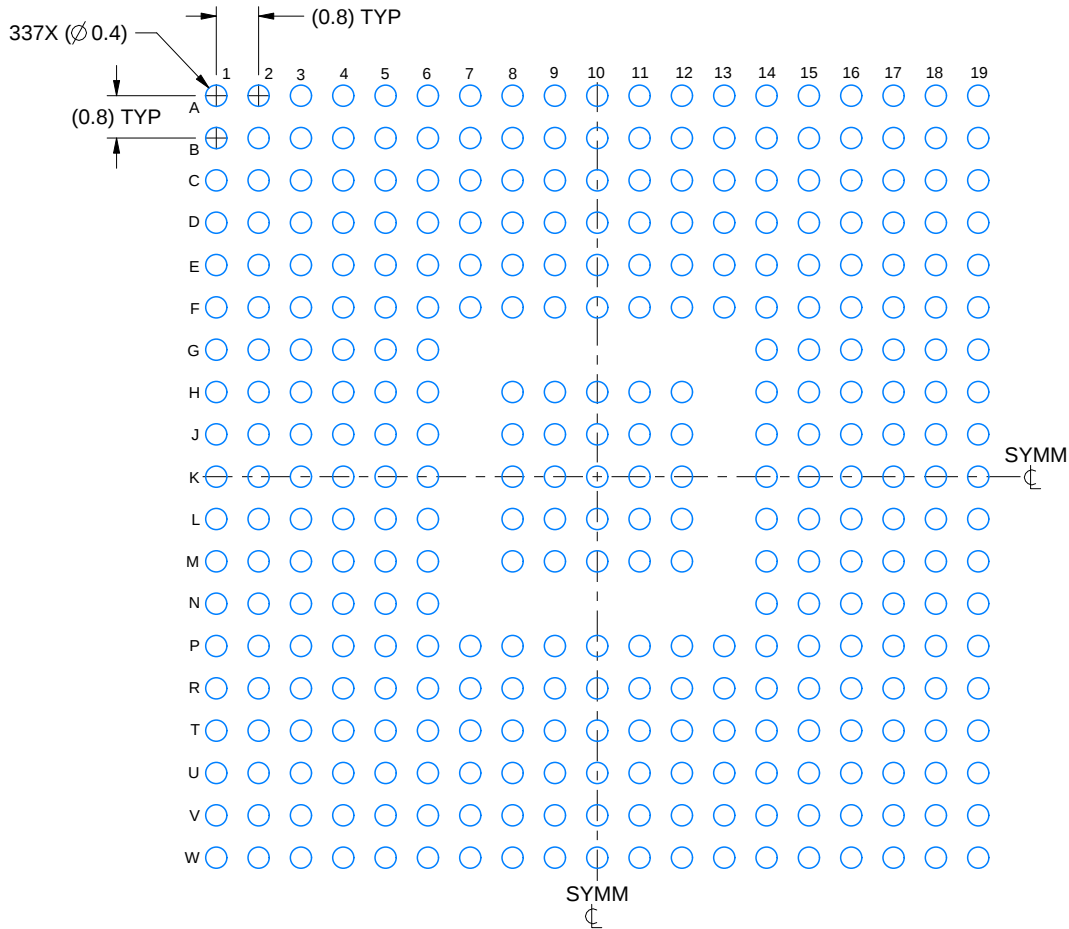
1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.

# EXAMPLE BOARD LAYOUT

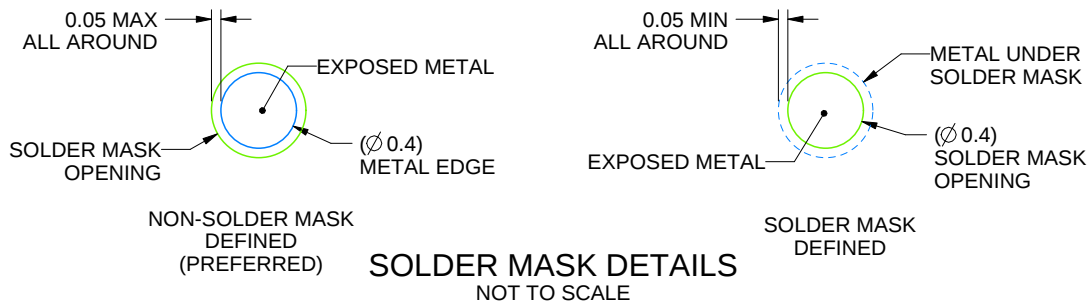
GWT0337A

NFBGA - 1.4 mm max height

PLASTIC BALL GRID ARRAY



**LAND PATTERN EXAMPLE**  
EXPOSED METAL SHOWN  
SCALE: 7X



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NOTES: (continued)

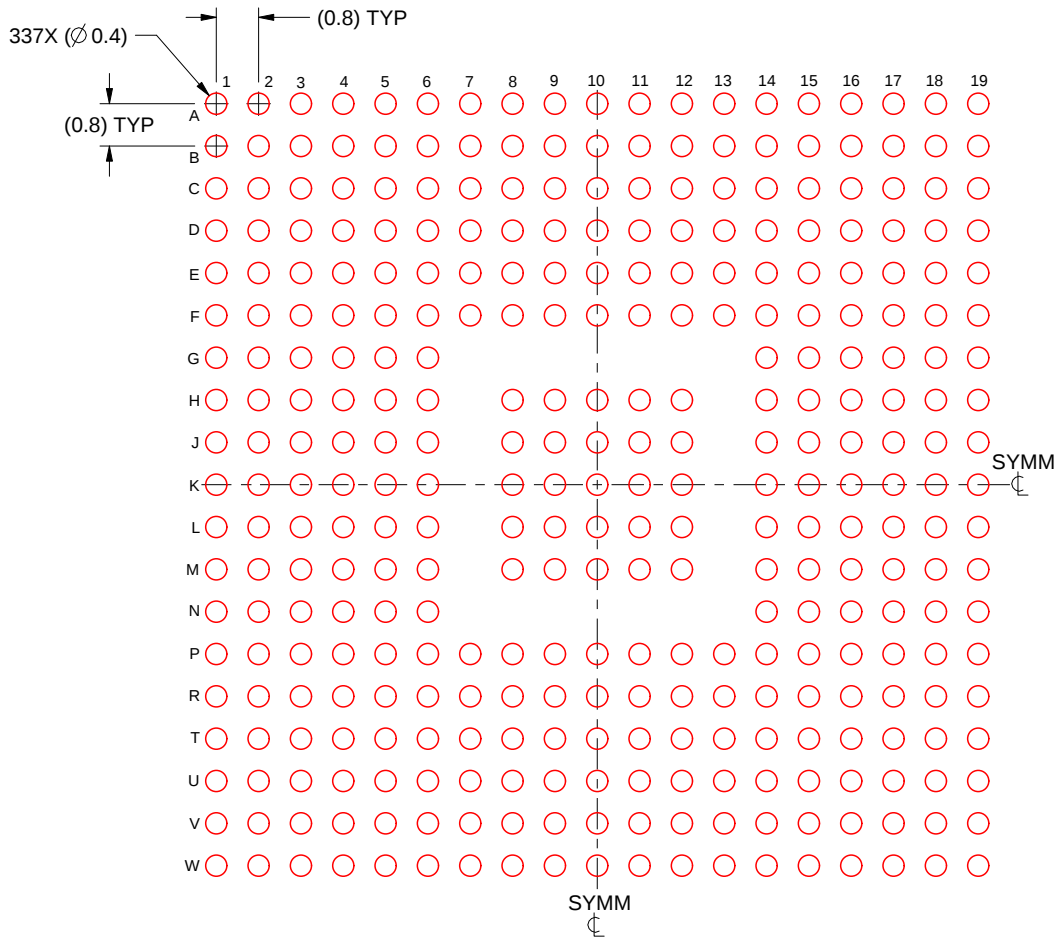
- Final dimensions may vary due to manufacturing tolerance considerations and also routing constraints. For information, see Texas Instruments literature number SPRAA99 ([www.ti.com/lit/spraa99](http://www.ti.com/lit/spraa99)).

# EXAMPLE STENCIL DESIGN

GWT0337A

NFBGA - 1.4 mm max height

PLASTIC BALL GRID ARRAY



**SOLDER PASTE EXAMPLE**  
 BASED ON 0.150 mm THICK STENCIL  
 SCALE: 7X

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NOTES: (continued)

4. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release.

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